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THIN FILMS PHYSICS AND TECHNOLOGY
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MICROSTRUCTURE AND SURFACE MORPHOLOGY
EVOLUTION IN THIN FILMS
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"Electron spectroscopies
applied to thin film analysis"

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ELECTRON SPECTROSCOPIES APPLIED TO THIN FILM ANALYSIS

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3rd Workshop on
Thin Films Physics and
Technology

OUTLINE

- Basic concepts on surface science

- Basic concepts on:

    - Photoemission spectroscopy
    Core levels & valence band states

    - Inverse photoemission
    Conduction band states

    - Auger electron spectroscopy
    Core-core-core transitions
    Core-core-valence transitions
    Core-valence-valence transitions

    - X-ray absorption spectroscopy
    Conduction band states

    - Low energy electron diffraction

    - Electron energy loss spectroscopy
    Valence & conduction band states

QUALITATIVE AND QUANTITATIVE SURFACE ANALYSIS VIA X-RAY PHOTOEMISSION AND AUGER ELECTRON SPECTROSCOPIES

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1. Introduction

The last three decades have seen the birth and development of a wide variety of experimental techniques in solid-state research which share surface sensitivity as a key character.[1-5] These methods enable one to probe chemical and physical properties of solids in a spatial region confined to within a few atomic layers below the solid surface. This opportunity, which crucially benefited from the parallel advance of a wide series of technological areas such as electronic and vacuum industries, has ignited a progressively increasing number of fundamental and applicative researches on the peculiar properties of the surface and near-surface region of solids. At present, a set of these surface-sensitive techniques (SST) are routinely utilized over an unlimited series of technological domains encompassing metallurgic, electronic, chemical, and vacuum industries.

Depending on the specific technique, elemental and chemical information, surface morphology, surface topography, surface structure, or magnetic properties can be addressed. An in-depth understanding of a problem usually demands for the use of a combined series of SST such as photoemission spectroscopy, Auger spectroscopy, electron energy-loss spectroscopy, scanning tunneling microscopy and spectroscopy, secondary-ion mass spectroscopy, surface x-ray diffraction, electron diffraction, atom scattering, and x-ray absorption spectroscopy. Each of the SST is moreover characterized by specific figures of merit as far as, for example, the surface sensitivity, the spatial resolution, the elemental sensitivity and other significant parameters are concerned.

Whenever a solid interacts with a gas or liquid environment, like in corrosion, oxidation, and catalysis, the near-surface region of the solid plays a crucial role in determining the evolution of the process (Fig. 1). Thereby, an in-depth evaluation of the near-surface properties as a function of external parameters (temperature, chemical agents, humidity, etc.) is of major relevance to an understanding and a control of the technological applications.

However, SST can be of invaluable importance also in the characterization of processes occurring in the bulk of matter. This is, for example, the case of fracture and creep where nanosized segregations at grain boundaries of polycrystalline materials can govern the macroscopic behavior of massive matter (Fig. 1). In this case, SST can be applied to study fractured surfaces and find chemical species or compounds which can affect the macroscopic behavior.

Another field which is unavoidably linked to the use of SST is the synthesis of artificially structured materials spanning a wide variety of methods such as molecular beam epitaxy, ion implantation, ion-beam assisted deposition, and laser ablation (Fig. 1). For many of these applications, an evaluation of the growth process on a real-time scale and with atomic layer sensitivity is of fundamental importance, as

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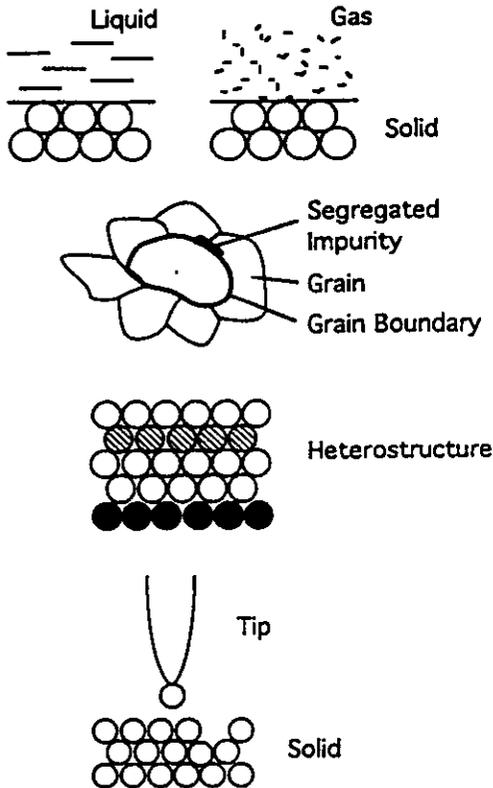*Also at Dipartimento di Fisica, Politecnico di Milano, Italy.

Fig. 1.   Examples where SST can be usefully applied for studying surfaces and interfaces.
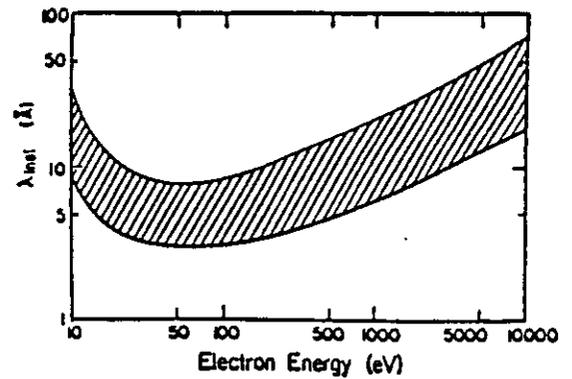

Fig. 2.   Plot of the electron inelastic mean-free-path versus the electron kinetic energy. Shaded is the area where most of the experimental points measured from different solids fall.
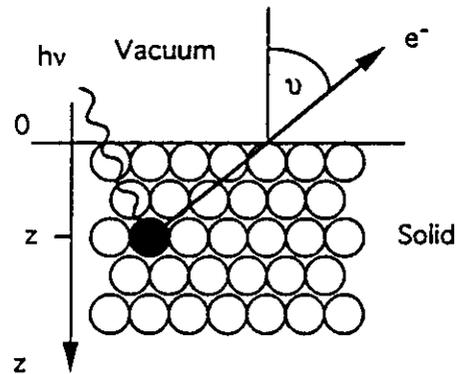

Fig. 3.   Sketch of how an electron created at a depth z below the surface can escape from the solid.

well as a characterization *a posteriori* via SST combined with controlled erosion via ion sputtering.

What is moreover rapidly emerging is the possibility of using some SST for atomic manipulation and engineering at solid surfaces as can be done with the tips of scanning tunneling microscopes (Fig. 1).

In a simplified view, all SST are based on the excitation of a solid via particle bombardment and on the measurement of the response of the solid. In most cases, this response is the emission of particles whose properties (energy, charge, direction of emission, angular momentum, etc.) can be traced back to the properties of the solid. Surface sensitivity can be determined by differing causes. In the case of electron spectroscopies, surface sensitivity is mostly determined by the energy-dependent inelastic mean-free-path of electrons in solids (Fig. 2). Imagine an electron is excited at some energy value as a result of a specific excitation mechanism (Fig. 3). The probability that this energy is conserved is lower than one

and depends on the path described by the particle within the solid. If $I_0(z)$ is the flux of electrons created at a selected depth (z) below the surface and at a specific energy value (E), the flux of electrons $[I(z)]$ which do not suffer an inelastic process prior to being emitted by the solid, and thereby conserving their energy, is related to z and the inelastic mean-free-path (λ) as follows

$$I(z) = I_0(z) \exp \frac{-z}{\lambda \cos \theta},$$

where θ is the angle of emission. It should now be clear that the exponential decay of the above formula makes a signal related to electrons of selected

energy more and more atenuated as electrons are cre-
ated deeper in the solid, over a very wide energy
range. If the final-state energy of the electrons is
somehow tunable, as can be done in photoemission
spectroscopy by tuning the excitation photon energy,
one can control the degree of surface sensitivity.

It is worth mentioning that most of the SST re-
quire high-vacuum conditions for being operative. In
the case of electron spectroscopies, this is primarily
dictated by the limited number of inelastic scatter-
ing events that emitted electrons must suffer with the
gas molecules of the residual gas prior to detection
for not being sharply attenuated in intensity. More-
over, the full control of surface-science experiments
imposes even more severe constraints that is to work
in ultrahigh-vacuum conditions (10^{-11}–10^{-10} mbar
range). On the basis of kinetic theory of gases and
under the assumption that the sticking probability
of a gas molecule at a solid surface is equal to one, it
can be easily found that the adsorption of an atomic
monolayer of molecules would be completed in 1 sec-
ond at $\approx 1 \times 10^{-6}$ mbar. The lower the pressure, the
longer the lifetime of a surface before being signifi-
cantly contaminated.

Among the surface-sensitive experimental meth-
ods, x-ray photoemission spectroscopy (XPS) and
Auger electron spectroscopy (AES) are easily recog-
nized as the historical roots of the neverending devel-
opment of SST and are also by far the most widely
utilized techniques for both qualitative and quantita-
tive analysis of solid surfaces. It is worth remarking
that the large families of materials (single- and poly-
crystals, amorphous, adsorbates, polymers, conduc-
tors, semiconductors, insulators, etc.) can be fruit-
fully studied via XPS and AES, the only severe
limitation being the vacuum compatibility of the
specimen.

In this paper, we will give a survey of the basic
principles, the instrumental aspects, and a selected
set of applications of XPS and AES. The text is con-
ceived as a primer for newcomers and a more pro-
found level of understanding can be achieved in the
quoted literature.

2. Basic Principles

2.1. *X-ray photoemission spectroscopy*

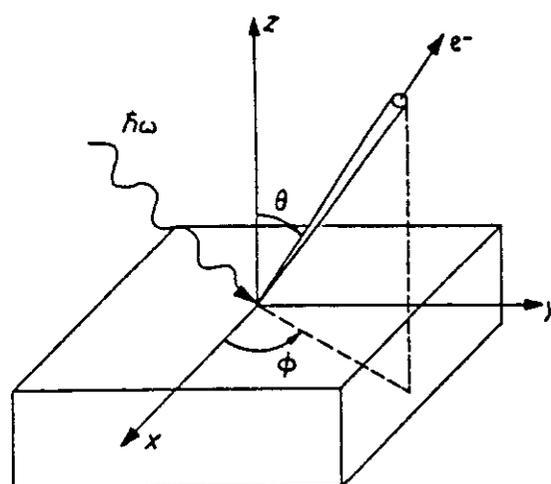This technique[1–13] is based on the photoelectric

Fig. 4. Pictorial view of a photoemission experiment
showing the impinging photon and the emitted electron.

effect. Figures 4 and 5 give a schematic view of a pho-
toemission experiment along with the corresponding
energy diagram sketched in a one-particle picture.
Monochromatic photons are sent toward a solid and
the emitted photoelectrons are analyzed in energy.
This simplified view allows one to appreciate the in-
herent powerful characters of the technique. The dis-
tribution in energy (final-state kinetic energy) of the
detected electrons (Fig. 5), which leave the system in
a one-hole final state, is expected, to a first approx-
imation, to mimic the distribution in energy of the
occupied electron states in the ground state of the
solid, the energy being conserved consistently with
the following relation

$$E_f = h\nu - E_i - \Phi \,,$$

where E_f and E_i represent the final- and initial-state
energies of the electron, respectively, $h\nu$ is the photon
energy, and Φ is the solid work function.[14] Deviations
from this simplified picture can occur and it will be
described further below. Nevertheless, the real effec-
tiveness of this technique stems essentially from the
direct insight it can provide on the electronic struc-
ture (core levels and valence-band states) of a solid.

A real photoemission spectrum[15] is shown in
Fig. 6. It is given as a function of the initial-state
binding energy, consistently with the above formula.
The measured profile is characterized by sharp struc-
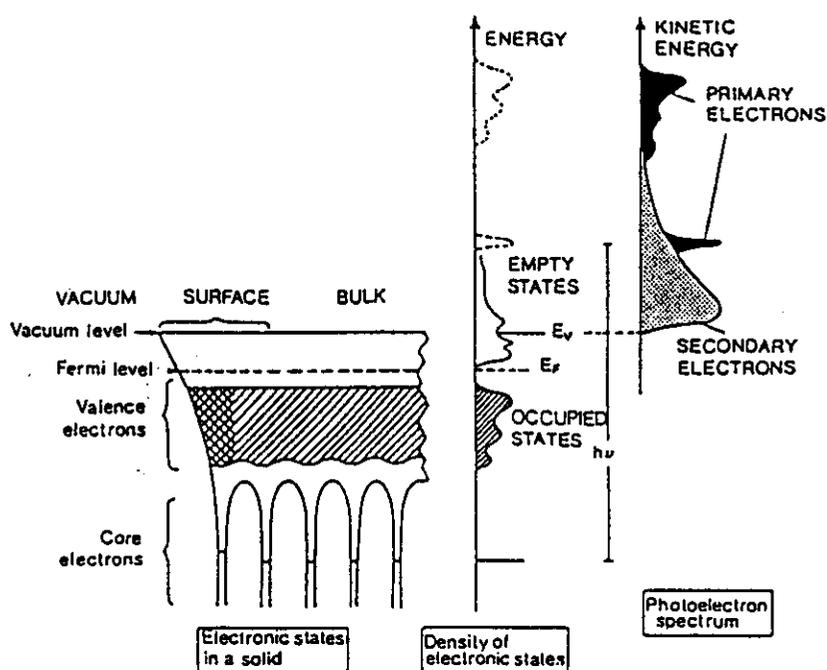tures which can be related to the atom and orbital

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Fig. 5.   Diagram of the energy levels relative to the ground state of a solid and a hypothetical photoemission spectrum where valence-band states and core levels are excited. E_V and E_F represent the vacuum level and the Fermi energy, respectively.

specific core levels. These features, usually called primary structures, are actually superimposed onto a mostly featureless background which exhibit a huge peak in the very low energy region ($\approx$ 5–10 eV) of the spectrum (see Fig. 5). This background is ascribed to the almost continuum distribution of the secondary electrons which are produced after inelastic scattering within the solid and have left memory of their primary energy. The excitation of most core levels requires at least soft x-rays and this explains the more usual acronym of the technique, i.e., x-ray photoemission spectroscopy (XPS). Also used is the acronym ESCA meaning electron spectroscopy for surface analysis.

The atom specificity of this technique is inherently related to the discreteness of the core-level energies in nature, i.e., each core-level distribution is a fingerprint of a specific chemical element. Handbooks[15,16] collecting XPS spectra for each elemental solid are currently available and are used as reference database for core-level identification.

A very important point which opens up the possibility for a profound understanding of the chemical state of an atom within a solid is related to the so-

called *core-level shift* (CLS). Actually, a core-level binding energy depends on the chemical bonds and environment local to a specific atomic site. Thereby, if reference specimens are studied and quoted, the identification of the chemical state of an atom in *a priori* unknown solid system is made possible, consistently with the energy resolution and the actual size of the CLS. Figure 6 gives a list of core-level binding energies of Zr in a wide number of compounds.

Another key point for an analysis of the chemical state of a solid is related to the study of the energy distribution of the valence-band states. The typical feature of these shallow states, is their delocalized character, compared to the local nature of core levels. They are thus expected to markedly change their distribution in energy as the chemical bonds are changed.

In a one-particle framework, given an impinging flux of photons, the current density of photoelectrons can be expressed in terms of a Fermi golden rule formula where the matrix element, in the dipole approximation, can be written as

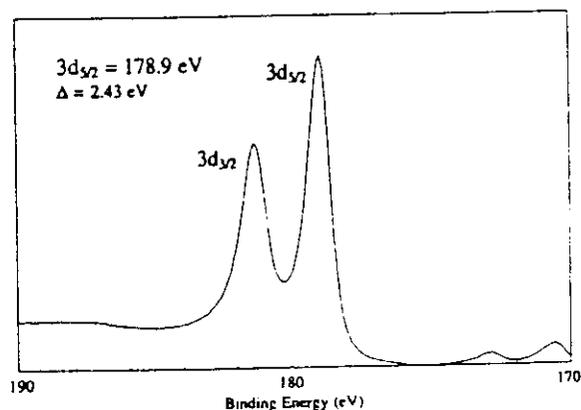$$M_{fi} = \langle \Psi_f | A \cdot p + p \cdot A | \Psi_i \rangle ,$$

Fig. 6. Reference XPS spectrum excited from solid Zr with a Mg-anode x-ray source ($h\nu = 1253.6$ eV). Also shown are an expanded view of the spin–orbit split Zr-3d core-level emission and a table indicating the Zr-$3d_{5/2}$ core-level binding energy for a set of Zr compounds.

where Ψ_f and Ψ_i are the final- and initial-state electron wave functions, respectively. A is the electromagnetic vector potential, and p is the electron momentum.

The quantitative character of the technique resides in the behavior of the core-level photoionization cross sections. If a specific value of photon energy is selected, the probability of core-level photoemission for incident photon depends on the specific core level of the specific atom under study. This is shown, for example, in Fig. 7 where calculated cross sections are reported[17] for Yb. The relative intensities of core-level photoemission peaks for say element A and element B in *a priori* unknown composition, should thereby reflect the relative atomic concentrations of these elements in the spatial region of the solid probed via XPS, once the behavior of the corresponding core-level cross sections is known.
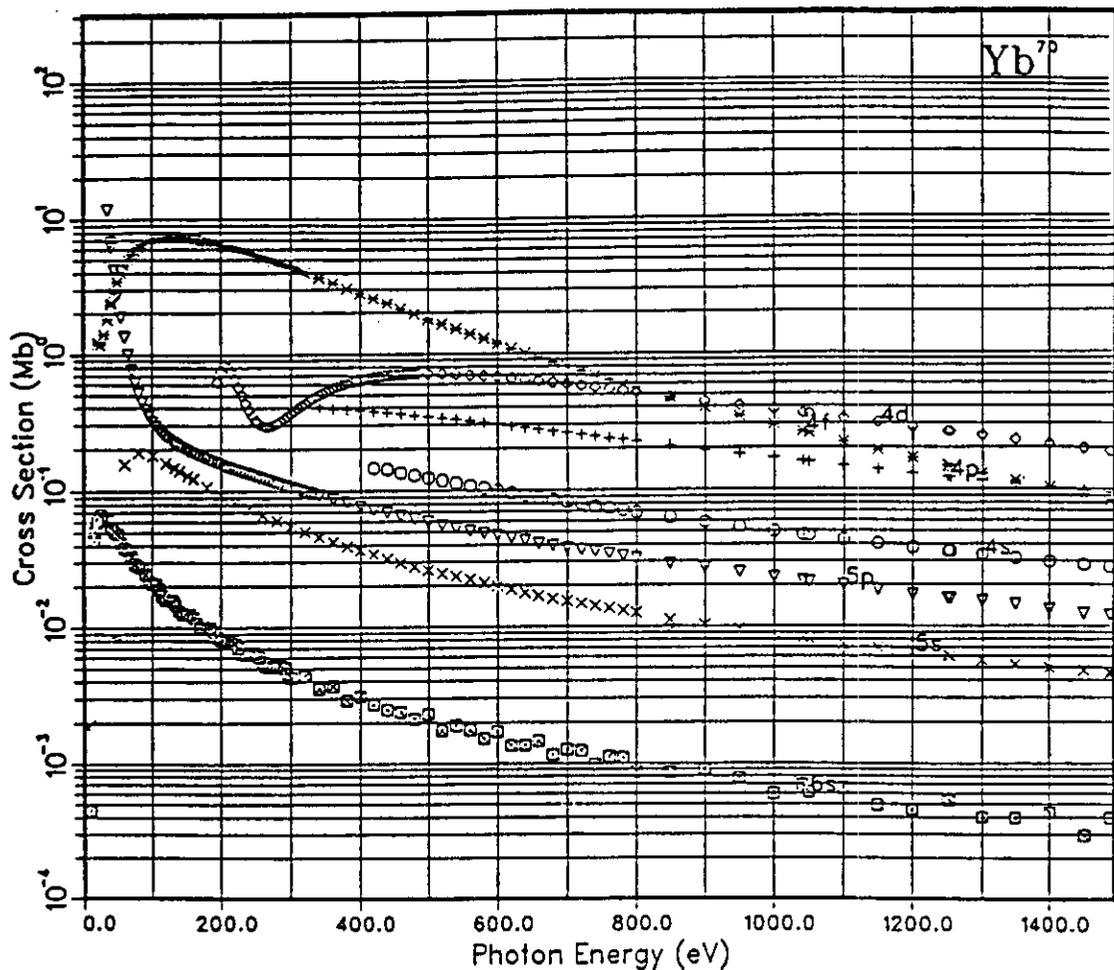
Fig. 7.   Calculated photoionization cross sections for a set of Yb core levels in atomic Yb as a function of the photon energy.

Yb binding energies(eV) are:

1s(2) 57009.8	2s(2) 9290.78	2p(6) 8897.20
3s(2) 2086.76	3p(6) 1904.14	4s(2) 402.610
3d(10) 1561.01	4p(6) 327.461	5s(2) 50.8637
4d(10) 190.652	5p(6) 30.7582	6s(2) 5.16038
4f(14) 15.9818		

2.2. *Auger electron spectroscopy*

Figure 8 depicts a view of the energy-diagram scheme relative to an Auger de-excitation process.[1-5,7,12,13,18-21] The starting point is to create a core hole inside the solid leaving an atomic site in an ionized state. This condition can be attained bombarding the solid with electrons, photons, ions, or other particles. The de-excitation of the system can occur along two distinct and competing processes: (i) an electron on a more shallow energy level can collapse over the core hole emitting a photon consistently with the fluorescence mechanism and leaving the system with $(N - 1)$ electrons; (ii) an electron at lower binding energy can refill the initially created core hole, the energy of this electronic transition being transferred to another electron. Provided the
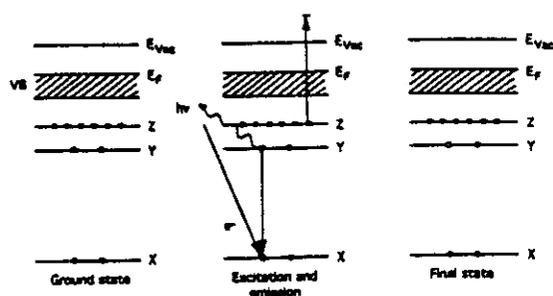
Fig. 8. Pictorial view of an energy-level scheme for an atom in a solid in its ground state (left), after creating a deep core hole and subsequent electron emission (center), and in the two-hole final state (right).
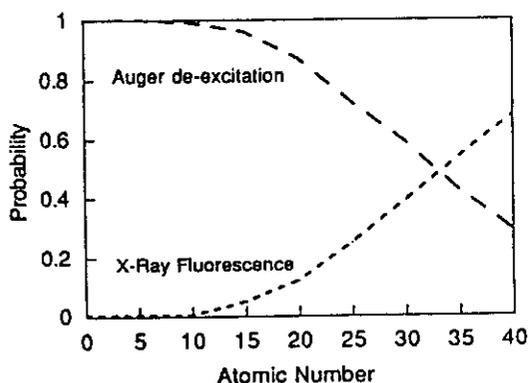
Fig. 9. Plot representing the Auger de-excitation probability and the x-ray fluorescence probability after creating a K hole as a function of the atomic number.

Fig. 10. Relative energies in the KLL Auger series. Also indicated is the transition from L-S to j-j coupling through intermediate coupling.

energy of the thus-excited electron falls above the vacuum level and the particle is able to escape from the solid, the electron is called an Auger electron and the overall de-excitation mechanism is called Auger process. The relative probability of the fluorescence versus Auger processes are plotted in Fig. 9 as a function of the atomic number (Z) for initial K core hole. The lower the atomic number, the higher the Auger yield.

In Auger spectroscopy, the system is left with two holes in the final state. The nomenclature of Auger spectroscopy indicates the transition with the sequence of the involved energy levels, say XYZ for the scheme of Fig. 8. The labeling of the energy levels is the same typically used in x-ray spectroscopy and

can change along with the atomic number depending on which scheme (j-j versus L-S versus intermediate) is more appropriate for the addition of the angular momenta of the electron states. (See Fig. 10 for Ref. 1.) The Auger process is characterized by the conservation of energy, angular momentum, and parity for the N-particle system. To a first approximation, the expression of the energy conservation is given below

$$E_{XUZ} = E_X - E_Y - E_Z - \Phi,$$

where E_X, E_Y, and E_Z are the one-particle core-level binding energies, E_{XUZ} is the Auger electron energy measured with respect to the vacuum level, and Φ is the solid work function. However, final-state effects can play a significant role. Therefore, corrections to the above formula are included such as

$$E_{XUZ} = E_X - E_Y - E_Z - \Phi - F_{YZ} + R_{YZ},$$

where F_{YZ} and R_{YZ} represent a two-final-state correlation energy and a final-state relaxation energy (including intra- and extra-atomic contributions), respectively.

By relying on the one-particle electron scheme of Fig. 8, it should be clear that the distribution in energy of the emitted Auger electrons should be somehow reminiscent of the discrete distribution in energy of the electron states in the solid. Thereby, Auger spectroscopy is immediately recognized to be elemental sensitive. Handbooks with standard Auger spectra from elemental solids are currently available.

In Fig. 11 a table with the principal Auger transitions is reproduced.[22]

Core-level chemical shifts are also expected to play a role in the Auger spectroscopy thereby providing, in principle, the chemical sensitivity to this technique. This means that Auger lines are to be measured for a wide series of standard elemental and compound solids for identification of the chemical

Chart of Principal Auger Electron Energies
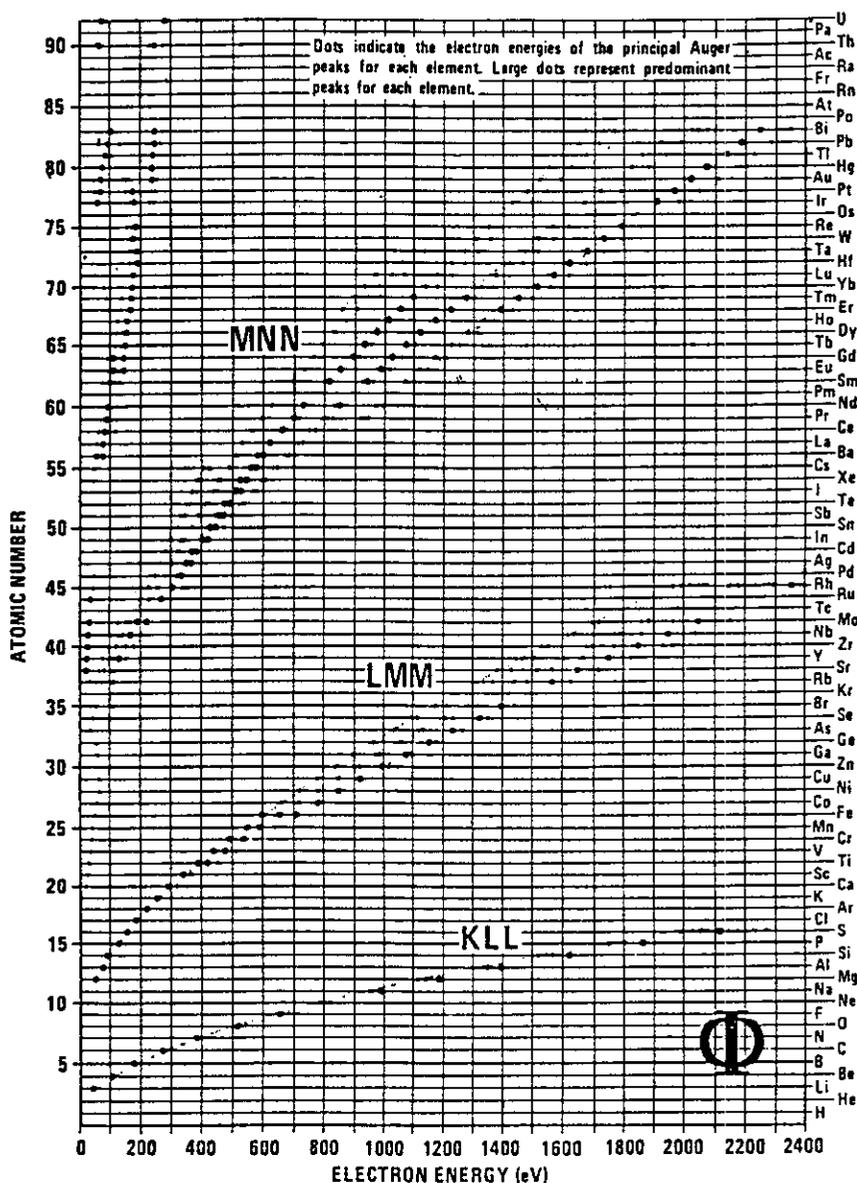
Fig. 11.   Table of the principal Auger electron energies as a function of the atomic number.
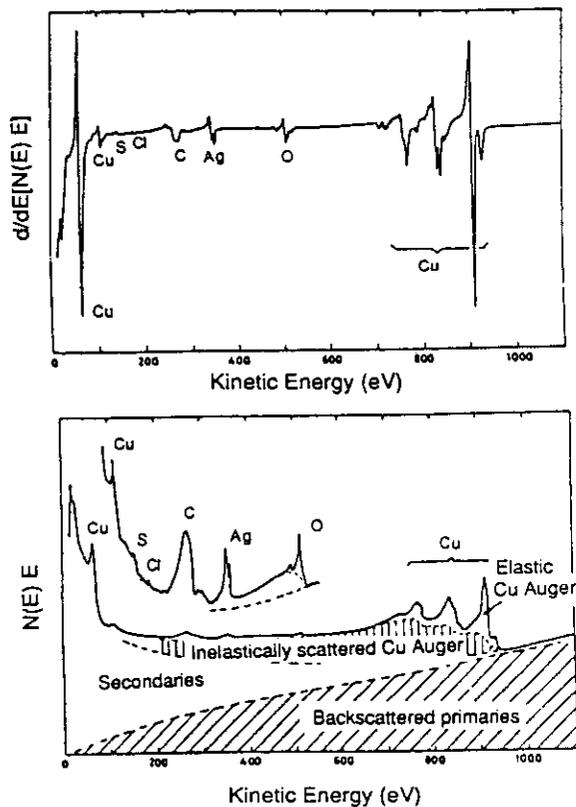
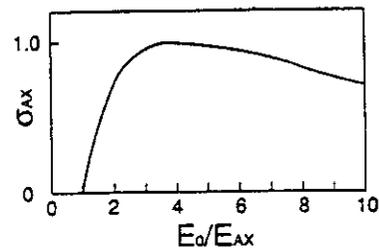Fig. 12. Auger spectra from a contaminated Cu specimen as measured via pulse counting and derivative detection.

Fig. 13. Cross section of core-hole creation by electron impact as a function of the primary-beam energy (E_0) normalized to the core-hole energy (E_{AX}) for a set of selected species.

cross section for ionizing a core level is plotted as a function of the primary-electron energy normalized to the core-hole threshold. It is easily concluded that the best condition corresponds to selecting a primary energy approximately three times the core-hole energy.

Auger transitions are also classified as to the localized versus delocalized nature of the involved electron states. It is usual to distinguish between core–core–core (CCC), core–core–valence (CCV), and core–valence–valence (CVV) transitions depending on whether the electrons are core or valence electrons. We will come back to this point further below.

The Auger process is governed by a matrix element which can be expressed in the following way

$$M_{fi} = \langle f | H'_A | i \rangle \, ,$$

where the final- and initial-state vectors $|f\rangle$ and $|i\rangle$ can be represented in a two-particle picture as $|\Psi_Y \Psi_Z\rangle$, $|\Psi_X \Psi_\lambda\rangle$, respectively. H'_A is the Hamiltonian describing the Auger transition which in the nonrelativistic limit becomes a Coulomb term. Ψ_λ refers to the Auger electron.

Since the Auger effect is a three-level transition and leaves the system in a doubly ionized state, multiplet effects are expected to dominate the energy distribution of the emitted Auger electrons, especially for CCC processes. This is, for example,[23,24] shown in Fig. 14. The nature of the matrix element dictates the character of the CCC transitions which is predominantly intra-atomic.

What makes Auger spectroscopy a quantitative method is the direct relation between the intensity of an Auger spectral feature and the number of
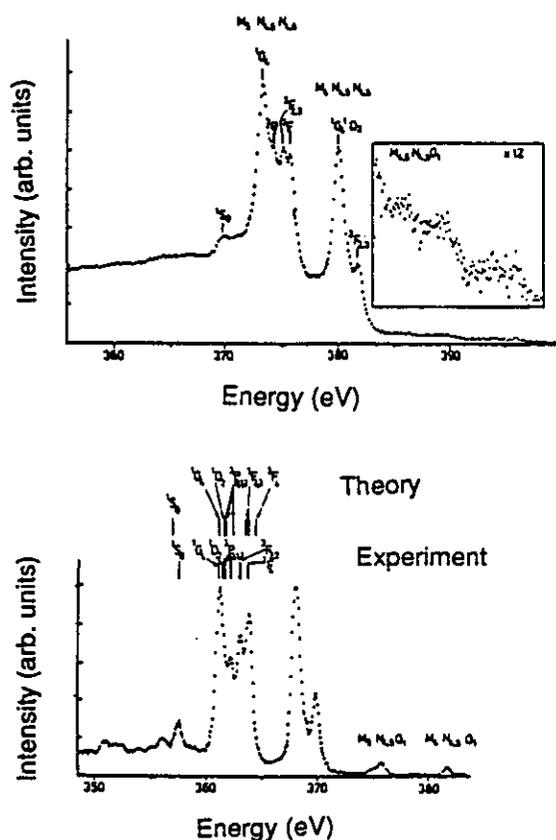
state of a specific element in an *a priori* unknown system. Chemical sensitivity will also be discussed further below in connection with Auger transitions involving valence-electron states.

An Auger spectrum from a contaminated Cu specimen[12] is shown in Fig. 12. Likewise the case of XPS, the corresponding spectroscopic features are superimposed on a secondary-electron background. Strictly speaking, Auger electron are secondary electrons as well. For the sake of clarity, they are usually referred to as elastic secondary electrons whereas the electrons which have lost memory of their initial excitation energy are called inelastic secondaries.

It is worth noting that the final-state energy of Auger electrons do not depend on the energy and on the nature of the particles used for creating the initial core hole. The ionizing particles can be classified depending on their ionization cross section. This is shown in the case of electrons in Fig. 13 where the

Energy (eV)

Theory

Experiment

Energy (eV)

Fig. 14.   Auger spectra of solid and vapor cadmium. The vertical bars represent the terms of the calculated multiplet distributions.
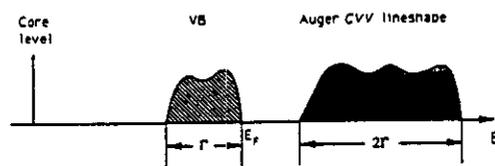

Fig. 15.   Pictorial view of a one-particle energy-level scheme for a solid and the expected spectral distribution for a CVV Auger transition assuming a pure band-like picture.

atoms supporting the Auger transitions through the transition-specific cross section. Similarly to the XPS case, atomic concentrations can be determined relative to the limited spatial volume which is probed by the surface sensitivity of the technique.

Of special importance are Auger transitions involving one or two valence-electron states. In a simple-minded scheme, the energy distribution of CCV or CVV Auger electrons is expected to mimic the valence density of states or the self-convolution of the valence density of states, respectively. See Fig. 15, for reference. More precisely, (i) the presence of a core-level wave function in the matrix element makes the valence density of states to be probed local to the atomic site where the initial core hole is created; (ii) the matrix element acts as a filter for the relative weights of the Auger structures depending on the angular momentum of the valence-band

states. This property of CCV or CVV line shapes yields additional chemical sensitivity to Auger spectroscopy. Deviations from the above picture can arise from the two-hole final state of the transitions. Let us therefore focus onto CVV line shapes whose cross sections are usually stronger than CCV transitions. Empirically speaking, there are many CVV transitions which can be successfully interpreted in terms of the density-of-states picture whereas other CVV line shapes resemble more closely the Auger response typical of free atoms where multiplet effects do play a dominant role. On a qualitative basis, it is reasonable to expect that, whenever the two holes left in the final state cannot efficiently delocalize from the ionized site, the electronic structure local to the Auger site can be significantly perturbed up to the breakdown of the Bloch theorem. The atom supporting the Auger transition can be envisioned as an impurity in the host solid with a peculiar local electronic structure. This will in turn determine an Auger response closer to that of free atoms. A general theory predicting the actual Auger CVV line shapes from solids is still lacking. However, in the late seventies a theory[25,26] has been formulated for filled band systems and is referred to as the Cini–Sawatzky theory. The criterion yielded by this theoretical approach can be schematized as follows

$\Gamma \gg U_{h\text{-}h}$ band-like limit ,

$\Gamma \ll U_{h\text{-}h}$ atomic-like limit ,

where Γ is the valence-bandwidth and $U_{h\text{-}h}$ is the two-hole correlation energy. The band-like limit is typical of covalent systems while the atomic limit is often encountered in d-metals. The case of the Si-$L_{2,3}VV$ line shape in solid Si is shown[27] in Fig. 16 along with two theoretical predictions. The validity
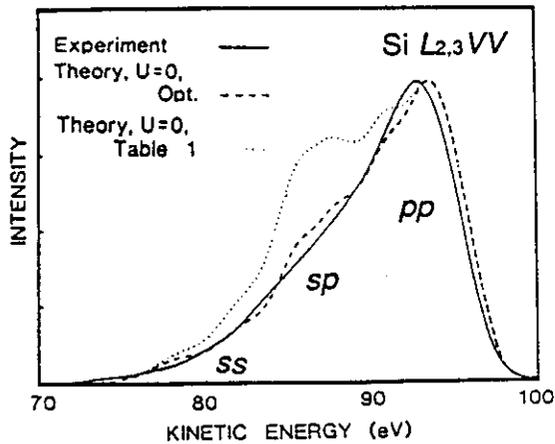
Fig. 16. Experimental Si-$L_{2,3}VV$ Auger line shape from solid silicon and theoretical spectral distributions calculated by setting the two-hole final-state energy equal to zero and by utilizing different sets of matrix elements.
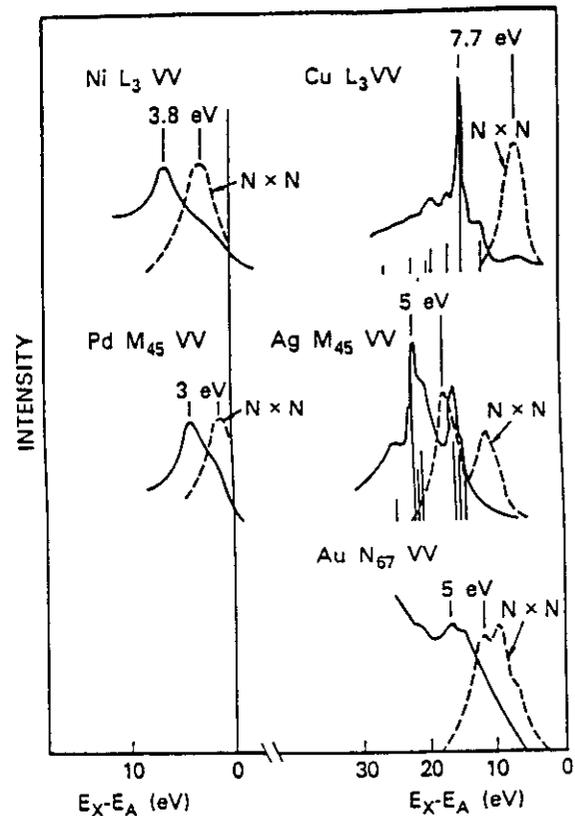

Fig. 17. Experimental CVV Auger line shapes from solid quasinoble and noble metals. Also indicated (dashed line) are the self-folded valence density of states $(N \times N)$. The vertical bars (Cu and Ag) represent terms of multiplet distributions as predicted in an atomic-like calculation. The energy scale is the so-called two-hole final-state energy scale. E_X and E_A indicate the core-hole binding energy as determined via XPS and the measured Auger kinetic energy, respectively.

of a band-like approach is quite clear. Also noticeable is the role of the matrix elements in determining the relative weights to the main structures. In Fig. 17 a significant selection of experimental CVV Auger line shapes of d-metals[20] is compared with self-folded local density of states. Note the element-specific agreement versus disagreement of this comparison. The behavior of Γ and U_{h-h} in a selection of transitional metals[20] is given in Fig. 18.

2.3. *Extra-contributions to XPS and AES profiles*

Features other than the mentioned primary structures of XPS and the elastic secondary Auger features are usually found in experimental spectra. Moreover, the real line shapes are also affected by a wide series of effects. An understanding of these aspects is of fundamental importance for a reliable line-shape analysis. A significant selection of such effects is given[28] in Fig. 19 and is briefly discussed here. (i) *Lifetime broadening* – all electron spectroscopies measure the system in an excited state of finite lifetime. This is unavoidably reflected in the finite broadening of the lines according to the Heisenberg uncertainty principle. A wide number of core-hole lifetimes has been quoted in the literature. (ii) *Phonon broadening* – the vibrational motion of atoms in the solid occurs usually on a time

scale longer than the temporal interval of the spectroscopic excitation. Thereby, atoms are probed in an infinite series of inhomogeneous positions during the acquisition of an XPS or AES spectrum. This is reflected in a Gaussian broadening of the final-state line shape. (iii) *Loss-induced broadening* – the excited electrons can promote inelastic scattering events while propagating in the solid such as excitation of plasmon modes of the Fermi gas or valence-to-conduction band state transitions. The result is typically the presence of extra features in the XPS or AES response. (iv) *Core-level asymmetry* – it is related to the many-body response of the solid to
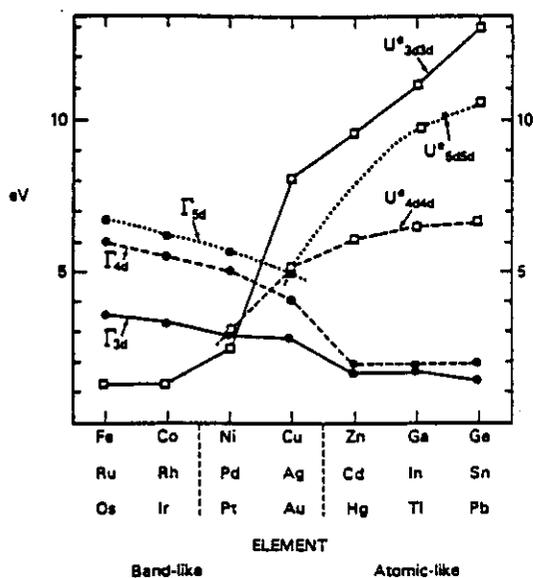
Fig. 18.   Survey of the d valence-band state width (Γ_{nd}) and of the two-hole final-state correlation energy (U_{nd-nd}) for a wide selection of transitional metals. Also indicated are the regions where the pertinent *CVV* Auger line shapes are closer to the band-like versus atomic-like limit.
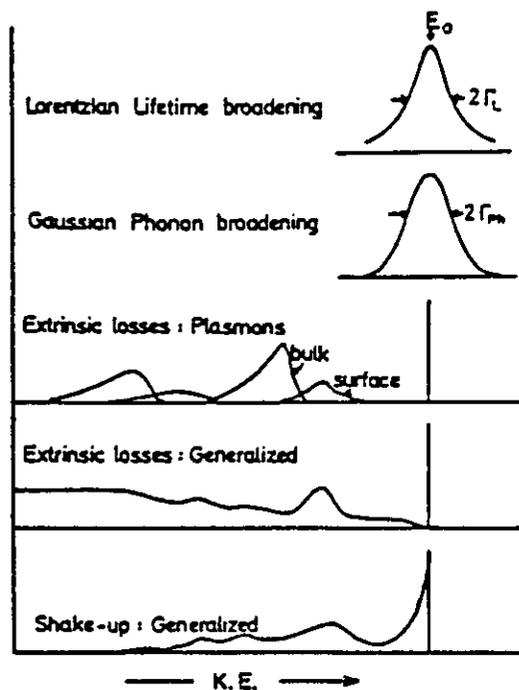

Fig. 19.   Schematic view of the main processes which can affect the final line shape of a core-hole-excited experiment.

the creation of a core hole and it is the stronger the higher the density of states at the Fermi level. It is a typical marker of metallicity.

3.   XPS Core-Level Line-Shape Fitting

A variety of fitting procedures has been proposed and utilized.[12] Regardless of the specific method of core-level fitting, some general remarks can be put forward.

A singlet contribution is expected from spherically symmetric orbitals for each of the homogeneous sites of a specific element in a solid. Orbitals of other than s-symmetry contribute with a spin–orbit split doublet. An exception to this scheme is the case of the shallow 4f states in the rare earths, where the partial filling of the orbitals is responsible of significant multiplet effects in the ionized final state.

Core-level fitting is usually accomplished via Voigt profiles which properly include both Lorentzian (lifetime) and Gaussian (phonons, instrumental width) broadening effects. Most of the fitting procedures also include the secondary-background line. Various models have been proposed for the secondaries profile.

As in any fitting procedure, the results must be critically examined. Any experimentalist is invited not to consider the recipes used for the core-level fitting as black boxes with *a priori* legitimate income and outcome. This means that for each core level, different choices of parameters must be explored. A fitting procedure will be considered reliable not only in terms of statistical criteria but also by checking whether the general trends emerging as outcome are crucially affected by small variations of the parameters.

4.   Quantitative Analysis

It is not our intention to cover all the detailed aspects of quantitative analysis based on XPS or AES. For this, the reader is referred to monographs or review papers. Here, we just limit ourselves to give the fundamental elements for this analysis.

Assume we have an homogeneous multielement solid. The basic idea is that the intentisy I_i of an element-specific spectral feature is proportional to

Atomic Sensitivity Factors X-ray Sources at 90°

Element	Line	ASF	Element	Line	ASF	Element	Line	ASF	Element	Line	ASF
Ag	3d	5.198	Eu	4d	2.210	Na	1s	1.685	Si	2p	0.283
Al	2p	0.193	F	1s	1.000	Nb	3d	2.517	Sm	$3d_{5/2}$	2.907
Ar	2p	1.011	Fe	2p	2.683	Nd	3d	4.697	Sn	$3d_{5/2}$	4.095
As	3d	0.570	Ga	$2p_{3/2}$	3.341	Ne	1s	1.340	Sr	3d	1.578
Au	4f	5.240	Gd	4d	2.207	Ni	2p	3.653	Ta	4f	2.589
B	1s	0.159	Ge	$2p_{3/2}$	3.100	O	1s	0.711	Tb	4d	2.201
Ba	4d	2.627	Hf	4f	2.221	Os	4f	3.747	Tc	3d	3.266
Be	1s	0.074	Hg	4f	5.797	P	2p	0.412	Te	$3d_{5/2}$	4.925
Bi	4f	7.632	Ho	4d	2.189	Pb	4f	6.968	Th	$4f_{7/2}$	7.498
Br	3d	0.895	I	$3d_{5/2}$	5.337	Pd	3d	4.642	Ti	2p	1.798
C	1s	0.296	In	$3d_{5/2}$	3.777	Pm	3d	3.754	Tl	4f	6.447
Ca	2p	1.634	Ir	4f	4.217	Pr	3d	6.356	Tm	4d	2.172
Cd	$3d_{5/2}$	6.032	K	2p	1.300	Pt	4f	4.674	U	$4f_{7/2}$	8.476
Ce	3d	7.399	Kr	3d	1.096	Rb	3d	1.316	V	2p	1.912
Cl	2p	0.770	La	3d	7.708	Re	4f	3.327	W	4f	2.959
Co	2p	3.255	Li	1s	0.025	Rh	3d	4.179	Xe	$3d_{5/2}$	5.702
Cr	2p	2.201	Lu	4d	2.156	Ru	3d	3.696	Y	3d	1.867
Cs	$3d_{5/2}$	6.032	Mg	2s	0.252	S	2p	0.570	Yb	4d	2.169
Cu	2p	4.798	Mn	2p	2.420	Sb	$3d_{5/2}$	4.473	Zn	$2p_{3/2}$	3.354
Dy	4d	2.198	Mo	3d	2.867	Sc	2p	1.678	Zr	3d	2.216
Er	4d	2.184	N	1s	0.477	Se	3d	0.722			

Fig. 20. Table of relative XPS atomic sensitivity factors for the main core-line emissions. In this scale, the reference value is the sensitivity factor of fluorine which is set equal to one.

the flux F of incident particles (photons in XPS, photons or electrons in AES), the atomic concentration of the ith species, the cross-section (σ_i) of the spectral transition under examination, and the transmission function (T) of the instrumental apparatus for the corresponding energies. Moreover, this must be thought of as confined in the limited spatial volume sampled through the inelastic mean-free-path of the corresponding XPS or AES electrons. Joint analysis of the most intense spectral features for each element detected in a specific XPS or AES spectrum should allow one to determine the relative atomic concentrations in the solid.

An easier aproach makes use of the so-called sensitivity factors (s_i for the ith element). Tables of atomic sensitivity factors are given in Figs. 20 and 21 for XPS[15] and AES,[22] respectively. These factors

are usually referred to a specific spectrometer operated in a well-defined mode, e.g., constant versus varying energy resolution, and are based on reference measurements made on elemental solids in well-controlled conditions. These factors include *ab-initio* cross-section effects. The evaluation of the atomic concentrations (x_i) is thus performed along the following formula for the ith element

$$x_i = \frac{\dfrac{I_i}{s_i}}{\sum_j \dfrac{I_j}{s_j}},$$

where the summation is performed over all the species detected in the specimen and I_i represents the spectroscopic intensity of the ith element.

Relative Auger Sensitivities of the Elements

$E_p = 3$ keV
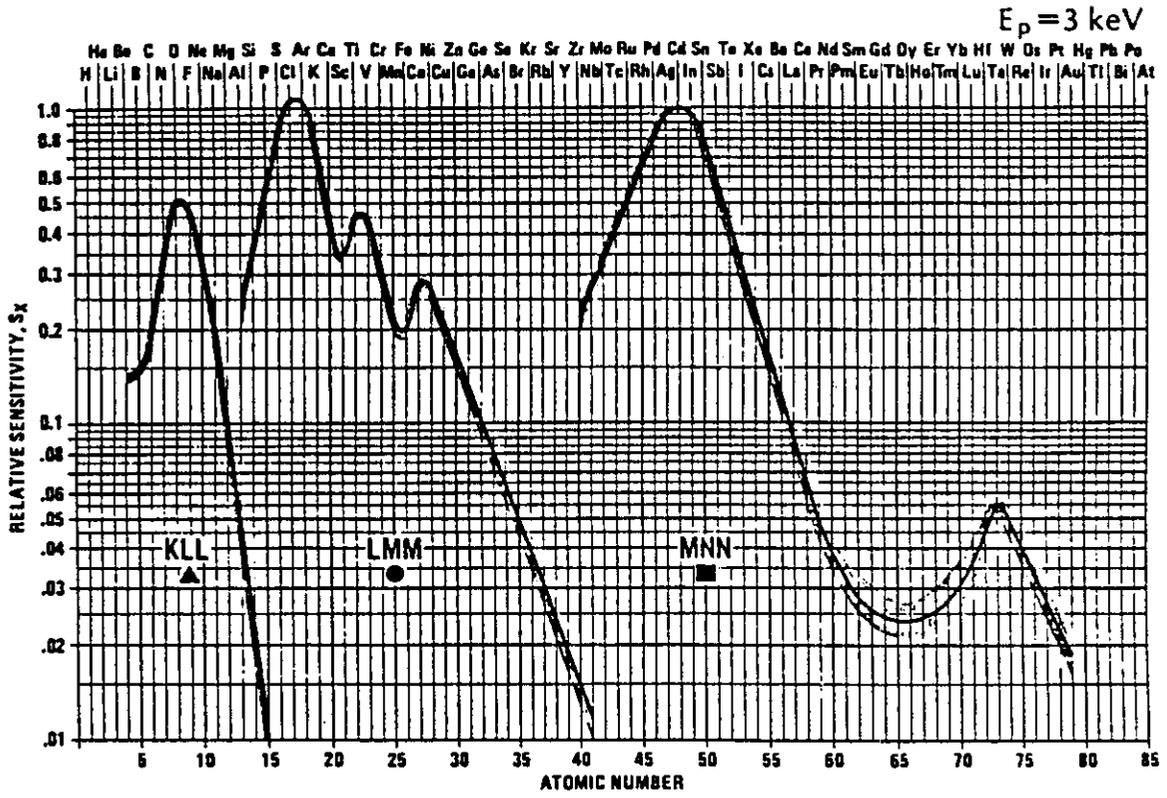
Fig. 21.   Relative Auger sensitivity factors for various families of Auger transitions.
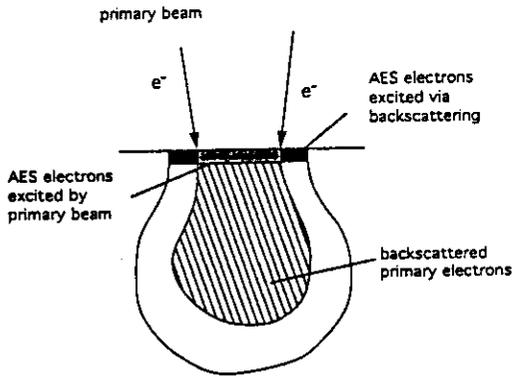
Fig. 22.   Pictorial view of the spatial distribution of an electron beam after impinging a solid surface.
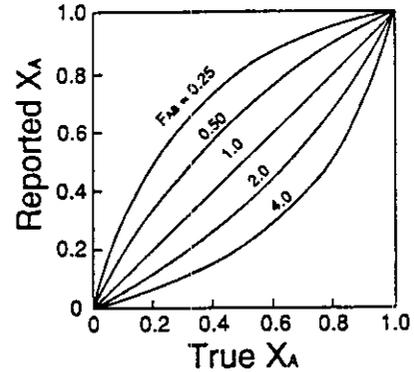

Fig. 23.   Comparison of the real composition and that estimated ignoring matrix effects in a binary solid.

Various factors other than those already mentioned can affect the experimental intensity of the ith species in a solid. Just to make an example, Auger electrons in electron-excited spectra can be significantly produced by high-energy electrons backscattered well below the near-surface region (see Fig. 22).

The backscattering process depends unfortunately on the matrix and this poses limitations to the above-illustrated scheme. Figure 23 shows real versus reported atomic concentrations in homogeneous binary systems for different values of the matrix factor which includes the just-mentioned backscattering effect. For more details, see Ref. 12.

5. Instrumentation

Some instrumental elements needed for both XPS and AES are the same: (i) an UHV apparatus; (ii) a sample with related *in-situ* preparation facilities; (iii) an electron-energy analyzer; (iv) an electron detector; (v) a pulse-counting electronics; and (vi) a computer driving the instruments.

The excitation source can be different. XPS is based on photon sources while AES is primarily utilized in the electron-excited version therby needing an electron gun. For this latter application, a current signal is more usually detected and this implies the use of phase-sensitive lock-in amplifiers.

A schematic picture of an electron spectroscopy experiment is shown in Fig. 24. For the UHV technology and related apparatus the reader is referred to Refs. 12 and 29. Hereafter, we will provide some details concerning photon and electron sources, and electron-energy analyzers.

5.1. Photon sources

Most of the commercial photon sources are based on either gas discharges for UV photons or electron bombardment of properly chosen anodes for soft x-rays. An example of an anode-based x-ray source is given in Fig. 25. A hot filament is usually the source of thermally emitted electrons which are then accelerated toward the anode. A thin window is usually inserted between the anode and the sample for cutting a significant fraction of the continuum bremsstrahlung radiation and preventing electrons from reaching the sample. In Fig. 26, a selection of the most promising lines provided by nature is given along with their natural width. It is noteworthy, that the charging effects which typically occur when doing photoemission of insulators are usually neutralized by low-energy electron beam sent toward the specimen surface.

Of fundamental and progressively increasing importance is the use of storage rings used as synchrotron radiation sources. The key features of these sources are (i) the continuum distribution of photon energies which can be properly selected by inserting a monochromator prior to the analysis chamber; (ii) the polarization of the synchrotron light whose electric-field vector is naturally parallel to the plane of the storage-ring orbit. Right-hand or left-hand circular polarization can be achieved by working
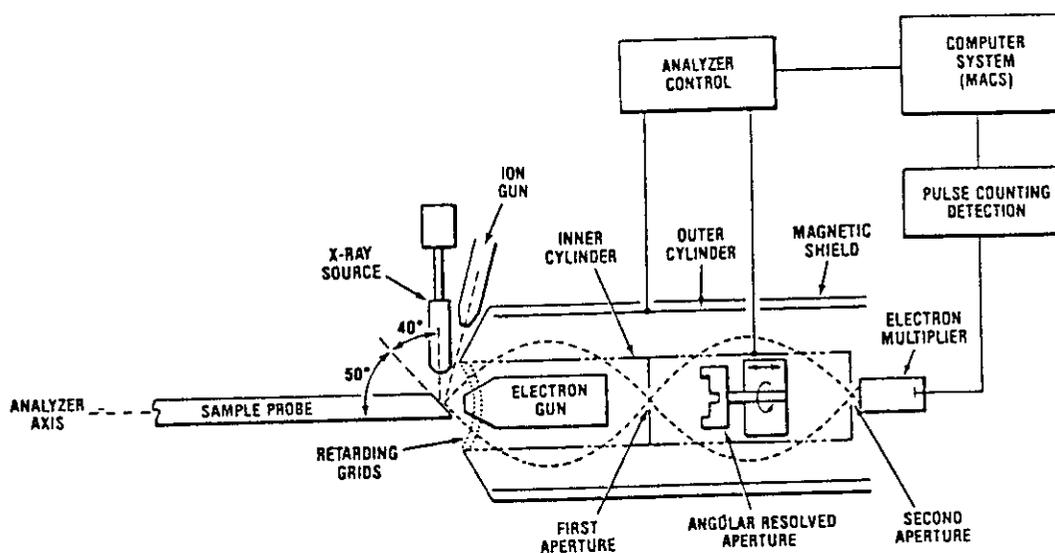
Fig. 24. Pictorial view of a surface-science spectroscopic experiment.
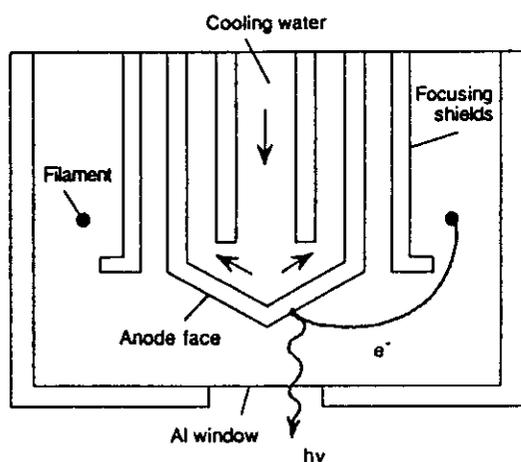
Fig. 25.   Schematic view of an anode-based x-ray source.
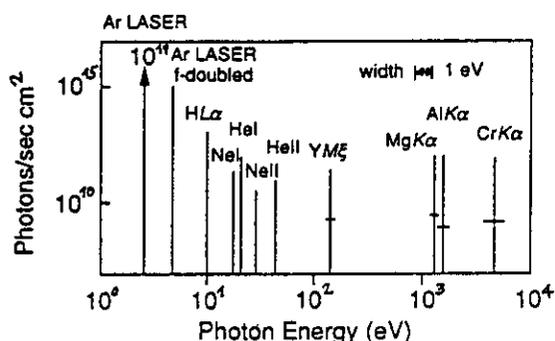
Fig. 26.   A significant selection of characteristic UV and x-ray lines provided by nature.

in off-plane geometry; (iii) the high flux of photons achievable over a very wide photon energy range; (iv) the high brilliance of the photon beams. This is crucially important for high energy-resolution experiments and spectromicroscopy. The recent use of insertion devices in storage rings has allowed an advance in the achievements of most of the above-mentioned parameters as is reported in some papers in this volume.

5.2.   *Electron sources*

Strictly speaking, AES poses less severe constraints to the design and construction of electron sources rather than other electron-excited spectroscopies such as electron energy loss and inverse photoemission. Actually, an ultrahigh energy resolution is not required, the energies of Auger electrons not being determined by the excitation source. Typically, a beam with good stability in intensity and a fine spot are required. Most of the electron guns use thermionic emitters. Also used are emission-field sources.

5.3.   *Electron-energy analyzers*

Various families of analyzers have been designed and constructed. They are usually classified along with the specific trajectory the electrons describe. The mostly utilized analyzers are the double-cylindrical-mirror analyzer (CMA) and the hemispherical analyzer (HSA). Both of them can work for XPS and AES. The latter is fruitfully used when angular resolution is required as for angle-resolved UPS or photoelectron or Auger electron diffraction experiments. Electron-energy analyzers have been recently designed allowing one to target spectromicroscopy by selecting small areas of the photoelectron-emitting specimens.

6.   Applications

Here, a selected set of scientific cases will be given for showing the potential of the XPS and AES techniques in studying problems in surface and interface sciences. The possibility of addressing elemental and chemical aspects of any kind of solid material (single-vs poly-crystals; chemisorbed and variously surface-treated systems), being limited just for the vacuum compatibility, should be appreciated. For more details concerning the examples which will be shown, the reader is referred to the original literature. The following overview is far from being complete but it should in any case be considered a good starting point for a further thorough examination.

Before we continue, it is worth mentioning the typical figures of merit of XPS and AES. For XPS, the constraints on energy resolution reside in the photon source (best values achieved so far: ≈ 0.3 eV for commercial apparatus; ≈ 0.02–0.05 eV at synchrotron sources). The best lateral resolution attained so far is of the order of 5 μm for commercial apparatus and tens of nanometer at synchrotron beamlines. The elemental sensitivity amounts to
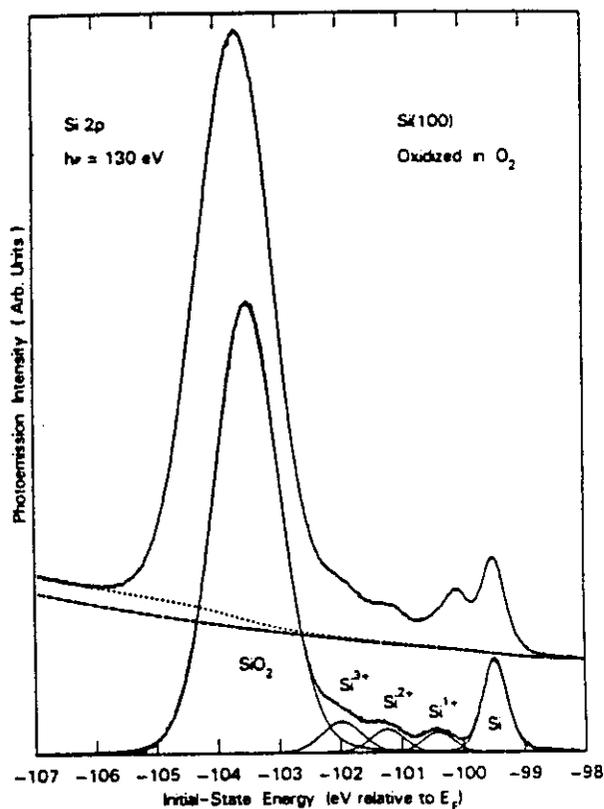
Fig. 27. Oxidation states at the SiO$_2$/Si(100) interface, as measured by the Si 2p core levels. The top curve represents the raw data. The bottom curve has the Si-2p$_{1/2}$ line and the secondary-electron background subtracted.

Fig. 28. Si-2p$_{3/2}$ core-line emission for two distinct oxide thicknesses at the SiO$_2$/Si(100) interface.

$\approx$ 0.1%, this value being subject to change markedly by making use of ultrabright synchrotron radiation. XPS can directly detect all the elements of the periodic Table except H and He.

For AES, the best lateral resolution is of the order of 5 nm while the elemental sensitivity is of the order of 0.1%. Energy resolution is not usually a bottleneck, the Auger line shapes being spread over extended energy ranges. Like XPS, AES cannot directly measure H and He.

In Figs. 27 and 28 are shown XPS Si-2p spectra[30] from silicon surfaces after oxygen chemisorption combined with thermal annealing. All these treatments were performed in UHV starting from *in-situ* cleaned Si surfaces. Clearly identified, even in the raw data, are the various chemically distinct contributions of Si atoms reflecting differing chemical environments

and spanning the Si^0, Si^{1+}, Si^{2+}, Si^{3+}, and Si^{4+} oxidation states. The sizeable oxidation-dependent core-level shift enables one to distinguish the various components within the instrumental resolution without sophisticated line-shape fitting. In this case, the use of the tunable synchrotron radiation allowed the authors to enhance the photoemission signal of the topmost layers, i.e., the final-state kinetic energies of the Si-2p photoelectrons fall in the broad minimum of the inelastic mean-free-path (Fig. 2). Also noticeable is the different relative weights of the various oxidation states depending on the evolution of the oxide thickness grown on the pristine substrate.

The effects of controlled exposure of different Si surfaces to fluorine, studied by XPS,[31] is shown in Fig. 29. A variety of oxidation states is found in both cases. These test cases are then compared with the results of fluorine etching. This shows that SiF$_3$ is the dominant contribution left after the etching

F on Si. Si 2p$_{3/2}$ Core Level

Oxidation State   Oxidation State
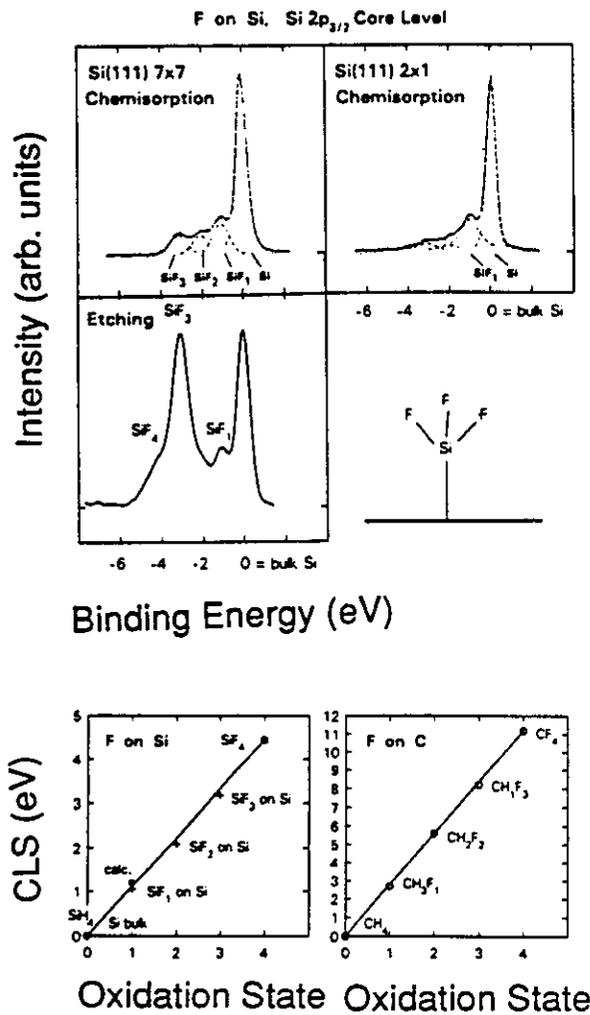
Fig. 29.   Background subtracted Si-2p$_{3/2}$ core-level spectra Si surfaces after chemisorption of one monolayer of fluorine (top panels) and after etching. Also shown is the relation between core-level shift and oxidation state in fluorinated silicon and carbon.

treatment. Removal of SiF$_3$ is thus the bottleneck of the etching reaction. Needless to say, this is an important information in the domain of solid-state electronics. Figure 29 also shows the behavior of the core-level shift spanning a wide variety of oxidation states for fluorinated silicon and carbon.

Core-level XPS has been proven to be quite effective for addressing the evolution of interface growth both for the chemical state identification and for the quantitative description of the growth mode. In Fig. 30 a series of Si-2p spectra measured at the
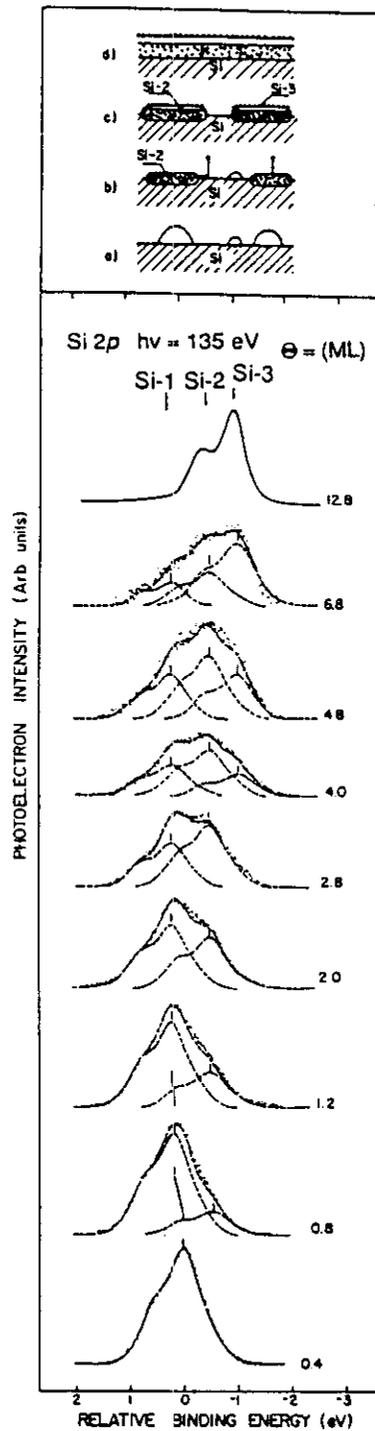
Fig. 30.   Si-2p core-level photoemission spectra from the Ce/Si(111) interface as a function of the Ce coverage. Also shown are the fitting components which are assigned to clean Si (Si-1), reacted Ce–Si pseudosilicide (Si-2), and surface segregated Si (Si-3).
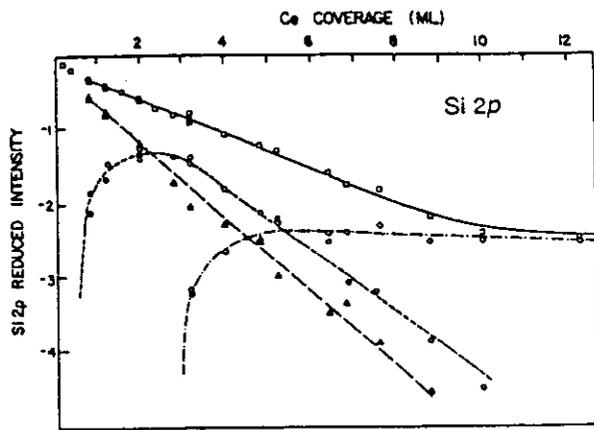
Fig. 31. Attenuation curves for the Si-2p core-level intensity relative to the total and distinct component signals shown in Fig. 30.

Fig. 32. Zr-3d core-level XPS spectra from ZR_2Fe and ZrVFe alloys after annealing treatments at selected temperatures.

Ce/Si(111) interface as a function of the Ce coverage is reported.[32] Line-shape fitting allowed the authors to identify up to three different Si sites. The plot of the intensities of such components as a function of the Ce thickness is also shown (Fig. 31). Comparison with reference models for the interface growth (layer-by-layer versus island formation versus layer-plus-island formation) suggests the real growth models as indicated in the top panel of Fig. 30. Studies of this kind have been widely performed for semiconductor–metal, metal–metal, and semiconductor–semiconductor interfaces.

An increasing number of studies have been recently devoted to evaluate the near-surface behavior of the so-called nonevaporable gettering alloys. The key feature of these systems, which can include d-metals, rare earths, or alkali atoms, is the ability of absorbing huge amounts of gases after proper thermal activation procedures. This property can also be engineered so as to be molecular-selective. Applications of these alloys are found in vacuum industry (pumping elements), in the field of gas purification (selective filters), and in the nuclear-fusion technology (tritium recycling). XPS spectra[33] from two important Zr-based alloys are shown in Figs. 32 and 33 as a function of the annealing temperature. In both cases, the alloys have been fractured in air and then inserted in the UHV apparatus where they have been thermally treated at selected steps (annealing duration $\approx$ 20 min) and measured after each annealing.

Fig. 33. C-1s core-level XPS spectra from ZR_2Fe and ZrVFe alloys after annealing treatments at selected temperatures.

The XPS spectra hereby reported refer to Zr-3d and C-1s core levels. It is noteworthy that:

(i) the surfaces of fractured specimens exhibit predominantly Zr-3d core levels associated to ZrO_2 and C-1s signal typical of chemisorbed C-containing molecules such as hydrocarbons, CO, and CO_2;

(ii) the progressively increasing annealing promotes the growth of intermediate oxidation states of Zr which appear at lower binding energies at the expenses of the Zr^{4+} component and the appearance of a more shallow contribution in the C-1s spectra which is ascribed to the formation of metal carbides in the near-surface region of the alloys. The joint Zr_2Fe versus ZrVFe analysis allows one to appreciate the different behavior of the two alloys after the same annealing steps thus enabling one to explore differences in the kinetics;

(iii) the high-temperature treatments enrich the near-surface region in Zr atoms which are predominantly in a metallic environment (alloyed or elementally segregated);

(iv) the residual content of carbon in Zr_2Fe at high temperature is typical of solely metal carbides whereas ZrVFe shows also contributions ascribed to chemisorbed molecules and graphitic carbon.

Fig. 34. Relative atomic concentrations as a function of the annealing temperatures from ZR_2Fe and ZrVFe.

If the line-shape analysis allows one to establish how the chemistry local to the different species sites evolves, an analysis of the signal intensities does establish how the relative atomic concentrations are affected in the near-surface region by the thermal treatments. This is shown in Fig. 34. The main messages are the progressive increase, as the temperature is raised, of Zr content at the expenses of carbon. Moreover, Zr_2Fe is able to remove all the oxygen atoms whereas a sizeable oxygen contribution is seen in ZrVFe even after the highest temperature annealing. Remarkable is the fact that the temperature range ($\approx$ 400–500°C for Zr_2Fe and $\approx$ 400–600°C for ZrVFe) where the Zr (C) sharply increases (decreases) has a direct correspondence with the temperature ranges found by studying the macroscopic gettering efficiencies of these alloys. This gives a fruitful example of systems where macroscopic measured properties can be accounted by an investigation focused onto the atomic-scale behavior.

The case of Fig. 35 deals with the combined use of a SST (AES) with controlled ion-induced erosion.[34] An important point is that both qualitative and quantitative aspects are addressed altogether within the same approach. In the domain of metallurgy a relevant point is to check whether surface properties of solid materials can be properly engineered, e.g., increase of the resistance to wear or to chemical agents. The use of thin films deposited via novel techniques seems to be promising, implying at the same time to find out good recipes for good adhesion with the substrate. Here, steel and copper specimens have been coated with an a-SiC film to increase the hardness of the surface. Samples of SiC films have also been nitrogen-implanted for improving the adhesion with the substrate. The depth profiles give the distribution of the atomic species as a function of the depth below the surface and, in particular, make evident the presence of nitrogen just across the film–substrate interface. Moreover, the evolution of both N-KLL and C-KLL Auger line shapes (Fig. 36) for the a-SiC/steel sample enables one to recognize the formation of Si–(N, C)–Cr complexes at the interface. These determine the improved film-to-substrate adhesion for the ion-implanted specimen.

A way for enhancing surface sensitivity is to exploit the dependence on the angle of emission of the electrons consistently with Fig. 3. This is especially important when the electron kinetic energy is not
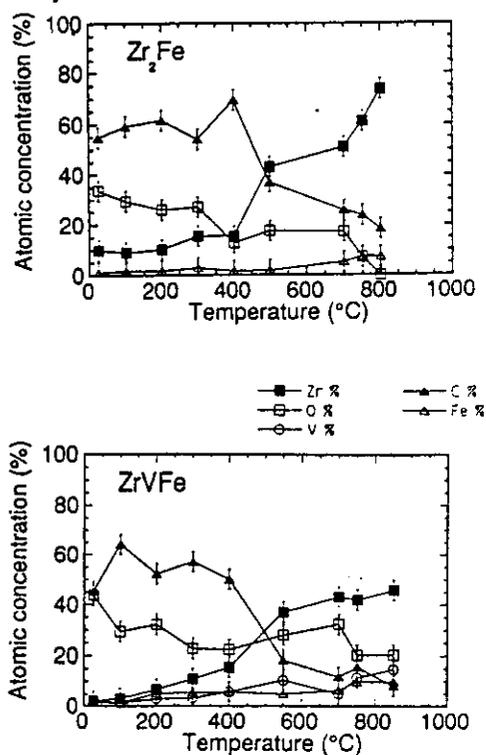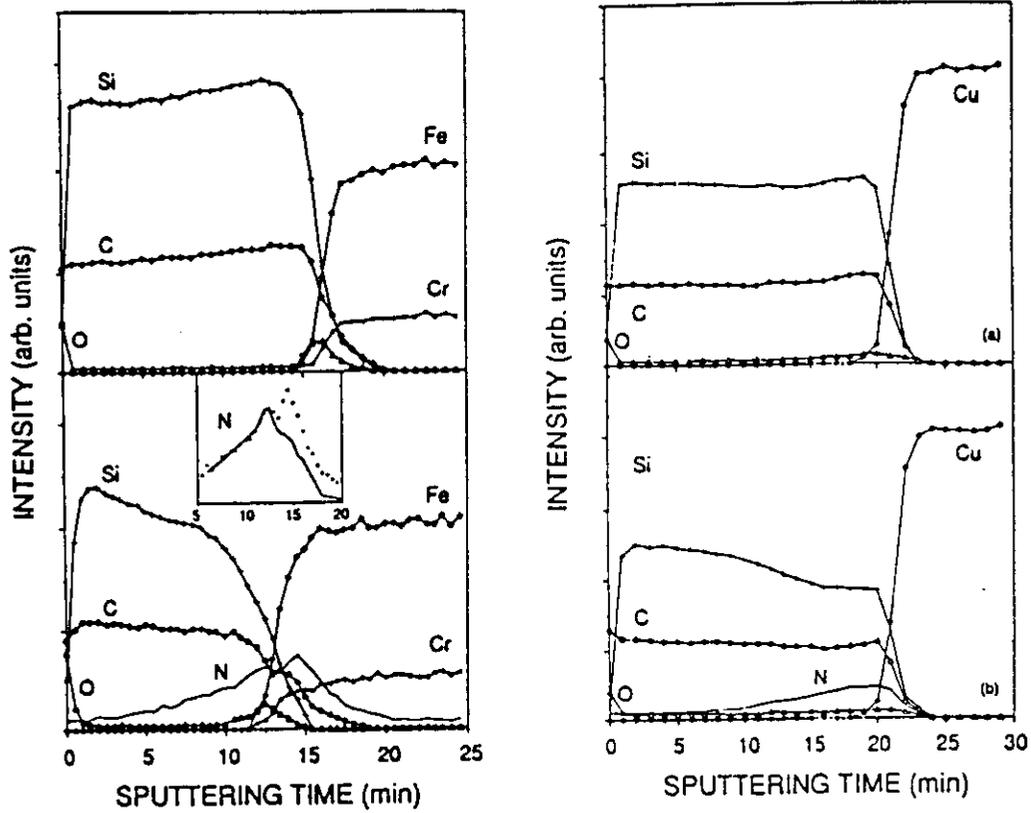
Fig. 35. Auger signal amplitudes as a function of sputtering time from as-deposited a-SiC film on a steel substrate (left side, top panel), N-implanted (1×10^{17} ions/cm^2) SiC–steel sample (left side, bottom panel), as-deposited a-SiC film on a Cu substrate (right side, top panel), N-implanted (1×10^{17} ions/cm^2) a-SiC/Cu bilayer.
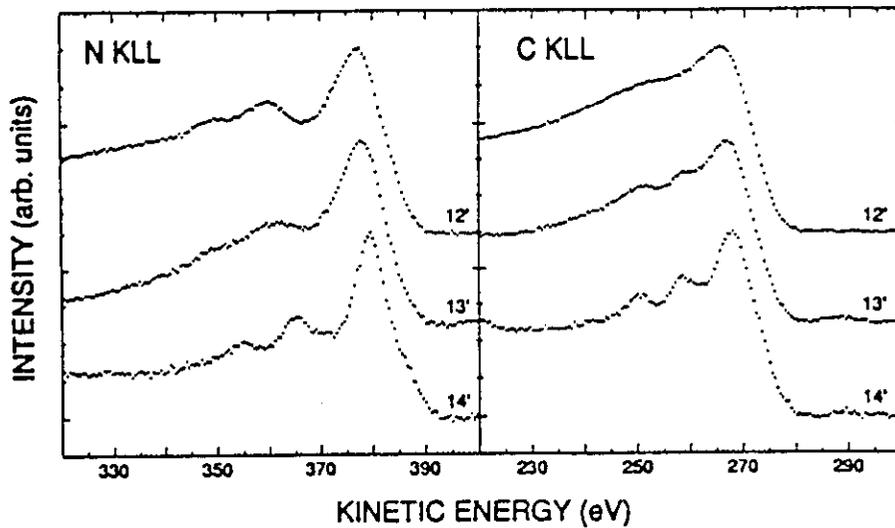
Fig. 36. N-KLL and C-KLL Auger spectra at three selected points of the N-implanted a-SiC/steep specimen of Fig. 35.

tunable and the corresponding inelastic mean-free-path is sizeable. Figure 37 collects a series of XPS spectra from polycrystalline gold taken with a conventional x-ray source.[35] A significant Au-$4f_{7/2}$ line shape change is visible as the angle of emission is varied. Line-shape fitting allows one to identify two
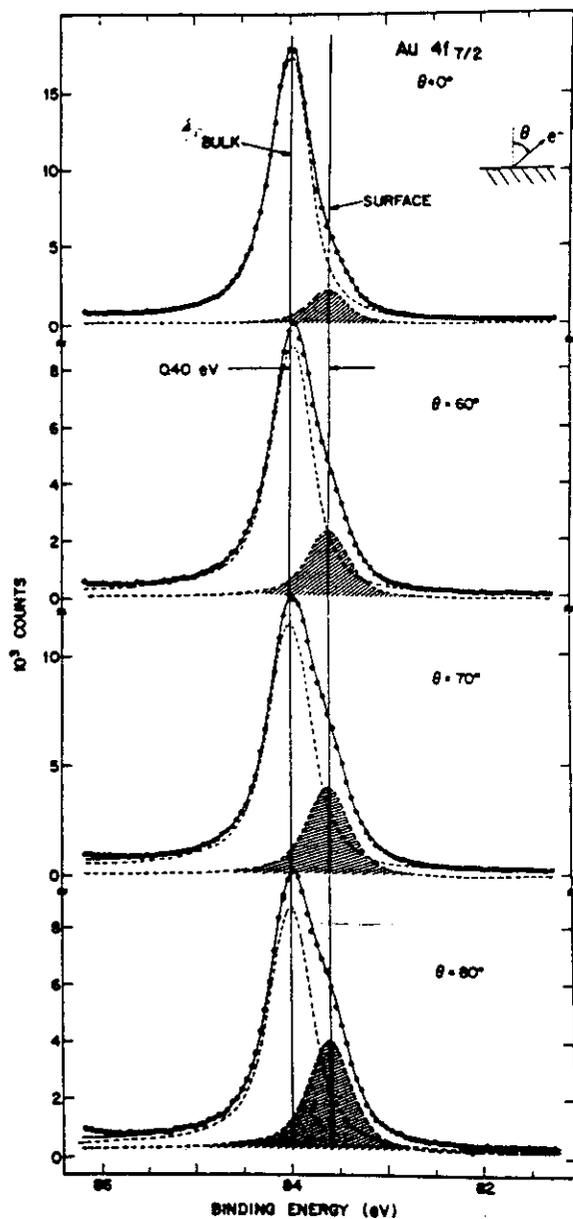
Fig. 37.   Least-squares fits to Au-$4f_{7/2}$ XPS line shape as a function of the angle of emission of the electrons from poly-Au. The surface components are shaded.
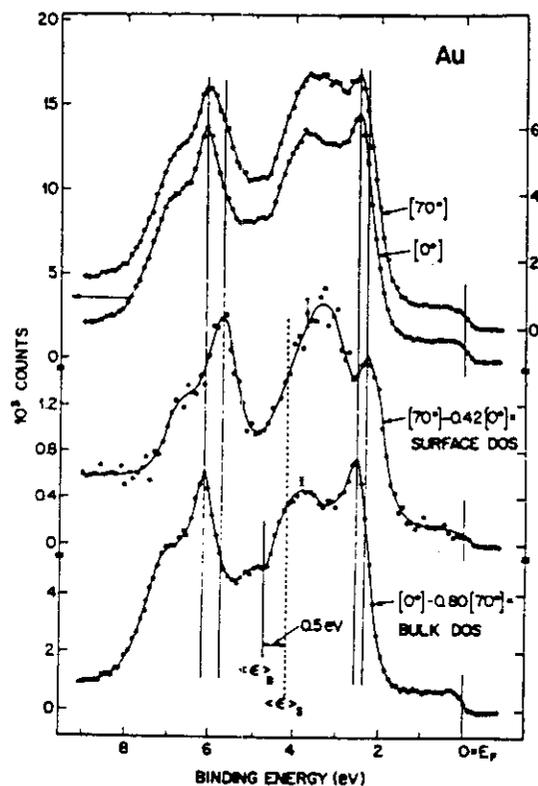
Fig. 38.   Separation of bulk versus surface contributions in the valence-band photoemission spectra of poly-Au.

prominent contributions, which are respectively ascribed to two inhomogeneous families of gold sites: bulk and surface atoms. The behavior of the energy distribution of the 5d-derived valence-band states is shown in Fig. 38. The intensity analysis of the Au-4f core level allowed the authors to discriminate the energy distribution local to the surface sites with respect to the bulk matter.

The following example illustrates how the tunability of the photon energy of synchrotron radiation can be exploited for discriminating surface versus bulk contributions. Figure 39 shows Ga-3d and As-3d core levels measured from a GaAs(110) single crystal.[36] By changing the surface sensitivity, the surface-related core-level contribution is significantly enhanced or depressed compared to the bulk components.

An example of spectromicroscopy via AES[37] is given in Fig. 40. The annealing of thin noble-metal films grown *in situ* on Si substrates promotes the
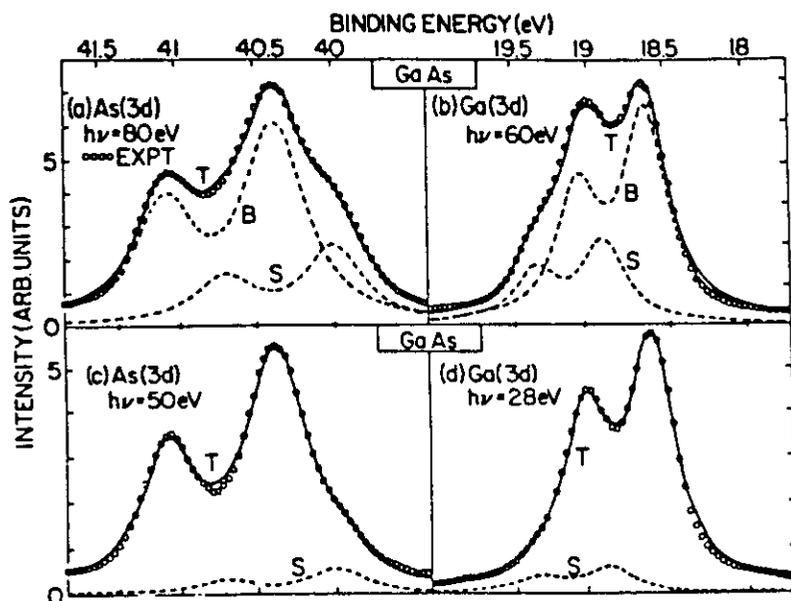
Fig. 39. Ga-3d and As-3d core-level photoemission spectra of the GaAs(110) surface. Shown are the bulk- and surface-related contribution as determined after line-shape fit.
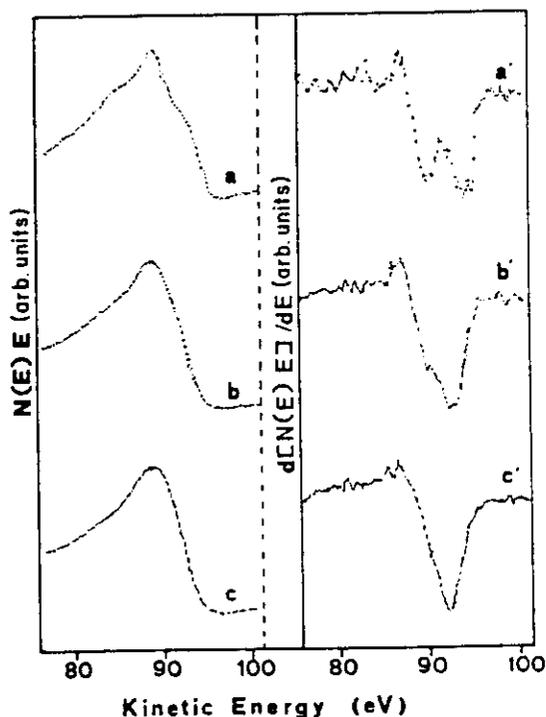
Fig. 40. Laterally resolved ($\approx$ 200 nm) Si-$L_{2,3}VV$ Auger line shapes from a thermally agglomerated Cu/Si(111) interface. (a) island, (b) flat region, and (c) flat region after soft Ar^+ sputtering.

formation of an inhomogeneous pattern with micron-sized islands superimposed on flat regions. AES, XPS, and low-energy electron diffraction (LEED) performed by averaging over an extended lateral area reveal an ordered two-dimensional phase where Cu and Si atoms are arranged to give rise to a super-structure with a weak chemical interaction between Cu and the topmost Si atoms. However, when a laterally resolved Auger analysis (lateral resolution $\approx$ 200 nm) is performed on the various morphologies, one finds that (i) the islands are Cu-rich systems where Si is also present and the Si-$L_{2,3}VV$ Auger line shape is typical of a Cu–silicide (see Fig. 41 for reference); (ii) the flat regions are characterized by Auger spectra which closely resemble the laterally averaged profiles. This example combines both the line-shape analysis for chemical identification and the intensity evaluation for the distribution of the atomic species. Imagine now to record the intensities of the Auger Cu- and Si-related signals as the narrow electron beam is focused onto a specific surface point and to do this while scanning over a laterally extended region. The result is the map of the chemical elements as they are distributed over the explored area. Examples of spectromicroscopy via XPS are widely discussed in the paper by Coluzza and Moberg in this volume.
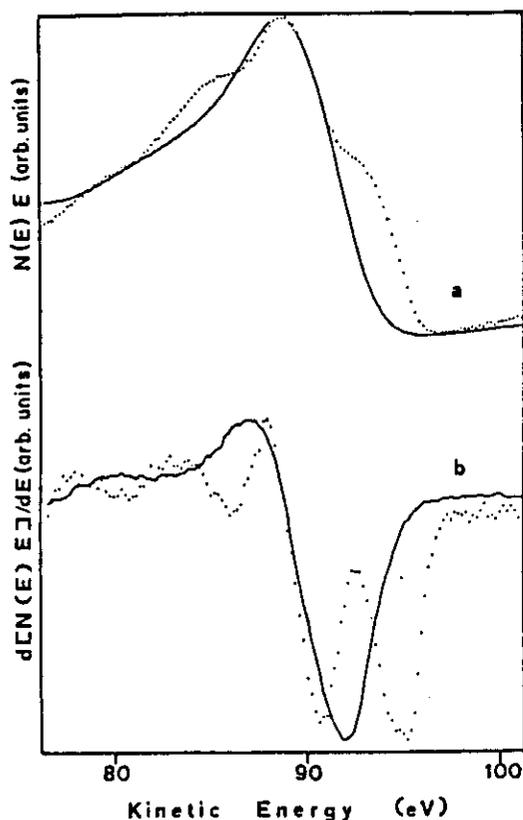
Fig. 41. Si-$L_{2,3}VV$ Auger line shape from Si(111) (solid lines) and Si(111) + $\approx$ 25 Cu monolayers (room-temperature growth) (points). Spectra (a) as measured in the pulse counting mode and (b) after numerical differentiation. The data refer to an averaged extended area of the specimens.

7.   Other Topics

Other versions of photoemission and Auger spectroscopies have been developed since the birth of these techniques. Some of them are discussed in other papers of this volume such as angle-resolved photoemission, photoelectron diffraction, and spin-resolved photoemission. At present, they are mainly utilized for fundamental and applicative research but not for routine analysis in industrial environments. The next few years will certainly make these exotic approaches more familiar in the industrial areas.

Acknowledgments

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APPLICABILITY OF SURFACE SCIENCE TECHNIQUES

- Metal manufacture
  > Nitriding, carburizing, welding, machining, powders, coatings, corrosion, oxidation, tribology, rubber adh.

- Electronics
  > Thin films, adhesion, doping, cleaning, contacts

- Motor vehicles
  > Paint adhesion, corrosion, wear, fatigue failures

- Chemicals
  > Catalysis, plastics, pharmaceuticals

- Vacuum
  > Getters, hydrogen storage, plasma/wall

SURVEY OF SURFACE SCIENCE TECHNIQUES

Technique	Info	Best spatial resolution	Sampling depth (ML)	Sensitivity	
AES	E, C, S	5 nm	3	0.3%	
EELS	E, C	1 mm	3	1%	
ISS	E	1 mm	1	1%	
RBS	E	1 mm	100	1%	
Static SIMS	C	1 μm	2	0.01%	
Dynamic SIMS	E	20 nm	10	< 1 ppm	
SNMS	E	50 μm	10	< 1 ppm	
UPS	C	100 nm	3	1%	
XPS	E, C, S	100 nm	3	0.3%	
AFM				Atomic	
STM		2÷3 Å lateral 0.01 Å vertical		Atomic	
LEED	S	1 mm	3		
AS	S		1		
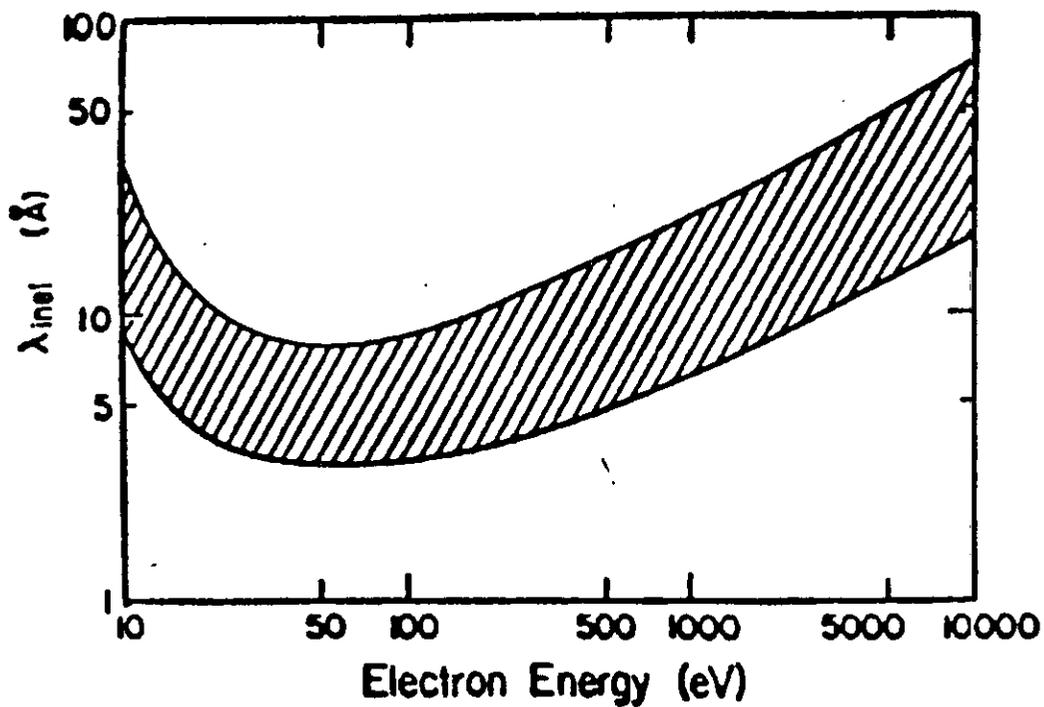
INELASTIC ELECTRON
MEAN FREE PATH AS A
FUNCTION OF ELECTRON ENERGY

SIGNAL ATTENUATION
versus
DEPTH

e^- PROBABILITY FOR NOT BEING INELASTICALLY SCATTERED $\propto e^{-z/\lambda \sin \vartheta}$
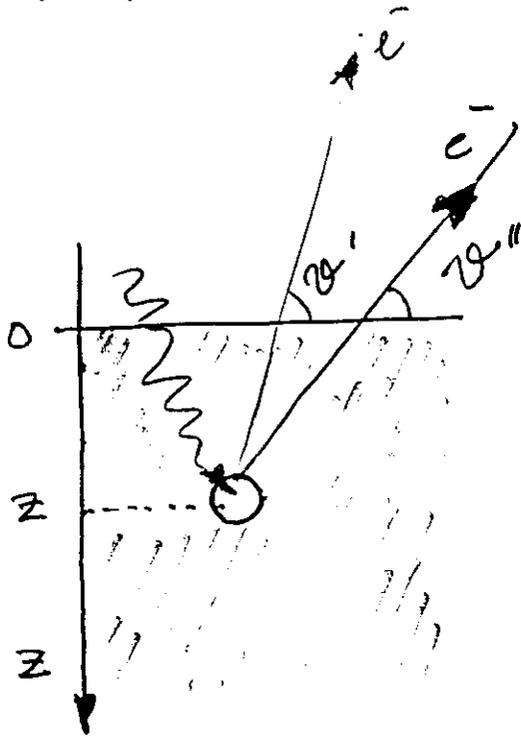
$$I_1 = I_0 \, e^{-z_1/\lambda \sin \vartheta}$$

$$I_2 = I_0 \, e^{-2z_1/\lambda \sin \vartheta}$$

$$- \cdots - - - - - - -$$

$$I_i = I_0 \, e^{-iz_1/\lambda \sin \vartheta}$$

ENERGY

KINETIC
ENERGY

PRIMARY
ELECTRONS

EMPTY
STATES

E_v

SECONDARY
ELECTRONS

E_f

OCCUPIED
STATES

$h\nu$

VACUUM   SURFACE   BULK

Vacuum level

Fermi level

Valence
electrons

Core
electrons

Electronic states
in a solid

Density of
electronic states

Photoelectron
spectrum

$\overline{+5}4.5$

C as graphite
Mg Kα

KVV

1020   970

Binding Energy (eV)

1s

KVV

1200   1000   800   600   400   200   0
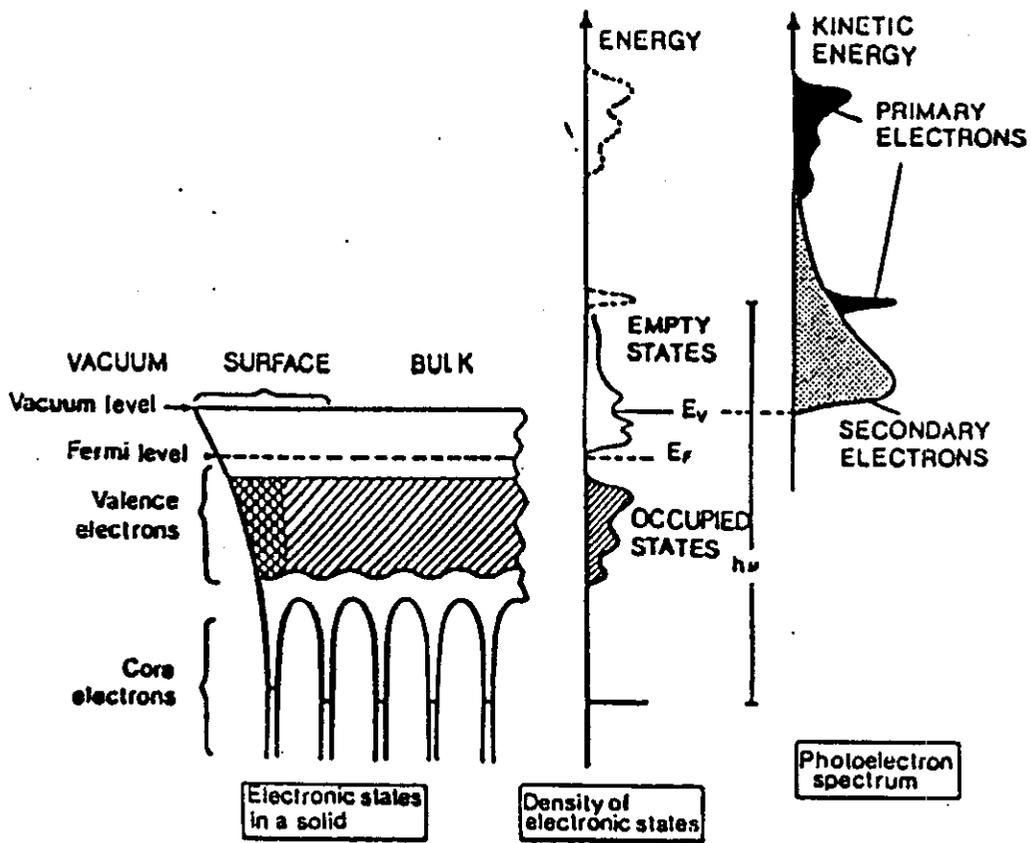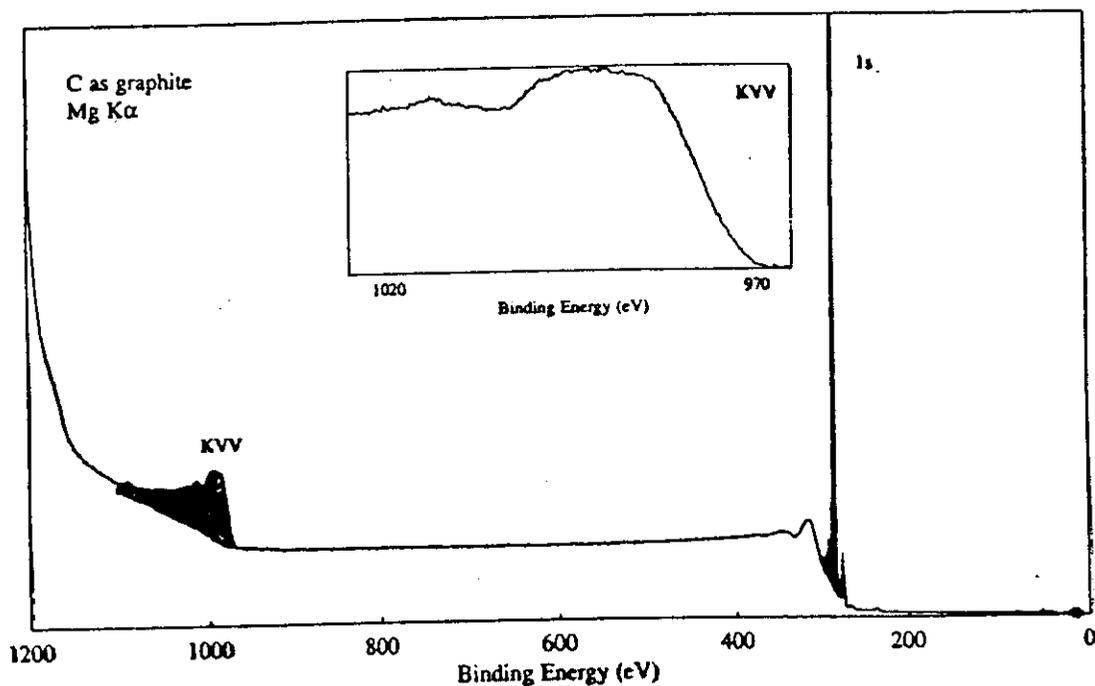
Binding Energy (eV)

1s Binding Energy (eV)							
Compound Type	280	282	284	286	288	290	292	294
Carbide								
Carbon								
C with N								
C with S								
C with O								
Alcohols								
Ethers								
Ketones/Aldehydes								
Carboxyls								
Carbonates								
C with Cl								
C with F								
CHF								
CF$_2$								
CF$_3$								

1s = 284.5 eV

1s

295   285   275

Binding Energy (eV)

Mg Kα

MNN

MNN

1120   1105   1090
Binding Energy (eV)

3d5/2

3d3/2

3p3/2

3p1/2

3s

Ar

4p

4s

1200   1000   800   600   400   200   0
Binding Energy (eV)
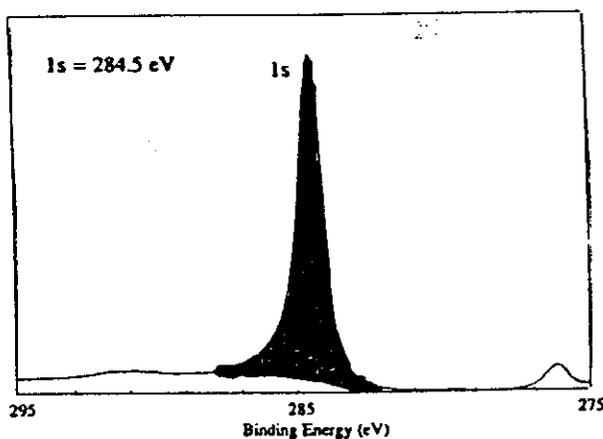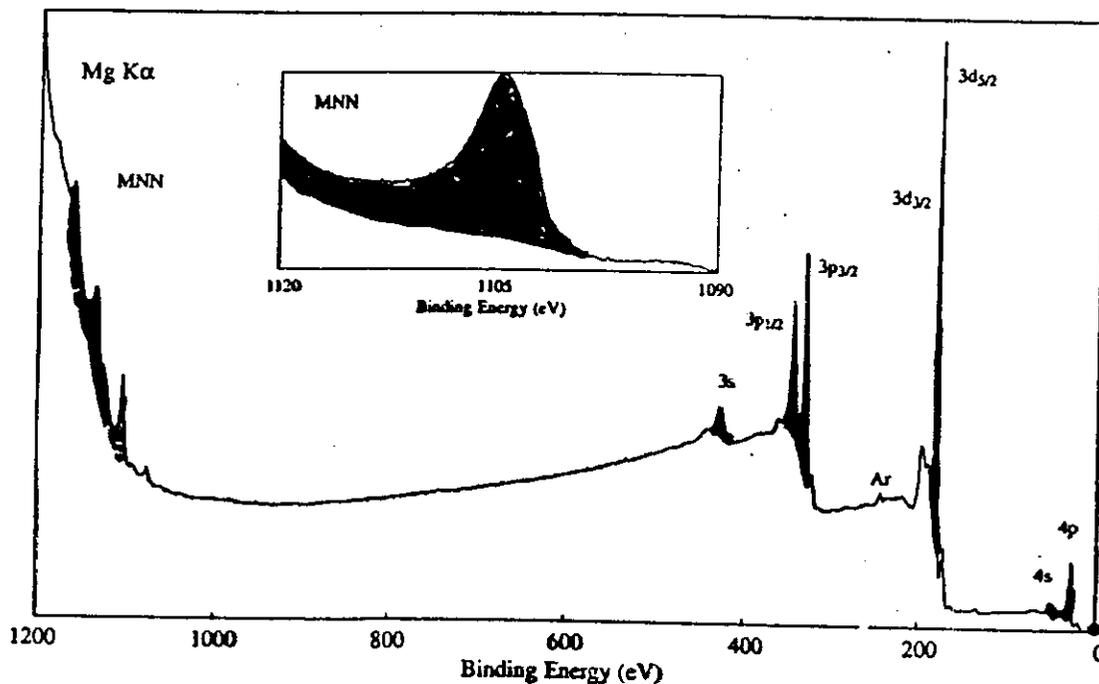
Compound Type	3d5/2 Binding Energy (eV)							
	178	179	180	181	182	183	184	185
Zr		■						
ZrO2					■			
ZrF3								▮
K2ZrF6							▮	
K3ZrF7						▮		
KZrF3 · H2O							▮	

$3d_{5/2} = 178.9$ eV
$\Delta = 2.43$ eV

$3d_{5/2}$

$3d_{3/2}$

190   180   170
Binding Energy (eV)
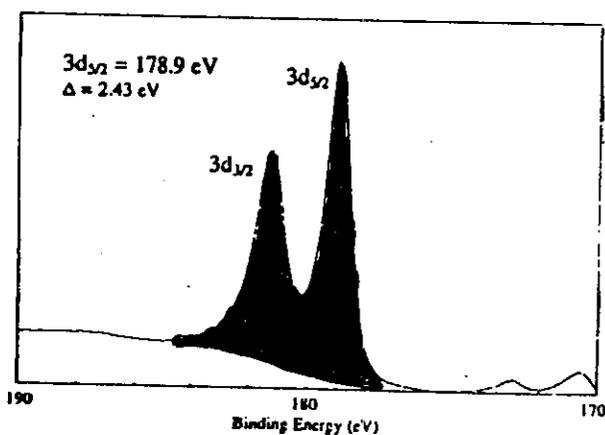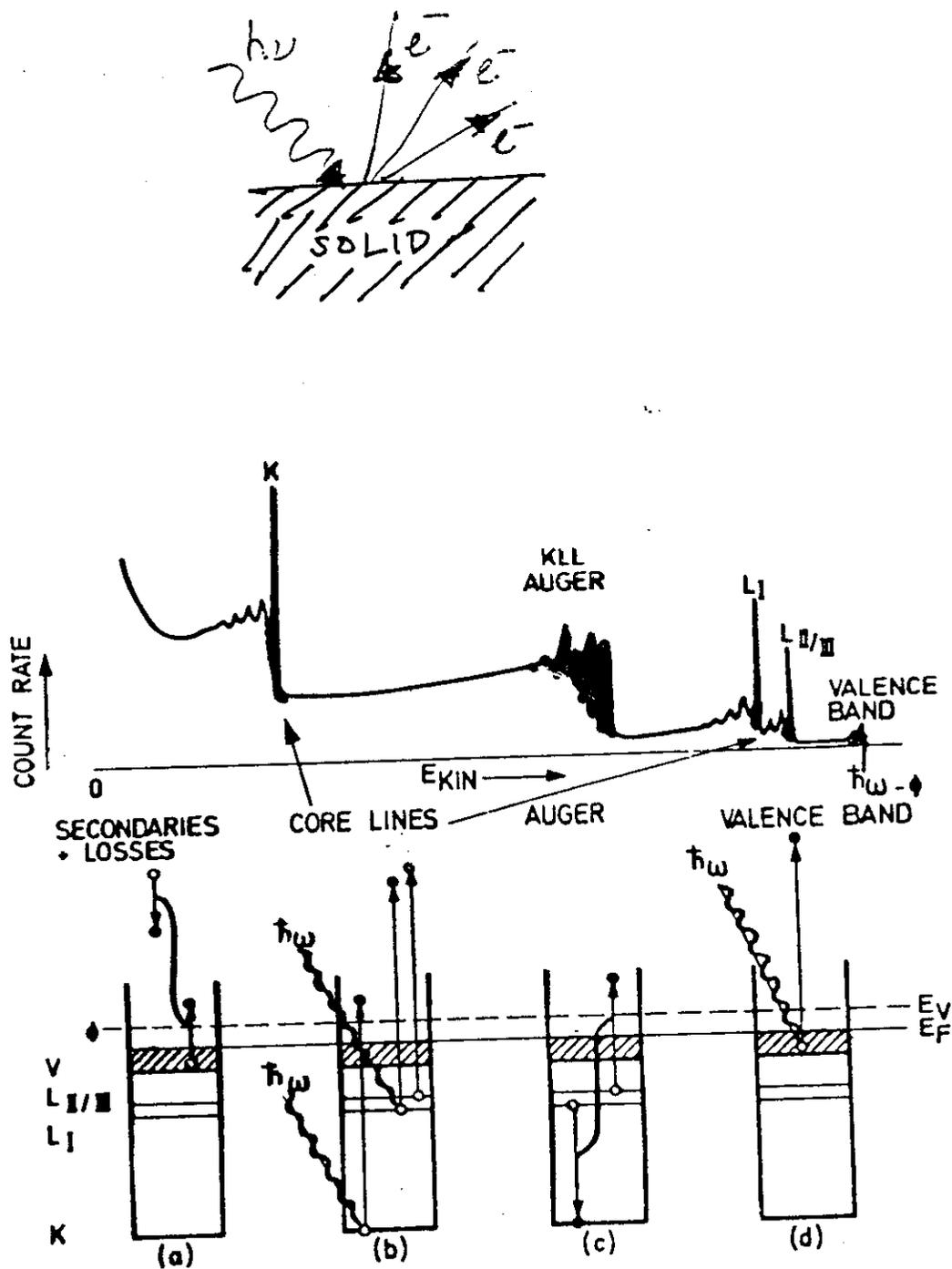
Figure 1.8   The basic processes contributing to an XPS spectrum (top) include: **(b)** direct optical excitation of core electrons; or **(d)** valence electrons; **(c)** hole de-excitation via the Auger process; and **(a)** inelastic losses giving rise to secondary electrons, and plasmon satellites

BASIC COMPONENTS
FOR XPS

- UHV APPARATUS

- SAMPLE

- PHOTON SOURCE

- ELECTRON ENERGY ANALYSER

- ELECTRON DETECTOR

- PULSE COUNTING ELECTRONICS

$\hbar \nu = 1486.6 eV$

$WIDTH = 0.85e^{\vee}$
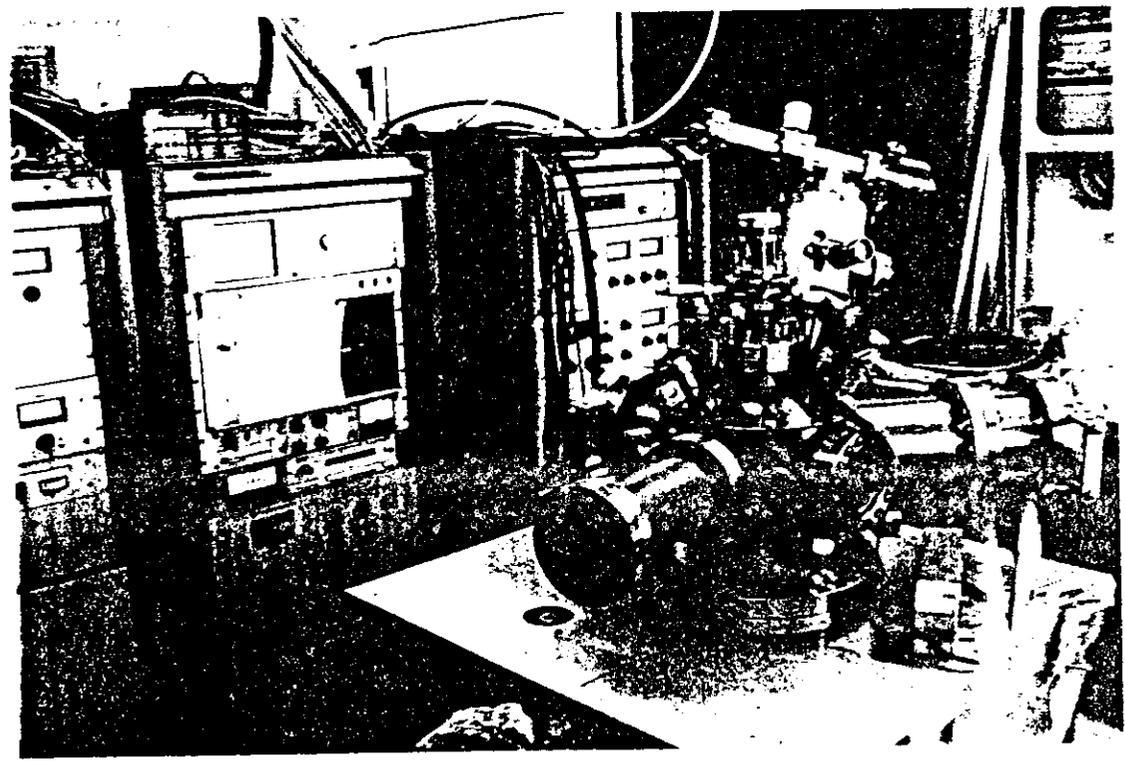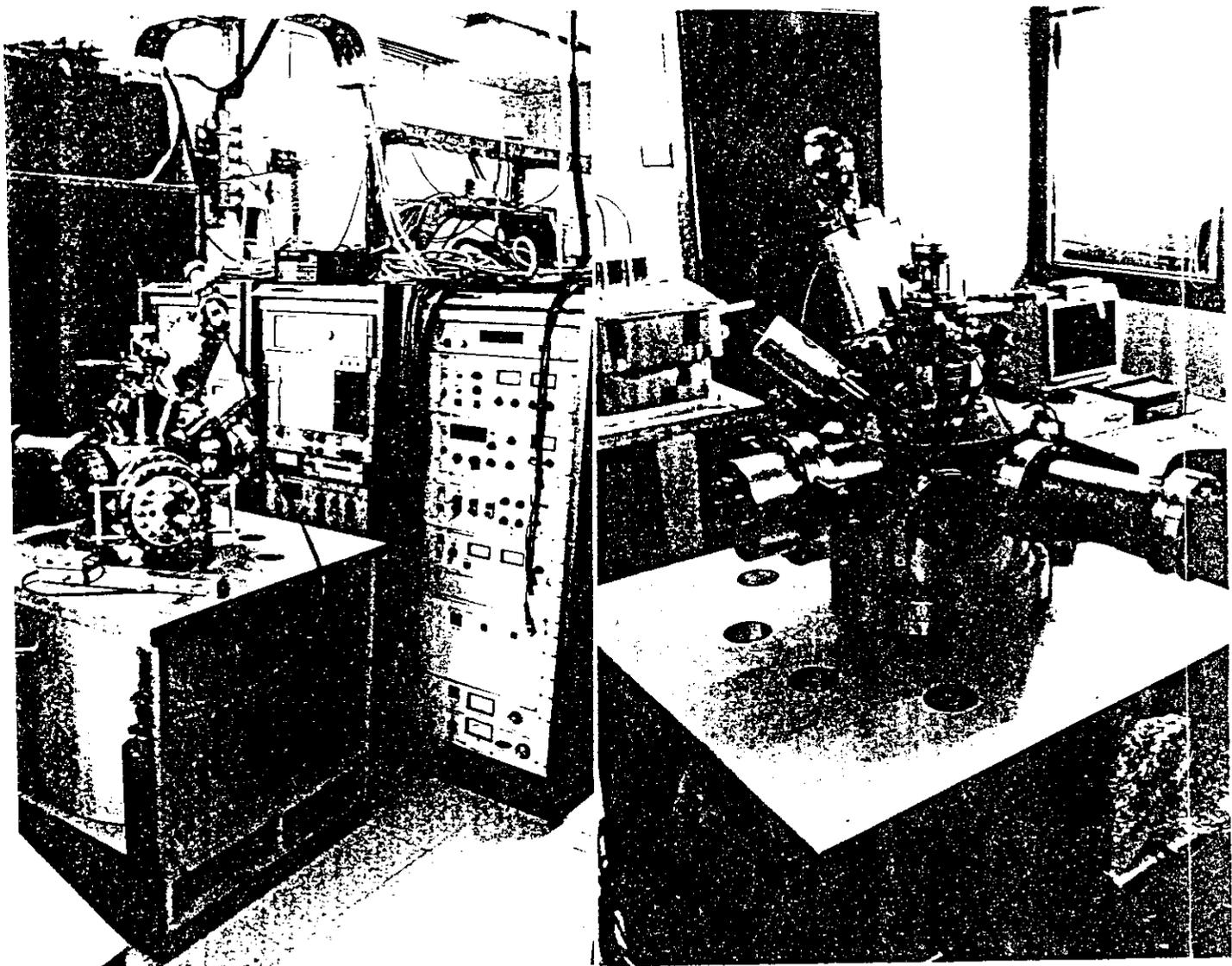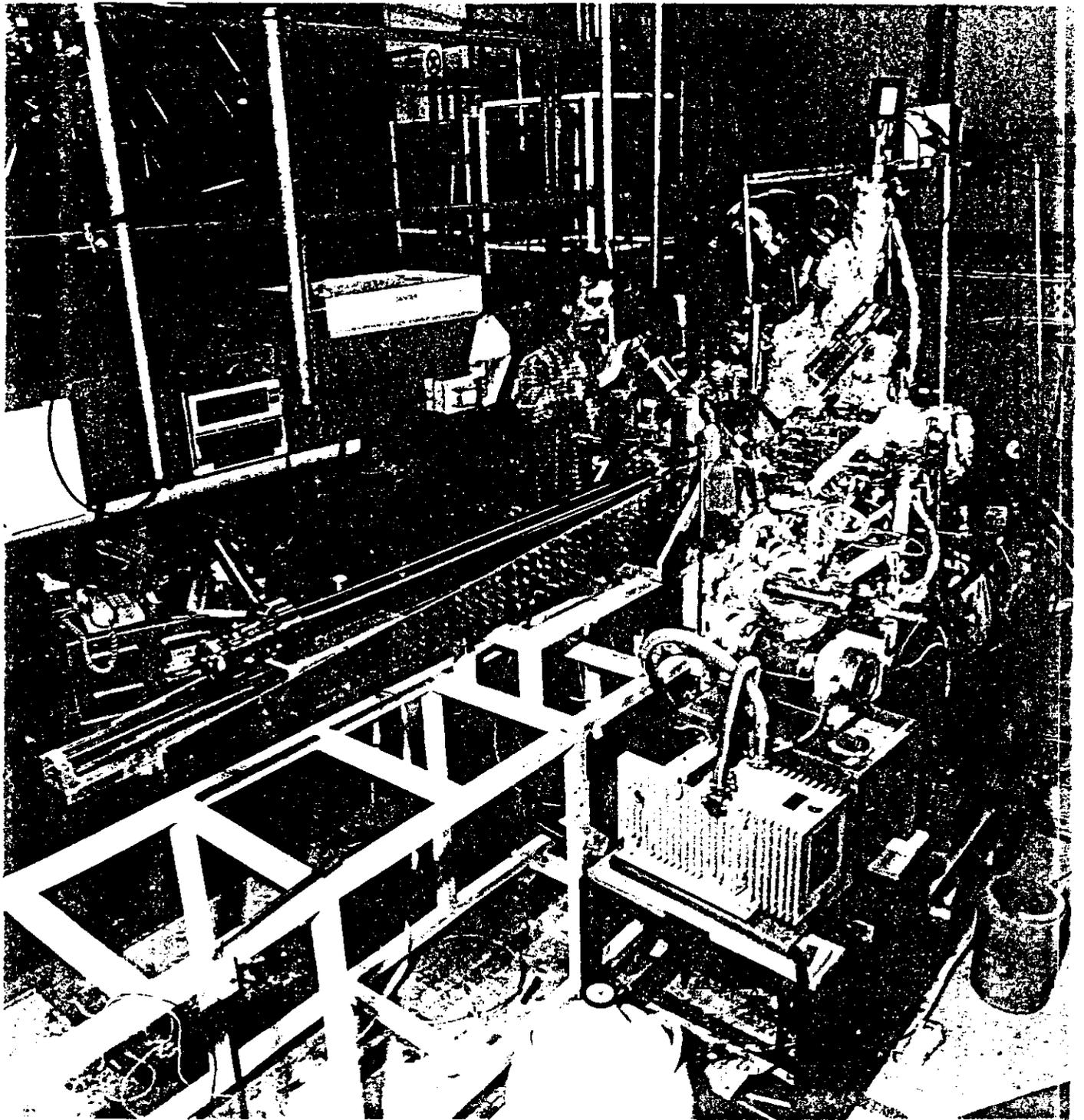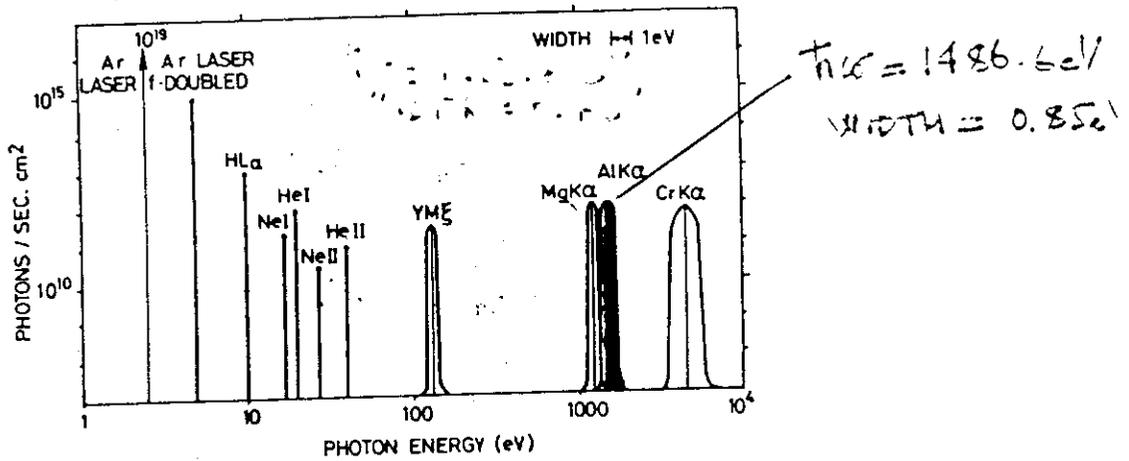
Fig. 5.5 Photon energies and intensities for line sources commonly used in photoemission experiments. Intensities are given for a 10 x 10 mm illuminated area at the sample position. Line widths are indicated on an expanded scale as shown in the top right corner. The AlK$_\alpha$ line is also shown after monochromatization (full peak)
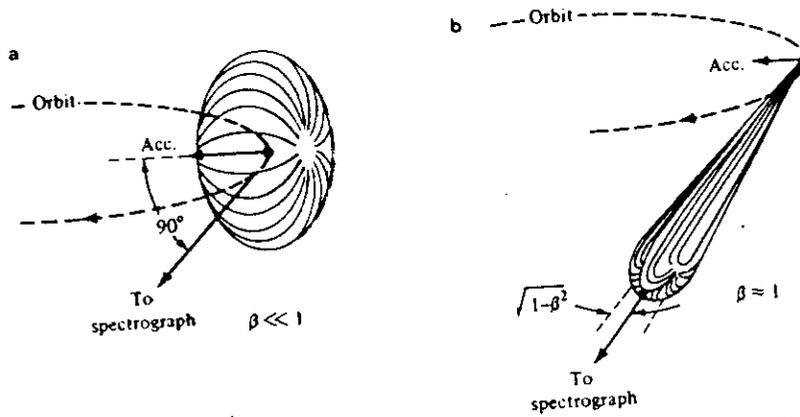
Fig. 6.1a and b. Angular distribution of emitted intensity a from a slow electron on a circular orbit. b from a relativistic electron moving with the velocity βc. The dipole pattern a is distorted into a narrow cone b in the instantaneous direction of motion of the electron [6.7]
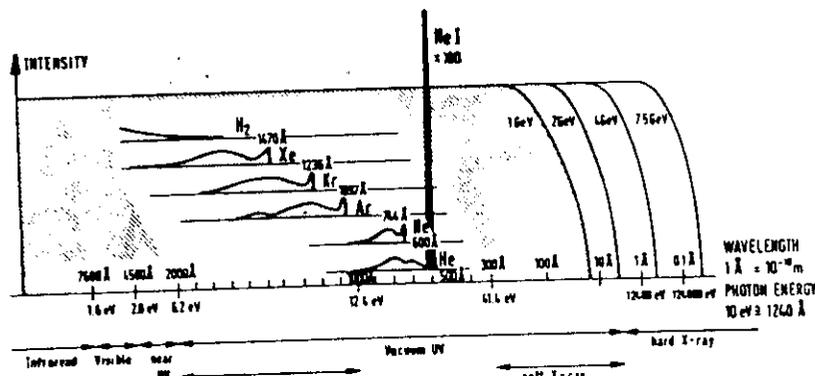
Schematic comparison of the spectral emission of radiation from a typical large synchrotron (e.g. DESY) with that of classical discharge sources. The intensities are roughly on the same relative scale [6.17]

Cooling water

Focusing shields

Filament 1

Filament 2

Anode face 1

Al window
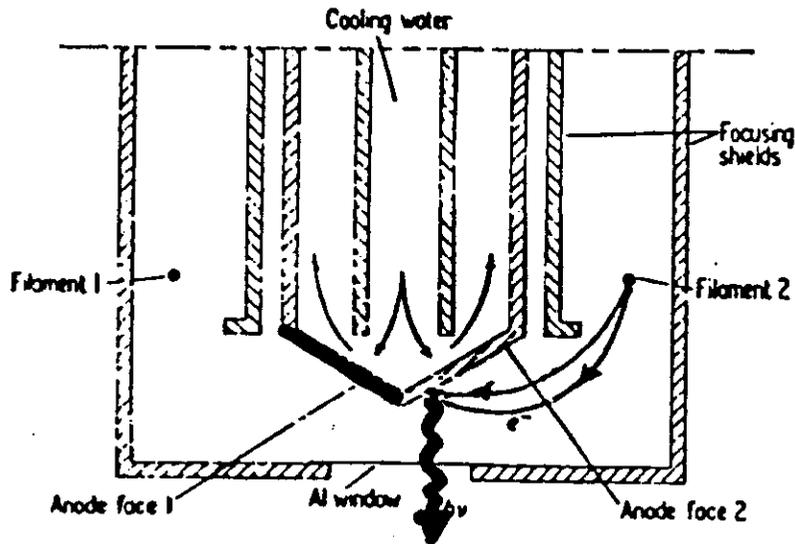
Anode face 2

Figure 2.18 Schematic of dual-anode X-ray source. The tapered anode has two faces, on which films of magnesium and aluminium respectively are deposited. Each anode face has its own semi-circular filament, near ground potential, from which electrons are accelerated through a potential of up to 15 kV to the anode face nearer to it. Switching from one anode face to another can be accomplished without the need to break the vacuum. (Reproduced from Yates, Barrie and Street[8] by permission of The Institute of Physics)
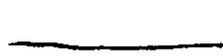
ELECTRON TRAJECTORY

ANODE FACE #2

ANODE. FACE #1

XPS TECHNICALITIES
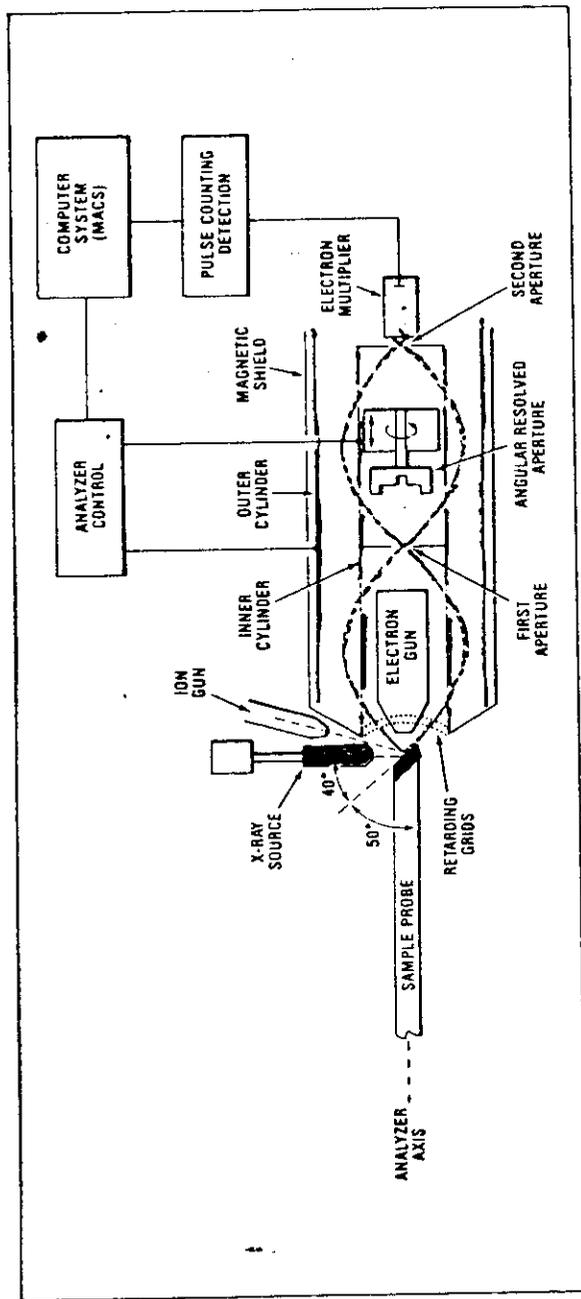
ELECTRON ENERGY ANALYSER

PHOTON SOURCE

ELECTRON PATH

ELECTRON DETECTOR

SAMPLE

COMPUTER SYSTEM (MACS)

PULSE COUNTING DETECTION

ANALYZER CONTROL

ELECTRON MULTIPLIER

MAGNETIC SHIELD

SECOND APERTURE

ANGULAR RESOLVED APERTURE

OUTER CYLINDER

INNER CYLINDER

ELECTRON GUN

FIRST APERTURE

ION GUN

X-RAY SOURCE

RETARDING GRIDS

SAMPLE PROBE

ANALYZER AXIS

40°

50°

180° hemi-
spherical
analyser

Hole

Lens 3

Spectrum
detector I

Imaging

Lens 5

Image x16

'ESCA'
image
x16-32

Lens 2

Real image
4 x mag

Image
detector 2

Field operture

Lens I

Objective operture

X-rays

ESCASCOPE

Spherical
Mu-metal
chomber

Figure 2.32 Diagram showing the electron optical arrangement in the ESCASCOPE instrument designed to produce energy-resolved two-dimensional images of the surface of a sample. Compared to the conventional lens-plus-analyser system, the additional elements are the input lens (3) the output lens (5) and the channel plate image detector. The principles of the imaging technique are discussed in the text. (Reproduced from Coxon et al.[24] by permission of Elsevier Science Publishers)

XPS OF INSULATORS:
CHARGING EFFECTS ;
NEUTRALIZATION
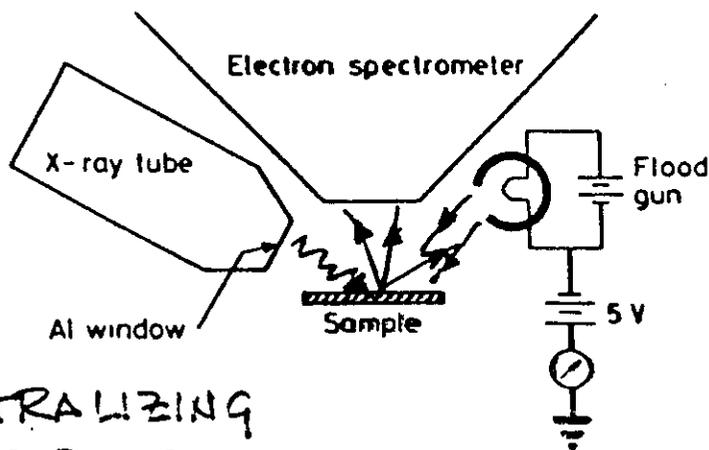
── NEUTRALIZING
    ELECTRONS

── PHOTOEMITTED
    ELECTRONS

── X-RAY
    PHOTONS
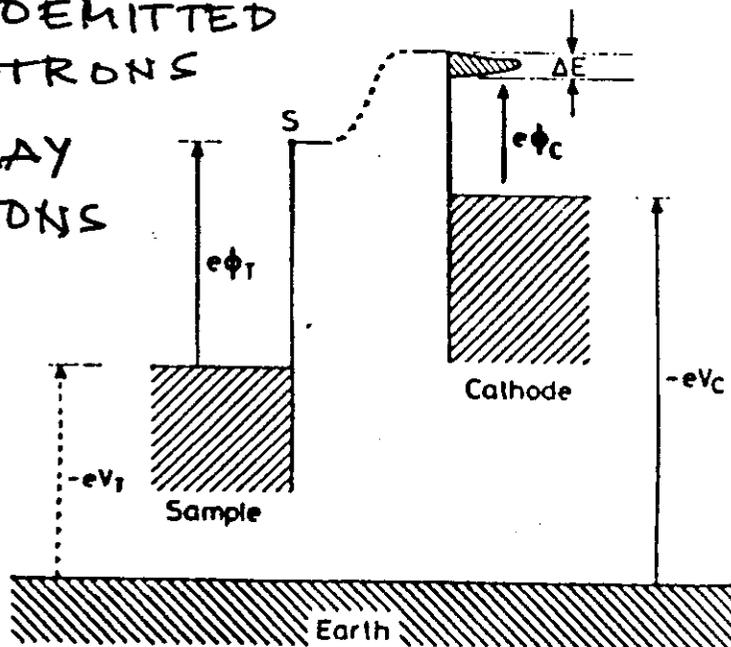
Figure A2.2 Stabilization of surface potential using an electron flood gun: (a) schematic flood gun arrangement (After Huchital and McKeon,[42]). (b) potential energy diagram for the sample and flood gun system with respect to earth (After Hunt, Stoddart and Seah[43])
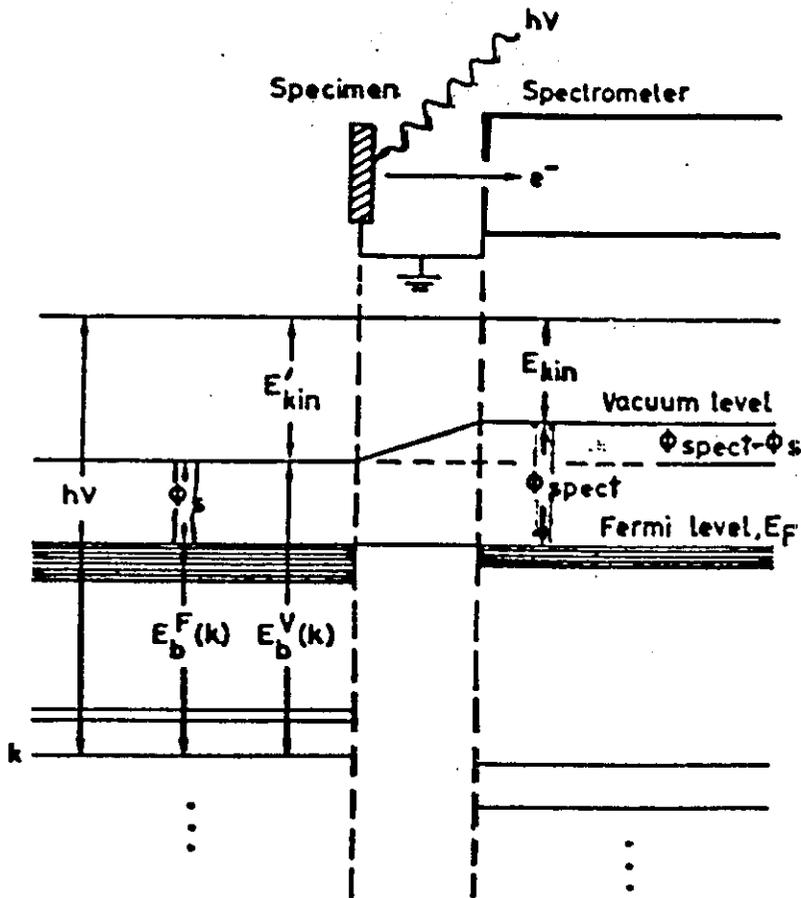
Fig. 3. Energy level diagram for a metallic specimen in electrical equlibrium with an electron spectrometer. The closely spaced levels near the Fermi level E_F represent the filled portions of the valence bands in specimen and spectrometer. The deeper levels are core levels. An analogous diagram also applies to semi-conducting or insulating specimens, with the only difference being that E_F lies somewhere between the filled valence bands and the empty conduction bands above.

HOW TO MEASURE THE SAMPLE ϕ_s
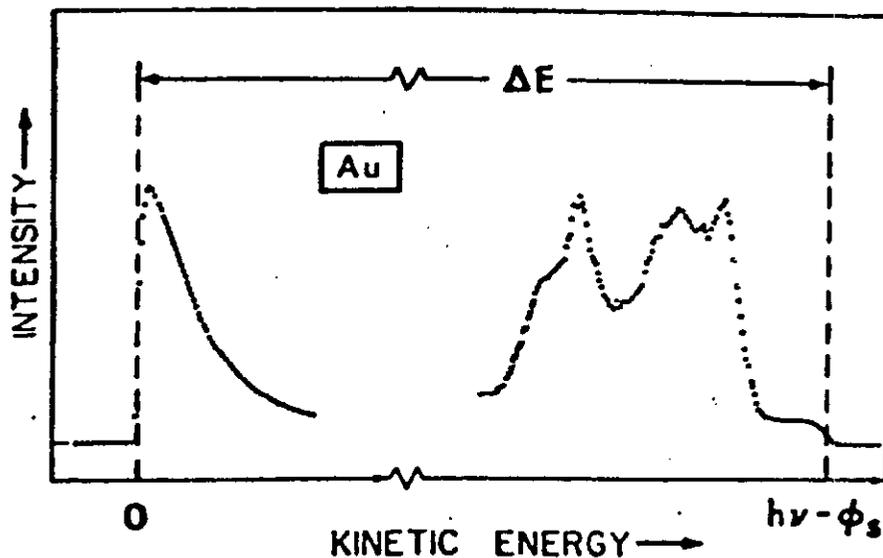
$\Delta E = h\nu - \phi_s$

Fig. 4. Full XPS spectral scan for a polycrystalline Au specimen, showing both the cut-off of the secondary electron peak at zero kinetic energy and the high-energy cut-off for emission from levels at the metal Fermi level. The measurable distance ΔE thus equals $h\nu-\phi_s$, provided that suitable specimen biasing has been utilized. For this case, $h\nu$ was 1253·6 eV and ϕ_s was 5·1 eV. (From Baer, ref. 56.)

VALENCE STATES

XPS PROFILE
        versus
DENSITY OF STATES
CALCULATION

HOW TO MEASURE
THE INSTRUMENTAL
        RESOLUTION

XPS Ag

a (×20)

0 38 eV

Ag
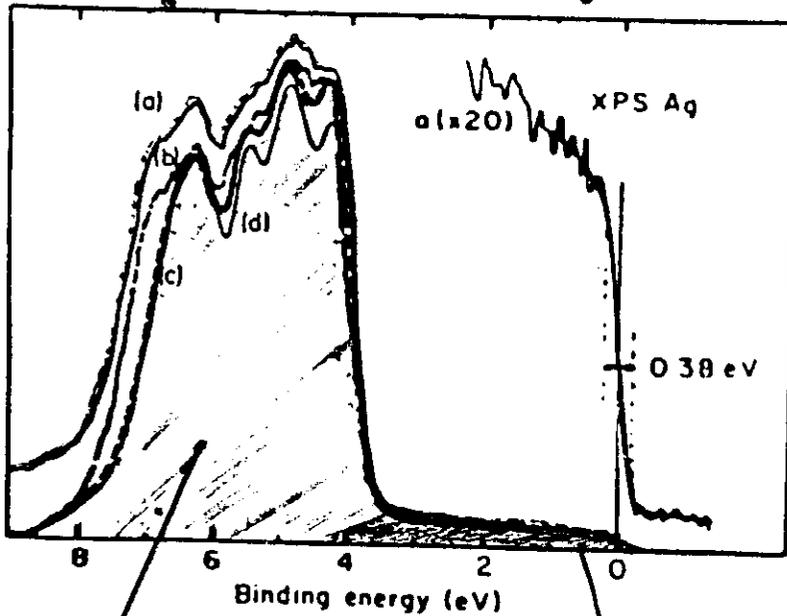
Figure 3.21 XPS valence spectrum for polycrystalline silver excited by monochromatic Al Kα radiation in comparison with the theoretical density of states: (a) raw XPS data; (b) data after substraction of smooth inelastic background; (c) and (d) total theoretical density of states after two different line shape broadenings to include lifetime and shake-up effects. The Fermi edge has been expanded to reveal the instrumental resolution. (After Barrie and Christensen[24])

MOSTLY
Ag 4d STATES

MOSTLY
Ag 5(sp) STATES

CORE LEVEL ASYMMETRY
via DONIACH – SUNJIĆ EFFECT

4f   VB

Au

0 52

90   85

10   5   0

Pt

1·05

75   70

10   5   0

BE.eV
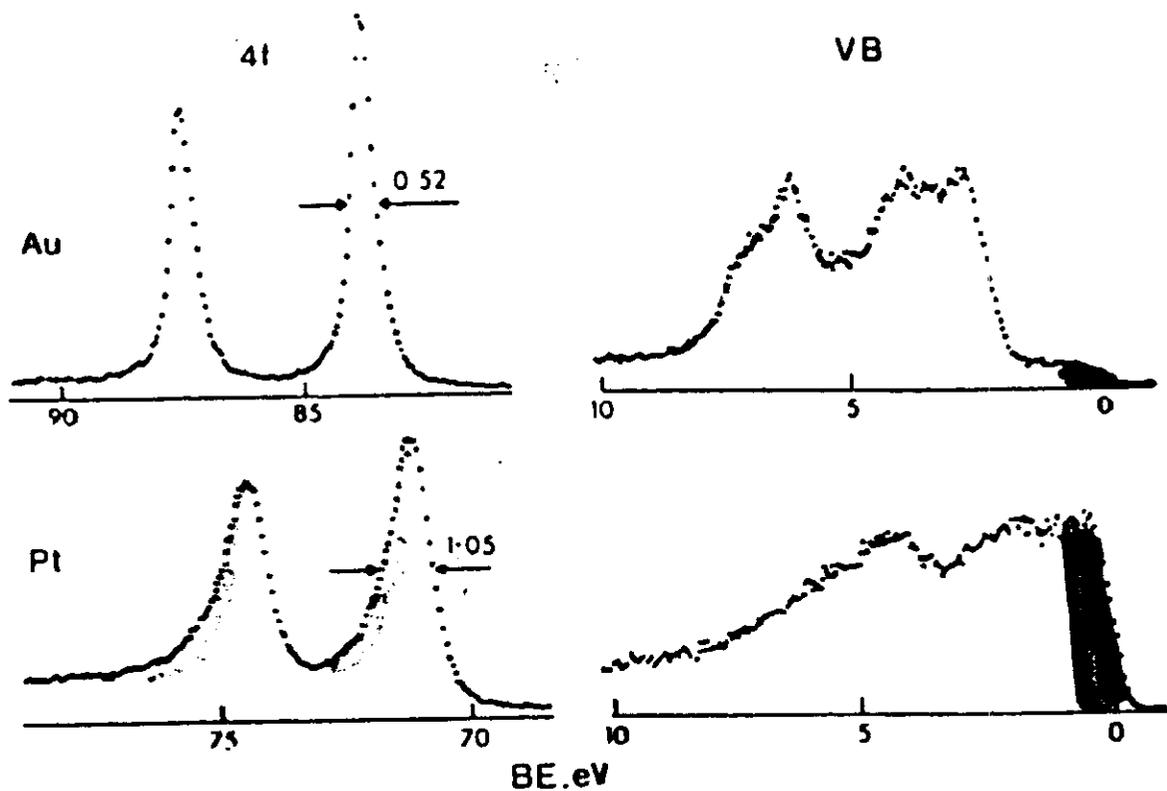
Figure 1.13 Core (4f) and valence (VB) photoelectron spectra of gold and platinum recorded using monochromatic Al Kα radiation. Note the relationship between the degree of core level asymmetry and the density of states at the Fermi level (BE = 0 eV). (After Barrie, Swift and Briggs[49])

ELECTRON- HOLE PAIRS EXCITED
AT THE FERMI LEVEL AS A
RESPONSE TO THE CORE HOLE
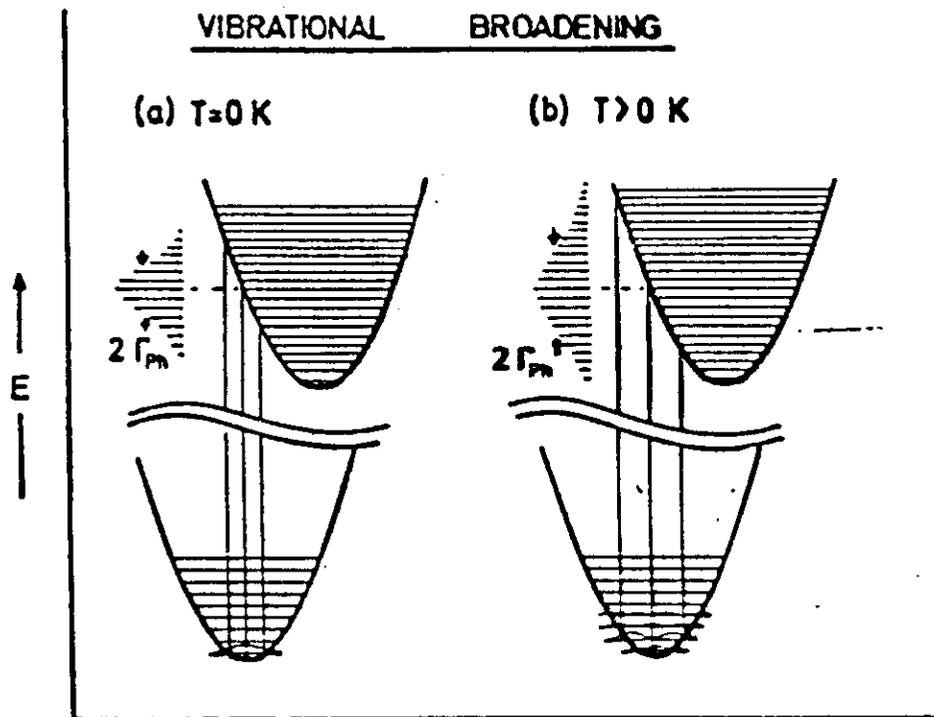
Fig. 11. The origin of phonon broadening in XPS and Auger lines.
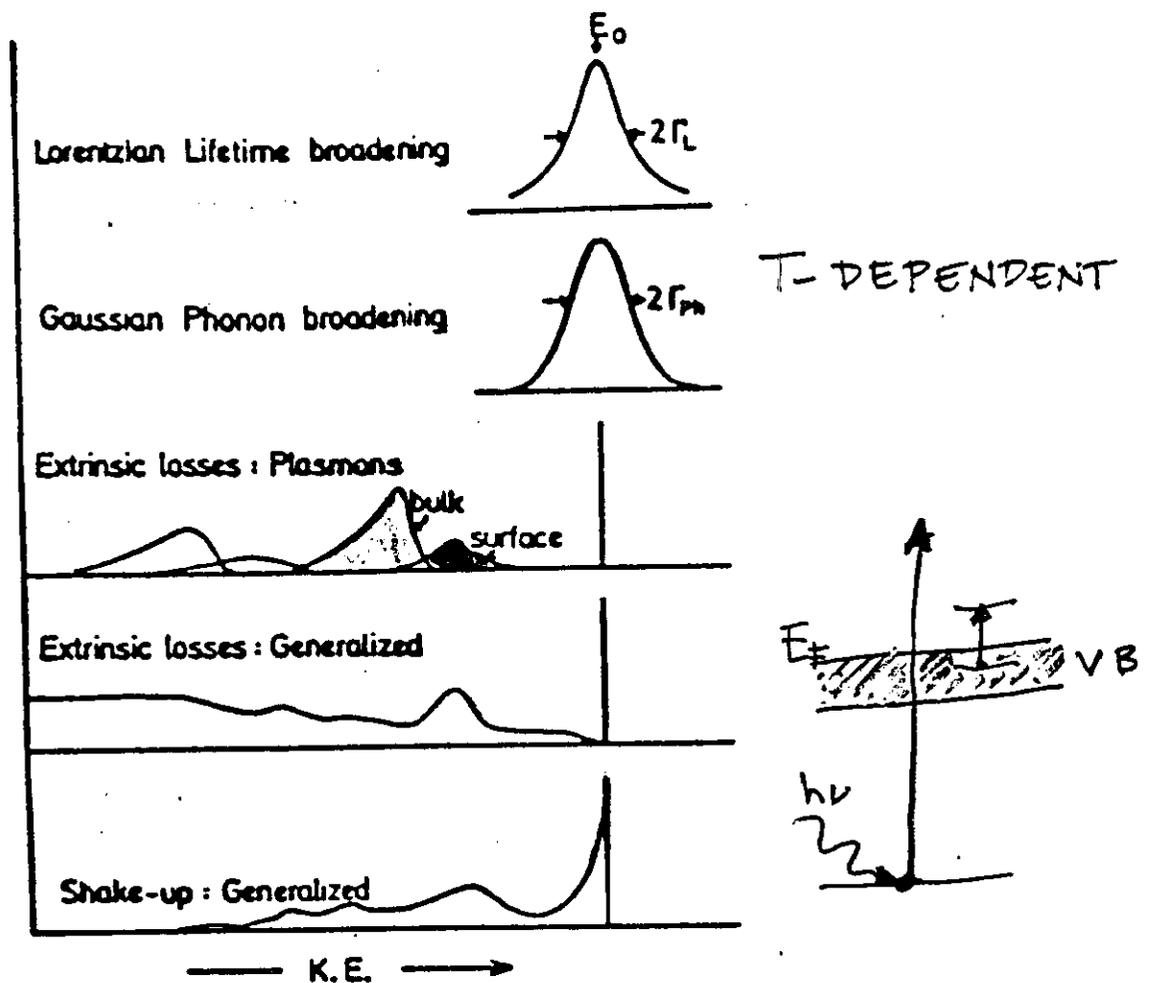
Fig. 10. Summary of the effects on line shapes in electron spectroscopies. Note that phonon broadening is associated with an energy shift not shown here.

OVERVIEW OF THE
PHYSICAL EFFECTS
AFFECTING THE
LINE SHAPE IN
ELECTRON SPECTROSCOPIES

INELASTIC SCATTERING:
PRIMARY versus SECONDARY
PHOTOELECTRONS

(a)

Au 4f

1350   1400   1450   1500
ELECTRON KINETIC ENERGY (eV)

(b)

Au 4d

1050   1100   1150   1200
ELECTRON KINETIC ENERGY (eV)

(c)

Au 4p

800   850   900   950
ELECTRON KINETIC ENERGY (eV)
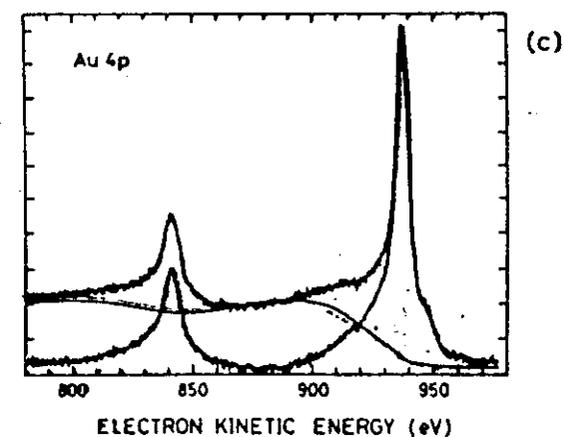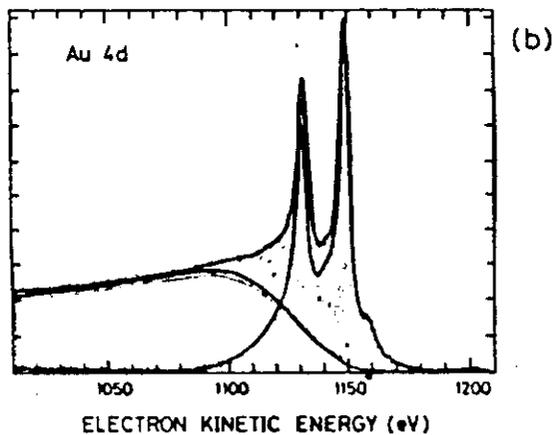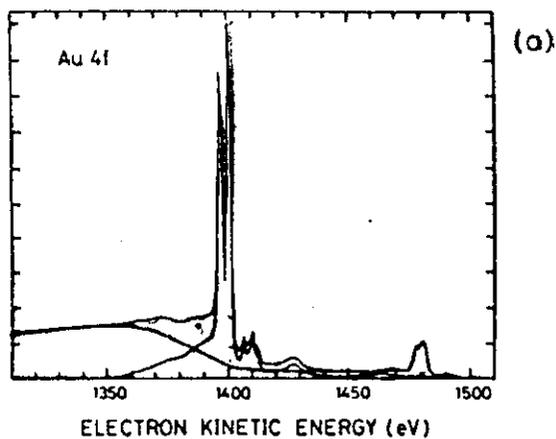
BACKGROUND
LINE

PRIMARY
PHOTOELECTRON
SIGNAL

FIG. 3. Experimental Al $K\alpha$ excited spectra of gold (upper curves) and the primary excitation spectra as determined by Eq. (1) (lower curves). The difference curves are the background signal of inelastically scattered electrons. The inelastic scattering cross section $K(E,T)$ (Ref. 21) for $E = 1400$, 1145, and 950 eV and the corresponding inelastic mean free paths $\lambda = 21.5$, 17.1, and 14.0 Å (Ref. 26), respectively, were used.

XPS MODEL IN SOLIDS

- THREE STEP MODEL

    - PHOTON ABSORPTION

    - ELECTRON TRANSPORT INSIDE
      THE SOLID (λ)

    - ESCAPE INTO VACUUM $\left(k_{\parallel} \text{ vs } k_{\perp}\right)$

XPS THEORY
ONE-PARTICLE PICTURE

- ELECTROMAGNETIC FIELD — MATTER INTERACTION

- SEMI-CLASSICAL TREATMENT OF THE ELECTROMAGNETIC FIELD

$$H = \frac{1}{2m}\left(\vec{P} - \frac{e}{c}\vec{A}\right)^2 + e\varphi + V$$

$\vec{P}$ ELECTRON MOMENTUM

e ELECTRIC CHARGE

m PARTICLE MASS

$\vec{A}$ VECTOR POTENTIAL

φ SCALAR POTENTIAL

H HAMILTONIAN

V POTENTIAL ENERGY

$$i\hbar\frac{\partial}{\partial t}|\psi\rangle = \left[-\frac{\hbar^2}{2m}\nabla^2 + \frac{ie\hbar}{mc}\vec{A}\cdot\vec{\nabla} + \frac{ie\hbar}{2mc}\vec{\nabla}\cdot\vec{A} + \frac{e^2}{2mc^2}\vec{A}^2 + e\varphi + V\right]|\psi\rangle$$

- $\frac{eA}{cP}$ FIRST ORDER PERTURBATION THEORY
  DIPOLE APPROXIMATION

- GAUGE CONDITIONS

$$i\hbar \frac{\partial}{\partial t} |\psi\rangle = \left(H_0 + H'\right) |\psi\rangle$$

$$H_0 = -\frac{\hbar^2}{2m} \nabla^2 + V(\vec{r})$$

$$H' = \frac{ie\hbar}{mc} \left(\vec{A}\cdot\vec{\nabla} + \vec{\nabla}\cdot\vec{A}\right)$$

- TRANSITION PROBABILITY BETWEEN
  EIGEN STATES OF THE UNPERTURBED
  HAMILTONIAN H_0

$$\frac{d^2 J}{dE\, d\Omega} \propto \left(E_f - E_{vac}\right)^{\frac{1}{2}} \cdot$$

ENERGY CONSERVATION CONDITION

$$\cdot \sum_i |M_{fi}|^2 \, \delta\!\left(E - \hbar\omega - E_i\right)$$

J PHOTOELECTRON CURRENT THROUGH AN
ENERGY ANALYZER SET AT E ;
WITHIN A SOLID ANGLE $d\Omega$ (PRIMARY EMISSION)

$E_f ; E_i$ FINAL STATE ENERGY ; INITIAL STATE ENERGY

E_{vac} VACUUM LEVEL

$\hbar\omega$ PHOTON ENERGY

M_{fi} MATRIX ELEMENT

XPS THEORY

ONE-PARTICLE PICTURE

$$H = H_0 + H'$$

$$H_0 = \frac{\vec{P}^2}{2m} + V(\vec{r})$$

$\vec{P}$ ELECTRON MOMENTUM

m ELECTRON MASS

$V(\vec{r})$ SCALAR POTENTIAL

H_0 UNPERTURBED HAMILTONIAN

H' INTERACTION HAMILTONIAN

$$H' \propto \vec{P} \cdot \vec{A} + \vec{A} \cdot \vec{P}$$

$\vec{A}$ VECTOR POTENTIAL OF THE ELECTROMAGNETIC FIELD

QUANTITATIVE EVALUATION

- HOMOGENEOUS SOLIDS

- $$X_A = \frac{I_A}{I_A^\infty}$$

X_A = MOLAR FRACTION OF COMPONENT "A"

I_A = INTENSITY FROM ELEMENT "A" IN THE SOLUTION

I_A^∞ = INTENSITY FROM ELEMENT "A" IN PURE "A"

- ASSUME YOU KNOW $\dfrac{I_A^\infty}{I_B^\infty}$

THEN

$$X_A = \frac{I_A / I_A^\infty}{\sum_{i=A,B} I_i / I_i^\infty}$$

XPS

$$I_i \propto I \, X_i \, \sigma_i \, \lambda(E_k) \, T$$

I = PHOTON FLUX

X_i = ATOMIC CONCENTRATION OF THE SPECIES "i"

σ_i = PHOTO-IONIZATION CROSS SECTION FOR A SPECIFIC CORE LEVEL OF THE SPECIES "i"

λ = ESCAPE DEPTH FOR THE PHOTOELECTRON OF ENERGY E_k

T = INSTRUMENTAL FACTOR

XPS ATOMIC SENSITIVITY FACTORS

Appendix E. Atomic Sensitivity Factors for X-ray Sources at 90°

This table is based upon empirical peak area values* corrected for the system's transmission function. The values are only valid for and should only be applied when the electron energy analyzer used has the transmission characteristics of the spherical capacitor type analyzer equipped with an Omni Focus III lens supplied by Perkin-Elmer. The data are calculated for x-rays at 90° relative to the analyzer.

Element	Line	ASF	Element	Line	ASF	Element	Line	ASF	Element	Line	ASF
Ag	3d	5.198	Eu	4d	2.210	Na	1s	1.685	Si	2p	0.283
Al	2p	0.193	F	1s	1.000	Nb	3d	2.517	Sm	3d5/2	2.907
Ar	2p	1.011	Fe	2p	2.686	Nd	3d	4.697	Sn	3d5/2	4.095
As	3d	0.570	Ga	2p3/2	3.341	Ne	1s	1.340	Sr	3d	1.578
Au	4f	5.240	Gd	4d	2.207	Ni	2p	3.653	Ta	4f	2.589
B	1s	0.159	Ge	2p3/2	3.100	O	1s	0.711	Tb	4d	2.201
Ba	4d	2.627	Hf	4f	2.221	Os	4f	3.747	Tc	3d	3.266
Be	1s	0.074	Hg	4f	5.797	P	2p	0.412	Te	3d5/2	4.925
Bi	4f	7.632	Ho	4d	2.189	Pb	4f	6.968	Th	4f7/2	7.498
Br	3d	0.895	I	3d5/2	5.337	Pd	3d	4.642	Ti	2p	1.798
C	1s	0.296	In	3d5/2	3.777	Pm	3d	3.754	Tl	4f	6.447
Ca	2p	1.634	Ir	4f	4.217	Pr	3d	6.356	Tm	4d	2.172
Cd	3d5/2	3.444	K	2p	1.300	Pt	4f	4.674	U	4f7/2	8.476
Ce	3d	7.399	Kr	3d	1.096	Rb	3d	1.316	V	2p	1.912
Cl	2p	0.770	La	3d	7.708	Re	4f	3.327	W	4f	2.959
Co	2p	3.255	Li	1s	0.025	Rh	3d	4.179	Xe	3d5/2	5.702
Cr	2p	2.201	Lu	4d	2.156	Ru	3d	3.696	Y	3d	1.867
Cs	3d5/2	6.032	Mg	2s	0.252	S	2p	0.570	Yb	4d	2.169
Cu	2p	4.798	Mn	2p	2.420	Sb	3d5/2	4.473	Zn	2p3/2	3.354
Dy	4d	2.198	Mo	3d	2.867	Sc	2p	1.678	Zr	3d	2.216
Er	4d	2.184	N	1s	0.477	Se	3d	0.722			

*C.D Wagner, et al. Surf. Interface Anal. 3, 211 (1981).
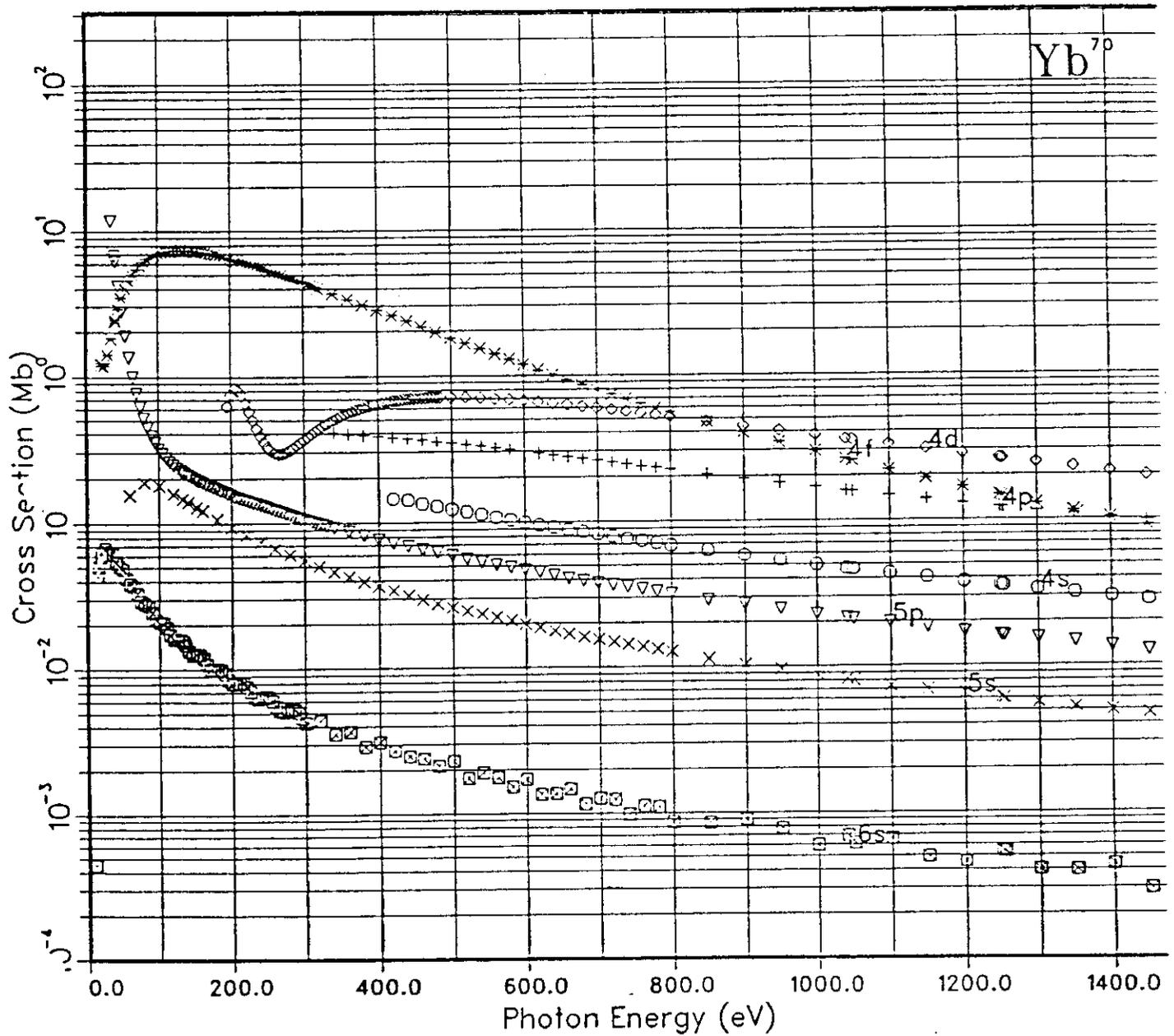
Yb^{70}

Cross Section (Mb)

Photon Energy (eV)

Yb binding energies(eV) are:

1s(2) 57009.8	2s(2) 9290.78	2p(6) 8897.20
3s(2) 2086.76	3p(6) 1904.14	4s(2) 402.610
3d(10) 1561.01	4p(6) 327.461	5s(2) 50.8637
4d(10) 190.652	5p(6) 30.7582	6s(2) 5.16038
4f(14) 15.9818		

XPS

- **Elemental sensitivity**
  via
  Core level binding energies

- **Chemical environment sensitivity**
  via
  Core level chemical shift

- **Quantitative evaluation**
  via
  Core level intensity analysis
  & cross section evaluation

- **Structural information**
  via
  Photoelectron diffraction

- **Access key to many body realm**
  via
  Spectral line shape analysis

XPS

- ELEMENTAL SENSITIVITY
  via
  CORE LEVEL BINDING ENERGIES

- CHEMICAL ENVIRONMENT SENSITIVITY
  via
  CORE LEVEL CHEMICAL SHIFT

- QUANTITATIVE EVALUATION
  via
  CORE LEVEL INTENSITY ANALYSIS
  & CROSS SECTION EVALUATION

- STRUCTURAL INFORMATION
  via
  PHOTOELECTRON DIFFRACTION

- ACCESS KEY TO MANY BODY REALM
  via
  SPECTRAL LINESHAPE ANALYSIS

XPS   Si 2p

Si (100) OXIDIZED IN O_2

RAW DATA

STRIPPED DATA

Si 2p
hν = 130 eV

Si(100)
Oxidized in O_2

Photoemission Intensity (Arb. Units)

Si^{3+}

Si^{2+}

Si^{1+}

SiO_2

Si^{3+} Si^{2+} Si^{1+} Si

-107 -106 -105 -104 -103 -102 -101 -100 -99 -98

Initial-State Energy (eV relative to E_F)
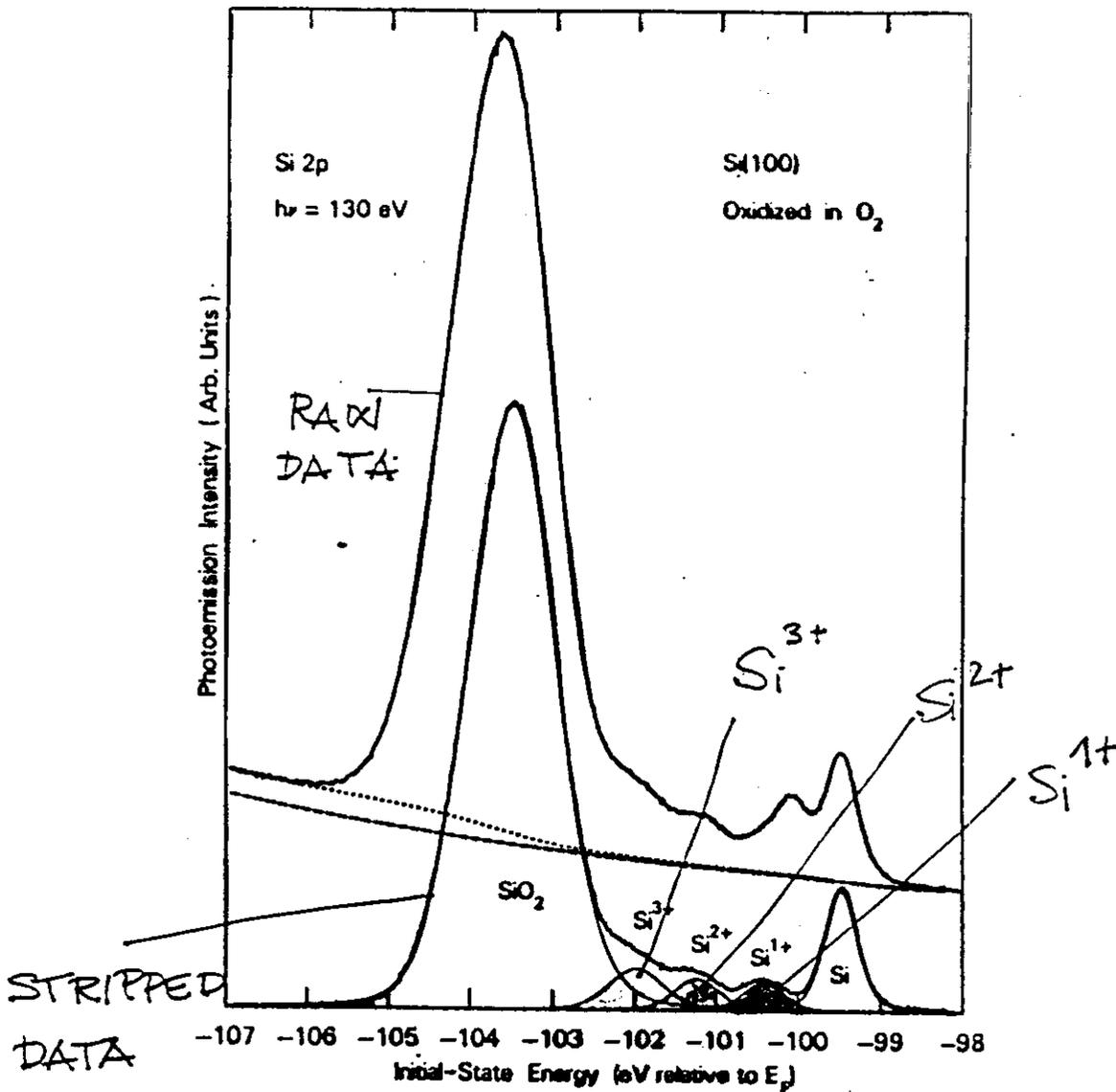
FIG. 1. Intermediate-oxidation states at the SiO_2/Si(100) in-
terface, identified by their Si 2p core-level shifts. The top curve
represents the raw photoemission data for the Si $2p_{1/2,3/2}$ core
levels. The bottom curve has the Si $2p_{1/2}$ line and the secondary
electron background subtracted. All three intermediate-
oxidation states are seen. For a truncated bulk structure only
Si^{2+} would be present since the Si(100) surface has two broken
bonds per atom.

HIMPSEL ½ al   PHYS. REV.   B 38 (1988) 6084

XPS   Si 2p₃/₂ (handwritten)

OXIDATION OF Si (100)

$h\nu$ = 120 eV

Si $2p_{3/2}$

5 Å

Si^{3+} Si^{2+} Si^{1+}

5 Å (handwritten)

INTENSITY (normalized to maximum)

SiO_2

11 Å

Si

Si^{3+}

Si^{2+}

Si^{1+}

11 Å (handwritten)

INITIAL ENERGY (eV relative to bulk)
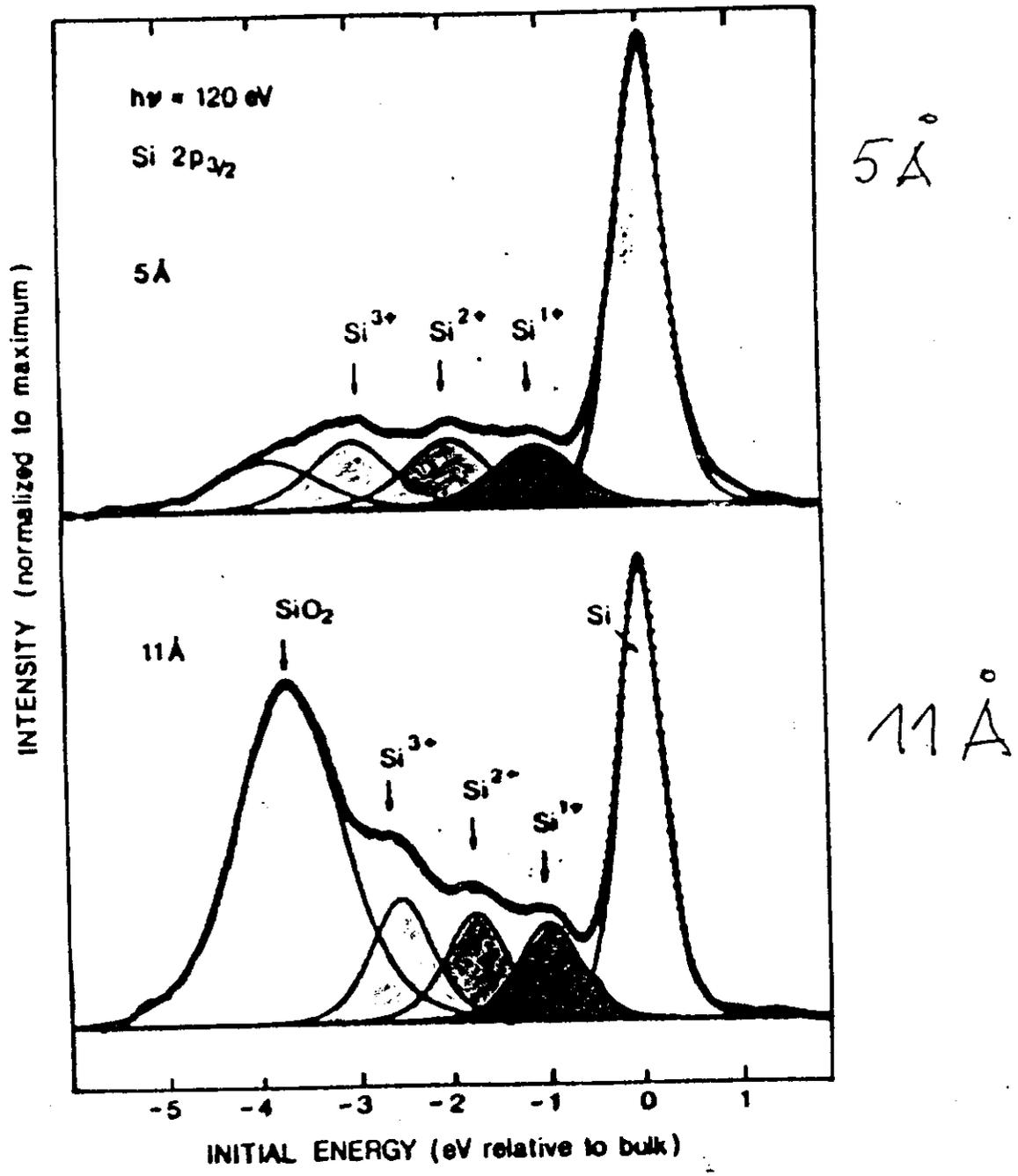
FIG. 3. Si $2p_{3/2}$ core level spectra for 5 and 11-Å-thick oxides decomposed into five components. The black crosses represent the experimental spectra and the solid lines indicate the theoretical functions and the different components.

XPS   Si 2p3/

Si (100)   Versus   Si (111)
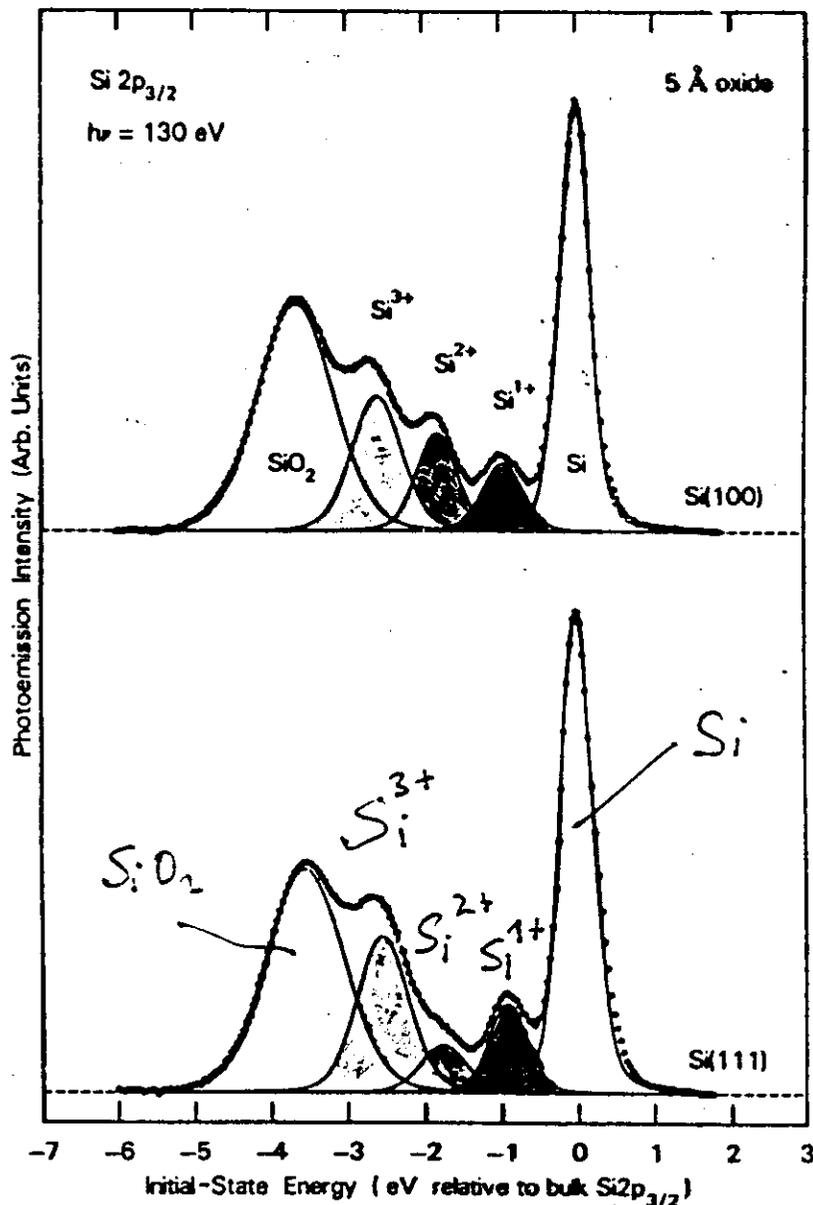
FIG. 4. Core-level spectra from ultrathin SiO_2 overlayers on Si(100) and Si(111) surfaces. The Si(111) substrate has less Si^{2+} and more Si^{1+} than the Si(100) substrate. Si^{3+} is enhanced by a factor of 1.7 at this photon energy due to a cross-section resonance (see Table II). The films were grown in 2×10^{-5} Torr O_2 at 750°C for 20 sec.
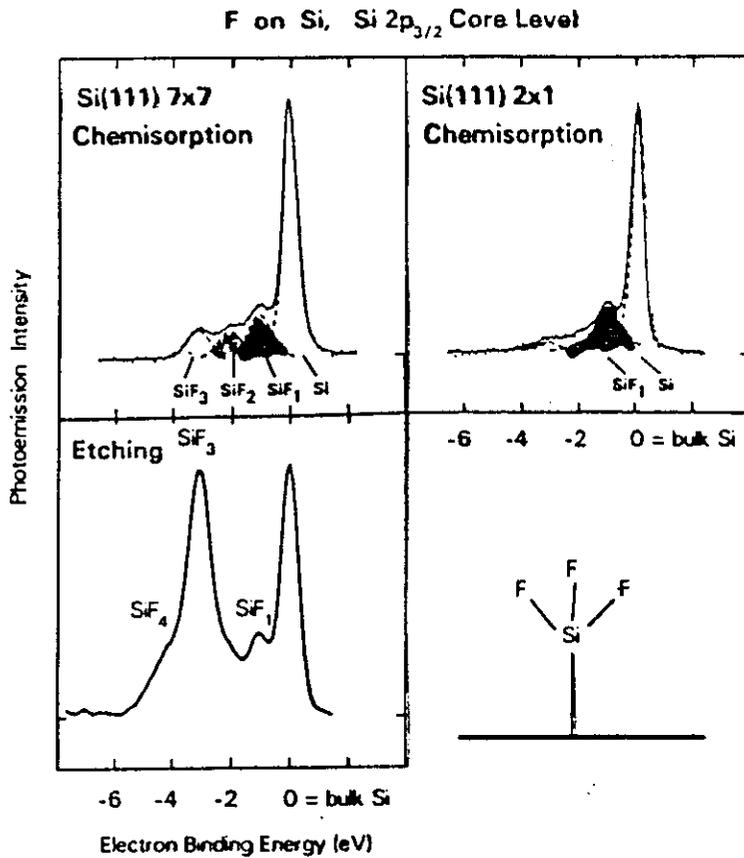
F on Si, Si $2p_{3/2}$ Core Level

Fig. 6. Si$2p_{3/2}$ core level spectra for fluorine-exposed Si surfaces [21]. The Si$2p_{1/2}$ contribution has been subtracted. At low exposure, about a monolayer of fluorine is chemisorbed and exhibits a distribution of oxidation states that varies with the surface structure. At high exposure, where the surface is etched, one finds predominantly SiF$_3$ indicating that the removal of SiF$_3$ from the surface is the bottleneck of the etching reaction
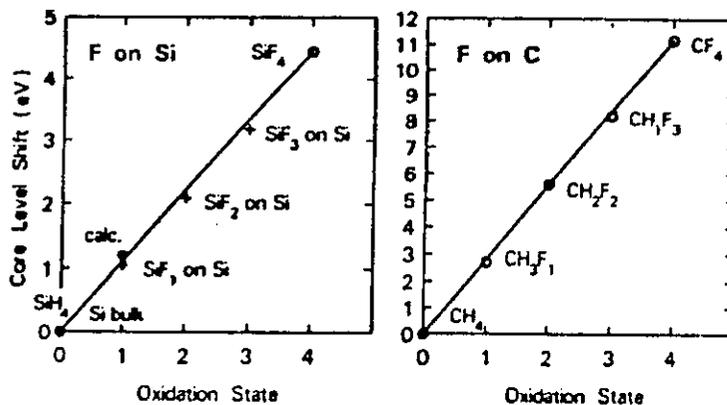
Fig. 5. Linear relation between core level shift [18] and oxidation state for fluorinated silicon and carbon. Fluorine on Si surfaces (crosses, from [21]; see Fig. 6) exhibits similar core level shifts as expected from an interpolation between SiH$_4$ and SiF$_4$. The calculated shift (dot) is for a fluorine-terminated Si(111) 1 x 1 surface [22]

SURFACE DOS
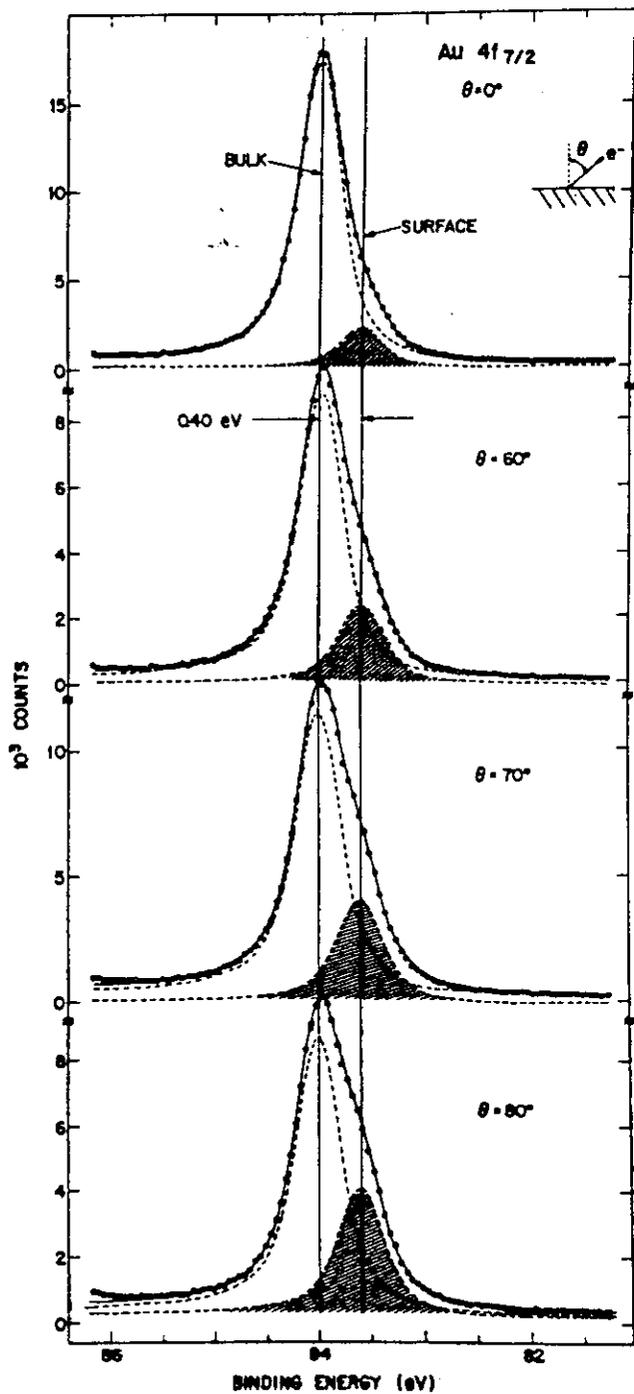
BULK DOS

Least-squares fits to Au $4f_{7/2}$ photoemission data as a function of θ. Each spectrum was fitted *individually* assuming two lines of equal shape with all line-shape parameters and line positions freely adjustable. The surface component is shaded. Note excellent consistency in binding energy of the bulk and surface components for each data set.
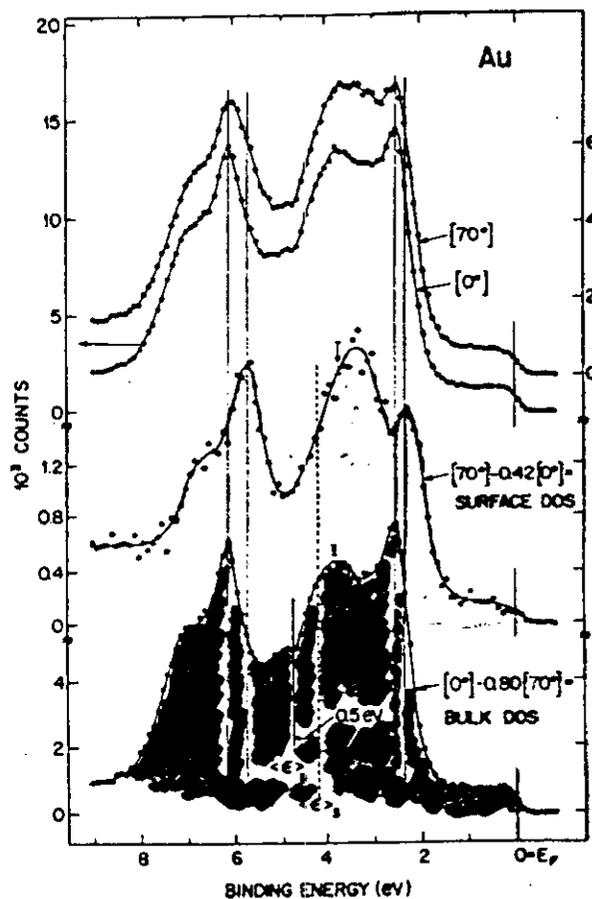
Separation of Au bulk and surface density of states from the difference between $\theta=0°$ and $70°$ spectra. Note different scales for raw data. Weighting factors 0.42 and 0.80 were determined from corresponding *core-level* spectra as in Fig. 2. Centers of gravity $\langle \epsilon \rangle$ for bulk and surface DOS are also shown.

$\vartheta = 0°$

$\vartheta = 60°$

$\vartheta = 70°$

$\vartheta = 80°$

X-RAYS
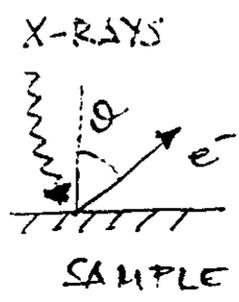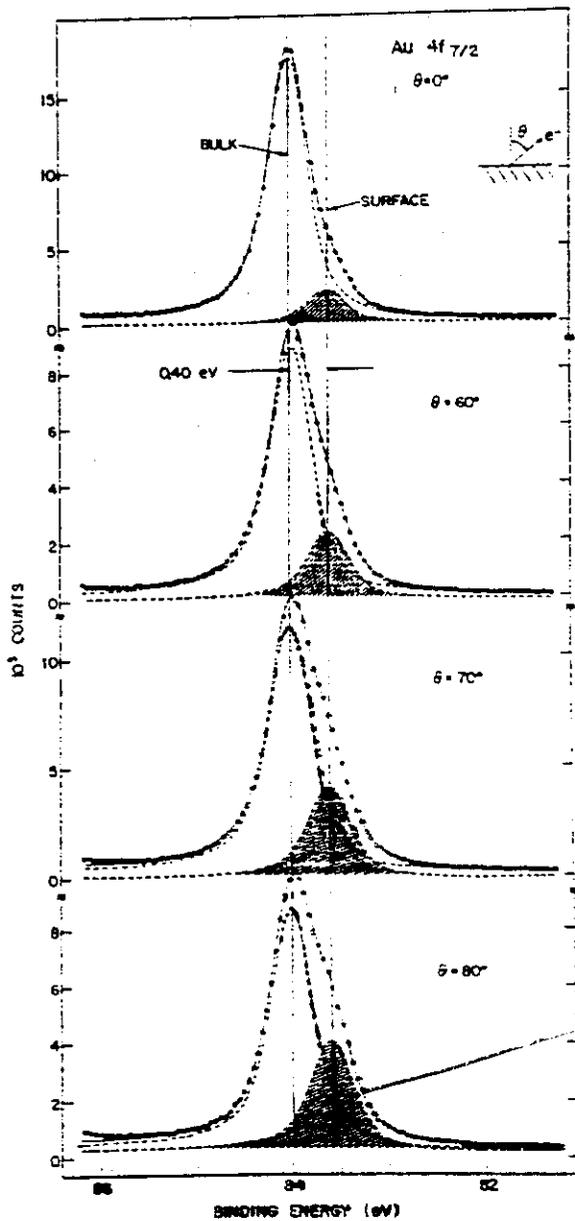
Al K_α RADIATION

SURFACE Au ATOMS

SURFACE

FIG. 3. Least-squares fits to Au $4f_{7/2}$ photoemission data as a function of θ. Each spectrum was fitted *individually* assuming two lines of equal shape with all line-shape parameters and line positions freely adjustable. The surface component is shaded. Note excellent consistency in binding energy of the bulk and surface components for each data set.

POLY CRYSTALLINE GOLD

Au $4f_{7/2}$ CORE LINE PHOTOEMISSION

BULK- VS SURFACE-SPECIFIC CORE LEVEL CONTRIBUTIONS

FROM P.H. CITRIN ½ al., PHYS REV LETT 41 (1978) 1425

CITRIN {et al}.

PRL
41 (1978) 1425

POLY-AU

AU 5d-RELATED

XPS

Al Kα RADIATION

X-RAYS

e⁻

SAMPLE

10³ COUNTS

SURFACE

[70°]-0.42[0°]=
SURFACE DOS

[0°]-0.90[70°]=
BULK DOS

BULK
THEORY

0.5 eV

⟨ε⟩₅
⟨ε⟩₃

BINDING ENERGY (eV)

[70°]
[0°]

FIG. 3. Separation of bulk and surface DOS from the difference of 0° and 70° spectra (note scale assignments). The weighting factors were determined from the corresponding 0° and 70° core-level spectra as in Fig. 2. The bulk theory is from Ref. 16.

Au 4f₇/₂   Ag 3d₅/₂   Cu 2p₃/₂

BINDING ENERGY (eV)

FIG. 1. Normalized x-ray photoemission spectra from Au, Ag, and Cu as a function of increasing surface sensitivity (increasing θ). —66—

GaP (110)

Side view of a slab of five GaP(110) layers.
The surface layer is relaxed according to the rotation-
relaxation model with a surface bond-rotation angle θ
$= 27.5°$. Chains of atoms along a (1̄10) plane passing
either through P (chain A) or through Ga (chain B) sur-
face atoms are shown.

a

SURFACE ATOMIC
GEOMETRY

(110) SURFACE OF

III-V SEMICONDUCTOR

b
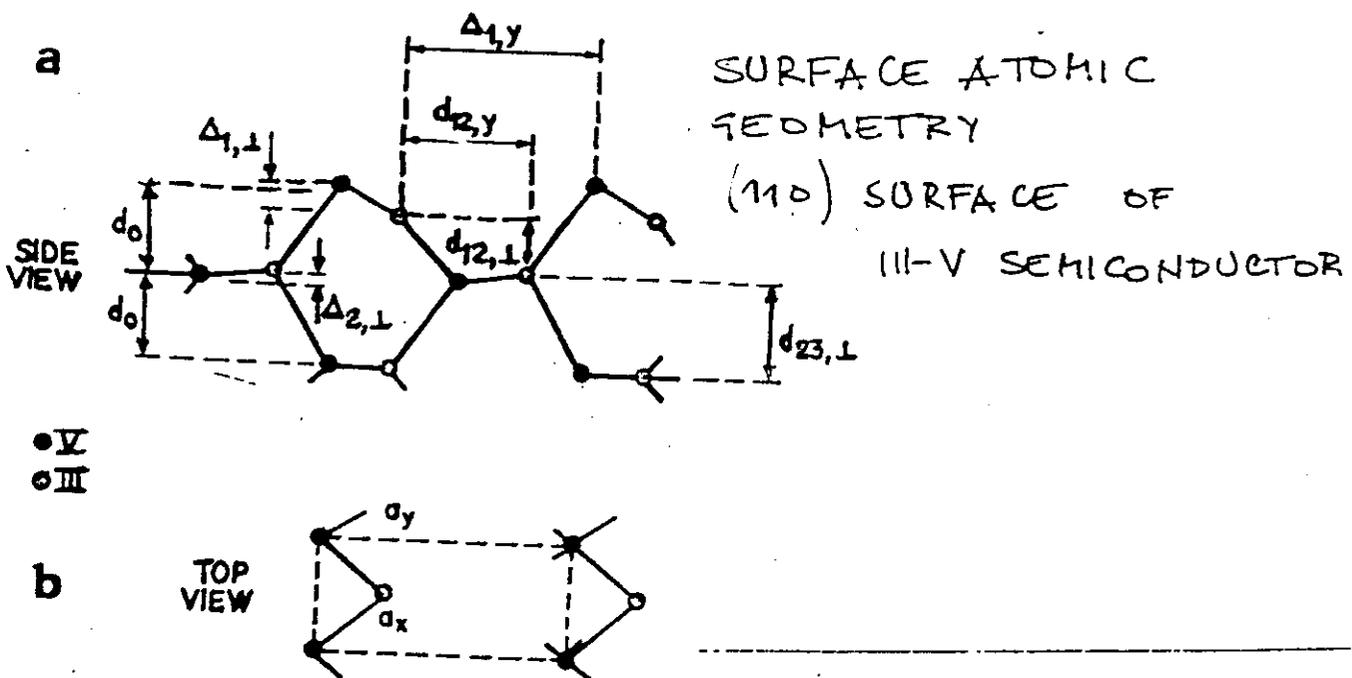
Panel (a): Schematic indication of the surface atomic geometry for the (110) surface of
III-V semiconductor compounds. The layer spacing is $d_0 = a_0/2\sqrt{2}$, where a_0 is the bulk lattice
constant. Panel (b): Surface unit cell. Space lattice parameters are $a_y = a_0$ and $a_x = a_0/\sqrt{2}$, where
a_0 is the bulk lattice constant.

SURFACE ≠ BULK

CORE LINE COMPONENTS

As 3d
$h\nu = 80eV$

As 3d
$h\nu = 50eV$

Sb
$h\nu = 70eV$

Ga 3d
$h\nu = 60eV$

Ga 3d
$h\nu = 28 eV$

Ga 3d
$h\nu = 60eV$

BINDING ENERGY (eV)

41.5 41 40.5 40   19.5 19 18.5 18

GaAs

(a)As(3d)
hν=80eV
∞∞EXPT
T
B
S

(b)Ga(3d)
hν=60eV
T
B
S

INTENSITY (ARB. UNITS)

GaAs

(c)As(3d)
hν=50eV
T
S

(d)Ga(3d)
hν=28eV
T
S

(e)Sb(4d)
hν=70eV
B
T
S

GaSb

(f)Ga(3d)
hν=60eV
T
B
S

0 33 32.5 32 31.5 31   20 19.5 19.0 18.5 18

BINDING ENERGY (eV)
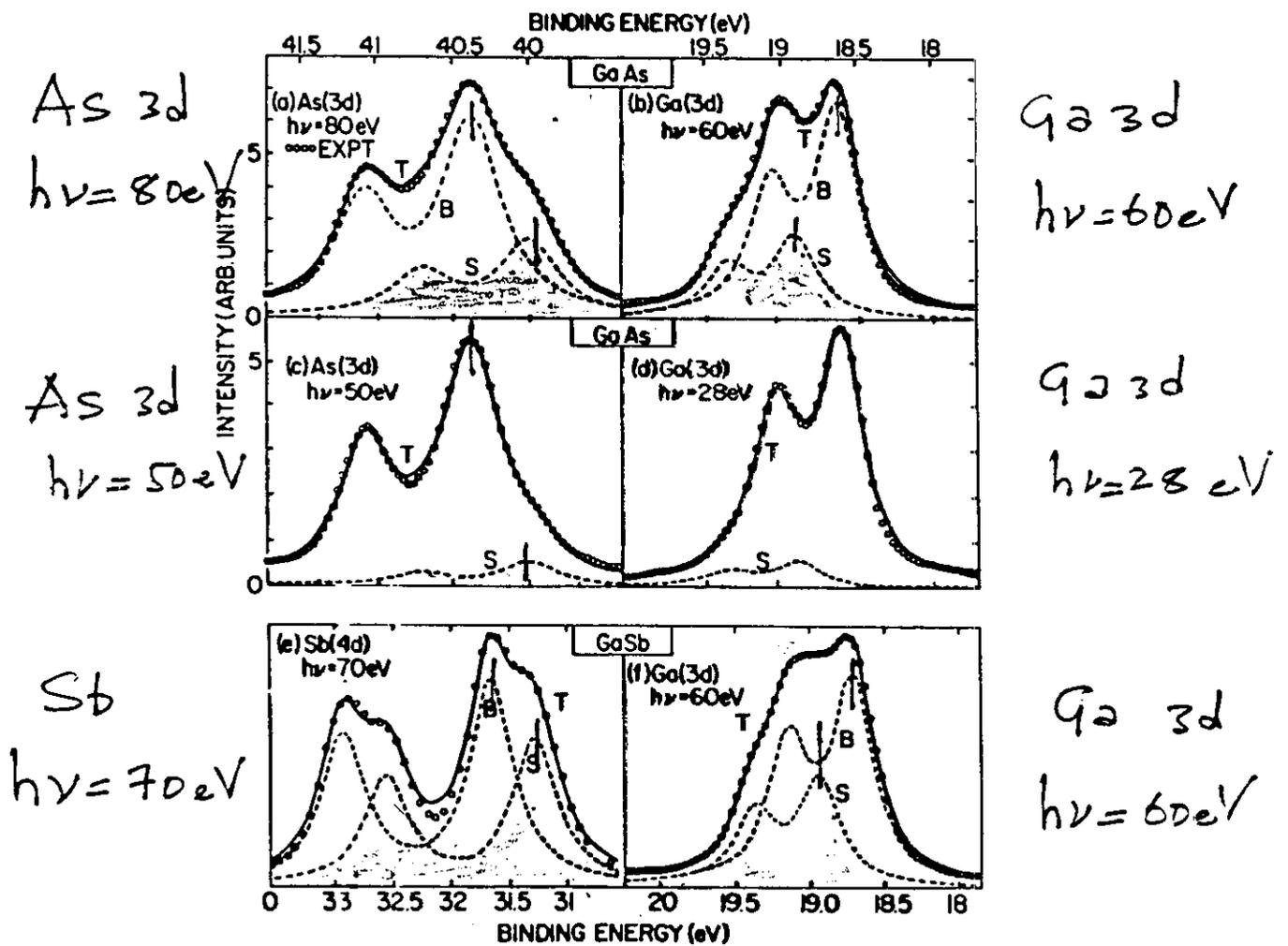
FIG. 1. Photoemission spectra for 3d and 4d core levels in GaAs(110) and GaSb(110). Spectra for low photon energies (~10 eV above threshold) show mainly bulk emission (B) while spectra for higher photon energies (~40 eV above threshold, small escape depth) show additional surface core-level emission (S). BG denotes the inelastic secondary-electron background.
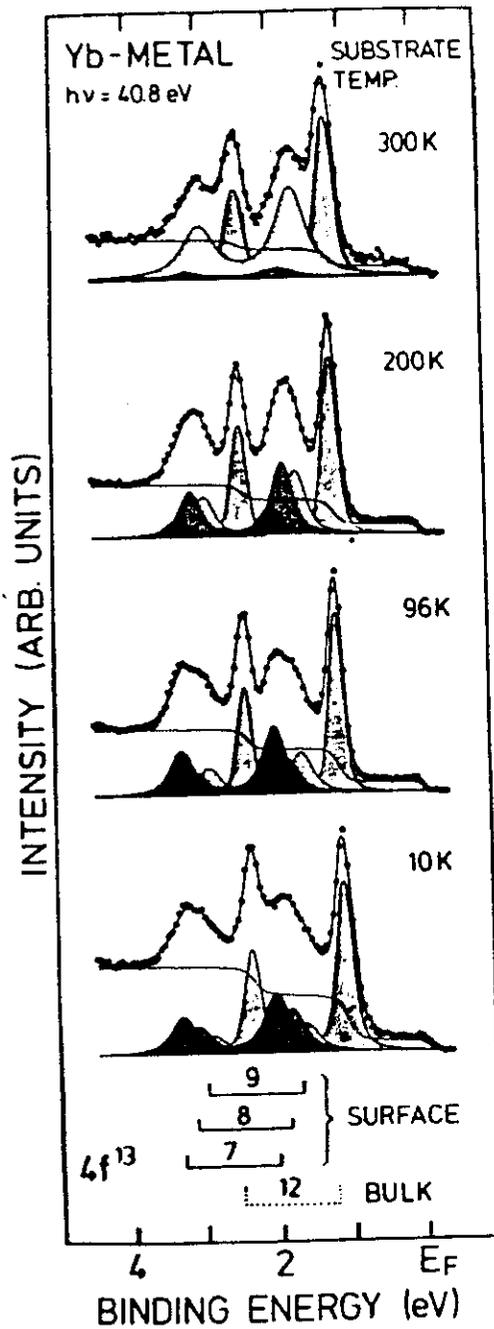
FIG. 1. Valence-band photoemission spectra of evaporated Yb metal at different substrate temperatures. The heavy solid line represents the result of a least-squares-fit analysis of the data points of four $4f^{13}$ final-state multiplets originating from the bulk [light solid curve (dotted bar diagram)] and the surface [shaded curve areas (solid bar diagram)]. The dotted line represents the integral background. The correlation between the surface peaks and the corresponding surface atom coordination numbers is indicated. Note the strong intensity variation of the surface peaks with substrate temperature.

COORDINATION DEPENDENCY
OF Yb-4f STATES
IN Yb-METAL

INTERFACE GROWTH STUDIED VIA CORE LEVEL XPS

AS A FUNCTION OF THE ELECTRON ESCAPE DEPTH
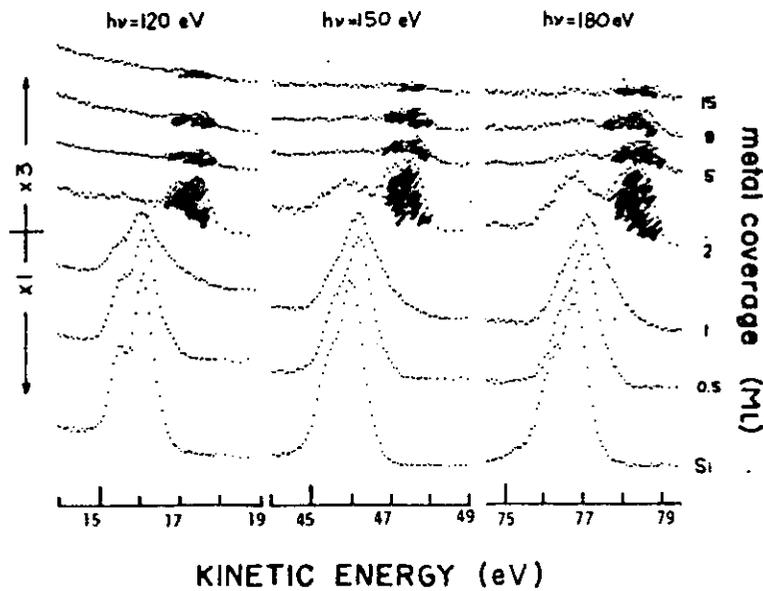
Fig. 58. Si 2p photoemission as a function of the photoelectron escape depth parameter, and of the coverage at the Eu-Si(111) interface. Tails of chemically shifted signal are seen, at lower binding energy of the bulk Si peak, already at 0.5 ML, but a fully shifted reacted component is manifest above 1 ML [161].

EUROPIUM /Si(111)

Si 2p XPS
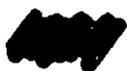
⬛⬛⬛ REACTED COMPONENT
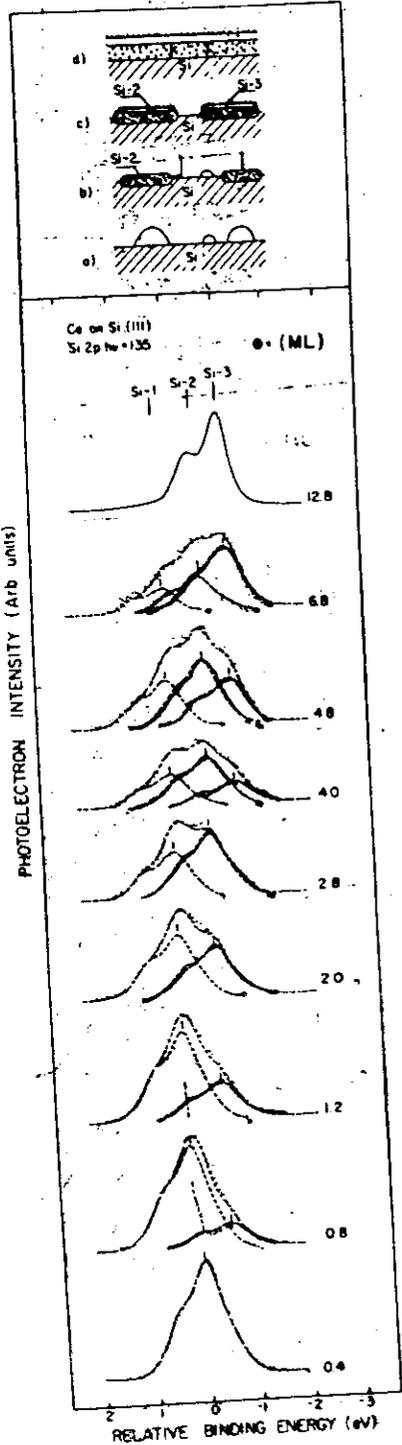
CLEAN Si

_____ REACTED PHASE

_____ Si SEGREGATED

CERIUM /Si (III)
Si 2p XPS

Ce on Si (III)
Si 2p hν=135   θ. (ML)

Si-1   Si-2   Si-3

PHOTOELECTRON INTENSITY (Arb units)

12.8
6.8
4.8
4.0
2.8
2.0
1.2
0.8
0.4

2   1   0   -1   -2   -3
RELATIVE BINDING ENERGY (eV)

Ce COVERAGE (ML)
2   4   6   8   10   12

Ce/Si (III)
Si 2p

Si 2p REDUCED INTENSITY
-1
-2
-3
-4
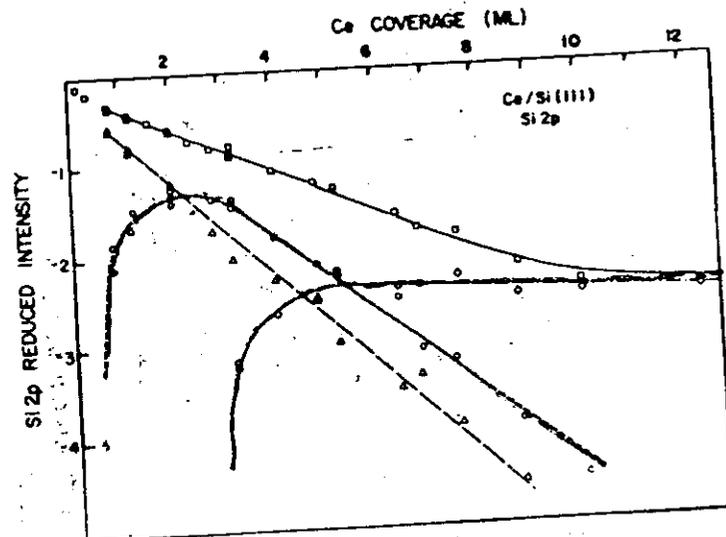
Fig. 70. Attenuation of the total Si2p emission (solid line at top) and attenuation of each of the three Si2p components deconvoluted in fig. 69. Although the substrate attenuation is monotonic, the reacted component grows to a maximum near 2.5 ML and is then attenuated. The surface segregated component appears only after the reacted component is covered up by Ce and is nearly constant in magnitude to high coverage [170].

Fig. 69. Si2p core photoemission spectra for Sm-Si(111) interfaces. The spectra are fitted with components representing clean Si (Si-1), a reacted phase (Si-2), and surface segregated Si (Si-3). The model for the interface proposed by Gnoni et al. is represented in the top panel of the figure [170].

PLASMA-TREATED
STAINLESS STEELS
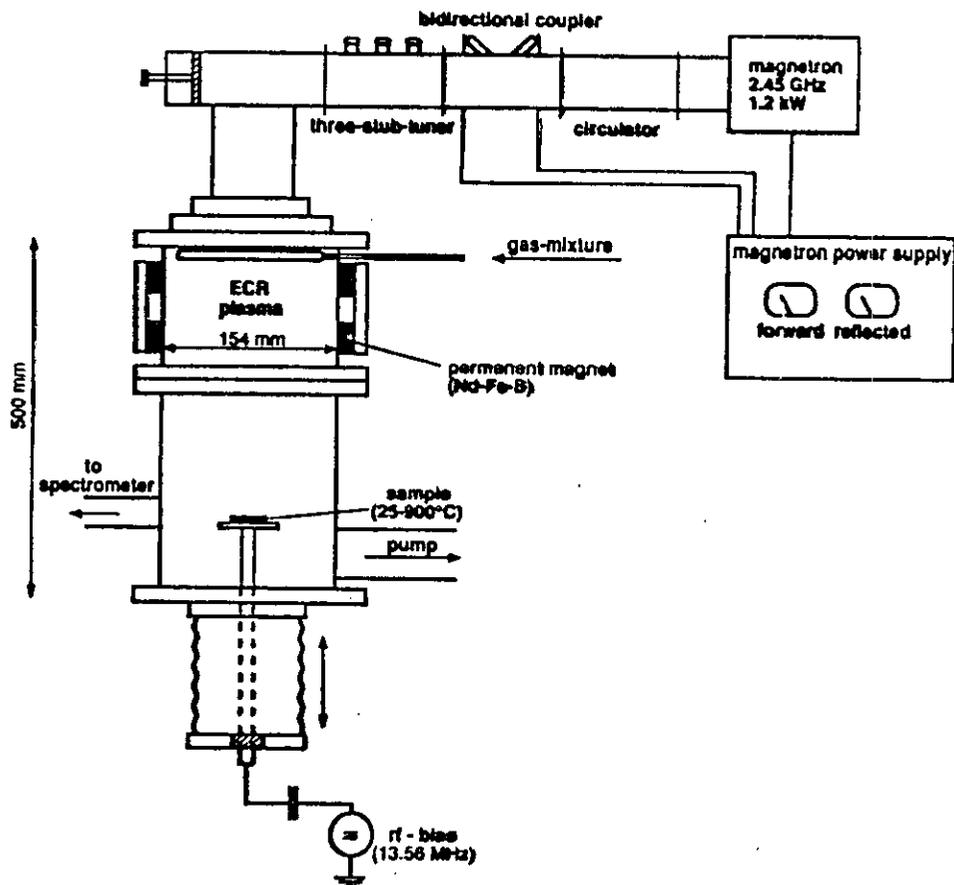
Fig. 1. Experimental set-up of the ECR plasma chamber.
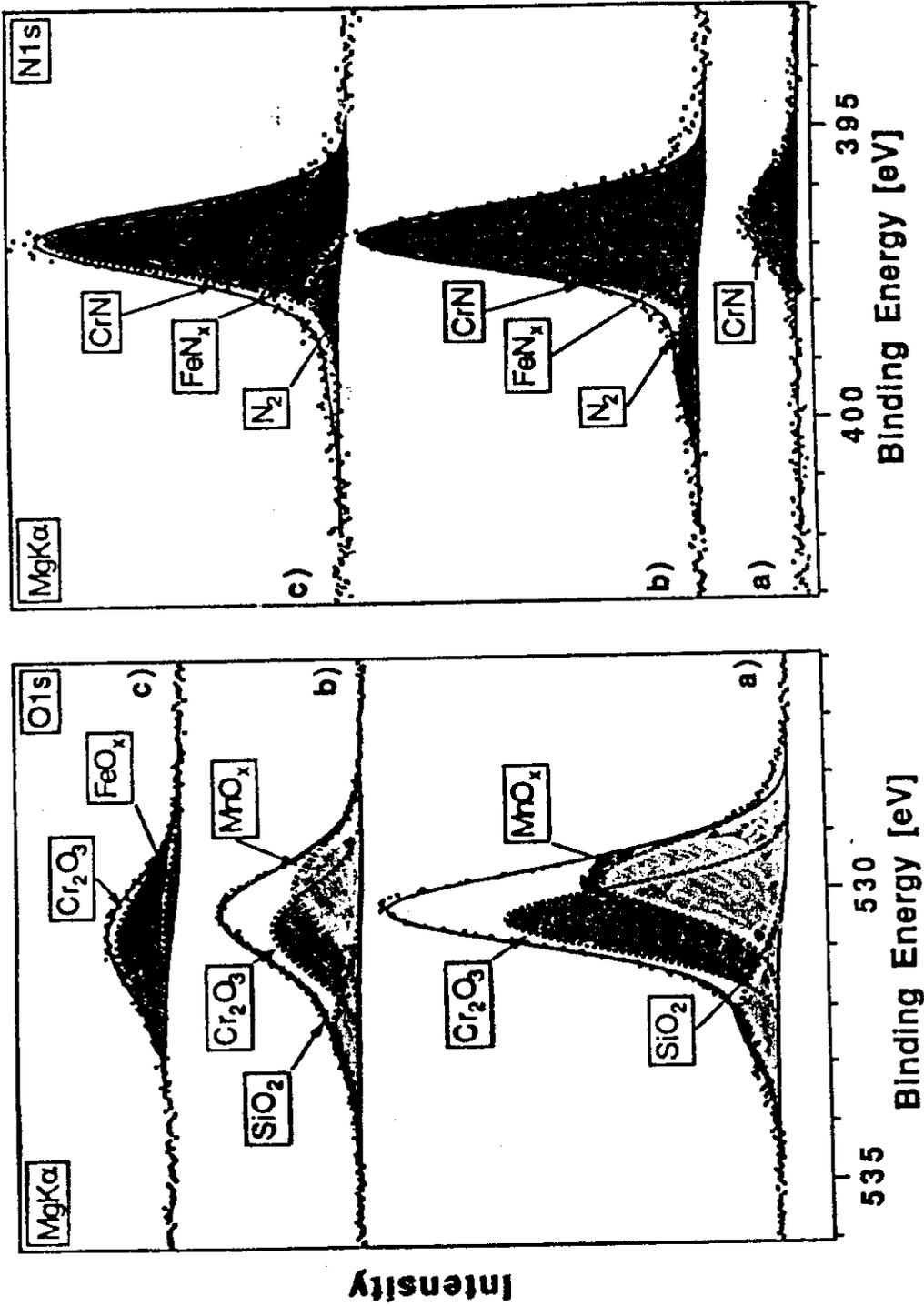
Fig. 8. Curve fitting for the N1s and O1s photoemission spectra of AISI 440C after treatment at $T = 600°C$ in: (a) N_2 gas; (b) N_2 plasma without bias ($U_s = 0$ V); (c) N_2 plasma with bias ($U_s = -100$ V).
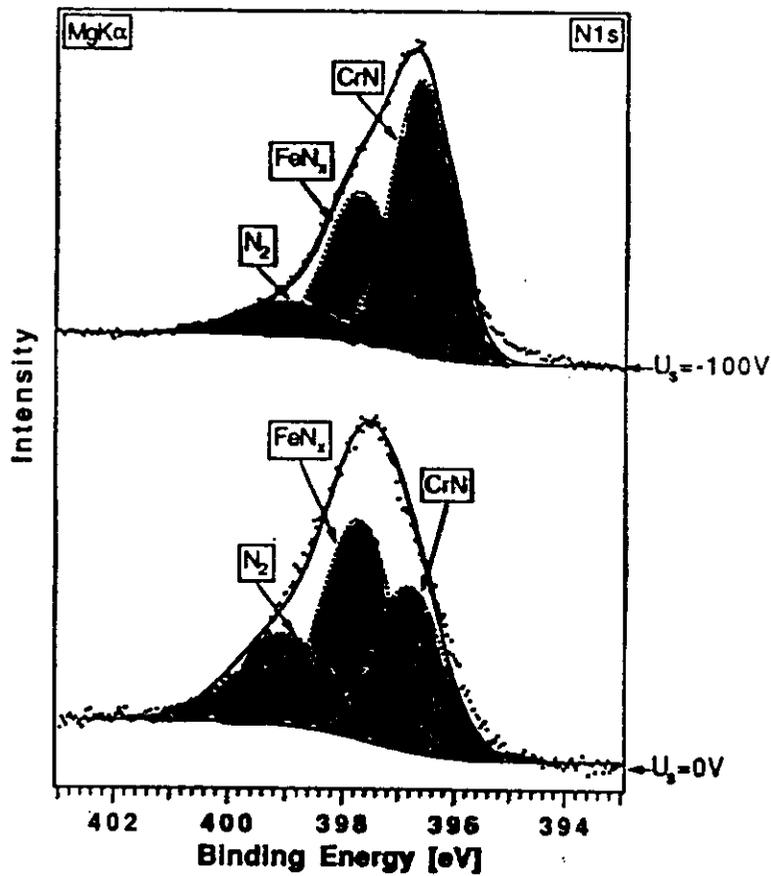
Fig. 5. Curve fitting for the N1s photoemission spectra of AISI 440C after N_2 plasma treatment at room temperature, with and without bias U_s.

P. GRÖNING, S. NOVAK, + L. SCHLAPBACH

APPL. SURF. SCIENCE 54 (1993) 265

NON EVAPORABLE GETTERING ALLOYS

METALLIC Zr

Zr 3d   Zr₂Fe   ZrVFe

800 C
750 C
700 C
500 C
400 C
300 C
200 C
100 C
RT

850 C
750 C
700 C
550 C
400 C
300 C
200 C
100 C
RT

.190 188 186 184 182 180 178 176   188 186 184 182 180 178 176

Zr 3d$_{5/2}$ Binding Energy (eV)

Zr 3d$_{3/2}$

OXIDIZED Zr
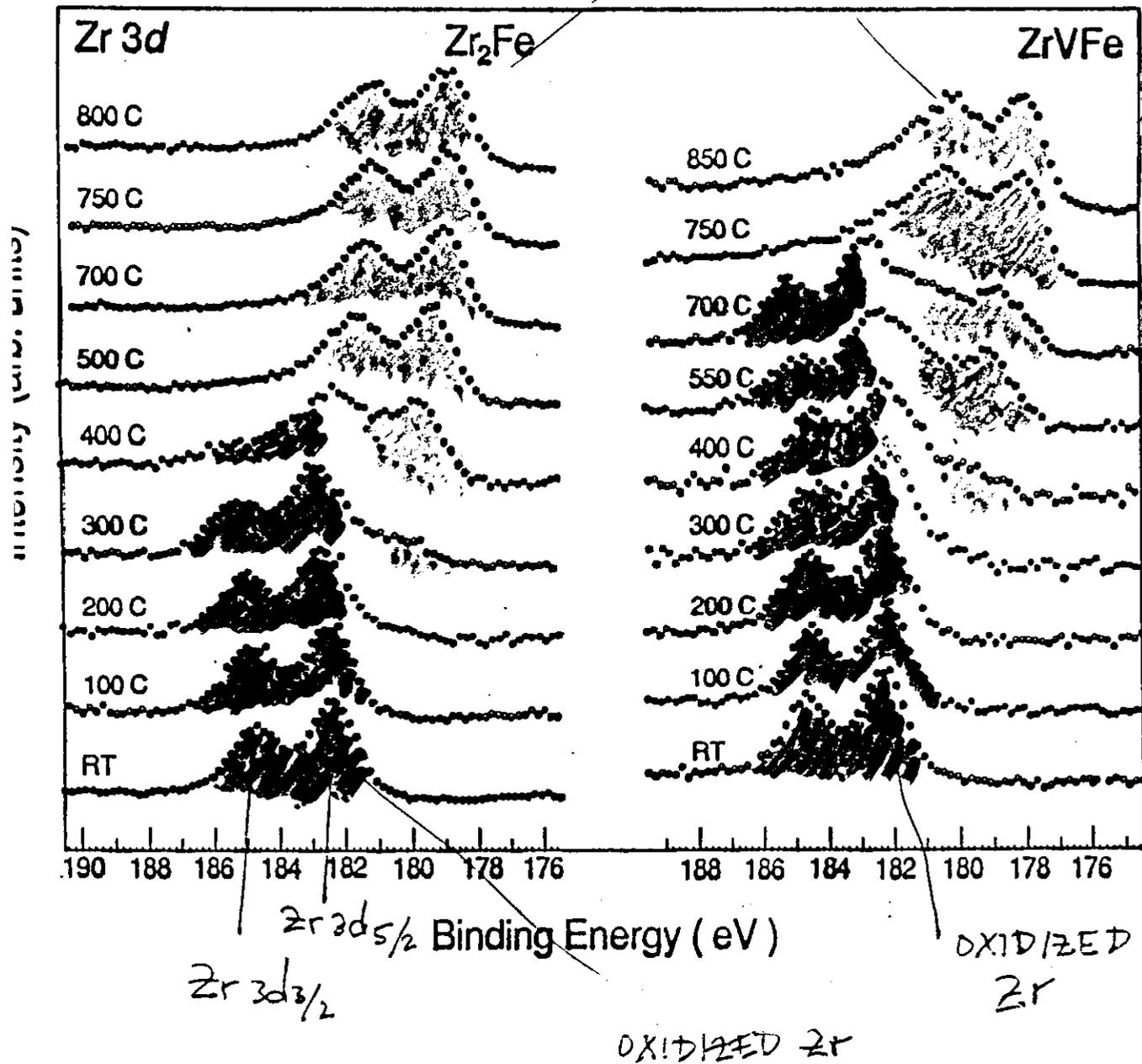
OXIDIZED Zr

J. KOVAČ, O. SAKHO, P. MANINI, M. SANCROTTI
SURF. & INT. ANALYSIS (1994)

Fe 2p   Zr₂Fe   ZrVFe

Binding Energy (eV)
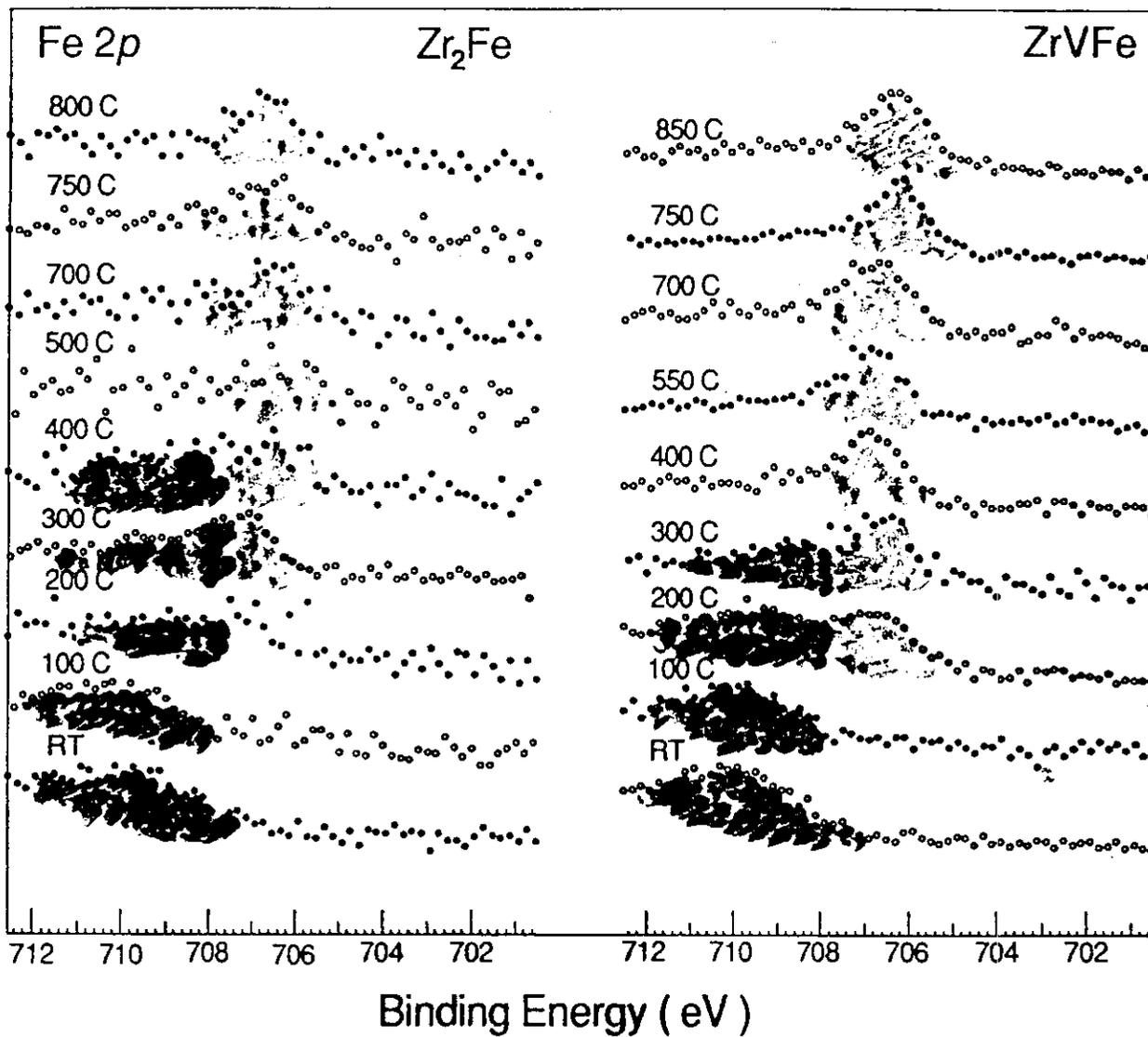
OXIDIZED IRON

METALLIC IRON

V 2p   ZrVFe

850 C

750 C

700 C

550 C

400 C

300 C

200 C

100 C

RT

Intensity (arb. units)

518 517 516 515 514 513 512 511
Binding Energy (eV)
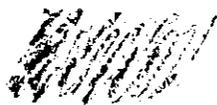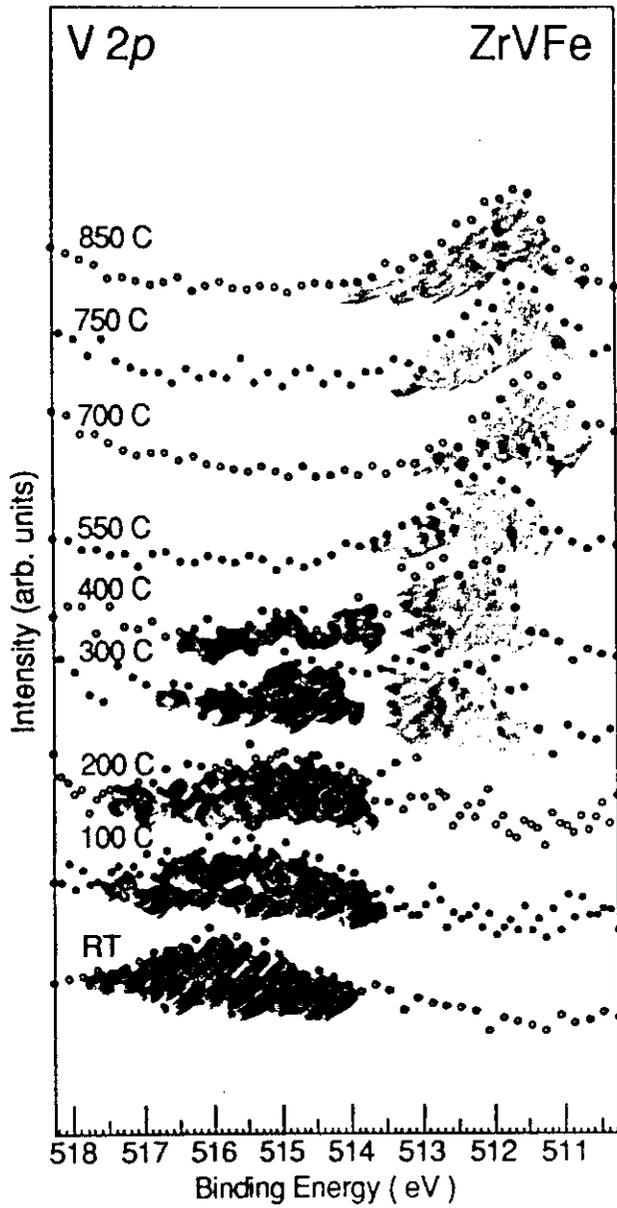
OXIDIZED   VANADIUM

METALLIC VANADIUM

C 1s   Zr₂Fe   ZrVFe
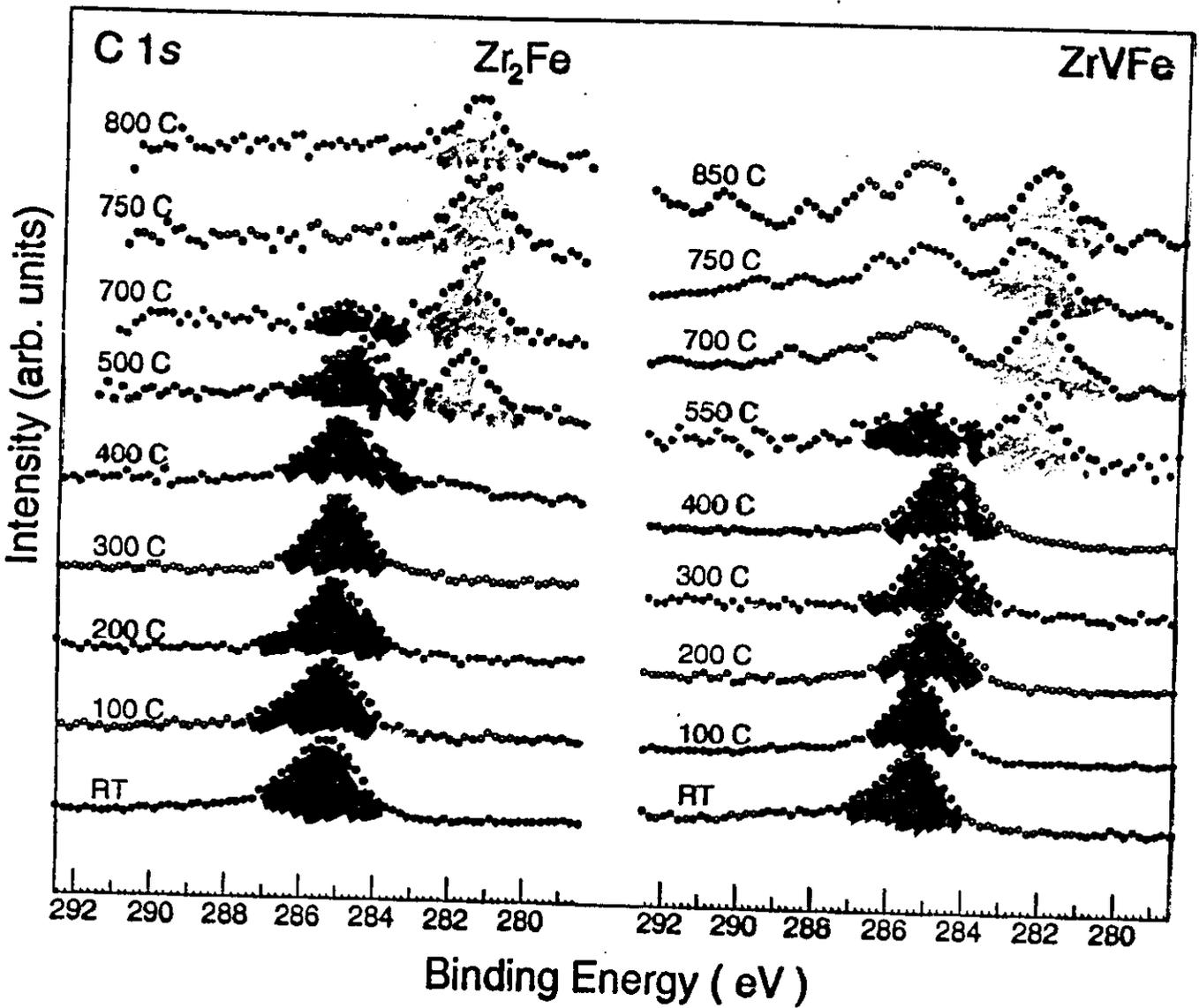
METAL CARBIDES

GRAPHITIC CARBON

C - BASED CONTAMINANTS

O 1s   Zr$_2$Fe   ZrVFe
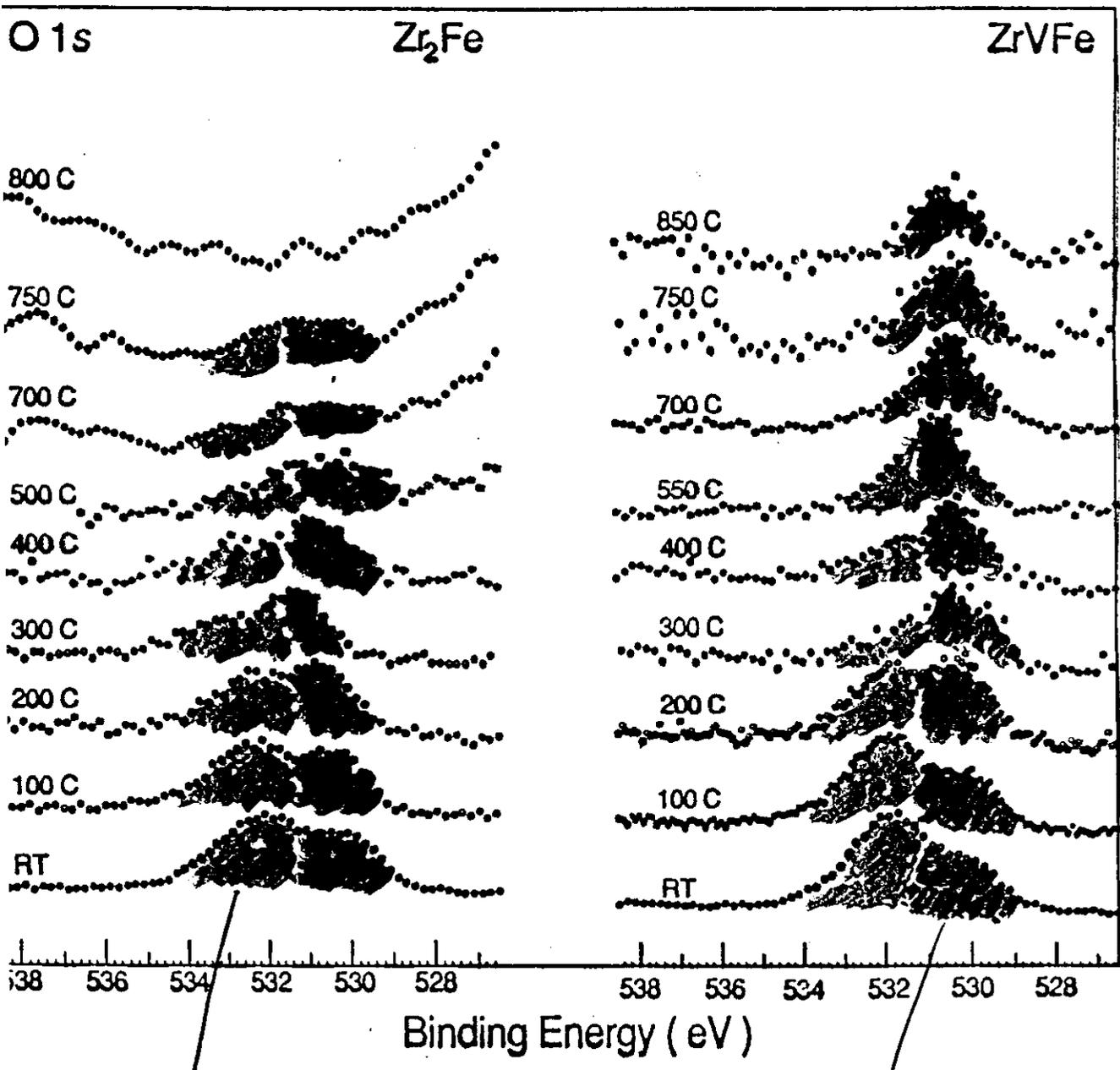
Binding Energy (eV)

Legend:
- ■ ZIRCONIUM
- ● CARBON
- ◇ OXYGEN
- × × × IRON
- ■ VANADIUM

Top graph: ZrVFe — Atomic % vs Temperature (°C)

Bottom graph: Zr2Fe — Atomic % vs Temperature (°C)

Legend:
- ZIRCONIUM
- CARBON
- OXYGEN
- ××× IRON
- VANADIUM

Zr57V36Fe7

Atomic % vs Temperature (°C)

Zr2Fe

Atomic % vs Temperature (°C)
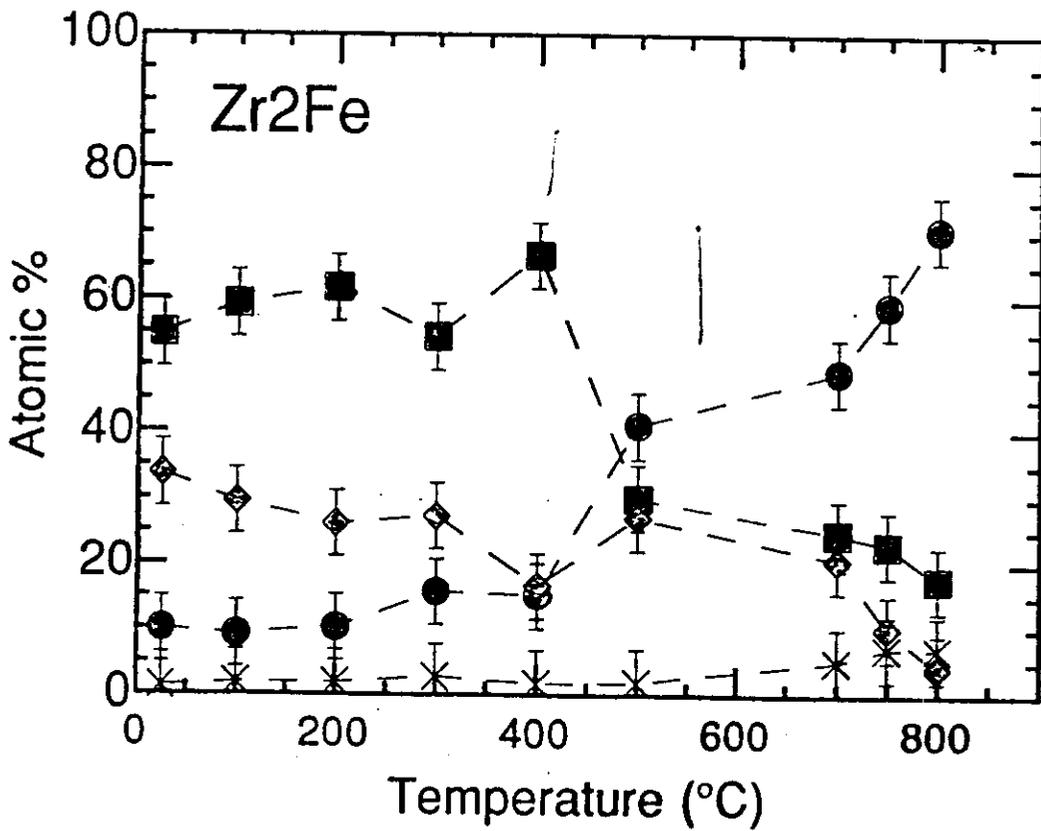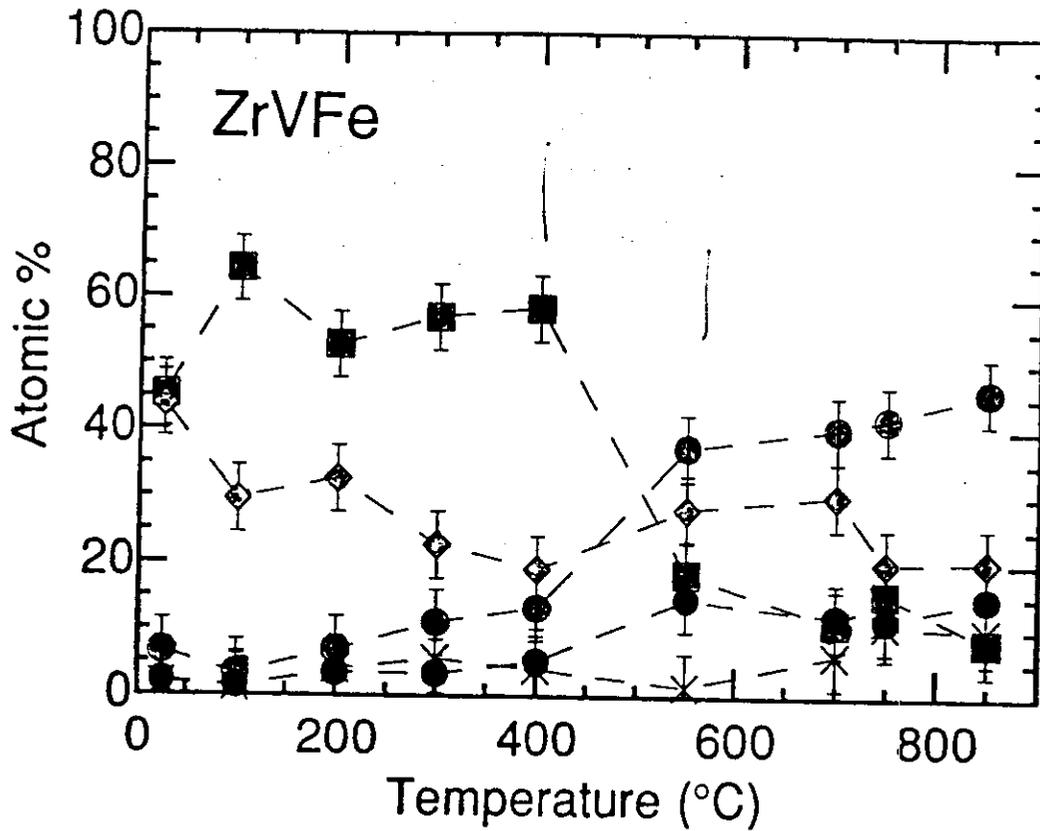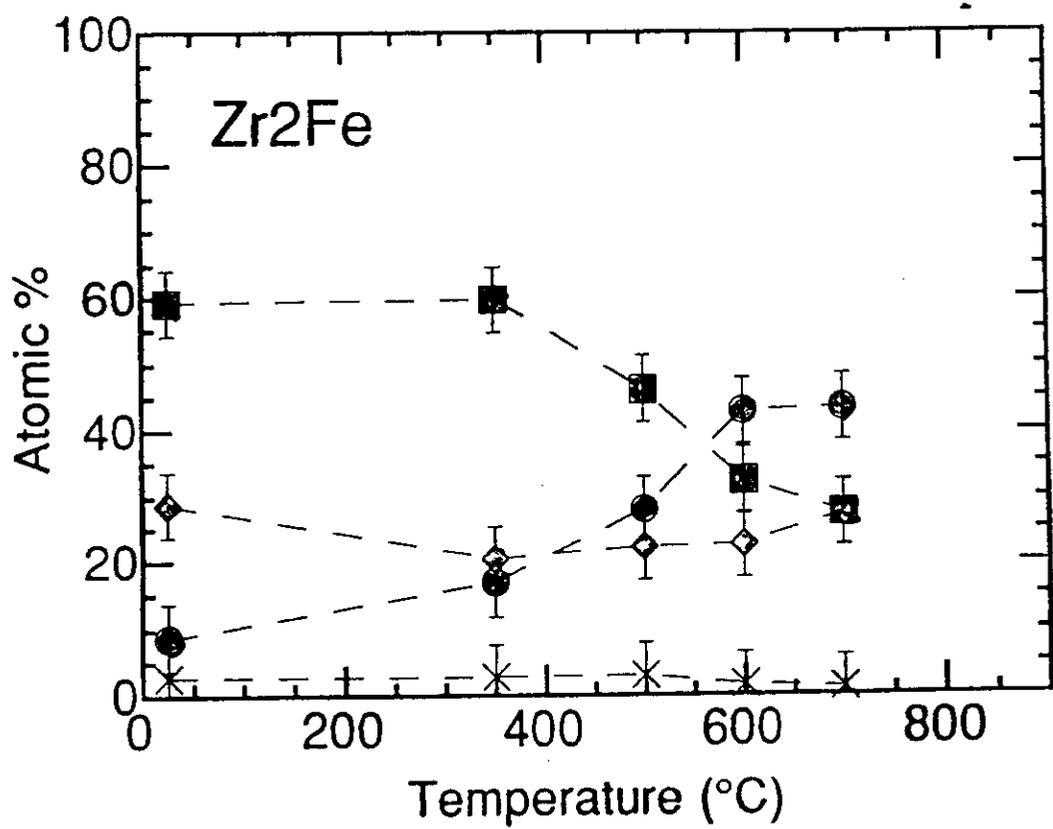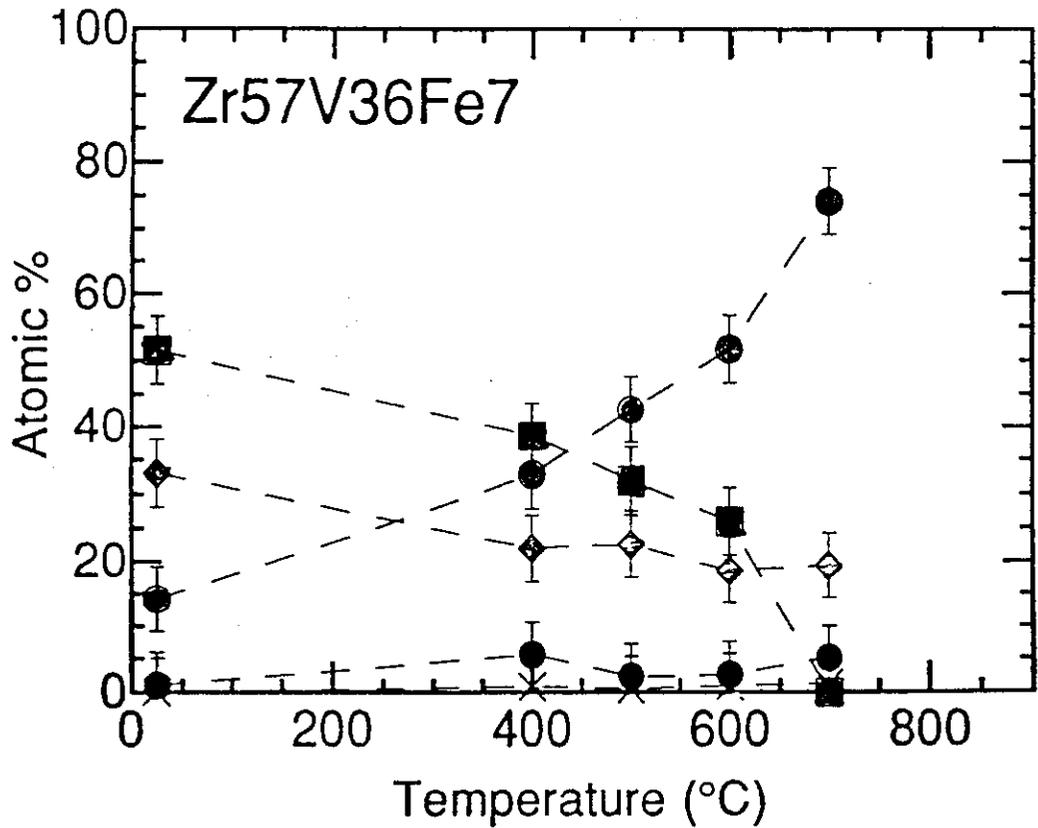
ELECTRON SPECTROSCOPIES

$\downarrow$
&
$\uparrow$

ION SPUTTERING

DEPTH PROFILING
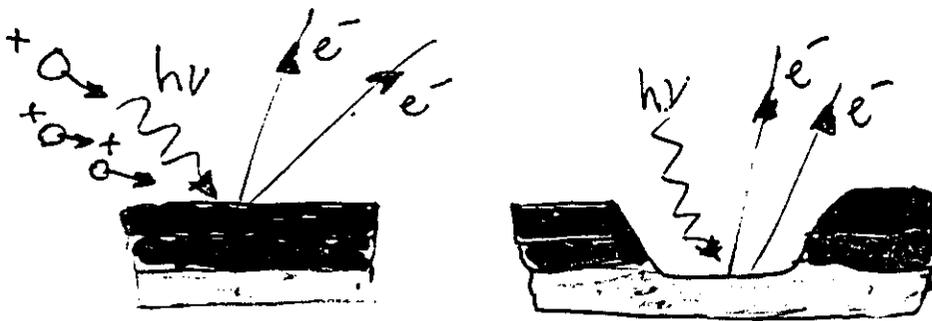
SPECTROSCOPIC SIGNAL

versus

SPUTTERING TIME

POWDER
GRAIN

SINGLE
CRYSTAL
GRAIN
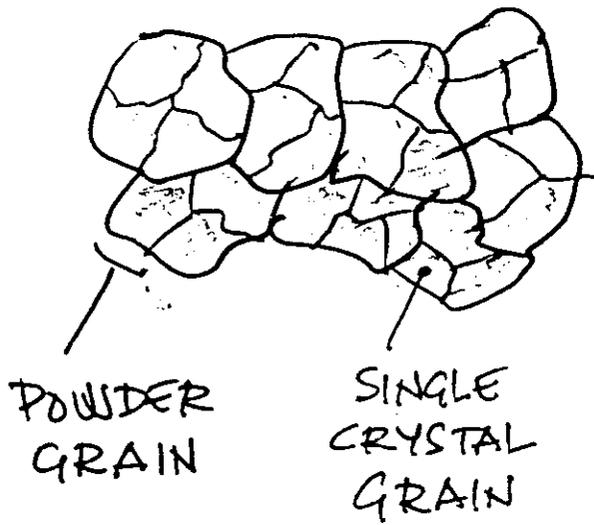
SCRAPING

INTERGRANULAR
PHYSICS, PRIMARILY

SPUTTERED
IONS   Ar⁺ IONS
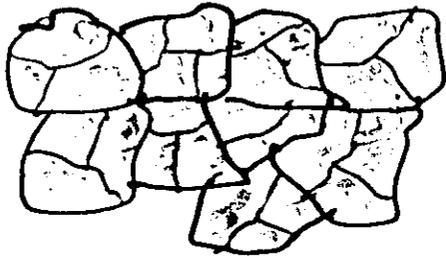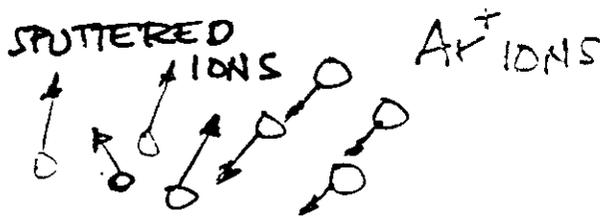
SPUTTERING

LAYER-BY-LAYER
EROSION

INTRAGRANULAR
PHYSICS

WATER-PROCESSED
$Zr[V_{0.5}Fe_{0.5}]_2$ ALLOY AFTER SPUTTERING

XPS   Zr 3d

Zr^{4+}

(OH)

Zr^{3+}

Zr^{2+}

SECONDARY
e^-
BACKGROUND
LINE

-190   -188   -186   -184   -182   -180   -178   -176

Binding Energy (eV)
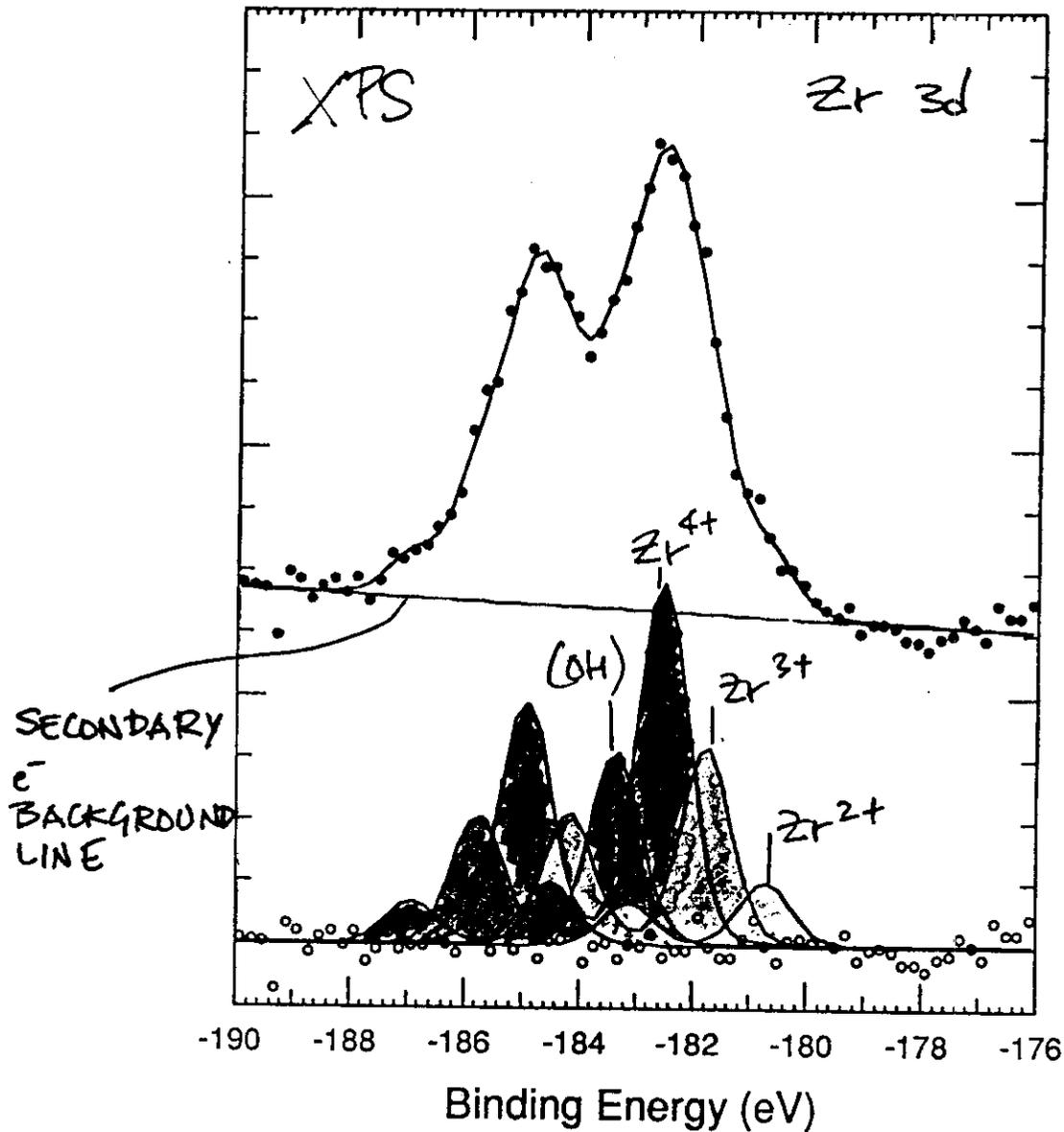
Zr 3d CORE LINE FIT
RESOLVING THE CHEMICALLY
DISTINCT Zr COMPONENTS

ZrVFe + H$_2$O

Legend:
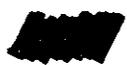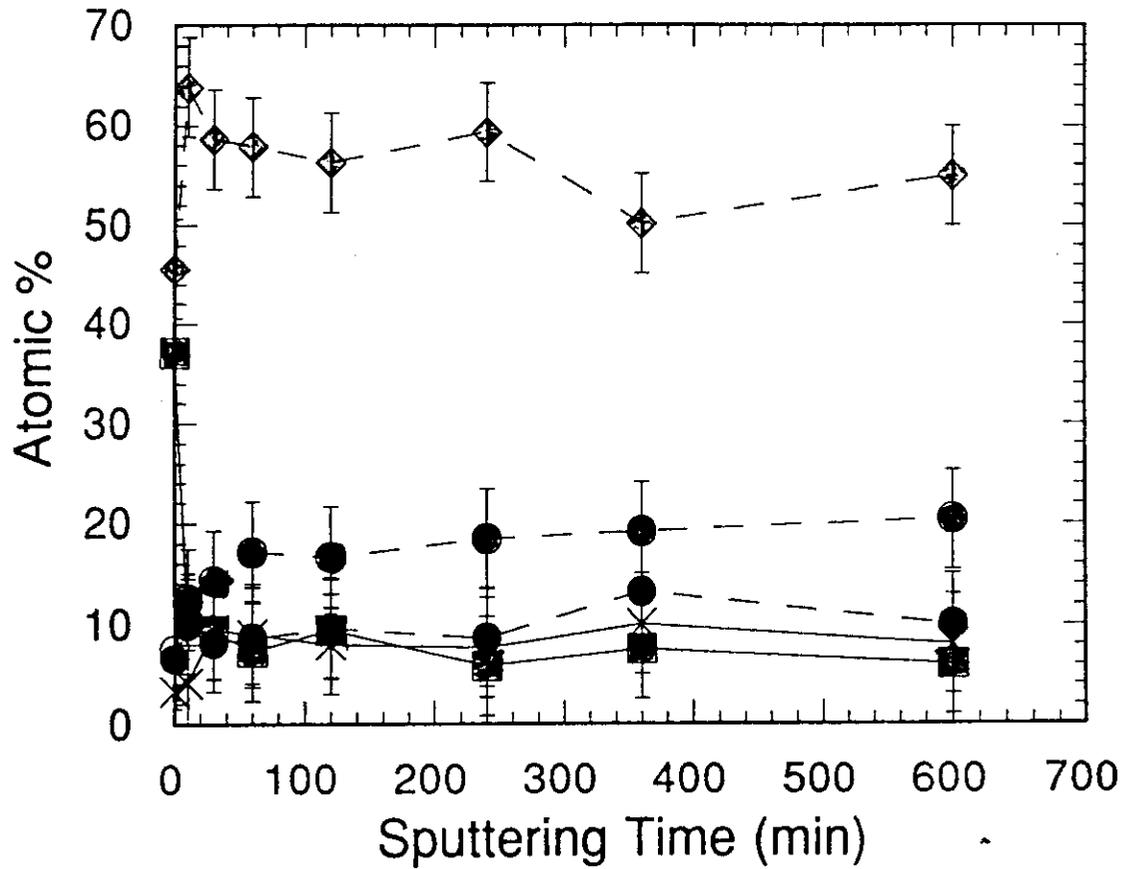
- ZIRCONIUM
- XXXX IRON
- CARBON
- VANADIUM
- OXYGEN
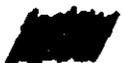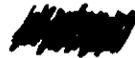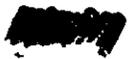
TOTAL DEPTH PROBED $\cong$ 0.6 μm

- INITIAL TRANSIENT

- ALMOST UNIFORM COMPOSITION VS DEPTH

- LARGE AMOUNT OF OXYGEN

WATER-TREATED ZrVFe

XPS   Fe 2p 3/2

Fe vs sputtering-time

WT, 600 mins

WT, 360 mins

WT, 240 mins

WT, 120 mins

METALLIC CHARACTER

WT, 60 mins

WT, 30 mins

WT, 10 mins

WT, 0 mins

Virgin

OXIDIZED CHARACTER

350

300

250

200

532   536   540   544

KINETIC ENERGY (eV)

XPS   Zr 3d

a) Virgin

Scraped

Sputtered
                                                          METALLIC
                                                          CHARACTER

b) Water-treated

Zr-(OH)
BONDS   OXIDIZED
                                         CHARACTER

Scraped

Sputtered

Intensity (arb. units)

190   188   186   184   182   180   178   176

Binding Energy (eV)

——— AS RECEIVED

XPS   Fe 2p3/2

a) Virgin

Scraped

Sputtered

b) Water-treated

Scraped

OXIDIZED
CHARACTER

METALLIC
CHARACTER

Sputtered

Binding Energy (eV)

718   716   714   712   710   708   706   704

Intensity (arb. units)

——— AS-RECEIVED

CHEMICALLY DISTINCT Zr COMPONENTS AS A FUNCTION OF THE SPUTTERED LAYERS
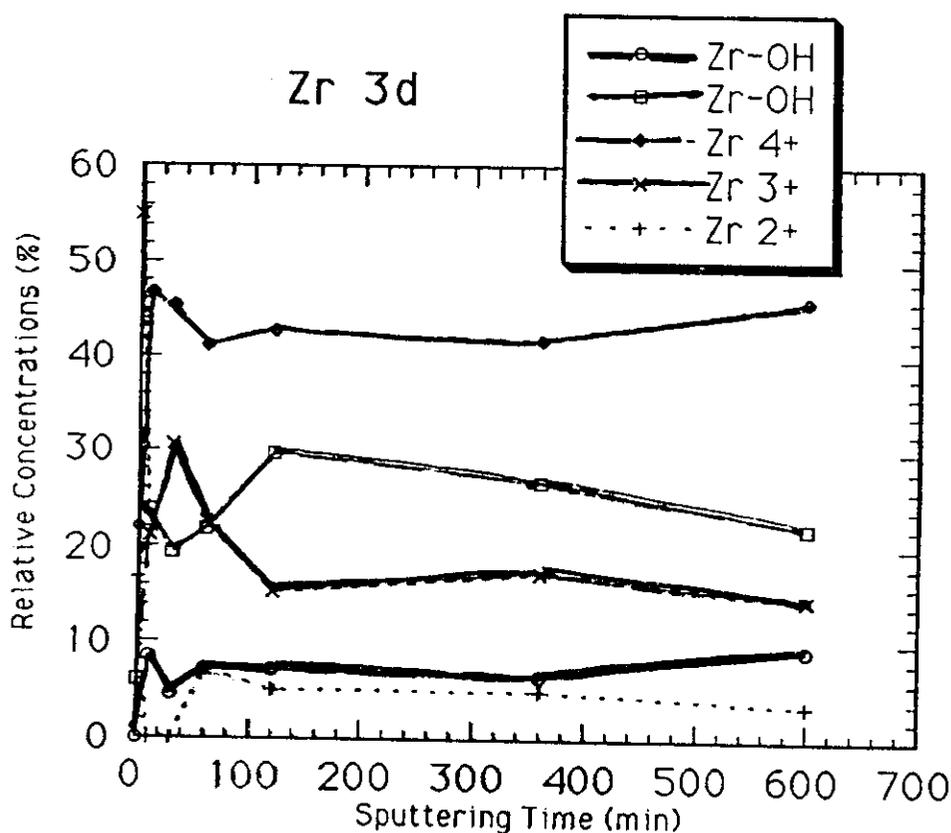
- MAJOR CONTRIBUTION OF Zr^{4+} (ZrO_2)
- SIZEABLE AMOUNTS OF Zr BONDED WITH HYDROXYL GROUPS
- NO TRACES OF METALLIC-LIKE Zr

MIXED - VALENCY

VALENCE - FLUCTUATIONS (VIA)

$$4f^{m} \rightleftharpoons 4f^{m-1} + e^{-}$$
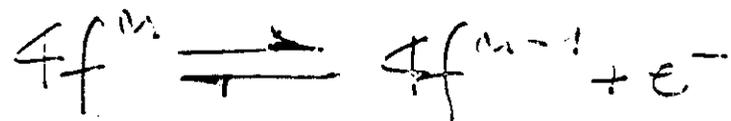
YTTERBIUM   Yb

ATOMIC CONFIGURATION

$$[Xe]\, 4f^{14}\, 5d^{0}\, 6s^{2}$$
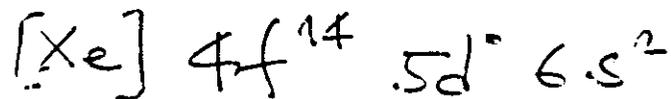
METALLIC STATE CONFIGURATION

$$[Xe]\, 4f^{14}\, (5d\, 6s)^{2}\quad \text{DIVALENT}$$
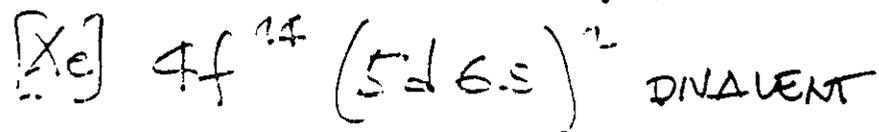
MIXED-VALENT Yb-COMPOUNDS

$$4f^{14} \rightleftharpoons 4f^{13} + e^{-}$$
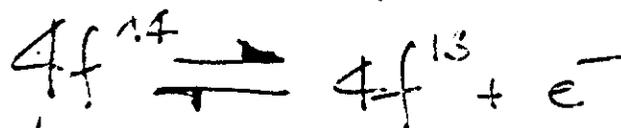
DIVALENT   TRIVALENT

$$\text{FLUCTUATION TIME} \simeq 10^{-13}\ \text{sec}$$
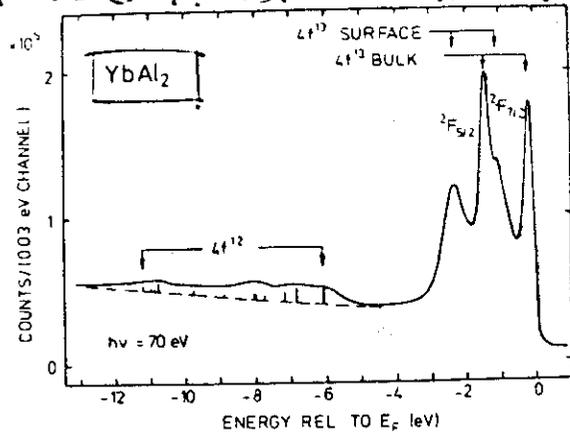
Fig. I Photoemission spectrum of YbAl$_2$ at hv=70 eV. Two final-state 4f^{13} doublets are seen, a narrow bulk doublet and a much wider surface doublet shifted to higher binding energy. Weaker bulk final-state 4f^{12} multiplet lines are also seen.
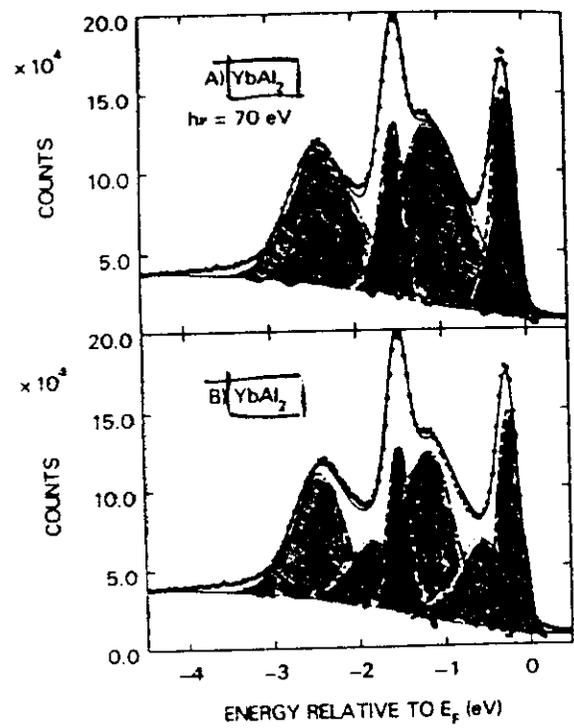
Fig. 2 Least-squares fit analysis of the 4f^{13} final-state multiplet spectrum using (a) two doublets and (b) three doublets of asymmetric gaussian lines plus background. Dashed lines represent emission from the bulk. In Fig. 2b dash-dotted (dotted) lines represent the first (second) surface layer.

G. KAINDL, B. REIHL, D.E. EASTMAN,
R.A. POLLAK, N. MARTENSSON,
B. BARBARA', T.PENNEY & T.S PLASKETT

STRUCTURAL DATA

2.89 Å

4.09 Å

fcc

Ag (110)

2.89 Å

4.09 Å
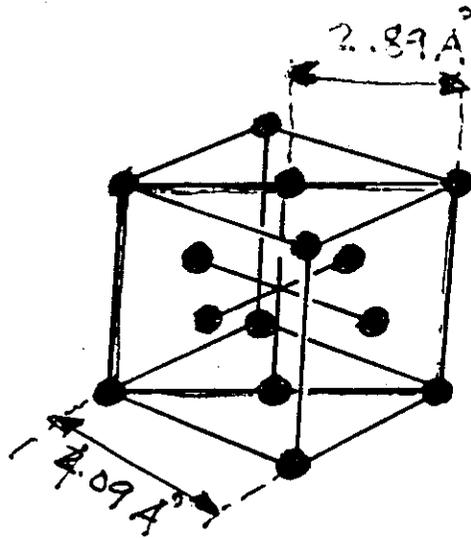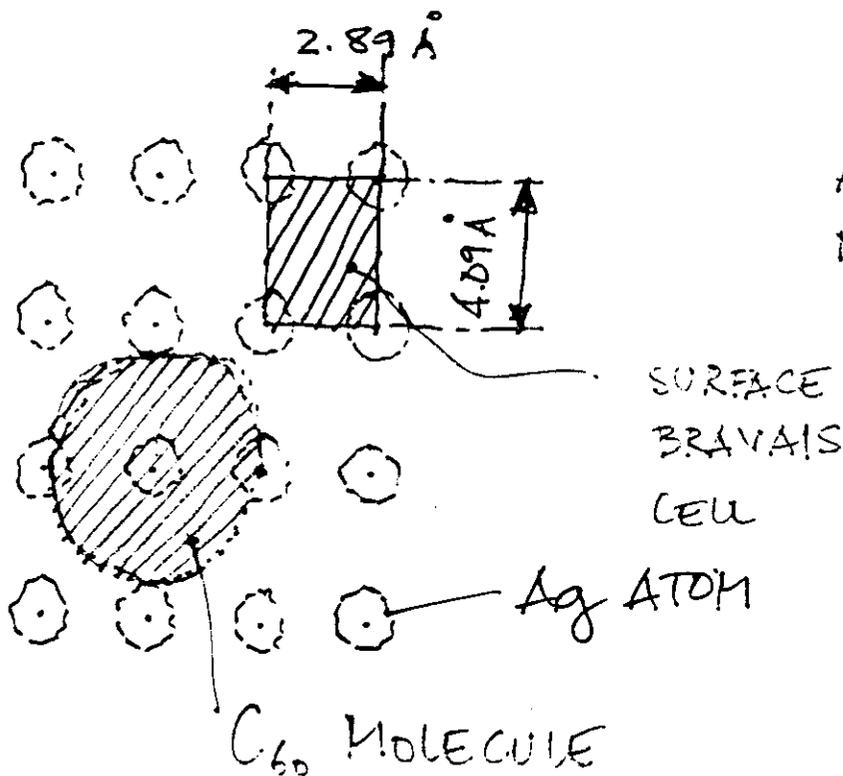
Ag (110)
NO RECONSTRUCTION

SURFACE
BRAVAIS
CELL

Ag ATOM

C$_{60}$ MOLECULE

~7.1 Å

(001)

1.45 Å

(010)

1.40 Å

(100)

C₆₀ MOLECULE

— SINGLE BOND

— DOUBLE BOND

- TRUNCATED - ICOSA HEDRON STRUCTURE

- "MAGIC" CLUSTER

- BUCKMINSTER FULLERENE

- ALL C ATOMS ARE EQUIVALENT

~7.1 Å

(001)

1.45 Å

(010)

(100)

1.40 Å

C_{60} MOLECULE

—— SINGLE BOND

—— DOUBLE BOND

- TRUNCATED - ICOSAHEDRON STRUCTURE

- "MAGIC" CLUSTER

- BUCKMINSTER FULLERENE

- ALL C ATOMS ARE EQUIVALENT

FIG. 2. Topographs of (a) well-ordered C_{60} monolayer on Ag(110) with nearest neighbor distance of ~9.4 Å. The line indicates Ag[1$\bar{1}$0] direction. (b) C_{60} island formation (I) on terraces and Ag steps (S) running along [1$\bar{1}$0] indicated by the line. (2,400×2,400 Å) $V_t = 0.3$ V, $i_t = 1$ nA. (c) Defect (D) indicated in hexagonal layer on one of the islands. The line indicates Ag[1$\bar{1}$0] direction.

FIG. 2. Topographs of (a) well-ordered C_{60} monolayer on Ag(110) with nearest neighbor distance of ~9.4 Å. The line indicates Ag[110] direction. (b) C_{60} island formation (I) on terraces and Ag steps (S) running along [1$\bar{1}$0] indicated by the line. (2.400×2.400 Å) $V_s = 0.3$ V, $i_t = 1$ nA. (c) Defect (D) indicated in hexagonal layer on one of the islands. The line indicates Ag[1$\bar{1}$0] direction.
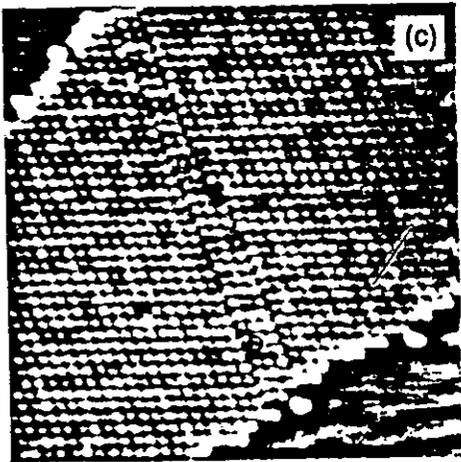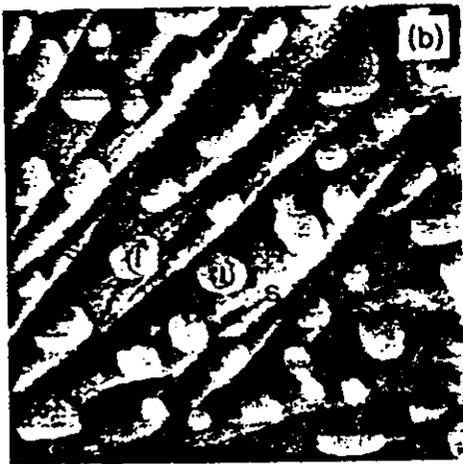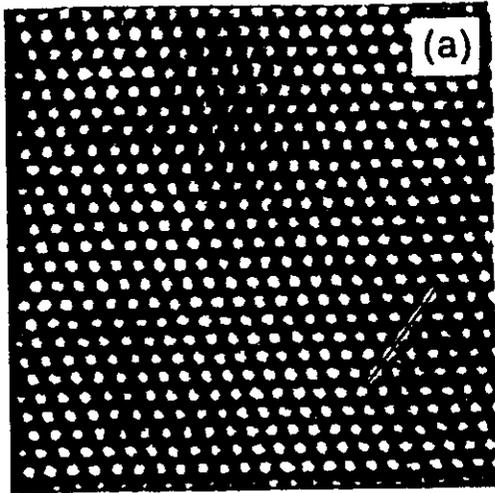
WELL ORDERED
C_{60} ON Ag (...)
AFTER ANNEALING
AT 705 K

CLOSE-PACKED DIRECTION
PARALLEL TO [1$\bar{1}$0]
Ag (...) c(4×4) C_{60}

C_{60} ISLAND FORMATION

JVST 3-12 (199?) 1742.

XPS   C 1s

I_{C1s}/I_{Ag3x}

C_{60}/Ag (110)

ANN @ 500°C   0.5

~0.7eV

ANN @ 400°C   0.75

RT   18.17
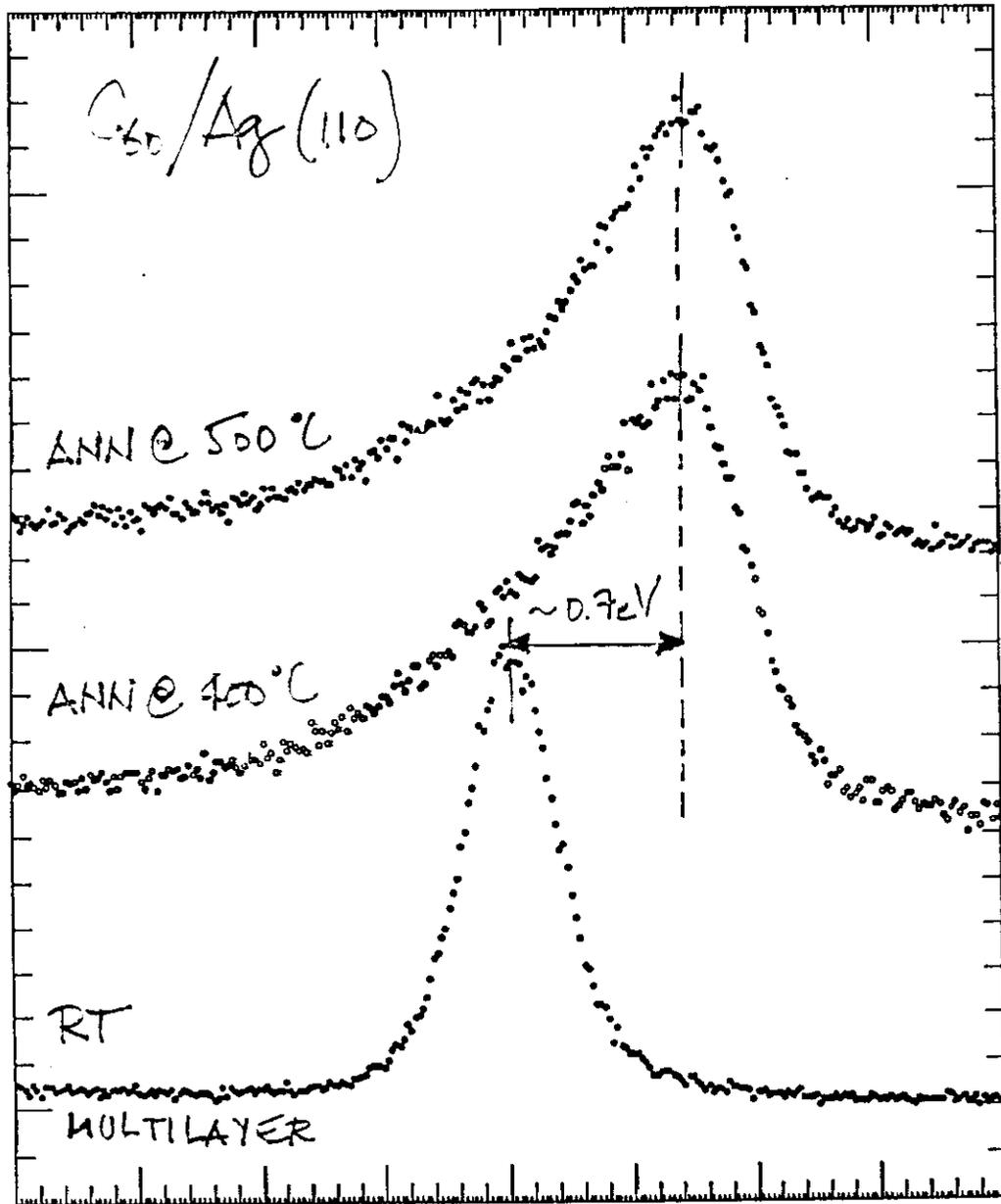
MULTILAYER

+287 +286.5 +286 +285.5 +285 +284.5 +284 +283.5 +283

BINDING ENERGY (eV)

XPS   C 1s
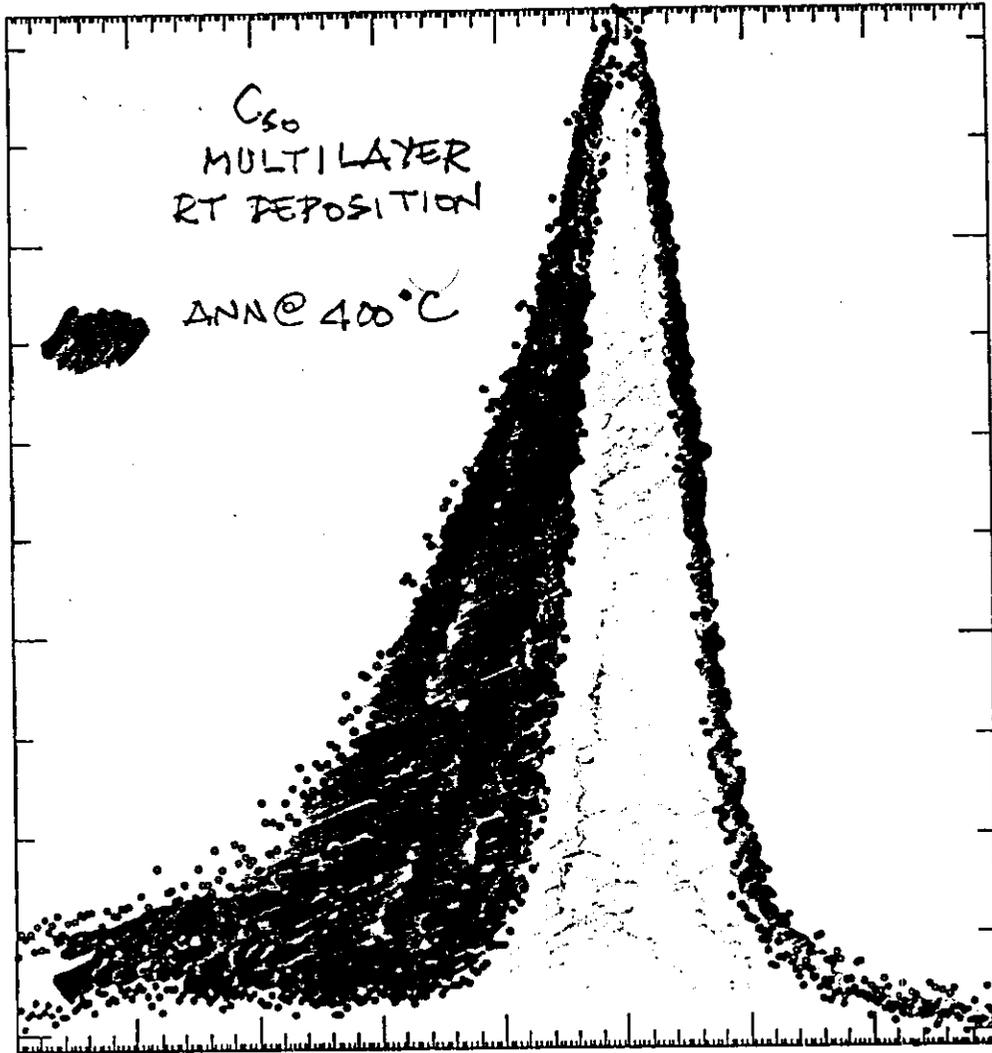
C_{60}
MULTILAYER
RT DEPOSITION

ANN @ 400°C

+287.5 +287 +286.5 +286 +285.5 +285 +284.5 +284 +283.5

BINDING ENERGY (eV)

C_{60} /Ag (110)

AFTER ALIGNMENT WITH RESPECT
TO THE MULTILAYER PEAK

ANGLE - INTEGRATED
PHOTOEMISSION

C_{60} / Ag (110)

VALENCE BAND

C_{60} MULTILAYER

ANN @ 500°C

ANN @ 400°C

Ag 4d

Ag CLEAN

BINDING ENERGY (eV)

+12   +10   +8   +6   +4   +2   0
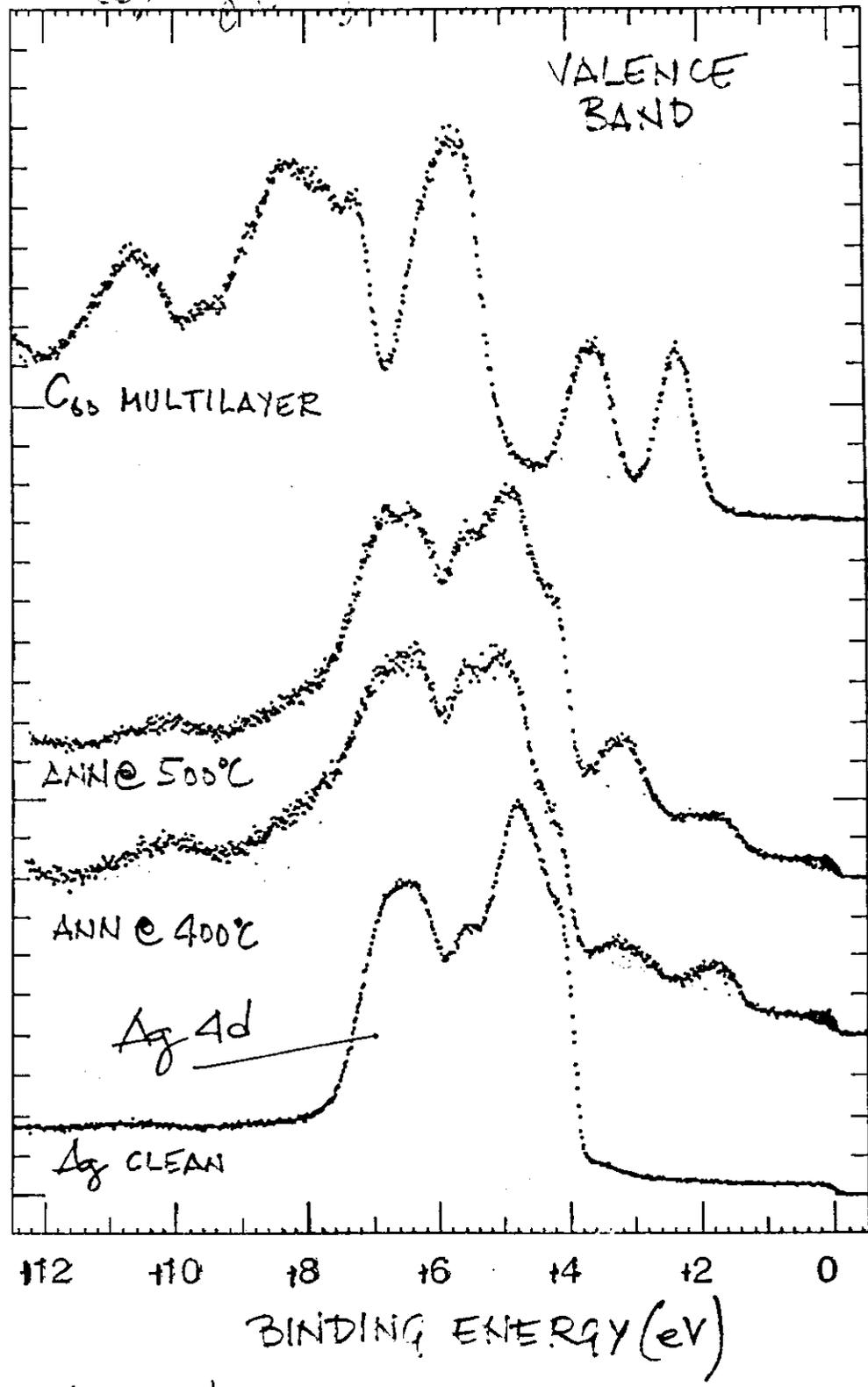
Ag 4d   COOPER MINIMUM

ANGLE-INTEGRATED
PHOTOEMISSION

HOMO RANGE

HOMO-1   HOMO

~1.26

C$_{60}$
MULTILAYER

LUMO

~0.55

ANN@500°C

ANN@400°C

Ag
CLEAN

+4.5 +4 +3.5 +3 +2.5 +2 +1.5 +1 +0.5 0 -0.5

BINDING ENERGY (eV)

C₆₀/Ag(110)

C1s NEXAFS

LUMO

t_{1u}

t_{1g}

LUMO+2

h_u

h_g

t_{2u}

Multilayer

1ML

ANNEALED
@ 400°C

Intensity (arb. units)

PHOTON ENERGY (eV)
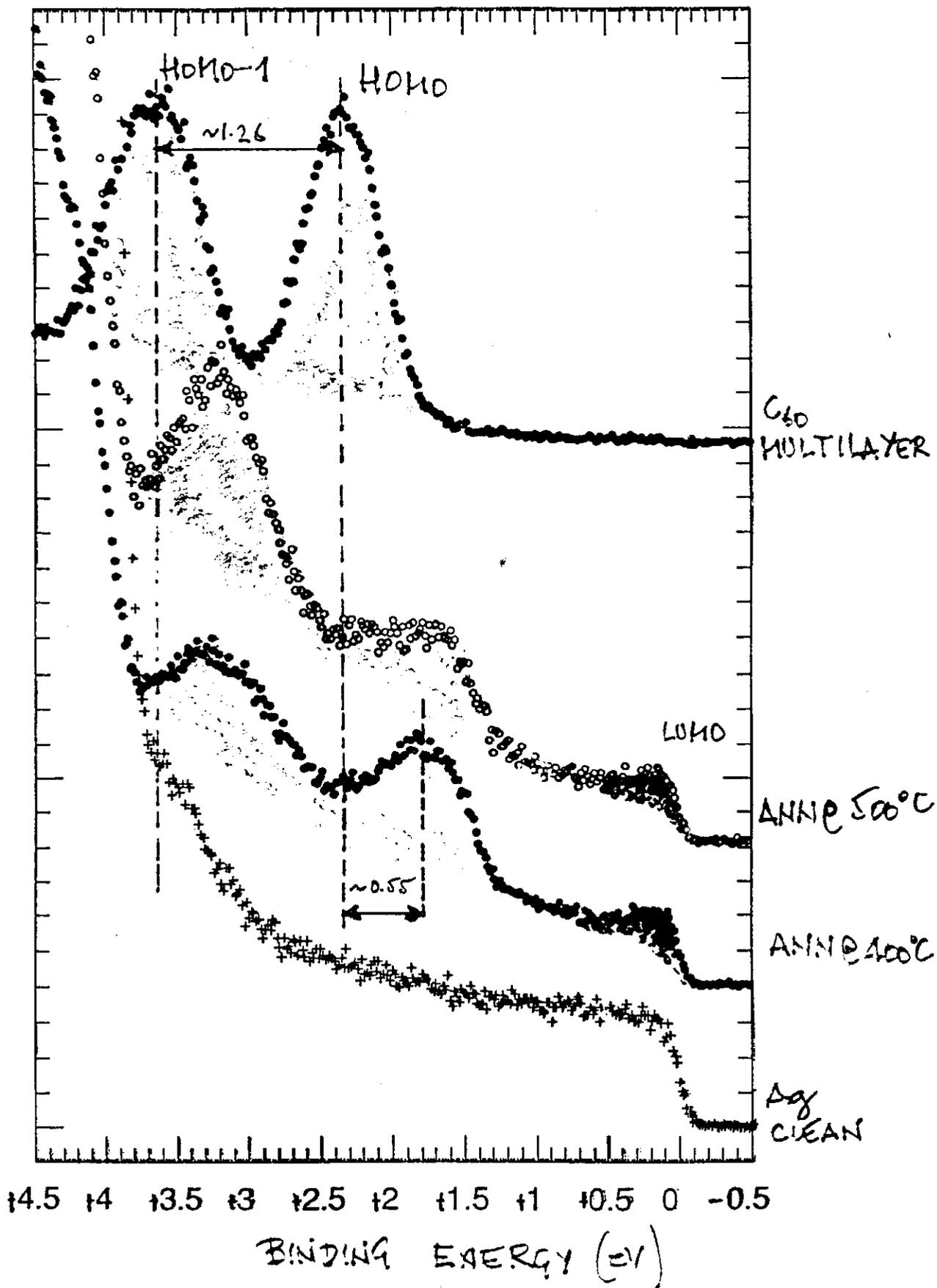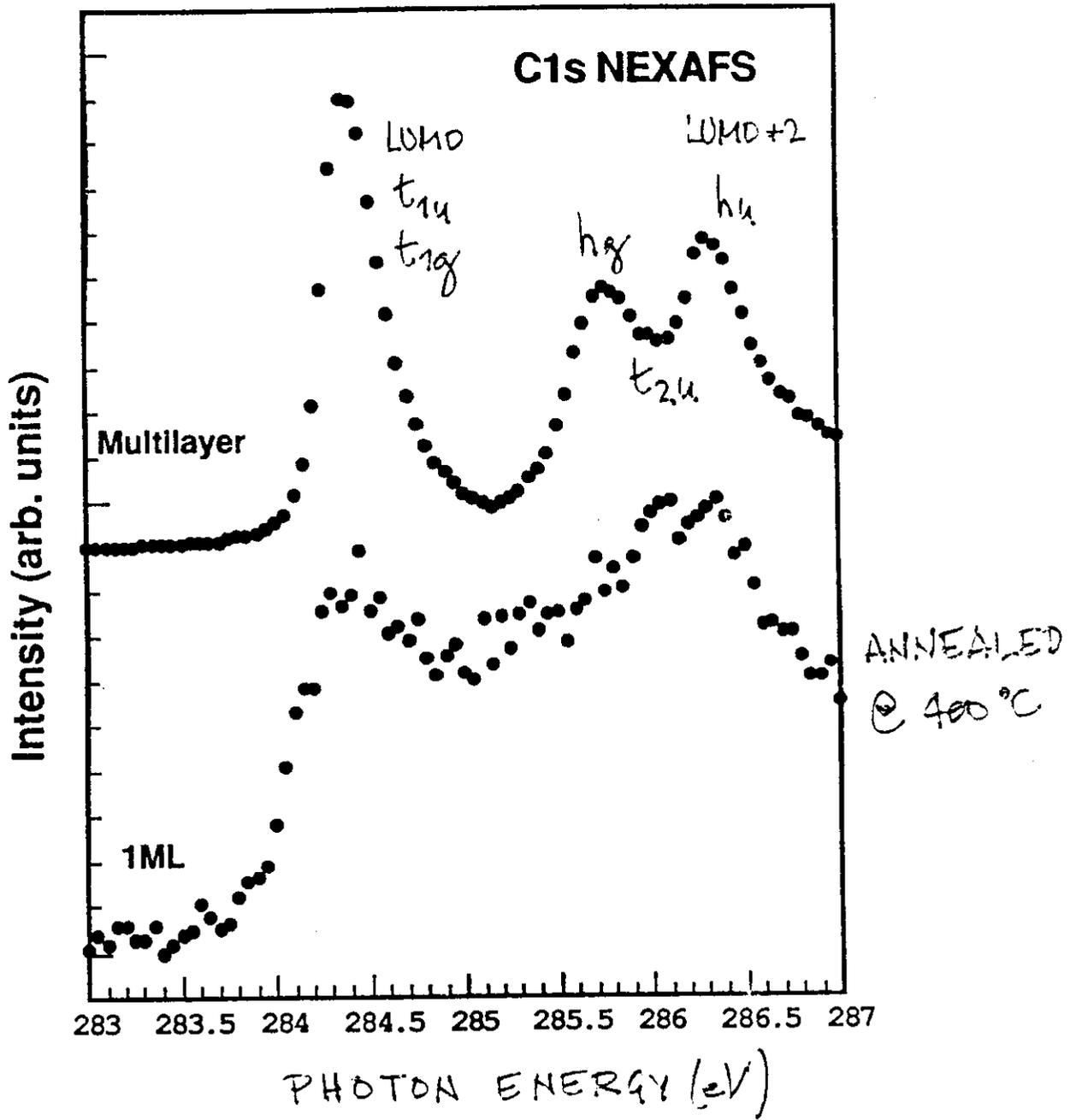
π^* ORBITALS

C 1s NEXAFS

COOPER MINIMUM PHOTOEMISSION

HOW TO DISCRIMINATE BETWEEN

$4d (5d) - \stackrel{?}{\neq} sp$ VALENCE BAND

STATES
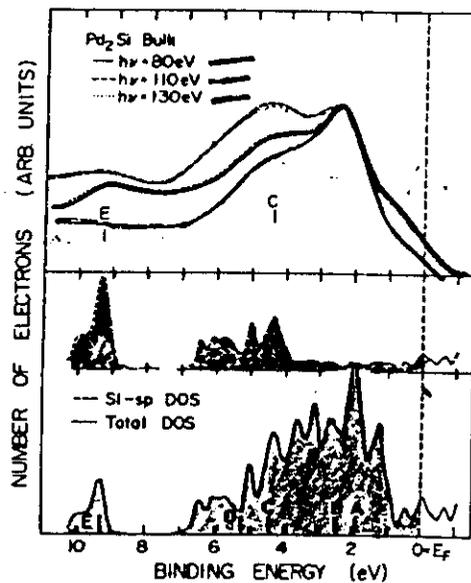
Pd$_2$Si

Pd 4d STATES

vs

Si 3(sp) STATES

FIG. 2. EDC's for the valence-band emission of Pd$_2$Si at $h\nu=80$, 110, and 130 eV are shown (top) normalized to the main 4d structure. In the lower part of the figure we show, for comparison, the total DOS (solid line) and the Si-derived s-p partial DOS as calculated by Bisi and Calandra in Ref. 14. The vertical bars mark the experimental features $A-E$ identified in Fig. 1. Experimentally, the suppression of the Pd-derived d emission at the 4d Cooper minimum ($h\nu>100$ eV) results in the emergence of the Si-derived s states at 9.3 eV and of the Si p states in bonding combination with metal d orbitals 3.5—6.5 eV below E_F. Theory does not show a similar one-to-one correspondence for the other experimental features but the qualitative agreement suggests that structures A and B arise from 4d nonbonding states. The emission within 1.5 eV from E_F is strongly enhanced at the Cooper minimum but the nature of the corresponding states is less clear. Either a substantial amount of metal s-p character is present near E_F or the antibonding Si p—metal-d orbitals are partially occupied.

FRANCIOSI et al

PHYS REV B

-102-
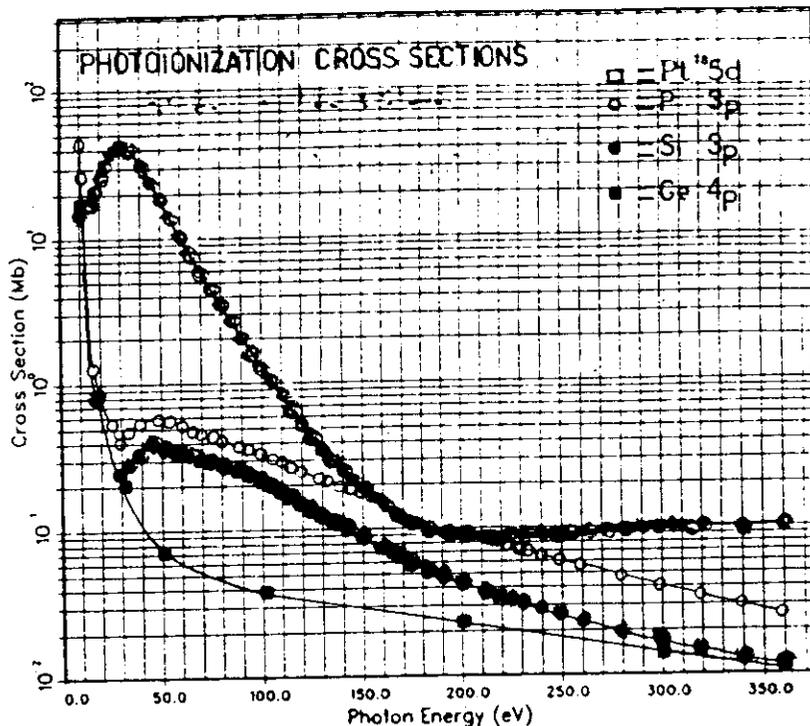
Photoionization cross section for 4d and 5d subshells in the energy range 0–200 eV compared to the cross sections for the 3ps and 4sp valence states of the semiconductors [21].
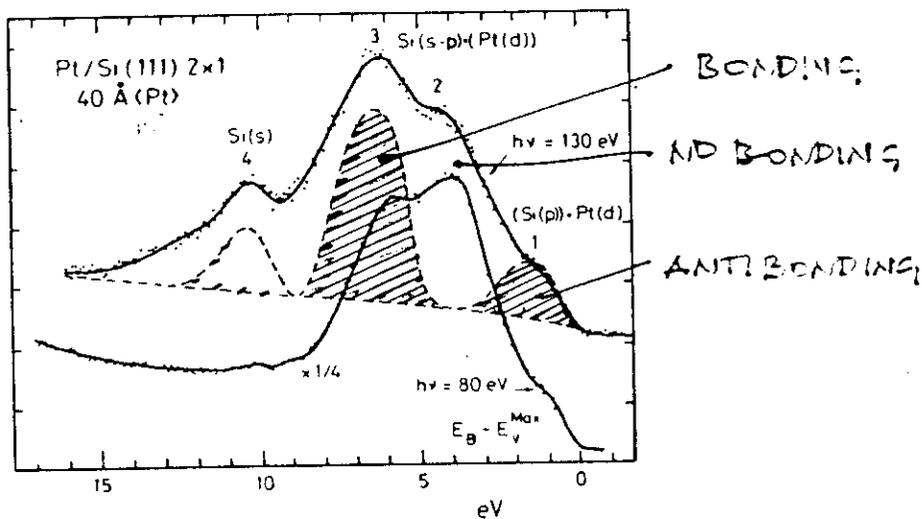
Analysis of the Si sp partial DOS at the Pt–Si(111) reacted interface (40 Å Pt–Si(111) at room temperature). The top panel displays the CM and the $h\nu$ = 80 eV photoemission data, and a three-peak partial DOS that accounts for the Si hybridized 3sp charge at the interface: a gap is present in correspondence to the localized Pt5d states. The same three-peak partial DOS is then self-convoluted and compared to the integrated SiL$_{2,3}$VV lineshape. The correspondence of all peaks and relative intensities (a part of the known reduction of the Si3s contribution) confirms the CM derivation of the Si sp partial DOS [159].

AFTTR P. MoRGEN et al
SURFACE SCIENCE (1987)

RESONANT PHOTOEMISSION

HOW TO SUPPRESS OR ENHANCE d-CHARACTER STATES IN VALENCE BAND STATE PHOTOEMISSION

CB
E_F
VB

THRESHOLD ABSORPTION

$h\nu$

$4p$

$h\nu$

VALENCE BAND PHOTOEMISSION

$4P$

RECOMBINATIO. AUTOIONIZATIO

$4p$

QUANTUM INTERFERENCE BETWEEN TWO EXCITATION CHANNELS

RES

ARES

$h\nu$
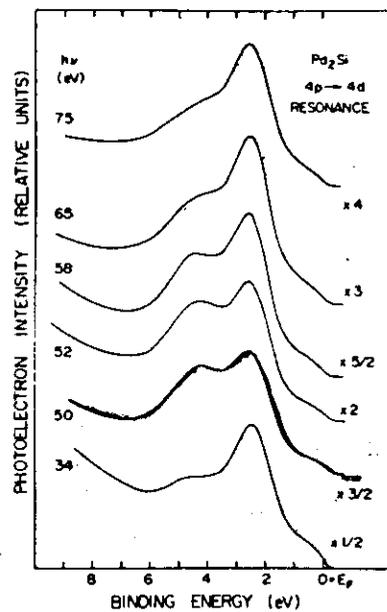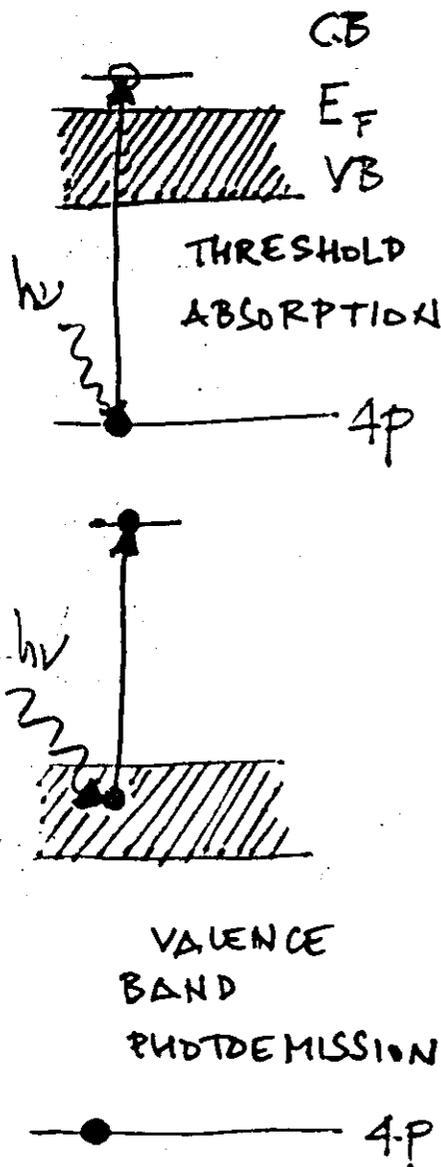
FIG. 4. Representative spectra of the valence-band emission of Pd$_2$Si for photon energy near the $4p \rightarrow 4d$ resonance. The spectra were normalized for monochromator output (Ref. 29) and are given in relative units. The modulation of the relative intensity of the experimental features reflects the suppression of the $4d$ character at antiresonance, where the Si-derived states are more visible ($h\nu \sim 50$ eV), and the following reenhancement at resonance (see Fig. 3). Resonant photoemission represents an important tool for analyzing the different orbital contributions to the valence states and, unlike the Cooper minimum technique, can in principle be applied to all d systems.
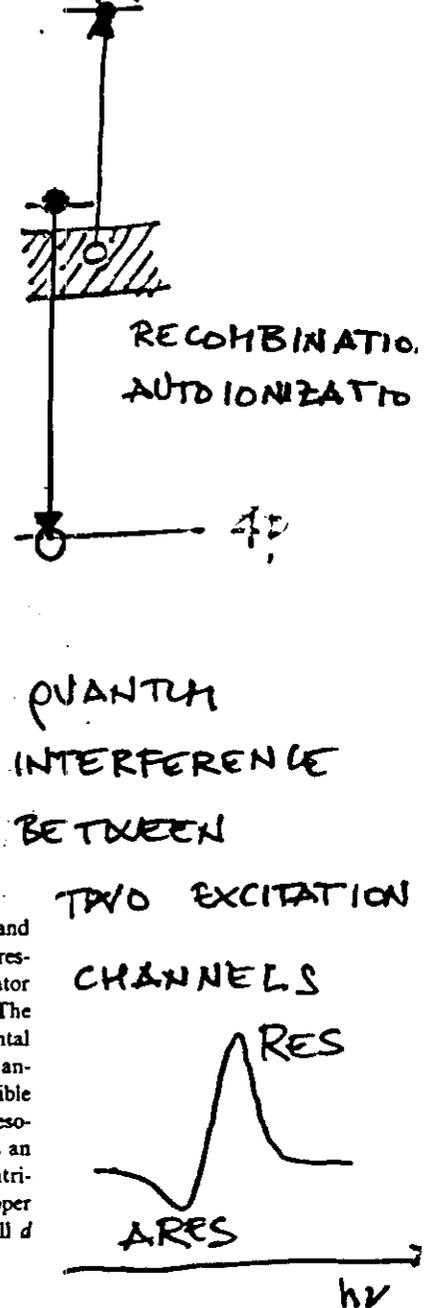
THREE-DIMENSIONAL VERSUS TWO-DIMENSIONAL BANDS
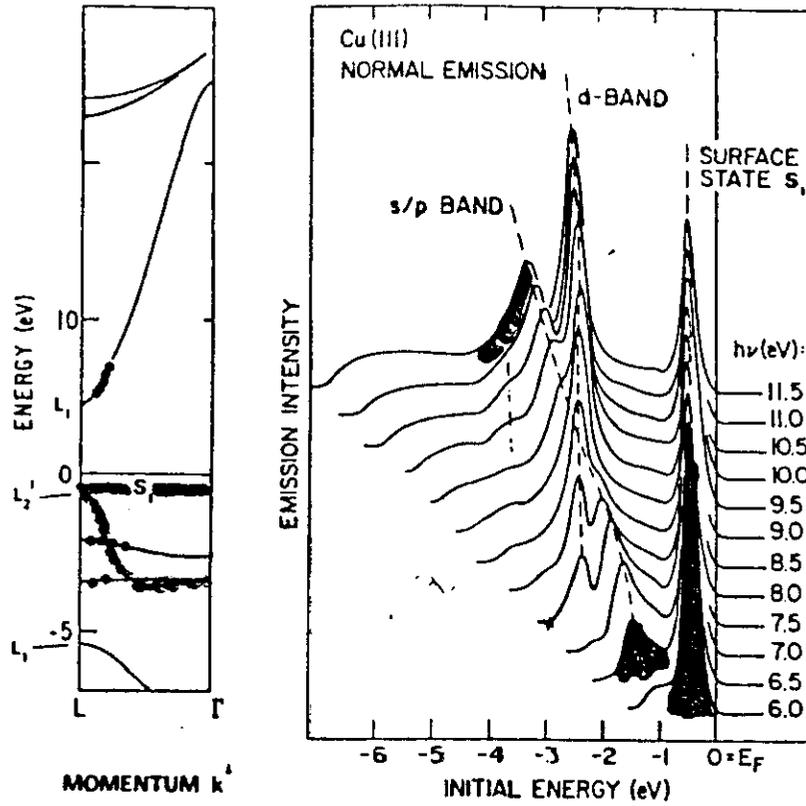
Surface and bulk states for Cu(111). The structure S_1 at $E_f - 0.4$ eV in the normal emission photoelectron spectra is a surface state; the other peaks are bulk states. Two characteristics of a surface state can be seen: S_1 is located in the $L_2' - L_1$ gap of bulk states. The binding energy of the surface state is independent of the photon energy $h\nu$ in contrast to the bulk states which move due to dispersion along the $k^\perp$ axis as shown on the left-hand side.

FRANCIOSI *et al*

PHYS REV B

EXPERIMENTAL BAND DISPERSIONS E (k̄)

MOMENTUM k̄ ALONG THREEFOLD AXIS
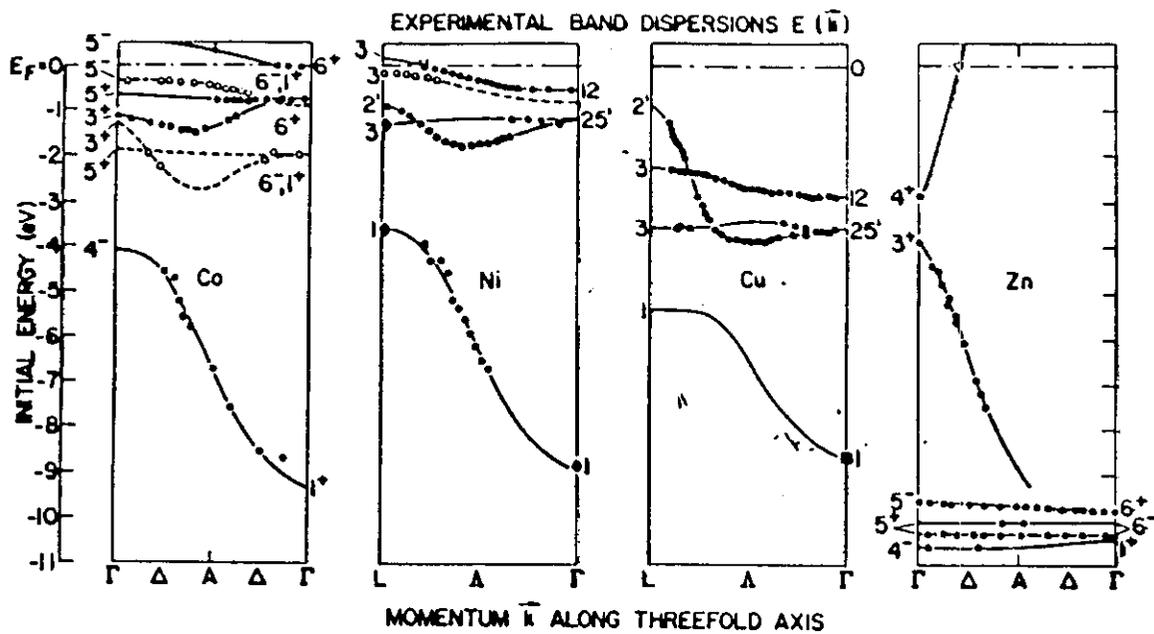
Overview of three-dimensional experimental energy band dispersions along the first row of transition and noble metals (from Eastman and Himpsel 1980b including data from Eberhardt and Plummer 1980 (diamonds) and Thiry *et al.* 1979 (square)). The flat $3d$ bands become filled with increasing atomic number and move down relative to the strongly dispersing s, p bands.

Fig. 20

BULK PHOTOEMISSION
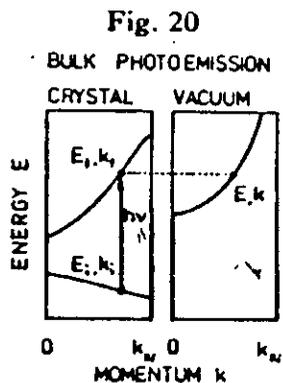
Electronic states for photoemission from the bulk (from Smith and Himpsel 1983).

ORIENTED MOLECULES
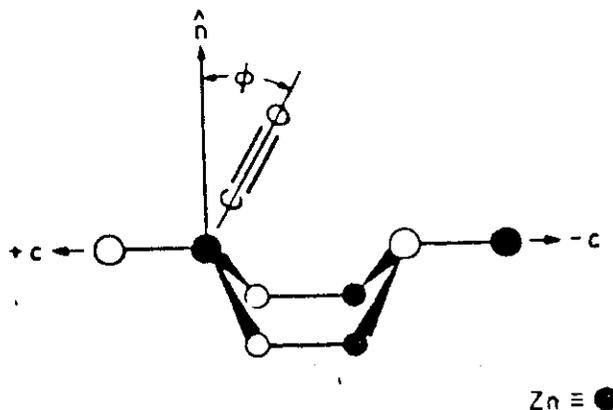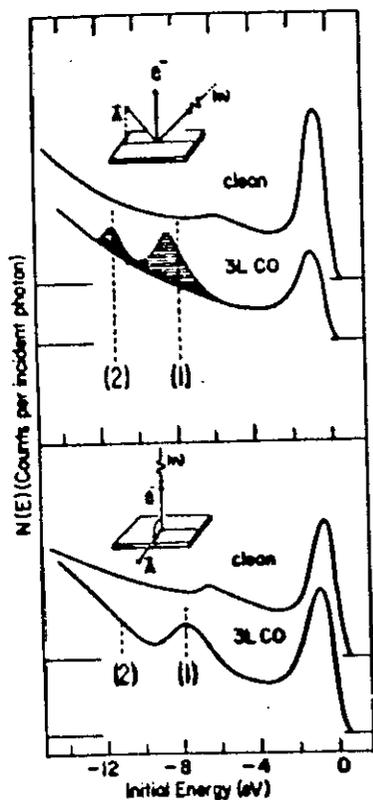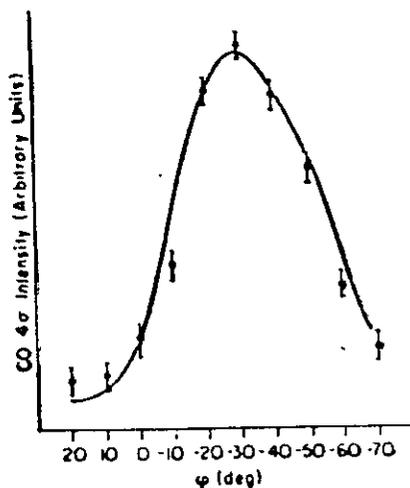
(a) Polarization-dependent angle-resolved photoelectron spectra for CO on Ni(100) which demonstrate that the axis of the CO molecule is perpendicular to the surface (after Smith *et al.* 1976 b). For normal emission and with the electric field vector parallel to the surface (bottom) the emission from the lowest orbital (4σ; structure 2) is symmetry forbidden. (b) Photoemission from CO on a ZnO(10$\bar{1}$0) surface giving evidence for inclined CO (from D'Amico *et al.* 1980) by comparing the angular dependence of the 4σ emission (dots) with oriented-molecule calculations (line, see Davenport 1976).

MIRROR PLANE SYMMETRY

Ni (100)

(011) PLANE
$k_{\parallel} = 1.30$ Å^{-1}
$\hbar\omega = 30$ eV
ΔE

EVEN —

—— CLEAN
---- CONTAMINATED

ODD —

(010) PLANE
$k_{\parallel} = 0.89$ Å^{-1}
$\hbar\omega = 17$ eV
ΔE

EVEN —

—— CLEAN
---- P(2×2)S

ODD + EVEN —

INTENSITY

-5 -4 -3 -2 -1 0   -5 -4 -3 -2 -1 0
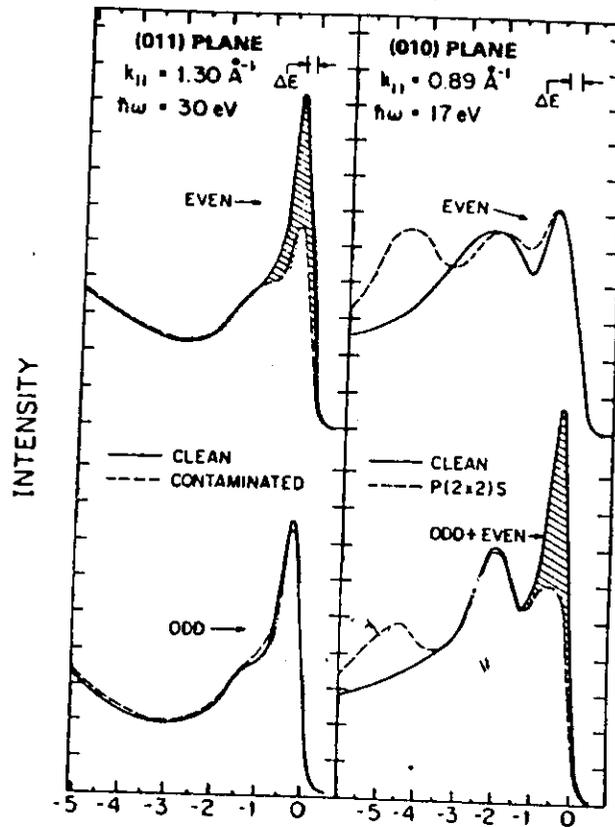
Surface states with even and odd mirror symmetry on Ni(100) selected by aligning the electric field vector parallel and perpendicular to the mirror plane, respectively, and detecting photoelectrons in the mirror plane (from Plummer and Eberhardt 1979).
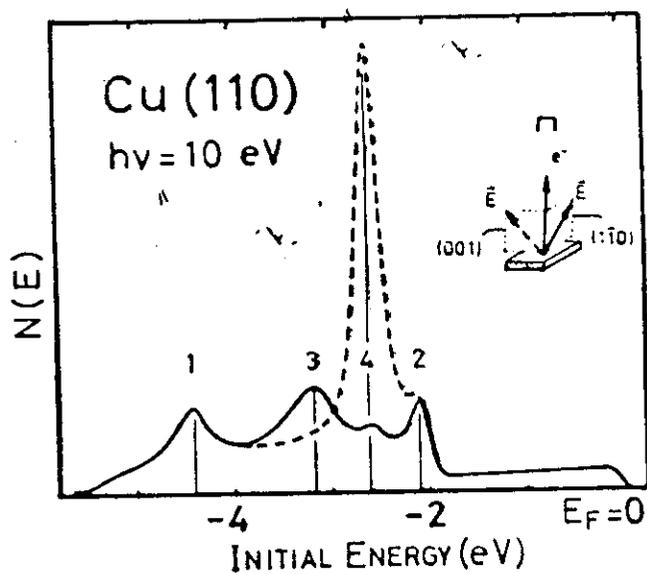
Fig. 5. Photoelectron spectra for normal emission from Cu(110), which demonstrate polarization selection rules. With the electric field vector **E** parallel to the (001) plane (dashed lines), states of Σ_4 symmetry are excited; with **E** parallel $(1\bar{1}0)$, Σ_3 states are excited (after Ref. 23).

INVERSE PHOTOEMISSION

$$E_i - E_f = \hbar \omega_o$$
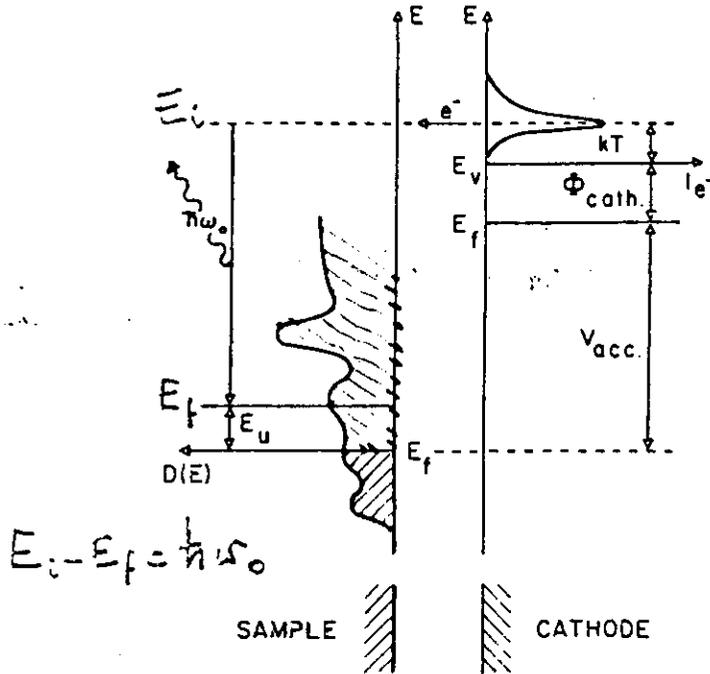
Energy diagram of the system cathode-sample. E_f—Fermi level; E_r—vacuum level; V_{acc}—acceleration potential of the electrons; ϕ_{cath}—work function of the cathode; T—temperature of the cathode; $\hbar\omega_o$—x-ray photon energy; E_u—unoccupied state energy; I_r—intensity distribution of the emitted electrons (thermionic emission); and $D(E)$—density of states.

$$E_u = V_{ACC} + \phi_{CATH} + kT - \hbar\omega_o$$
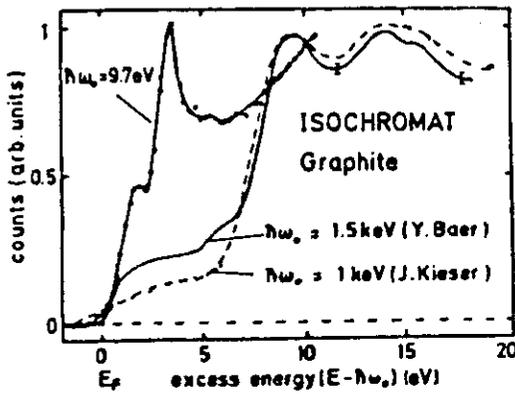
Bremsstrahlung isochromat spectra from graphite for photon energies in the UV and X-ray regime [18.37-39]
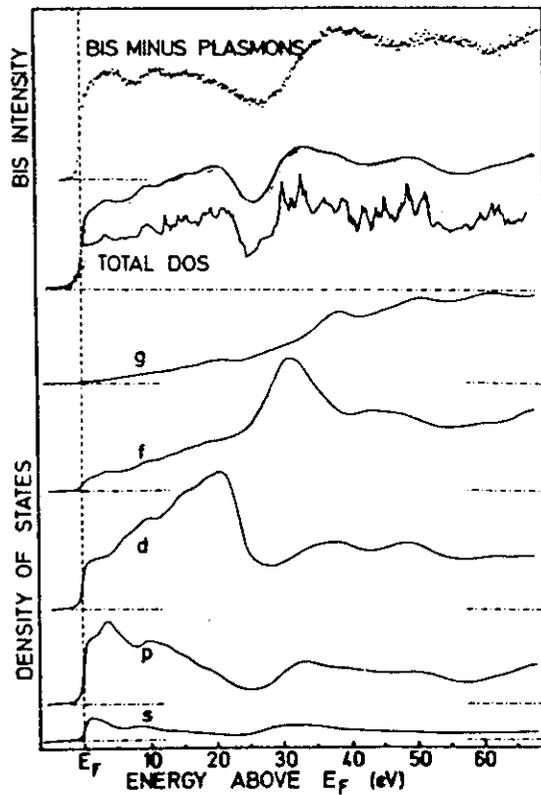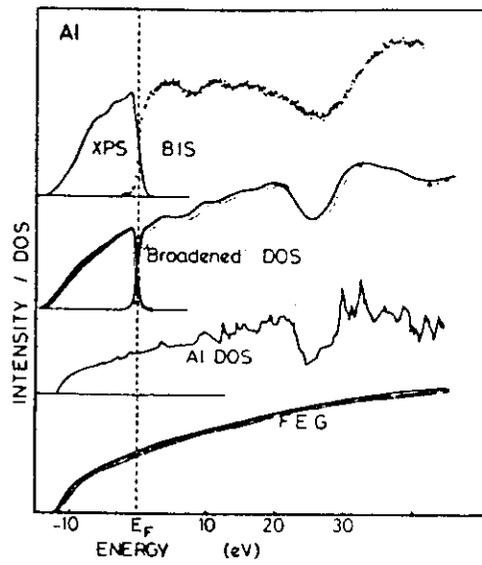
FIG. 5. The partial (s, p, d, f, g) and total density of states
curves for Al as compared to the measured BIS spectrum
corrected for plasmon losses. With the exception of one total
DOS curve, the DOS have been broadened to account for instru-
mental and lifetime broadening effects (see text).

Y   Zr   Nb

E_F 2 4 6 8 10 (eV)

Mo   Ru

E_F 2 4 6 8 10 (eV)

Rh   Pd   Ag

E_F 2 4 6 8 10 (eV)
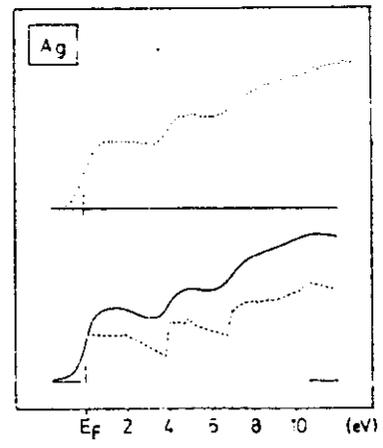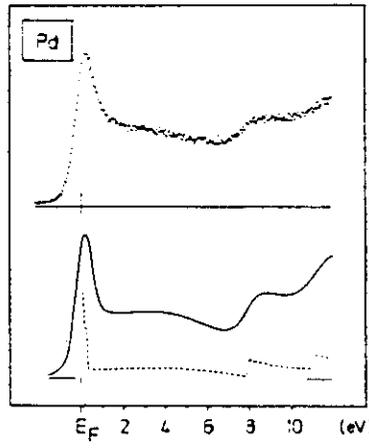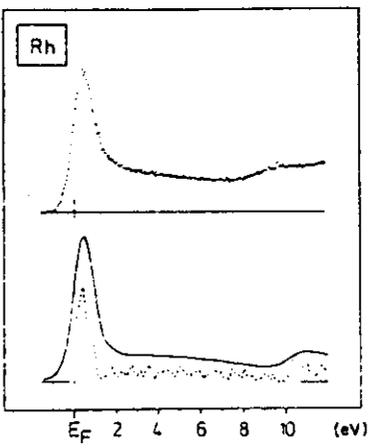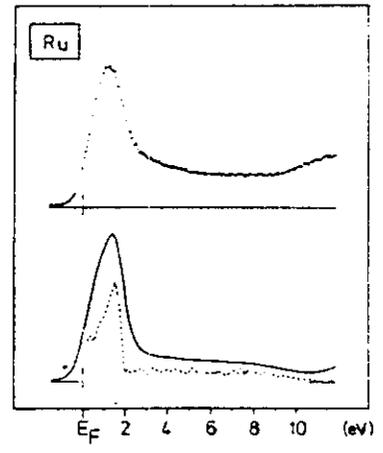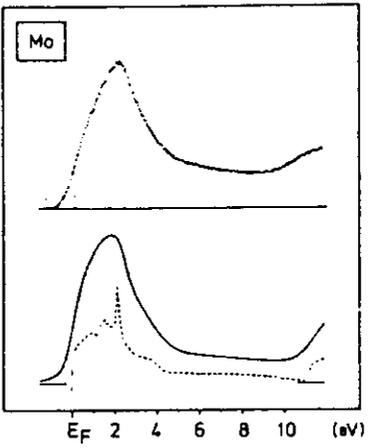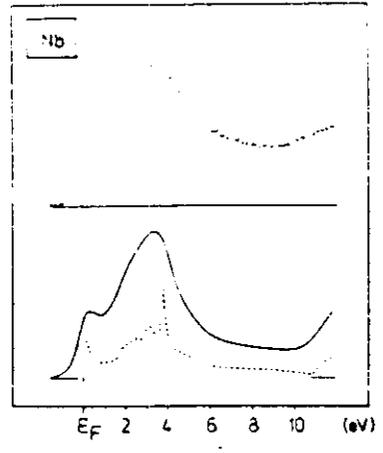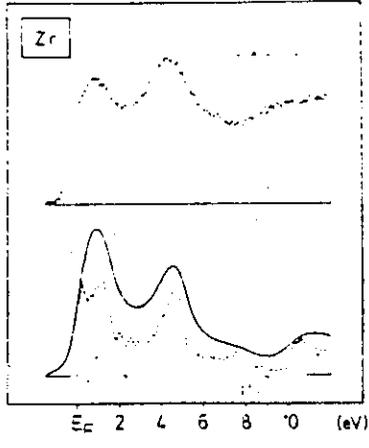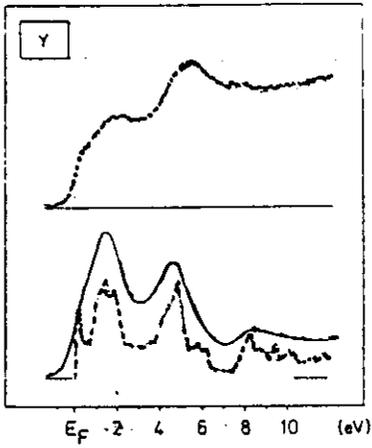
···········   EXPERIMENT

- - - -   CALCULATED DOS's

————   GAUSSIAN & LORENTZIAN
BROADENED DOS's

PES   IPES

$E_i = E_f - \hbar\omega$ $E_f = E_i - \hbar\omega$

$$\vec{k_{i_\parallel}} = \vec{k_{f_\parallel}} - \vec{q_\parallel} - \vec{q_{ph}}$$

$$\vec{k_{f_\parallel}} = \vec{k_{i_\parallel}} - \vec{q_\parallel} - \vec{q_{ph}}$$

$$J_{ph}/J_{el} = \nu^2 \cos^2\theta / 2 E c^2 \cos\varphi$$

J_{el} — ELECTRONS PER HARTREE PER STERADIAN
PER PHOTON

J_{ph} — PHOTONS PER HARTREE PER STERADIAN
PER ELECTRON

ν — PHOTON ENERGY

c — VELOCITY OF LIGHT IN ATOMIC UNITS (137)

θ — POLAR ANGLE OF PHOTON EMISSION

φ — POLAR ANGLE OF ELECTRON EMISSION

E — ELECTRON ENERGY IN HARTREE

$\nu = \frac{1}{137}$

J. B. PENDRY
PRL <u>45</u> (1980) 1356
J. PHYS. <u>C14</u> (1981) 1381

d-BAND NOBLE METAL

$\hbar\omega = 0.4$ hartree

OCCUPIED SURFACE STATES

UNOCCUPIED SURFACE STATES
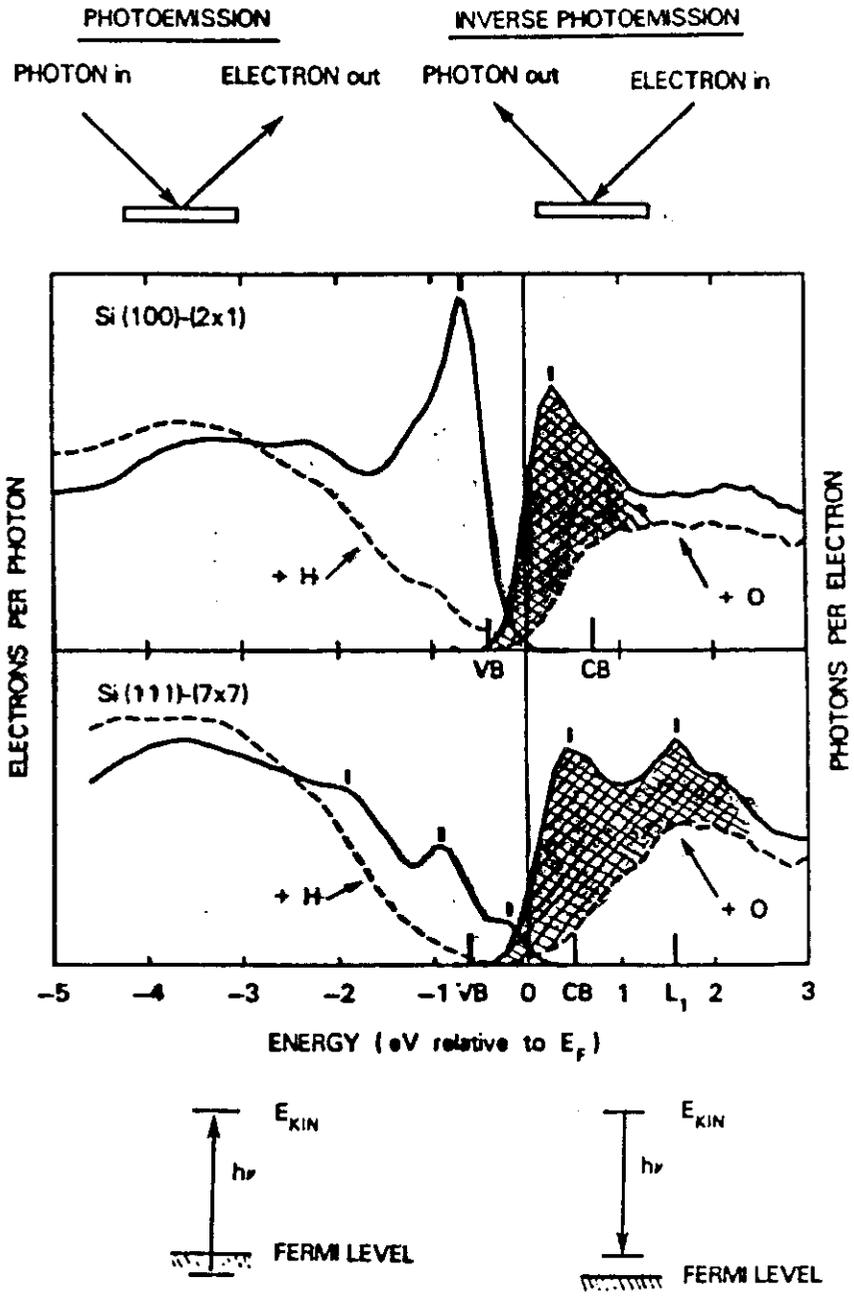
Fig. 4. Comparison between photoemission and inverse photo-
emission for surface states (tickmarks) on different Si surfaces
[17]. Photoemission measures occupied states whereas inverse
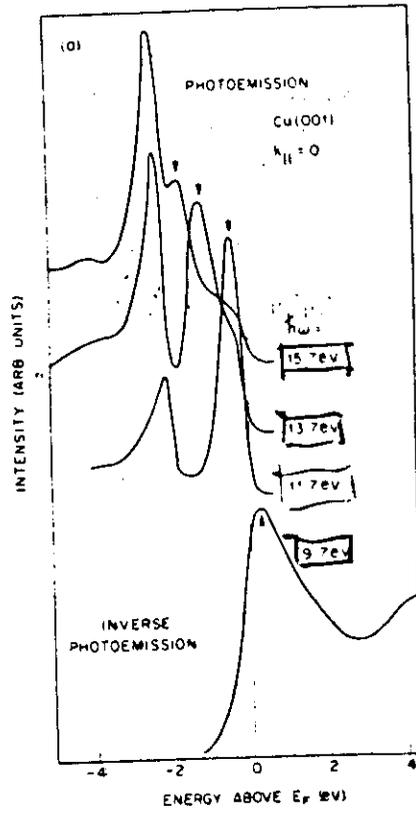photoemission measures unoccupied states
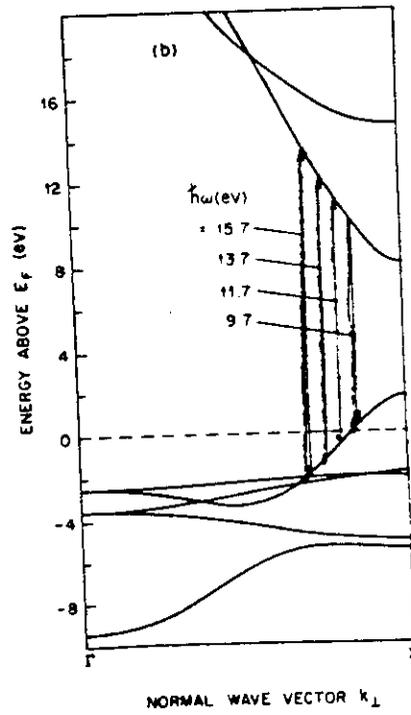
FIG. 3. Complementarity of photoemission and inverse p⁻ ¹toemission: (a) comparison of angle-resolved photoemission spectra on Cu(001) taken for normal emission with a k-resolved inverse photoemission spectrum taken for normal electron incidence; (b) corresponding direct k-conserving transitions in the ΓX direction of the bulk band structure.

U CORRELATION ENERGY (COULOMB + EXCHANGE)

Δ_- IONIZATION ENERGY OF $4f^n$

Δ_+ AFFINITY ENERGY OF $4f^{n+1}$

$$U = \Delta_- + \Delta_+$$

INVERSE PHOTOEMISSION
VIA GRATING SPECTROMETER
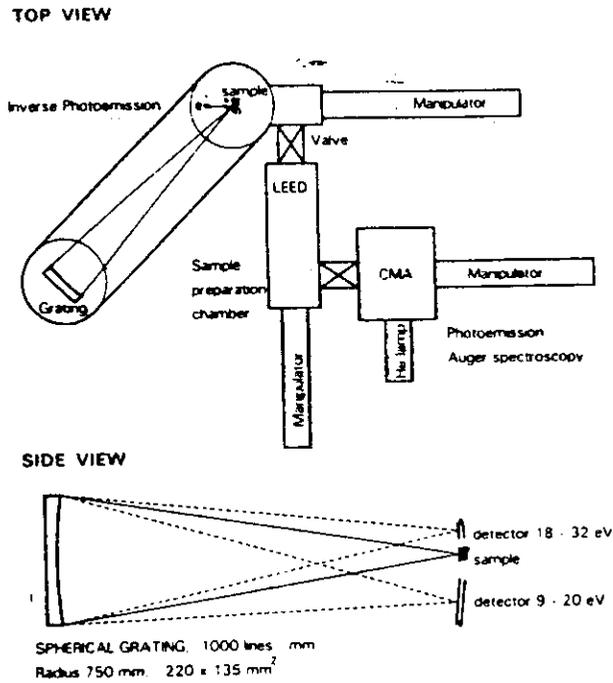
FIG. 2. Schematic of a newly developed system combining photoemission with inverse photoemission in the ultraviolet.

Th. FAUSTER et al
RSI 56 (1985) 1212

$\hbar\omega_0 = 1486.6\,eV$

J. K. LANG & Y. BAER
RSI 50 (1979) 221
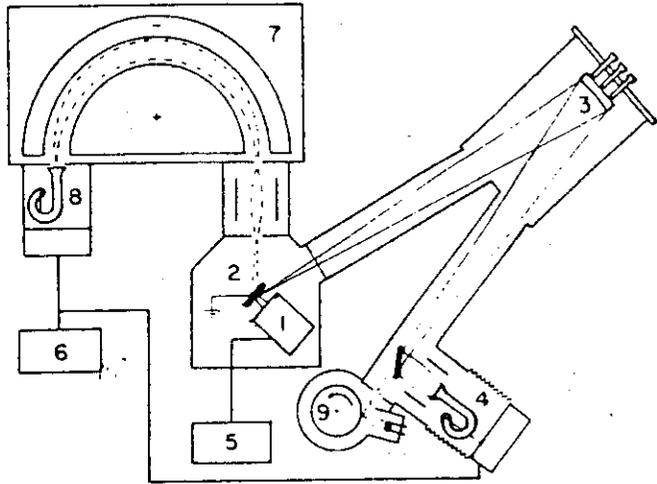
Combined XPS–BIS apparatus. 1—Electron gun; 2—sample; 3—x-ray monochromator; 4—x-ray photon detector; 5—electron gun power supply; 6—counting electronics and data outputs; 7—photoelectron energy analyzer; 8—photoelectron detector; and 9—x-ray tube.

V. DOSE
APPL PHYS 14 (1977) 117
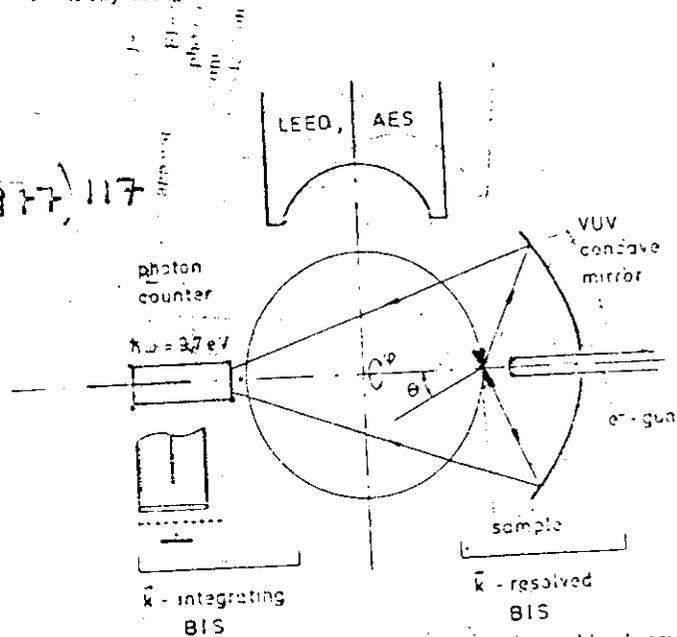
Schematic of an apparatus for momentum-resolved isochromat spectroscopy. An enlarged view of the detector position is given in the lower left corner.
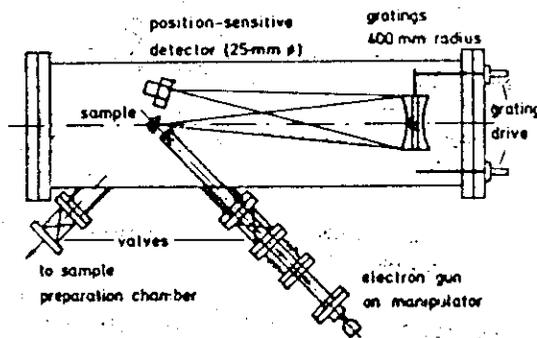
Fig.18.3. Top view of a grating spectrograph for inverse photoemission showing retractable electron source and sample. The light from the sample is dispersed by one of the two gratings and focused on a position-sensitive detector. Sample preparation is performed in a separate vacuum chamber
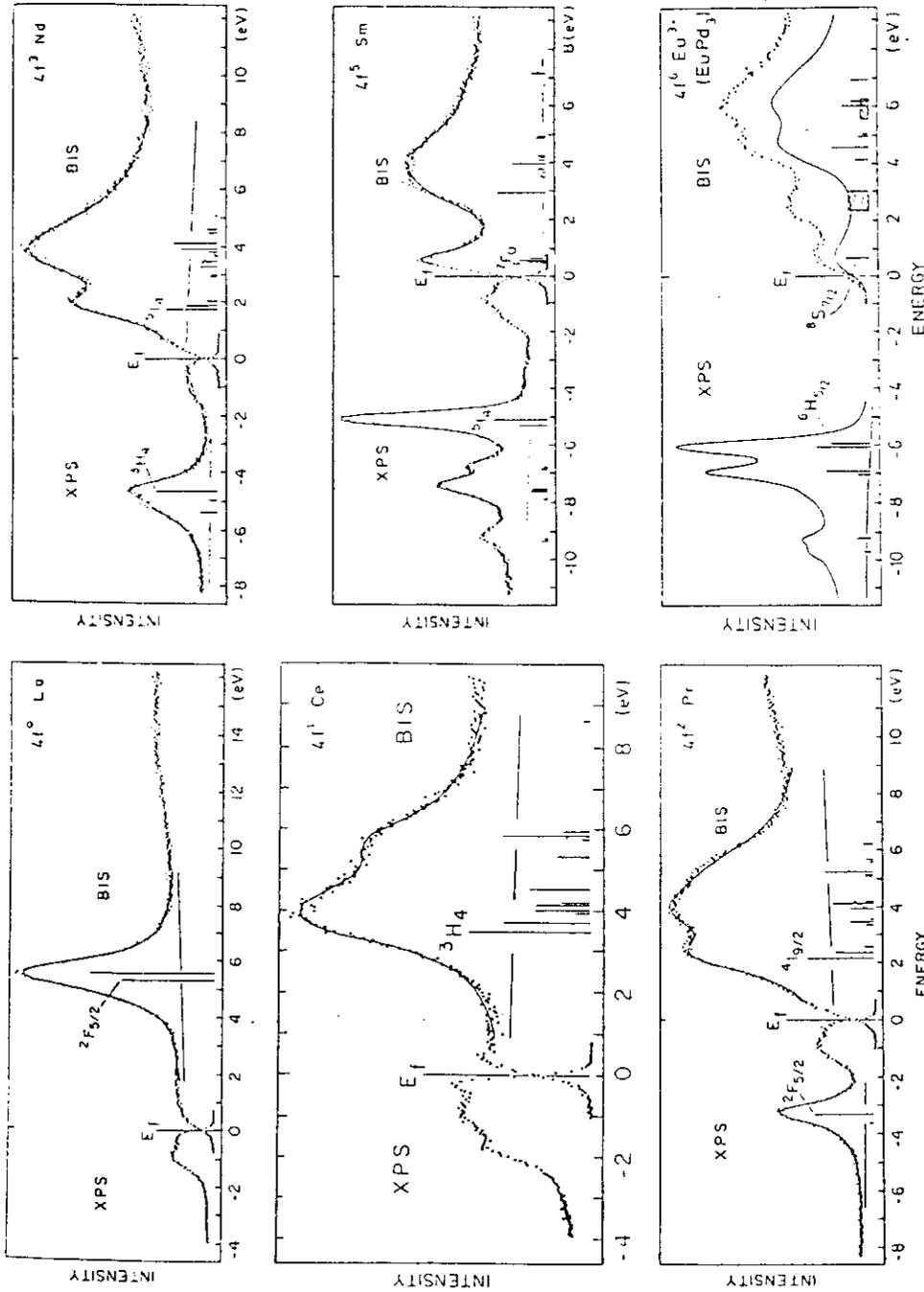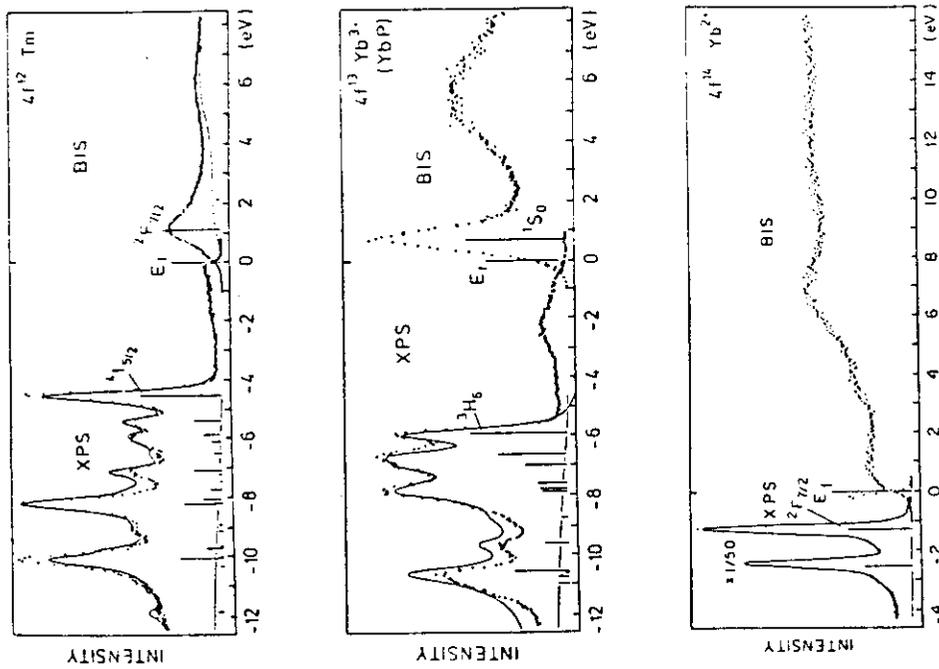
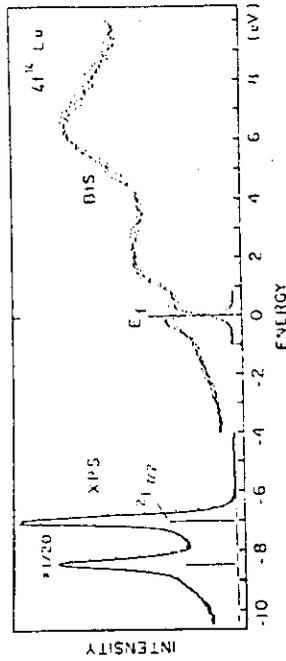Schematic of an apparatus for momentum-resolved isochromat spectroscopy. An enlarged view of the detector position is given in the lower left corner.

Fig.18.2. Energy dependence of the photoionization efficiency of I_2 (•••) and of the optical transmission of CaF_2 (---). The combined effect provides a bandpass (——) centered at 9.7 eV. For SrF_2 the resulting bandpass (shaded area) has an improved energy resolution and is centered at 9.5 eV

P.M.G. ALLEN & al

JVST   A5 (1987) 3346

FIG. 4. Comparison of functional response of --- CS_2–CaF_2 counter, and —— He/I_2–CaF_2 Geiger counter (Ref. 1).

Fig. 8b.

Fig. 8a.

Fig.f.

Fig. 8. Atomic-like analysis of XPS and BIS spectra for all $4f^n$ initial states. The spectra of the pure metals are taken from Lang et al. (1981), the spectra of YbP from Wuilloud et al. (1986) and the BIS spectrum of $EuPd_3$ from Laubschat et al. (1984). The coefficients of fractional parentage shown as vertical bars have been calculated in the LS coupling scheme (Nielson and Koster 1964, Cox et al. 1981), except for the XPS process from the initial configurations f^8 to f^{13} where the intermediate coupling scheme has been used (Gerken 1983). The particular situation met in Ce is discussed in sections 6 and 7.

Fig. 8e.
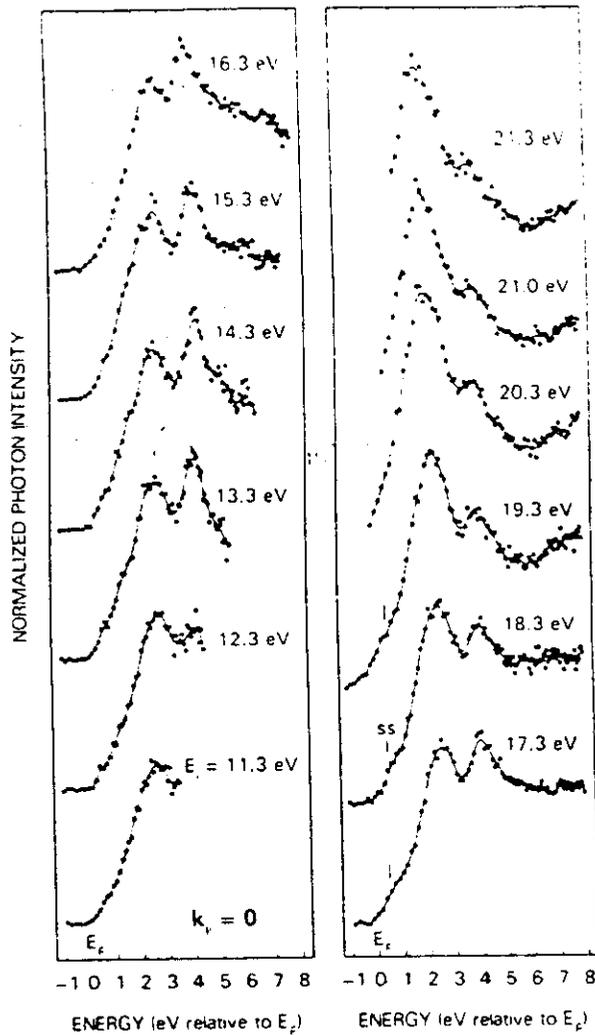
Inverse-photoemission spectra at normal incidence for a range of initial electron energies E_i.
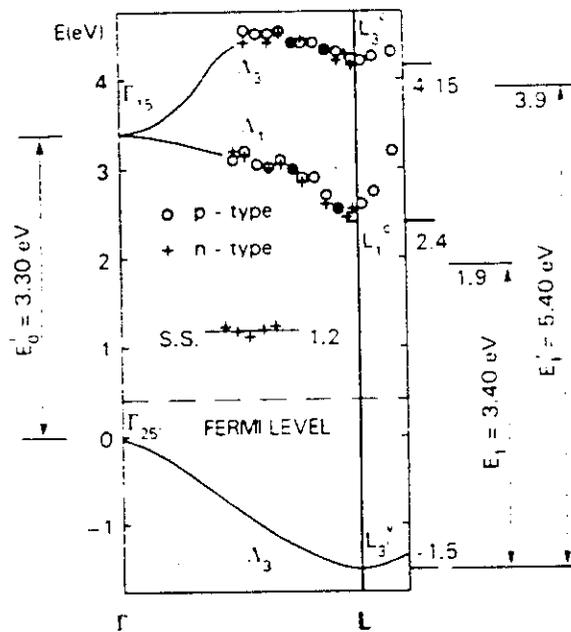
Energy dispersion of conduction-band states along ΓL as derived from inverse-photoemission data. The Λ_3^c band is from Ref. 6. and optical transition energies appropriate for $T = 300$ K are from Ref. 7. Data points marked S.S. correspond to an empty surface state on the Si(111) 2×1 surface.
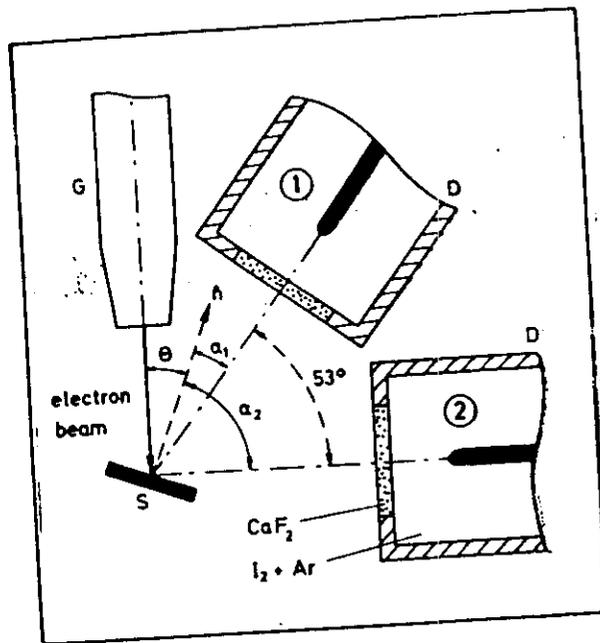
Fig. 1. Experimental setup with two photon detectors (D) for measuring light-polarization effects in inverse photoemission. G = electron gun, S = sample.
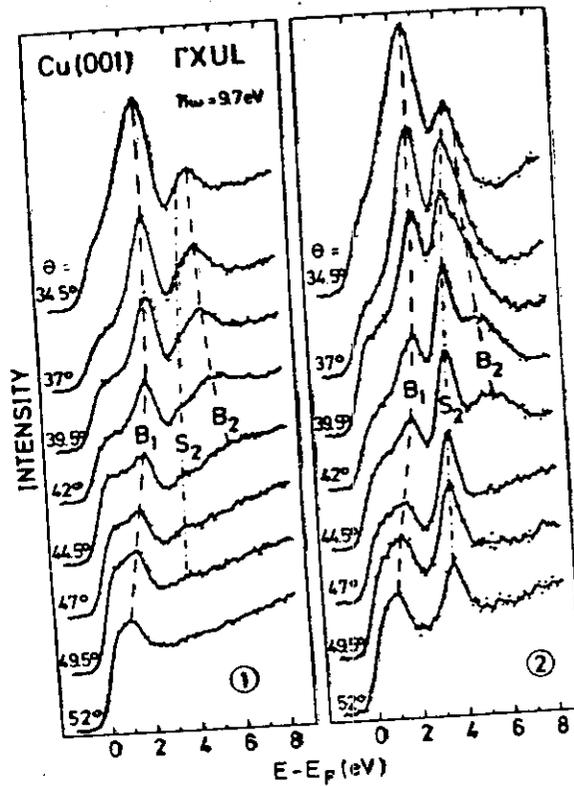
Fig. 2. Bremsstrahlung isochromat spectra of Cu(001) in the ΓXUL-azimuth for various angles of incidence. The left panel shows spectra obtained with detector 1, the right panel those of detector 2. The spectra have been renormalized to equal background intensity at 8 eV.

AES

- **Elemental sensitivity**
  via
  Kinetic energies of AES lines

- **Chemical environment sensitivity**
  via
  Shift of line energies & line shape analysis

- **Quantitative evaluation**
  via
  *Line intensity analysis
  & cross section evaluation*

- **Structural information**
  via
  Auger electron diffraction

- **Access key to many body realm**
  via
  *Spectral line shape analysis &
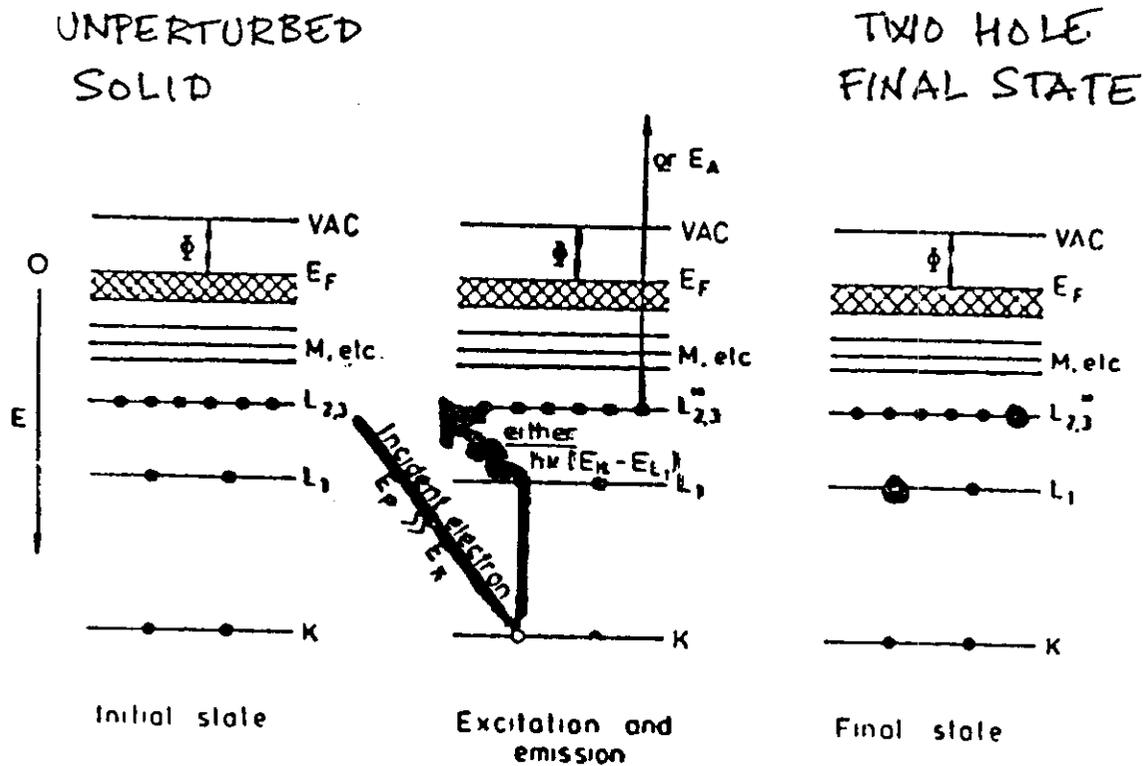 theoretical calculations*

$K\,L_1\,L_{2,3}$ AUGER TRANSITION

UNPERTURBED
SOLID

TWO HOLE
FINAL STATE

Initial state

Excitation and
emission

Final state

Figure 3.4 Schematic diagram of the process of Auger emission in a solid. The ground state of the system is shown at the left. In the centre an incident electron of energy E_p has created a hole in the core level K by ionization; for this to occur efficiently E_p should be $\geqslant \sim 5E_K$. The hole in the K shell is filled by an electron from L_1, releasing an amount of energy $(E_K - E_{L_1})$, which can appear as a photon of energy $h\nu = (E_K - E_{L_1})$ or can be given up to another electron. In this example the other electron is in the $L_{2,3}$ shell, and it is then ejected with energy $(E_K - E_{L_1} - E^*_{L_{2,3}})$; $E^*_{L_{2,3}}$ is starred because it is the binding energy not of $L_{2,3}$ in its ground state but in the presence of a hole in L_1. The doubly ionized final state is shown on the right
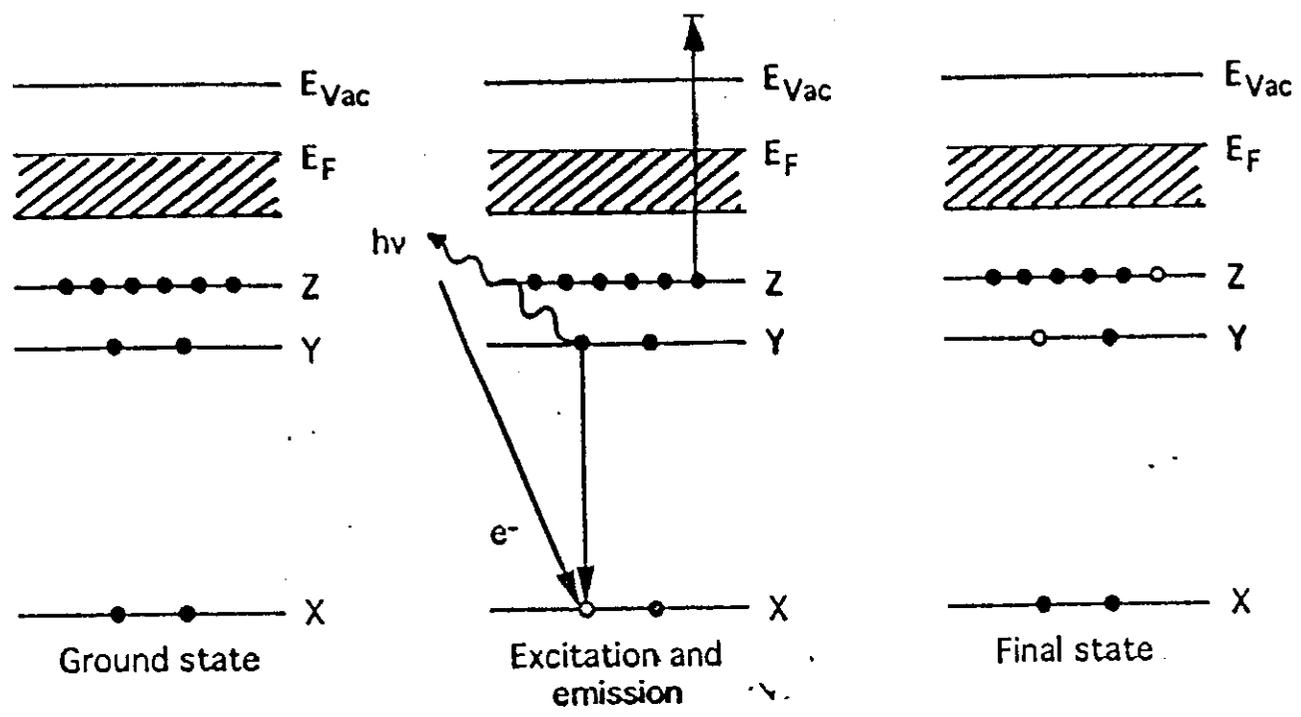
ENERGY CONSERVATION

$$E\left(K\,L_1\,L_{2,3}\right) = E_b(K) - E_b(L_1) - E_b\left(L_{2,3}\right)$$

$$E\left(ABC\right) = E_b(A) - E_b(B) - E_b(C) - \mathcal{J} + \mathcal{R}$$

$\mathcal{J} =$ TWO HOLE FINAL STATE CORRELATION EN.

$\mathcal{R} =$ RELAXATION ENERGY

| Ground state | Excitation and emission | Final state |

E_{Vac}

E_F

$h\nu$

Z

Y

e^-

X

Fig. 8

ENERGY DISTRIBUTION OF
THE e⁻ EMISSION FROM GRAPHITE
FOLLOWING PRIMARY ELECTRON
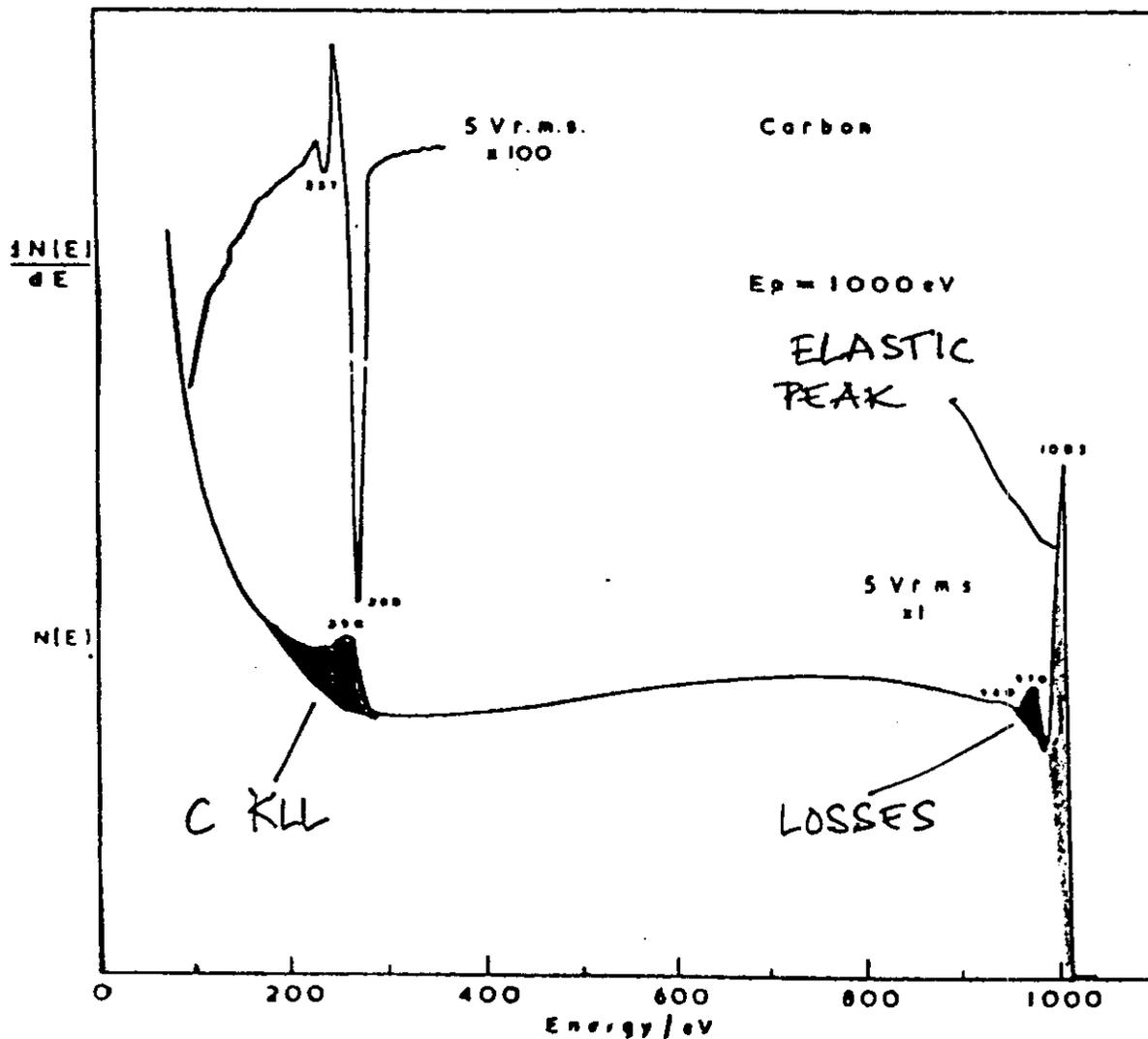BOMBARDMENT

$$E_p = 1000 \ eV$$

Figure 3.2 Lower curve: distribution of energies of secondary electrons ejected from a graphite surface by incident electrons of energy 1000 eV. Upper curve: differential distribution over the energy range containing the carbon KLL Auger peaks. In the differential distribution the peak 'position' is taken to be that of the high energy minimum, by convention
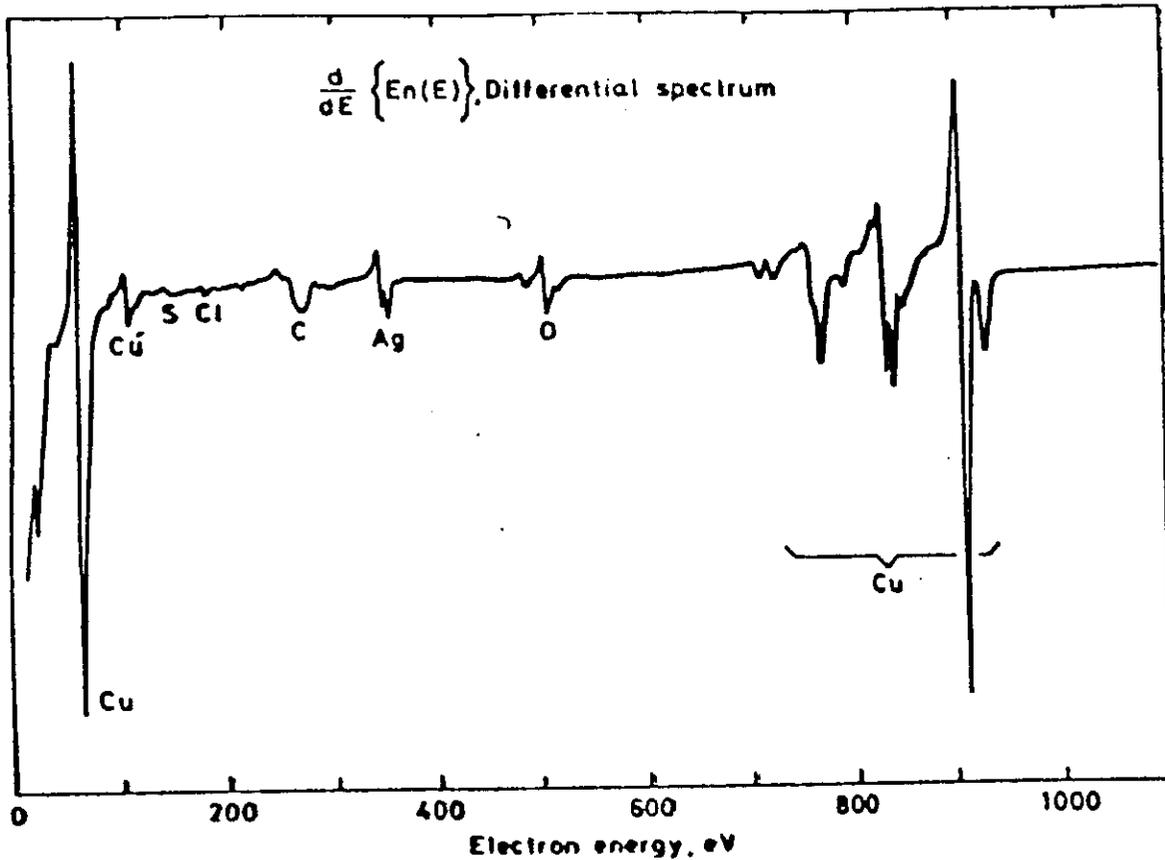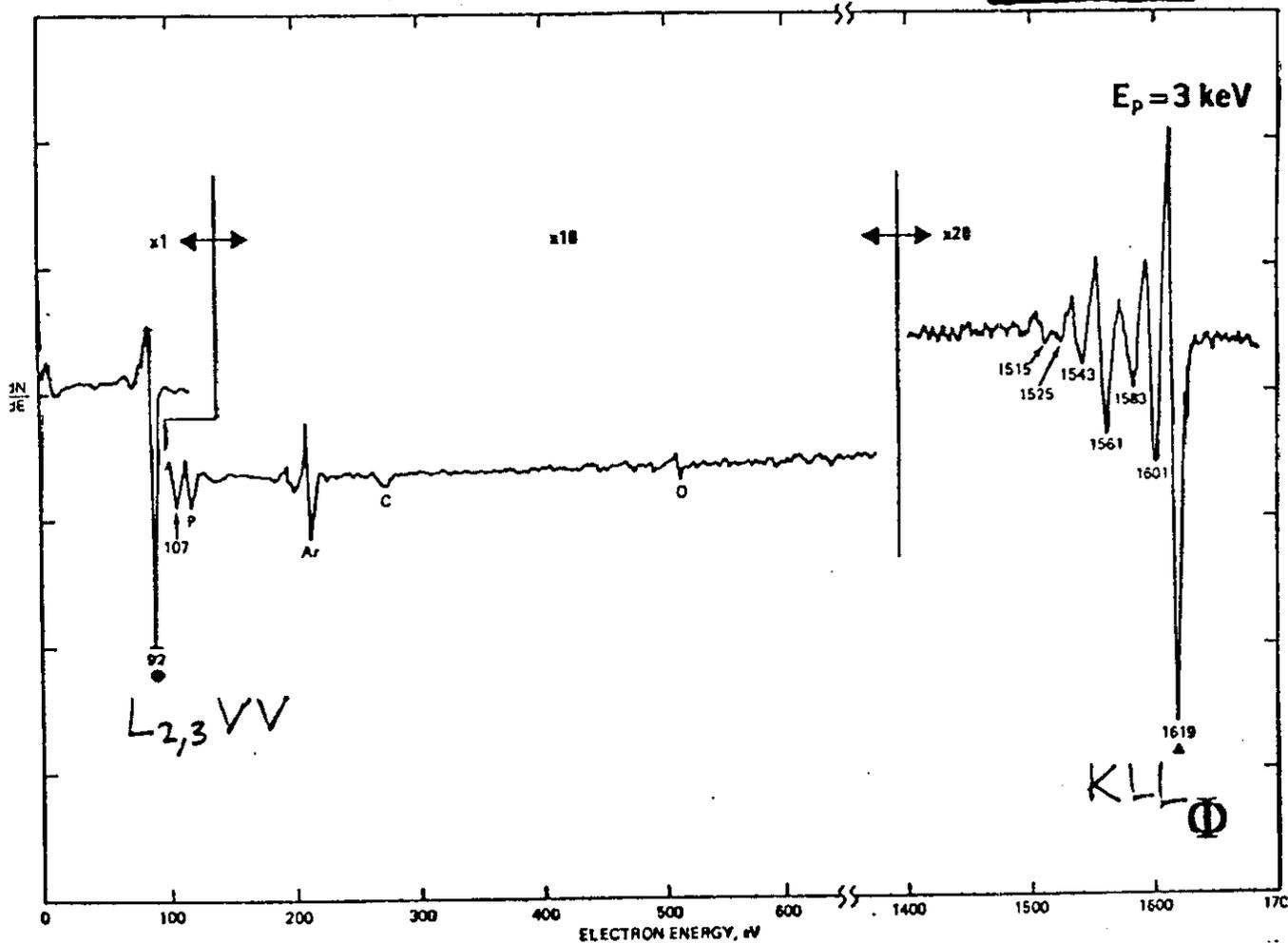
$\frac{d}{dE}\left\{En(E)\right\}$, Differential spectrum

Cu

S Cl

C

Ag

O

Cu

Cu

Electron energy, eV

(a)

En(E), Direct spectrum

Cu

Cu

C

Ag

O

Cu

S

Cl

Unscattered
Cu Auger

Inelastically scattered Cu Auger

Directly produced
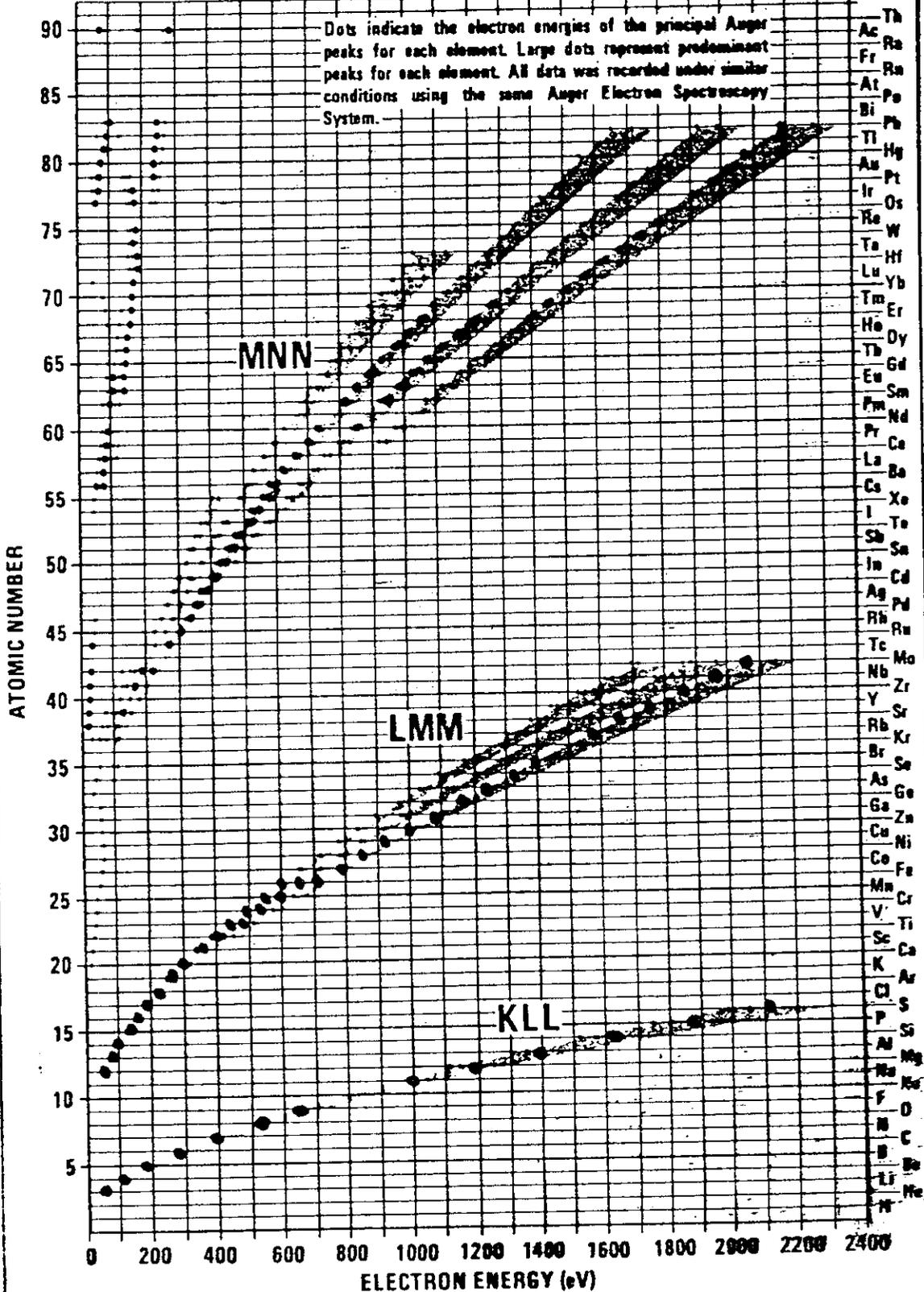secondaries

Backscattered primaries

Electron energy, eV

(b)
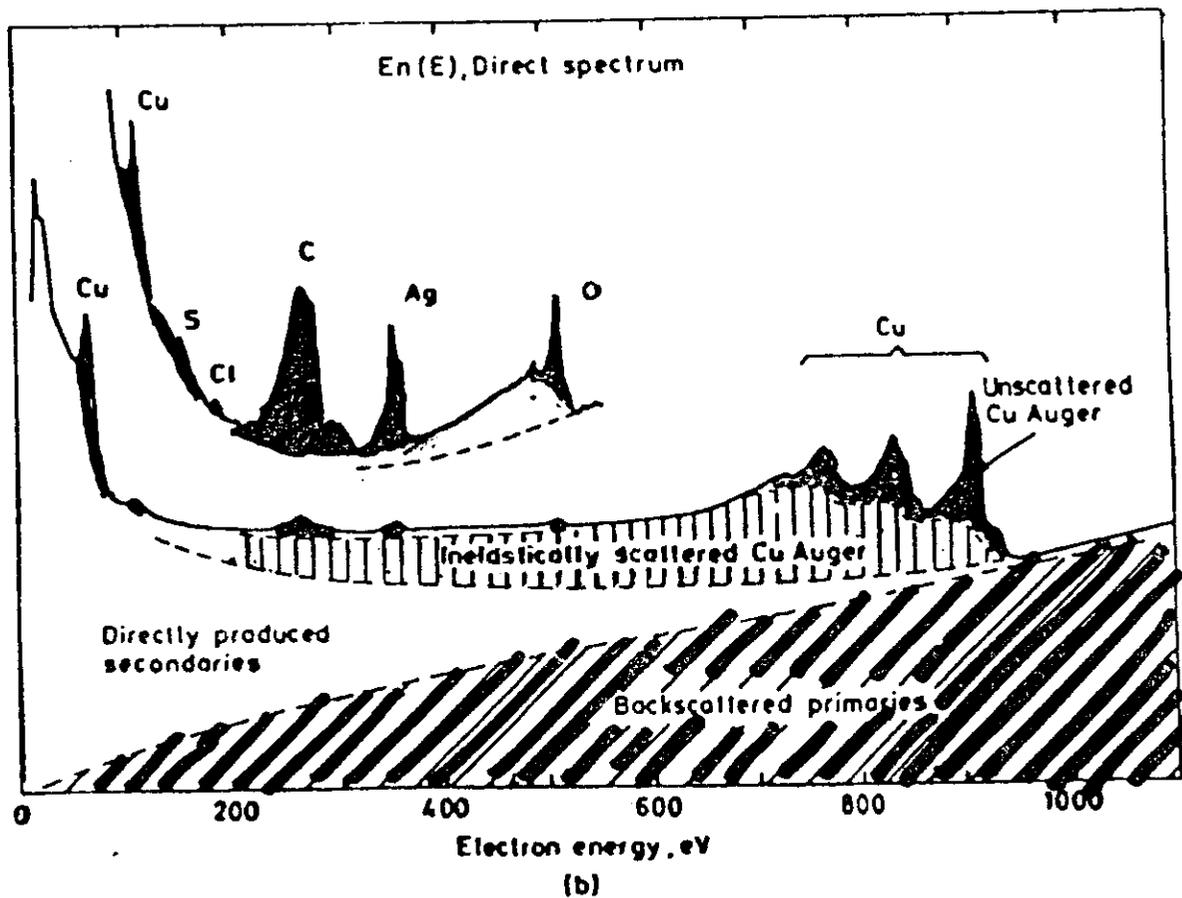
Figure 5.13 Differential and direct electron spectra from contaminated copper. (After Seah[56])

Si AUGER SPECTRUM

DERIVATIVE MODE

Silicon, Si Atomic Number 14

$E_p = 3\ keV$

x1   x10   x20

$\frac{dN}{dE}$

1515
1525
1543
1583
1561
1601

P
107

Ar

C

O

92
$L_{2,3}VV$

1619
KLL Φ

ELECTRON ENERGY, eV

0   100   200   300   400   500   600   1400   1500   1600   170

PRINCIPAL AUGER ELECTRON ENERGIES

Dots indicate the electron energies of the principal Auger peaks for each element. Large dots represent predominant peaks for each element. All data was recorded under similar conditions using the same Auger Electron Spectroscopy System.

MNN

LMM

KLL

ATOMIC NUMBER

ELECTRON ENERGY (eV)

INTERMEDIATE   COUPLING
J-J

Figure 3.1 The transition from pure *L–S* through intermediate to pure *j–j* coupling across the Periodic Table, and its effect on relative energies in the *KLL* Auger series. (Reproduced from Sevier[2] by permission of John Wiley & Sons Inc.)

DE-EXCITATION PROCESSES

FOLLOWING ATOM IONIZATION

PROBABILITY OF AUGER e⁻ EMISSION

Versus

PROBABILITY OF X-RAY FLUORESCENCE
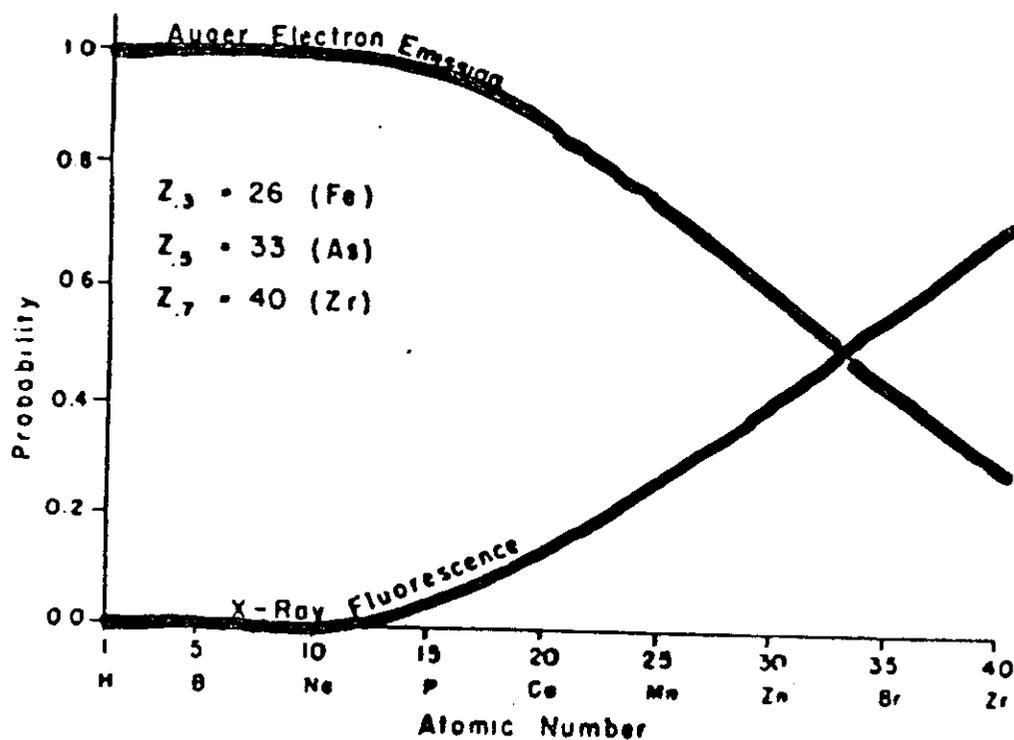
Figure 3.5 Relative probabilities of relaxation by emission of an Auger electron and by emission of an X-ray photon of characteristic energy, following creation of a core hole in the K shell

AES
FRAGMENTS OF THEORY

MATRIX ELEMENT

$$M_{if} = \langle i | \frac{1}{r} | f \rangle$$

$$|i\rangle \qquad |\psi_A \psi_K\rangle$$

$$|f\rangle \qquad |\psi_B \psi_C\rangle$$

- ANGULAR MOMENTUM CONSERVATION

- PARITY CONSERVATION

- CORE – VALENCE – VALENCE   CVV
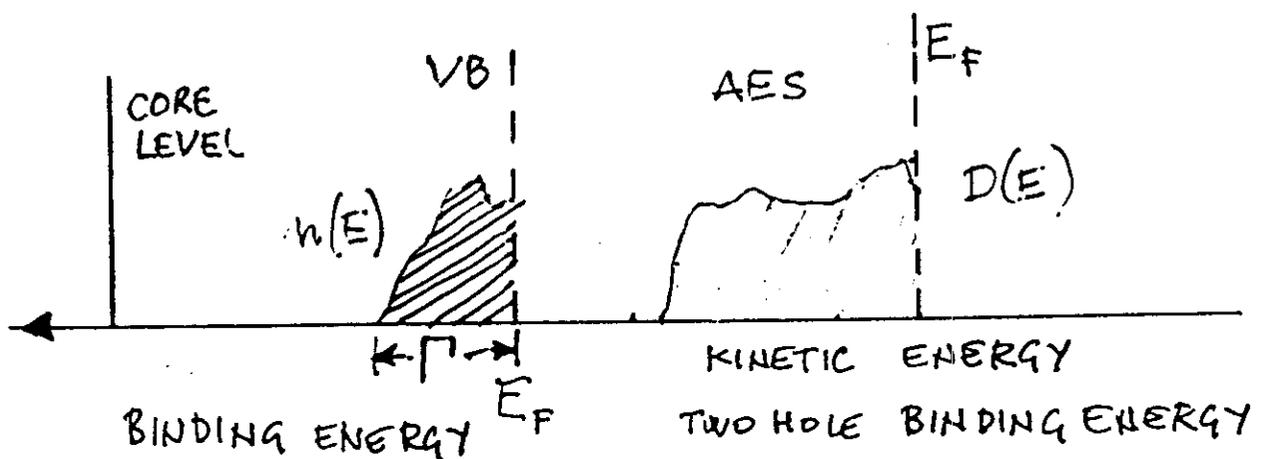
$$D(E) \propto n(E) * n(E) = \int \rho(E-\varepsilon)\, \rho(\varepsilon)\, d\varepsilon$$

SELF-FOLDED DENSITY OF STATES
PROJECTED ONTO THE CORE HOLE SITE

BASIC COMPONENTS FOR AES

- UHV APPARATUS

- SAMPLE

- ELECTRON GUN

- ELECTRON ENERGY ANALYSER

- ELECTRON DETECTOR

- ANALOG SIGNAL ELECTRONICS and/or PULSE COUNTING ELECTRONICS
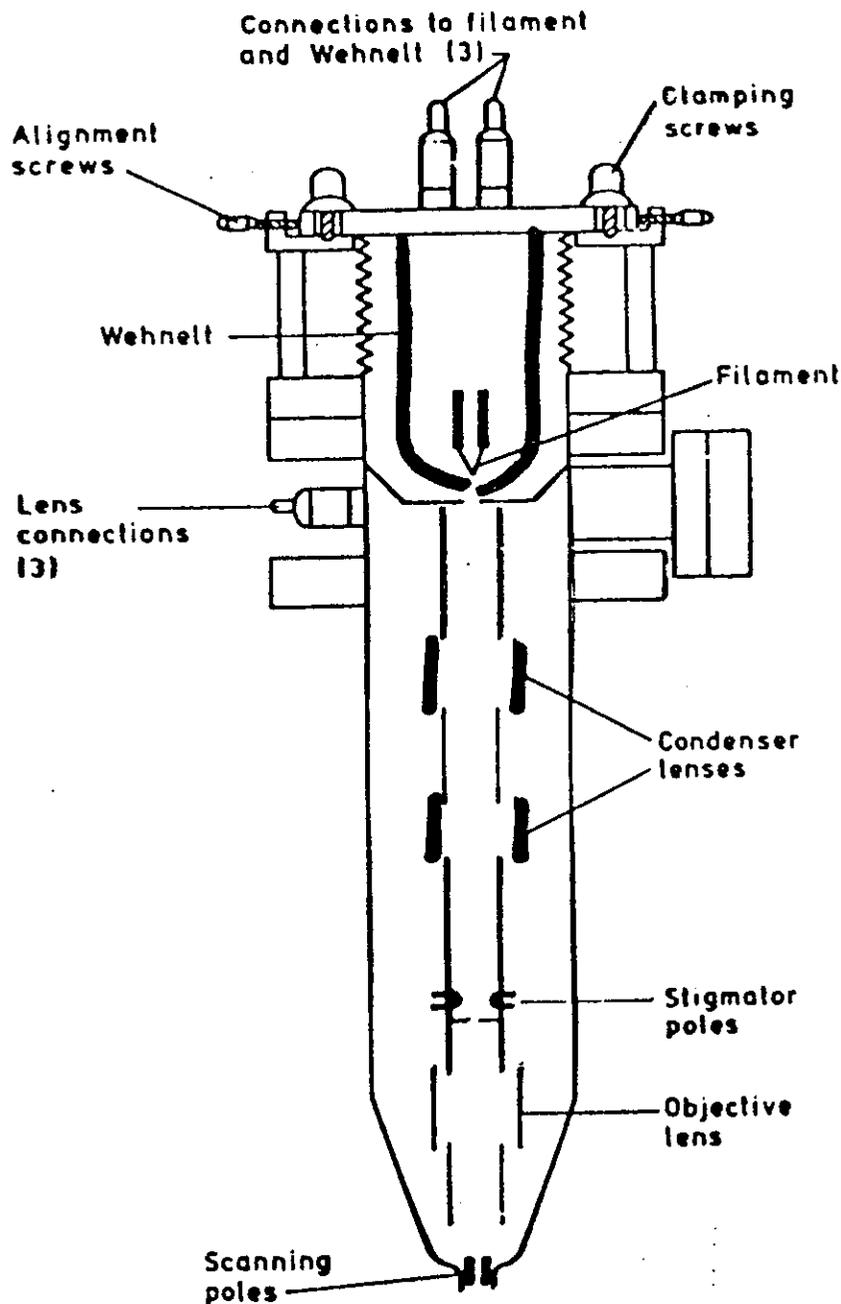
ELECTRON GUN

Figure 2.23 Example of an electrostatically focused electron gun for operation at energies up to 10 keV and currents between 1 and 10 nA. The filament and Wehnelt cylinder can be adjusted in position together by screws operating on a flexible bellows. Two condenser lenses and an objective lens perform the focusing, and beam rastering is carried out by a set of orthogonal plates at the end of the electron optical column. Optimum spot size obtainable is about $0.2\,\mu m$, but a $0.5\,\mu m$ spot is more normal in everyday use. (Reproduced by permission of Vacuum Generators Scientific Ltd)

HOW TO DECIDE THE ENERGY OF
THE PRIMARY ELECTRON BEAM

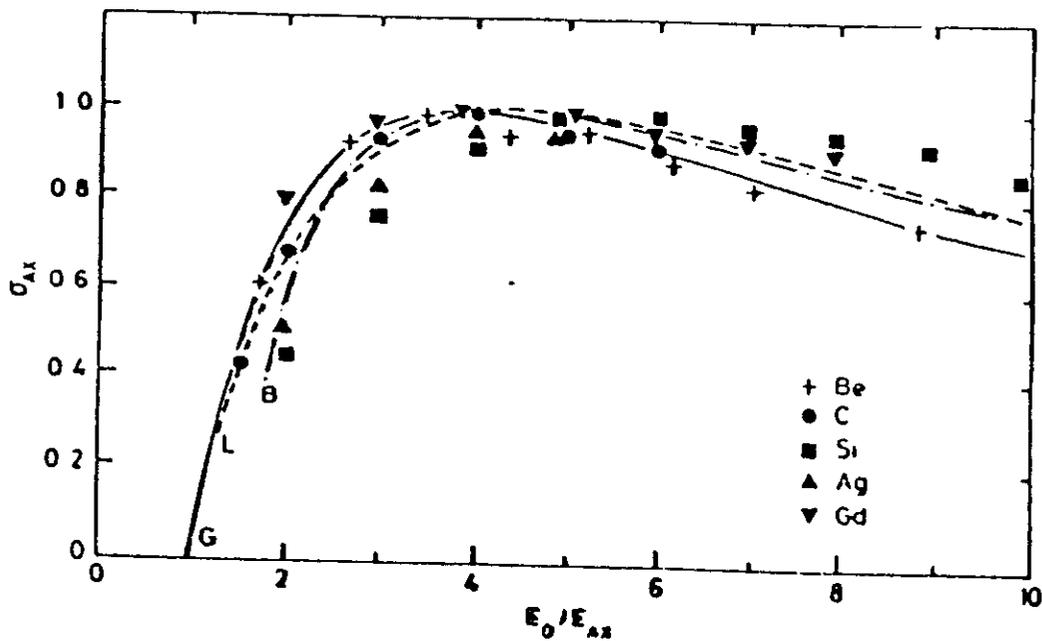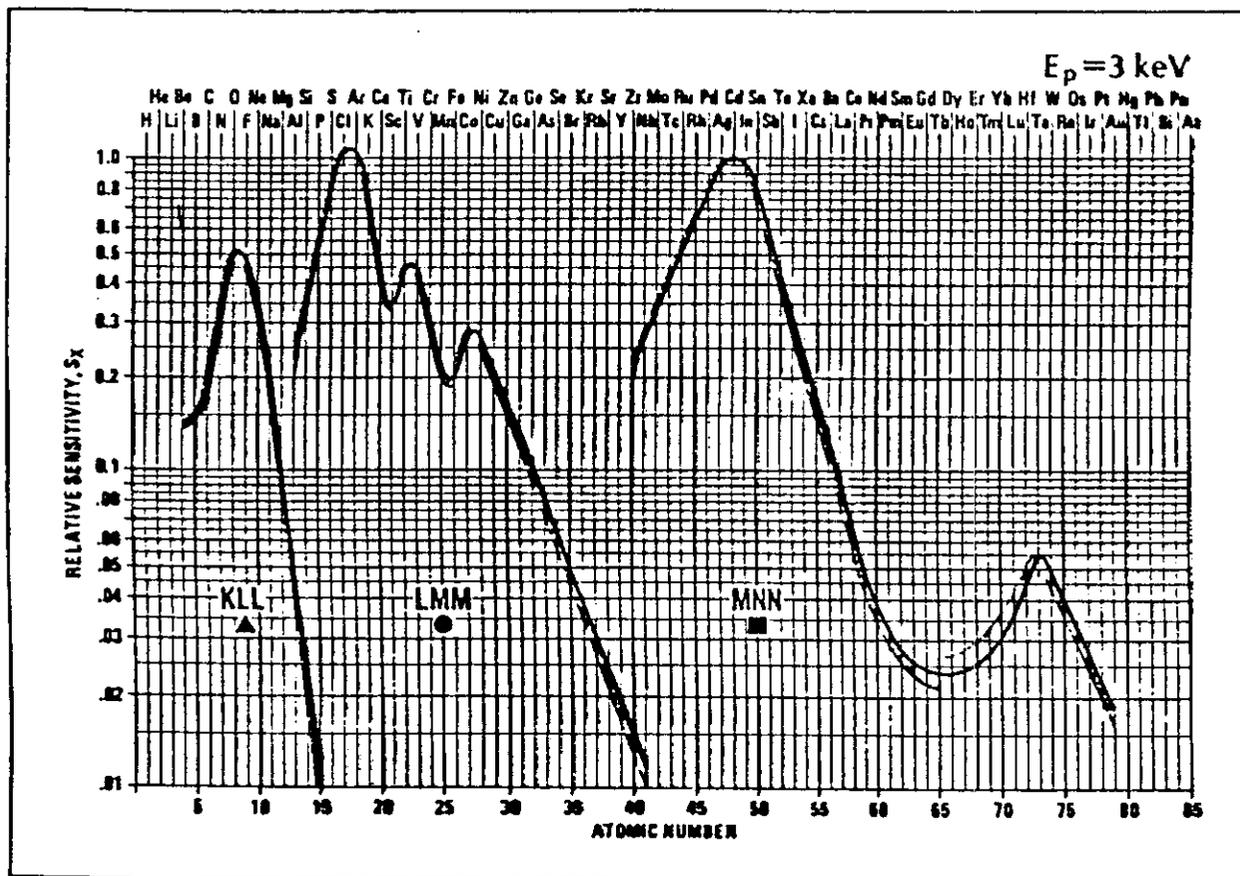IONIZATION CROSS SECTION FOR LEVEL 'X'[a]
versus
PRIMARY BEAM ENERGY $\left(E_0 / E_{Ax} \right)$

Figure 5.2 The energy dependence of the Bethe,[7] (B) Gryzinski[8] (G) and Lotz[9] (L) cross-sections for ionizing level X, together with experimental measurements for beryllium,[10] carbon, silicon, silver and gadolinium[11]

E_{Ax} = IONIZATION ENERGY OF LEVEL "X"

E_0 = PRIMARY BEAM ENERGY
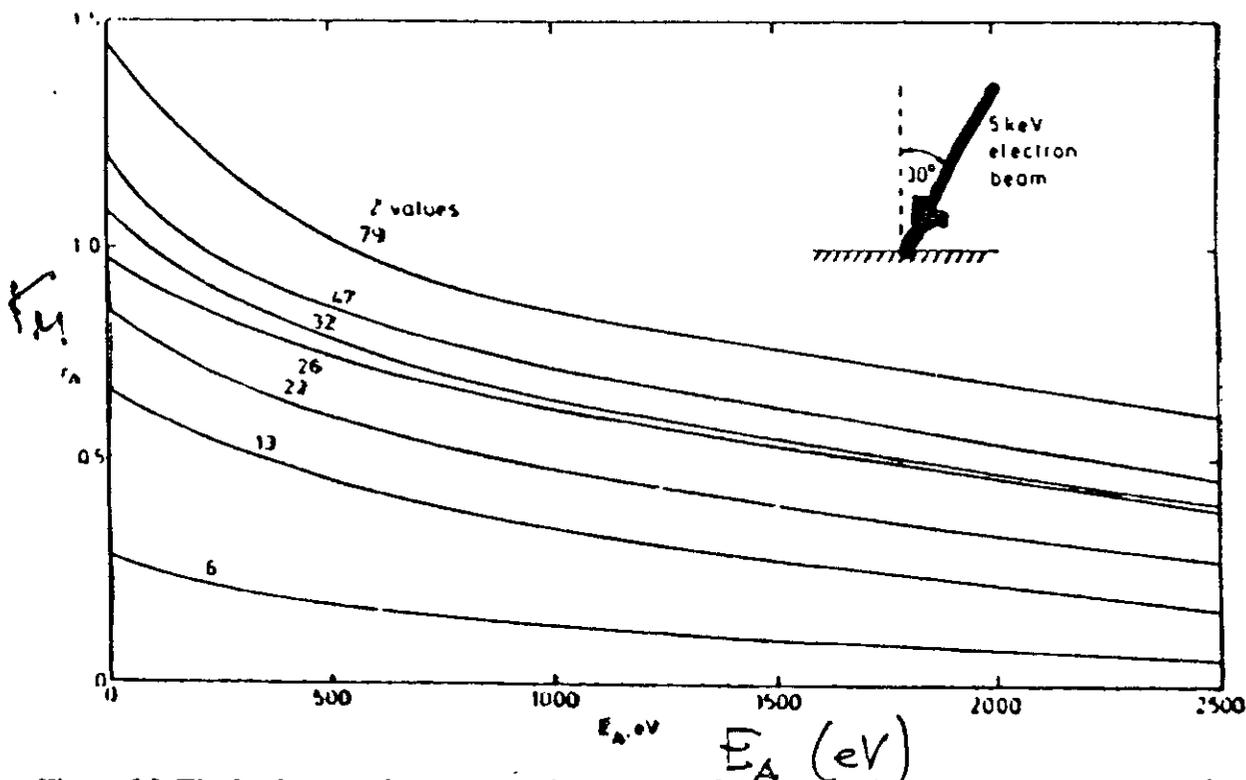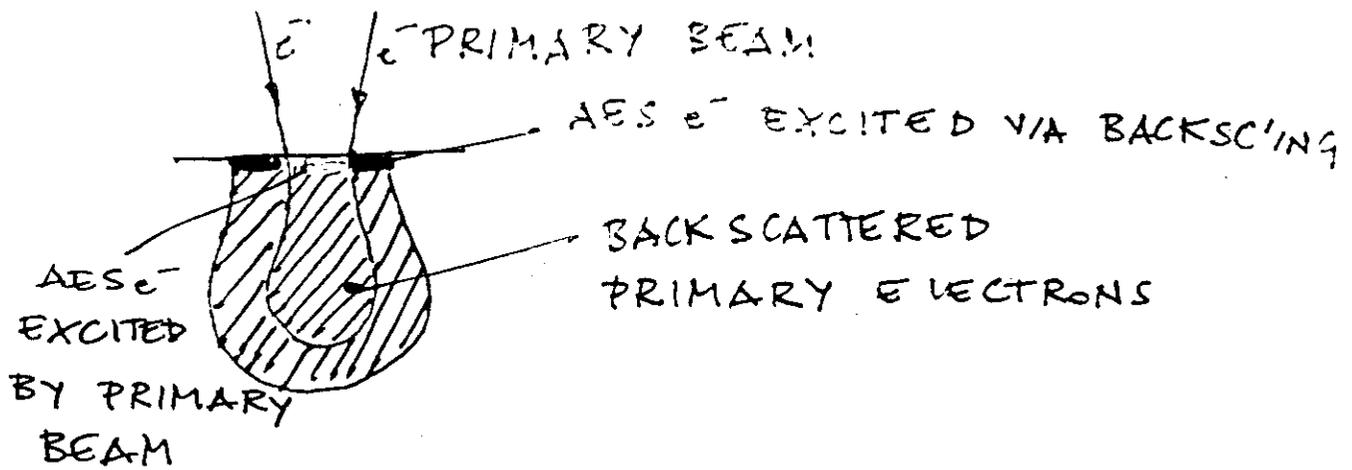
Relative Auger Sensitivities of the Elements

$E_p = 3\,keV$

e^- e^- PRIMARY BEAM

AES e^- EXCITED VIA BACKSC'ING

BACK SCATTERED PRIMARY ELECTRONS

AES e^- EXCITED BY PRIMARY BEAM

Z values
74
67
32
26
22
13
6

5 keV electron beam
30°

r_M

1.0

0.5

0

0   500   1000   1500   2000   2500

$E_A \cdot eV$ $E_A \, (eV)$

Figure 5.3 The back-scattering term, r_M, for a range of elements using 5 keV electrons at 30° from the surface normal, from the calculations of Shimizu and Ichimura[12,13,15]

$$\sigma_{Ax}\left[1 + r_M\left(E_{Ax}; E_0; \alpha\right)\right]$$

r_M BACK SCATTERING TERM (MATRIX DEPENDENT)

BINARY SYSTEMS

TRUE COMPOSITION
versus

COMPOSITION DEDUCED IGNORING THE MATRIX TERM
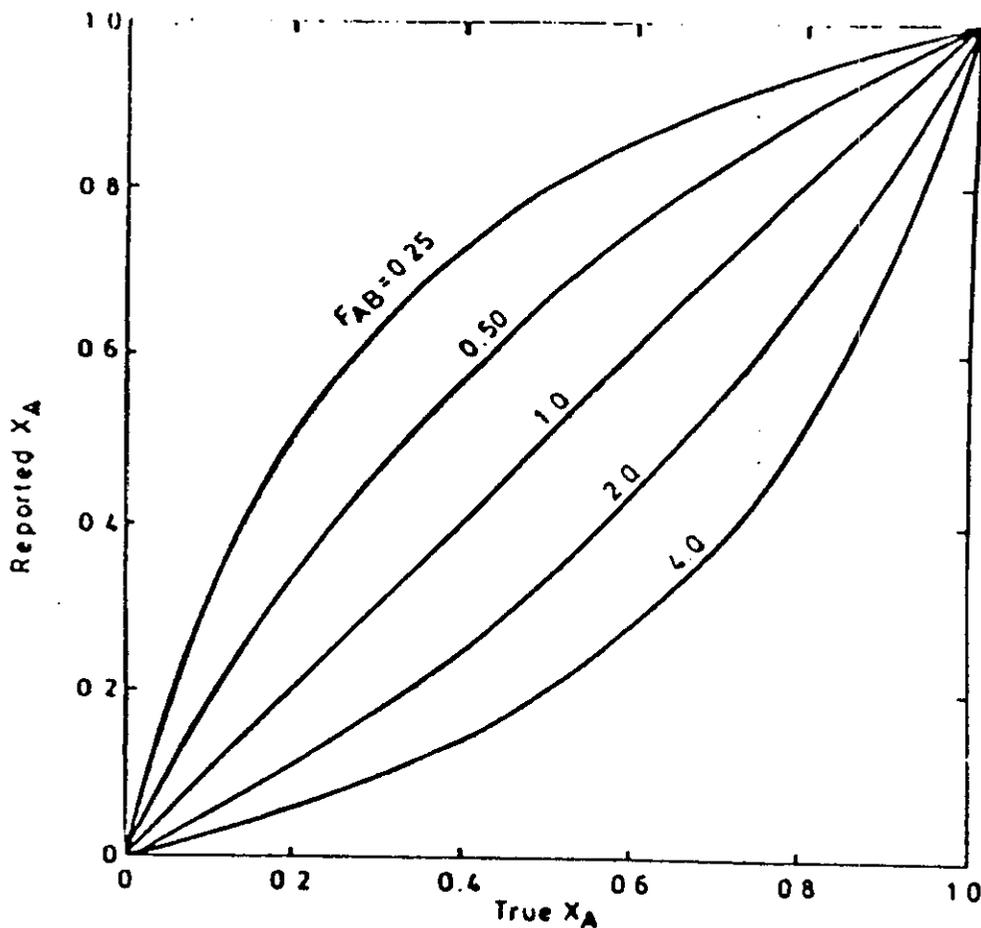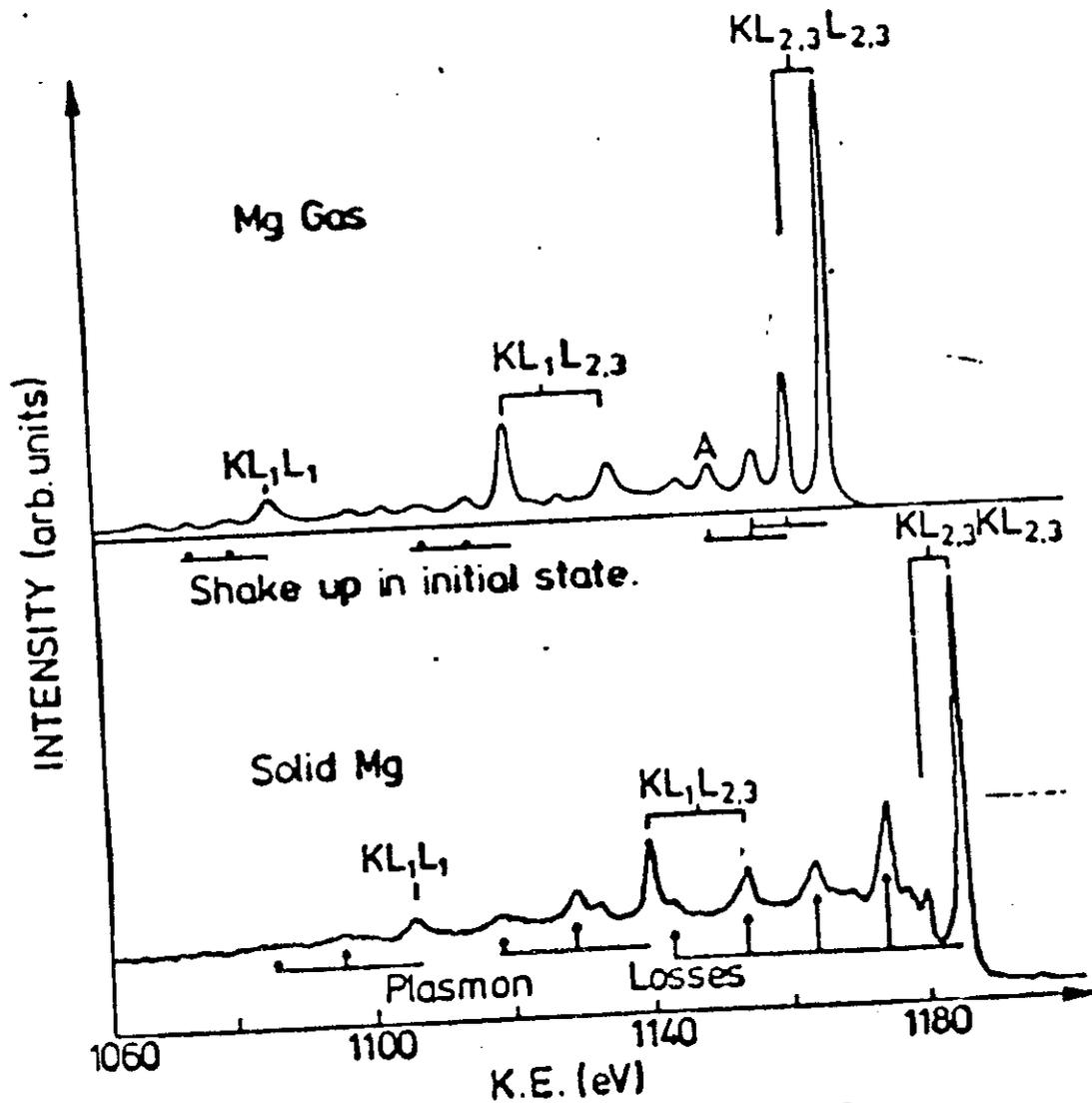

Figure 5.6 A comparison between the true composition and that deduced ignoring the matrix term
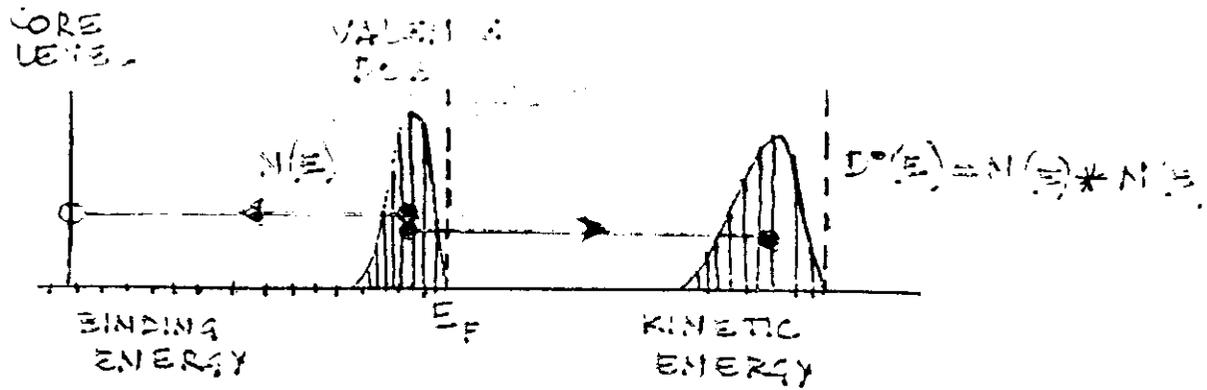
AES

GAS PHASE

versus

SOLID PHASE

12. The KLL Auger spectra of Mg gas[115] and solid Mg.[119]

AES

- ELEMENTAL SENSITIVITY
  via
  KINETIC ENERGIES OF AES LINES

- CHEMICAL ENVIRONMENT SENSITIVITY
  via
  SHIFTS OF LINE ENERGIES
  & LINESHAPE ANALYSIS

- QUANTITATIVE EVALUATION
  via
  LINE INTENSITIES &
  SENSITIVITY FACTORS

- STRUCTURAL INFORMATION
  via
  AUGER ELECTRON DIFFRACTION

- ACCESS KEY TO MANY BODY REALM
  via
  LINESHAPE ANALYSIS &
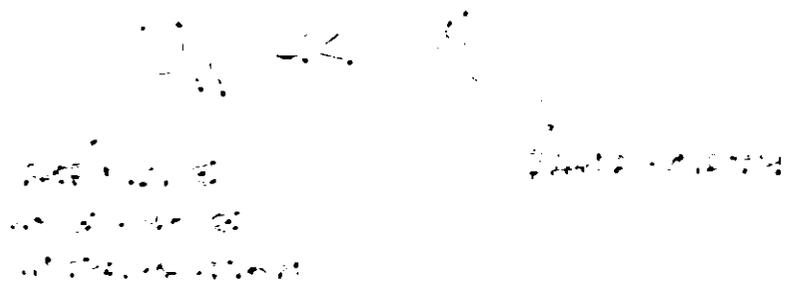 THEORETICAL CALCULATIONS

CORE
LEVEL

VALENCE
DOS

$N(E)$

$D^\circ(E) = N(E) * N(E)$

BINDING
ENERGY

E_F

KINETIC
ENERGY

$$I(E) = D^\circ(E) = N(E) * N(E)$$

$$N(E) = N_{\ell'}(E) + N_{\ell''}(E)$$

$$\tilde{N}(E) = \alpha N_{\ell'}(E) + N_{\ell''}(E) \qquad \text{WEIGHTED DOS}$$

$$\tilde{I}(E) = \tilde{N}(E) * \tilde{N}(E) \qquad \text{SELF-CONVOLUTED TRANSITION DOS}$$

CORE-VALENCE-VALENCE (CVV)
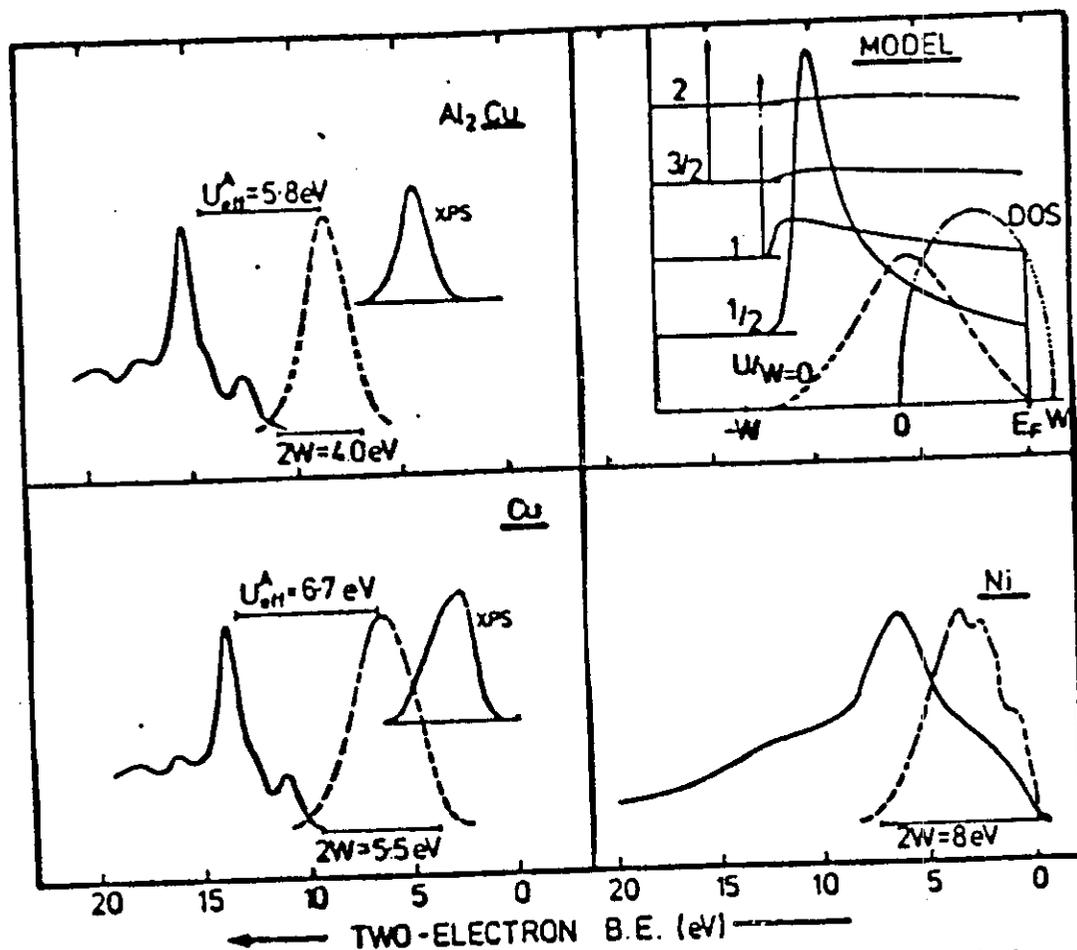AUGER TRANSITIONS IN A
PURE BAND-LIKE SCHEME

III-V's = (SP) MATERIALS

Fig. 9. Illustration of the effect of $U_{eff}^A/2W$ on LVV Auger spectra. Top right: results in one band model[124] showing how increasing the Coulomb repulsion first distorts the band and then causes a split-off state to occur. Experimental examples for the multiband case with Cu, Al$_2$Cu. and Ni are given:[82] (———) AES result, (— — —) self convoluted XPS d-bands for Al$_2$Cu and Cu and theoretical self convoluted density of occupied states for Ni (from Liebsch[124]). XPS bands of Ni may contain two hole effects[143] and are not given. Note that U_{eff}^A should be measured to the centre of gravity of the Auger bands.

CORE - VALENCE - VALENCE   AES

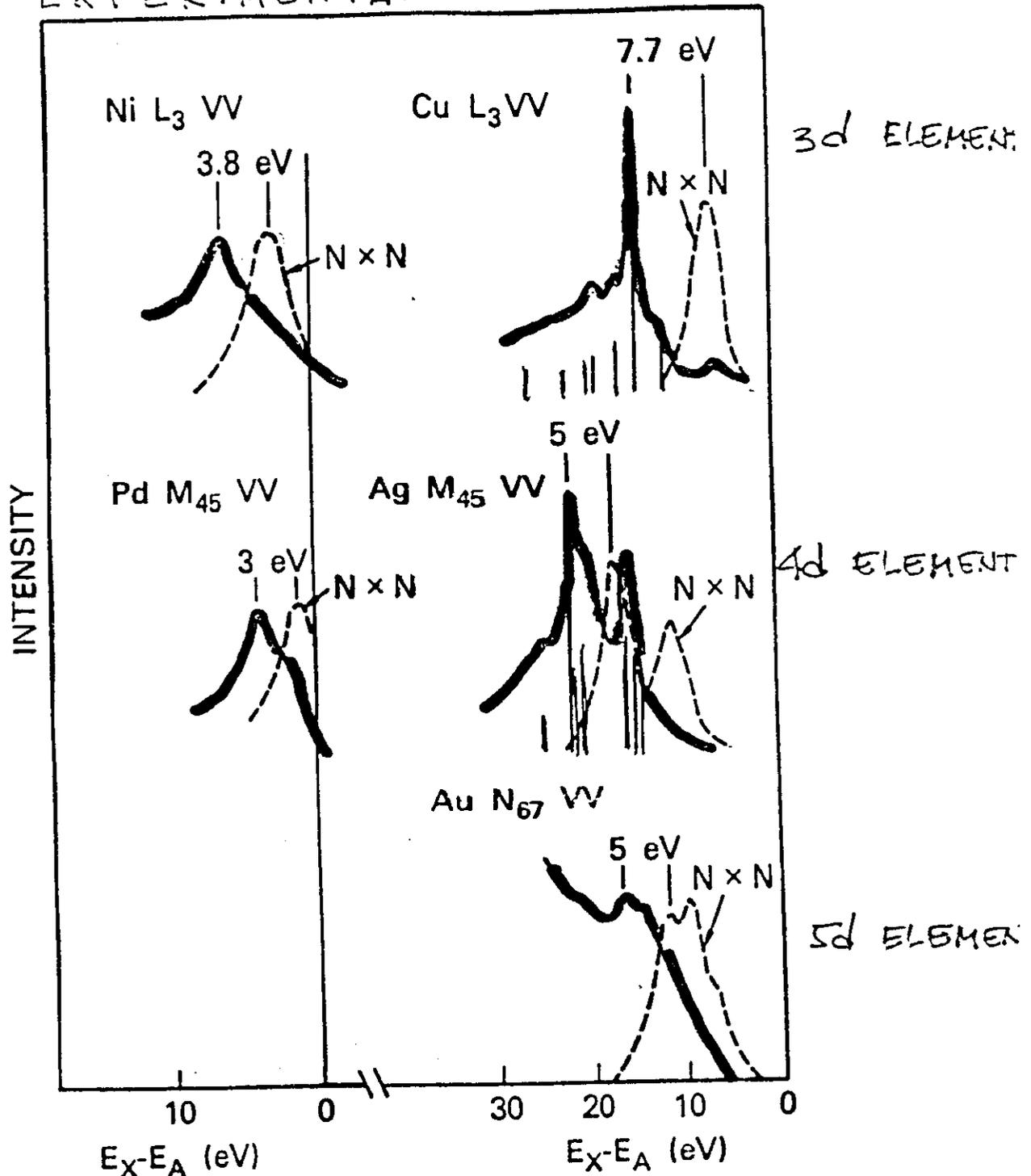SELF-FOLDED   VALENCE DENSITY OF STATES
EXPERIMENTAL · LINESHAPES

FIGURE 10. Comparison of the CVV Auger line shapes for the transitional metals as indicated in Figure 9 with the fold of the one-electron DOS. The vertical bars from Cu and Ag indicate results from an atomic calculation. E_x is the core-binding energy and E_A the Auger electron kinetic energy. (From Ramaker, D. E., *Chemistry and Physics of Solid Surfaces IV*, Vanselow, R. and Howe, R., Eds., Springer-Verlag, Berlin, 1982, 19. With permission.)

BAND WIDTH $\left(\Gamma_{nd}\right)$

versus

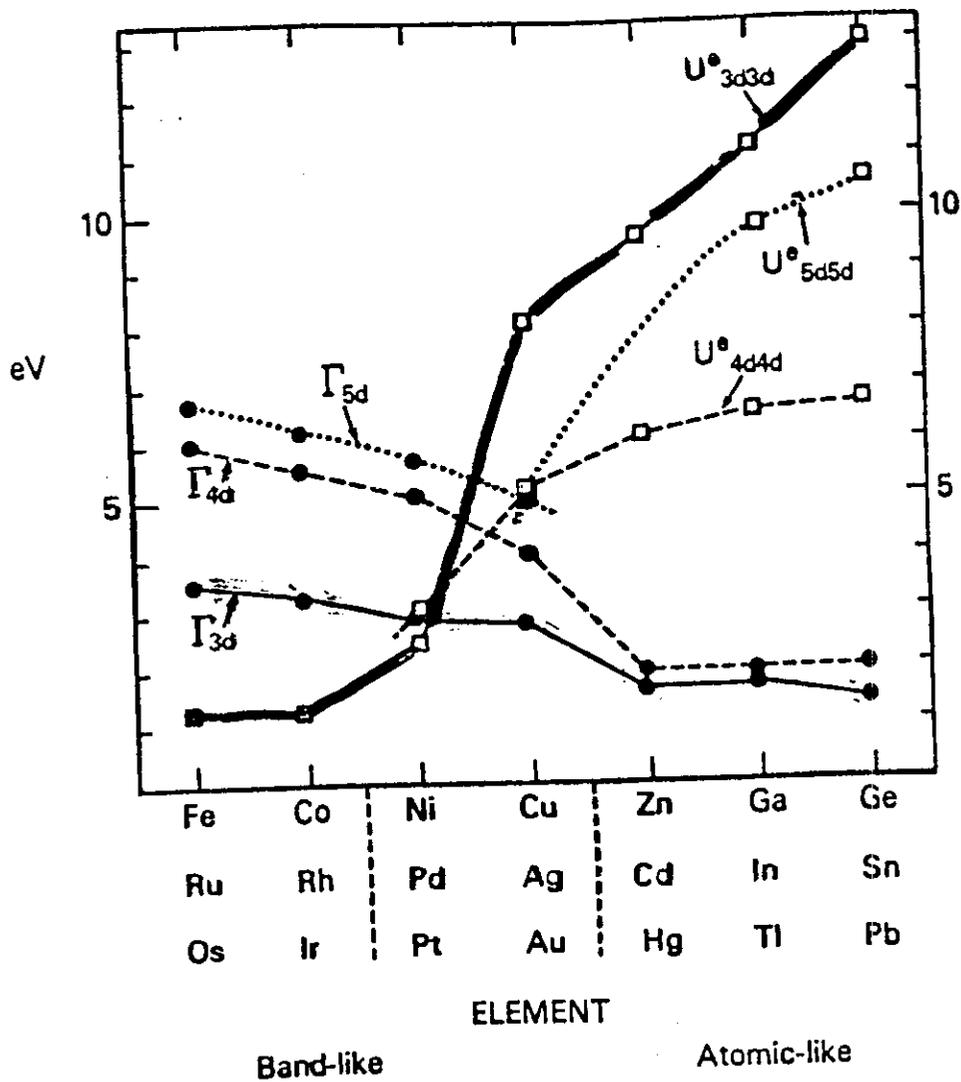HOLE-HOLE REPULSION ENERGY $\left(U^e_{hd\,hd}\right)$

FIGURE 9. Comparison of the bandwidth (Γ_{nd}) with the effective hole-hole repulsion (U^e_{nand}) of the metals with electron configuration d^8s^2 to $d^{10}s^2p^2$.[94] Metals with bandlike and atomiclike line shapes are indicated; those between the dashed lines are transitional. (From Ramaker, D. E., *Chemistry and Physics of Solid Surfaces IV*, Vanselow, R. and Howe, R., Eds., Springer-Verlag, Berlin, 1982, 19. With permission.)

$U \ll \Gamma$ BAND-LIKE

$U \gg \Gamma$ ATOMIC-LIKE

CARBON - BASED SYSTEMS

SELF-FOLDED DENSITY OF STATES
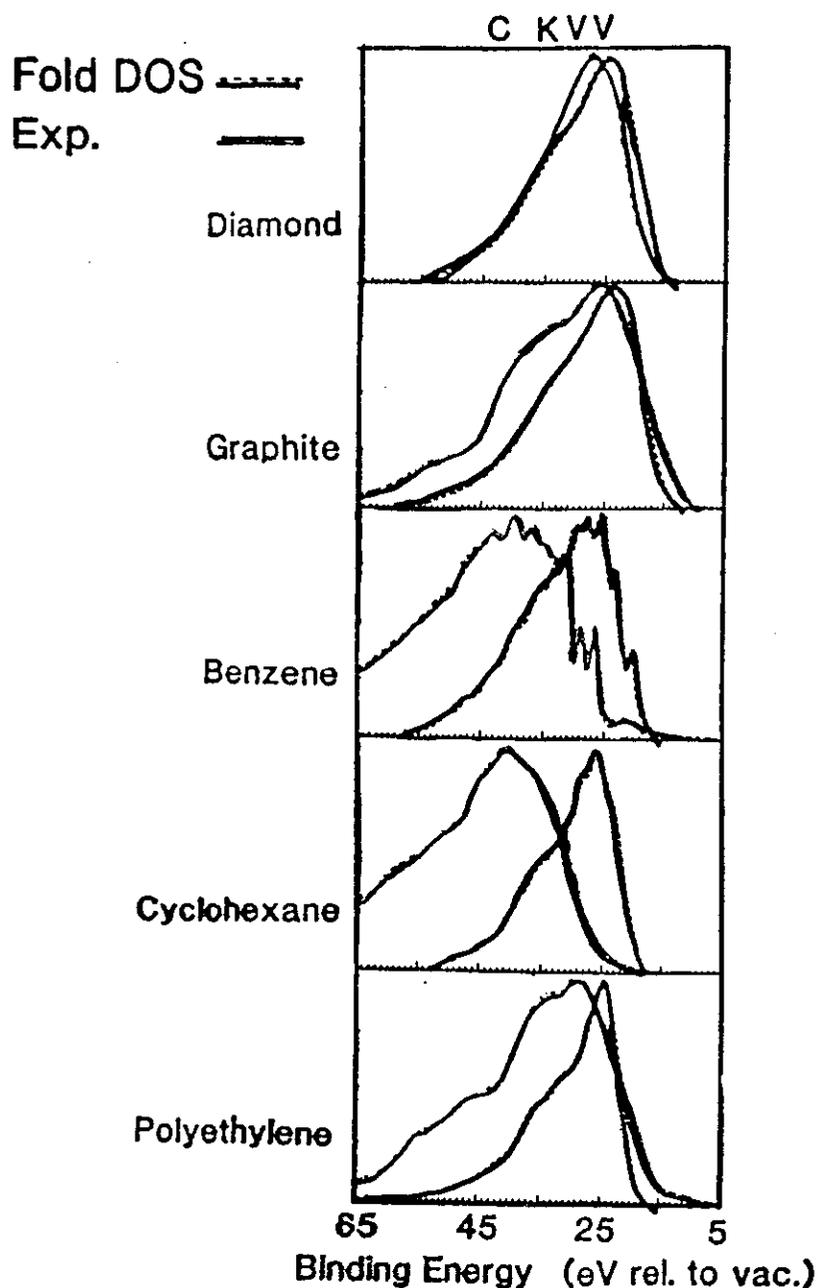### Versus
C KVV AUGER EXPERIMENTAL PROFILES

FIGURE 6. Comparison of the experimental C KVV Auger line shapes (solid line) obtained from the literature for diamond,[73] graphite,[67] benzene,[77] cyclohexane,[53] and polyethylene[76] with the self-fold of the DOS (dotted line) obtained as described in the text. (From Ramaker, D. E., *Applic. Surf. Sci.*, 21, 1, 1985. With permission.)

Si L$_{23}$VV

Experiment ———
Theory, U=0,
        Opt. - - - -
Theory, U=0,
    Table 1 ....

pp

sp

ss
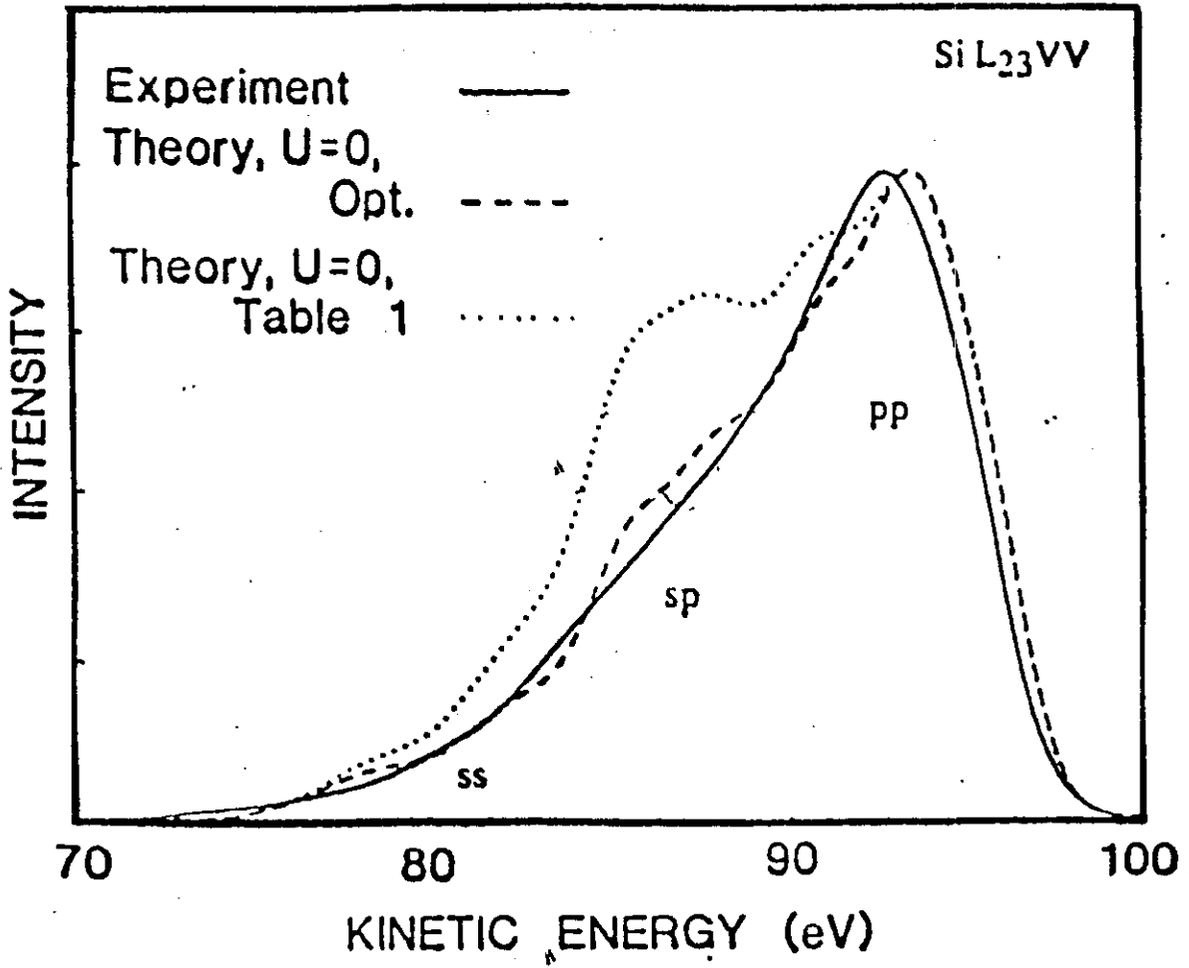
KINETIC ENERGY (eV)

INTENSITY

70   80   90   100

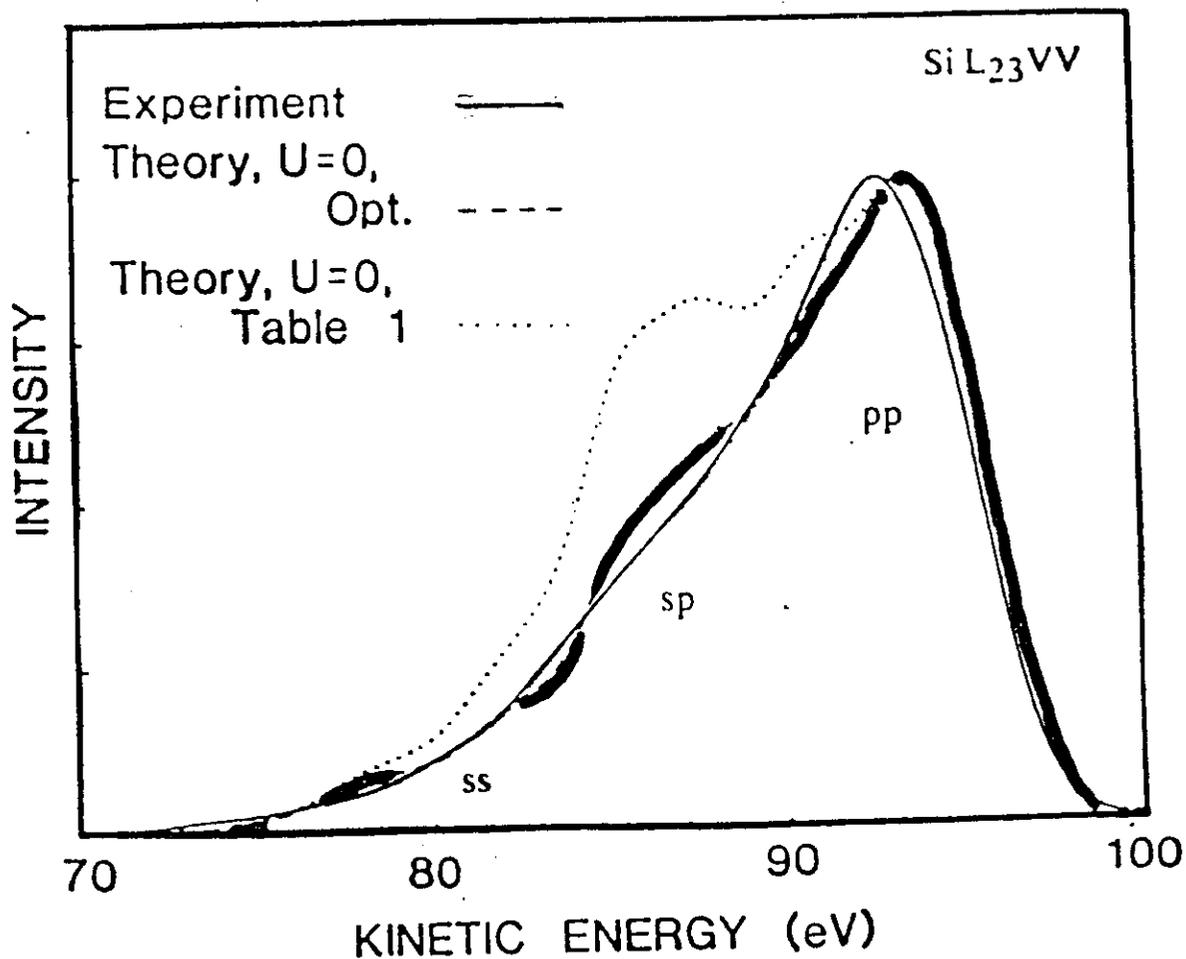Fig. 16

CORE -VALENCE -VALENCE
BAND-LIKE SPECTRUM

FIGURE 15. Comparison of the experimental Si L₂₃VV Auger line shape for elemental Si with the theoretical line shape obtained by utilizing optimal matrix elements (dashed line) and with the matrix elements predicted from Figure 8 (dotted line) (both sets of matrix elements are given in Table 1). The theoretical fits were obtained with U = 0 in Equation 6.⁹⁰ (From Almbladh, C. O. and Morales, A. L., *Phys. Rev.*, B39, 3503, 1989. With permission.)
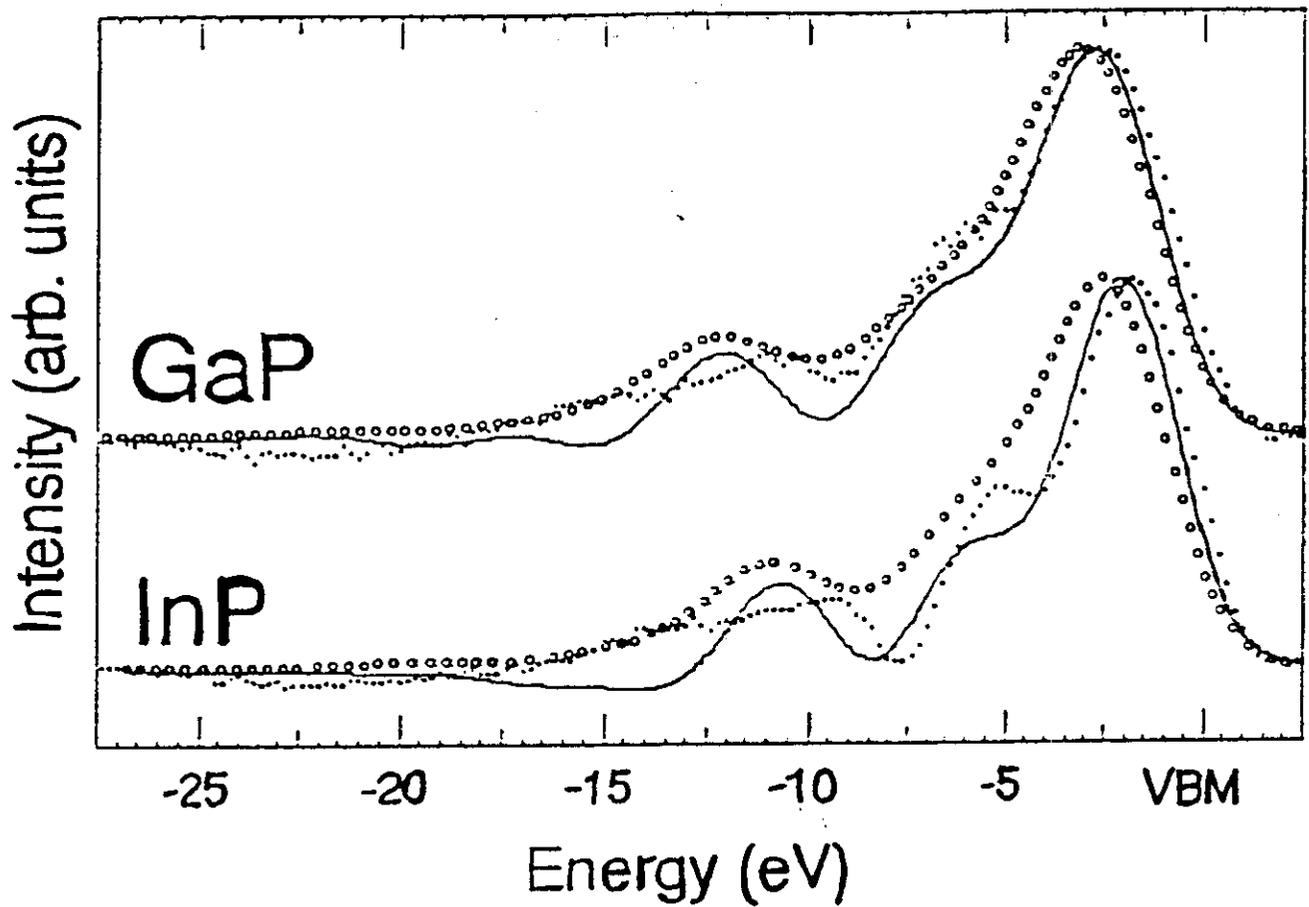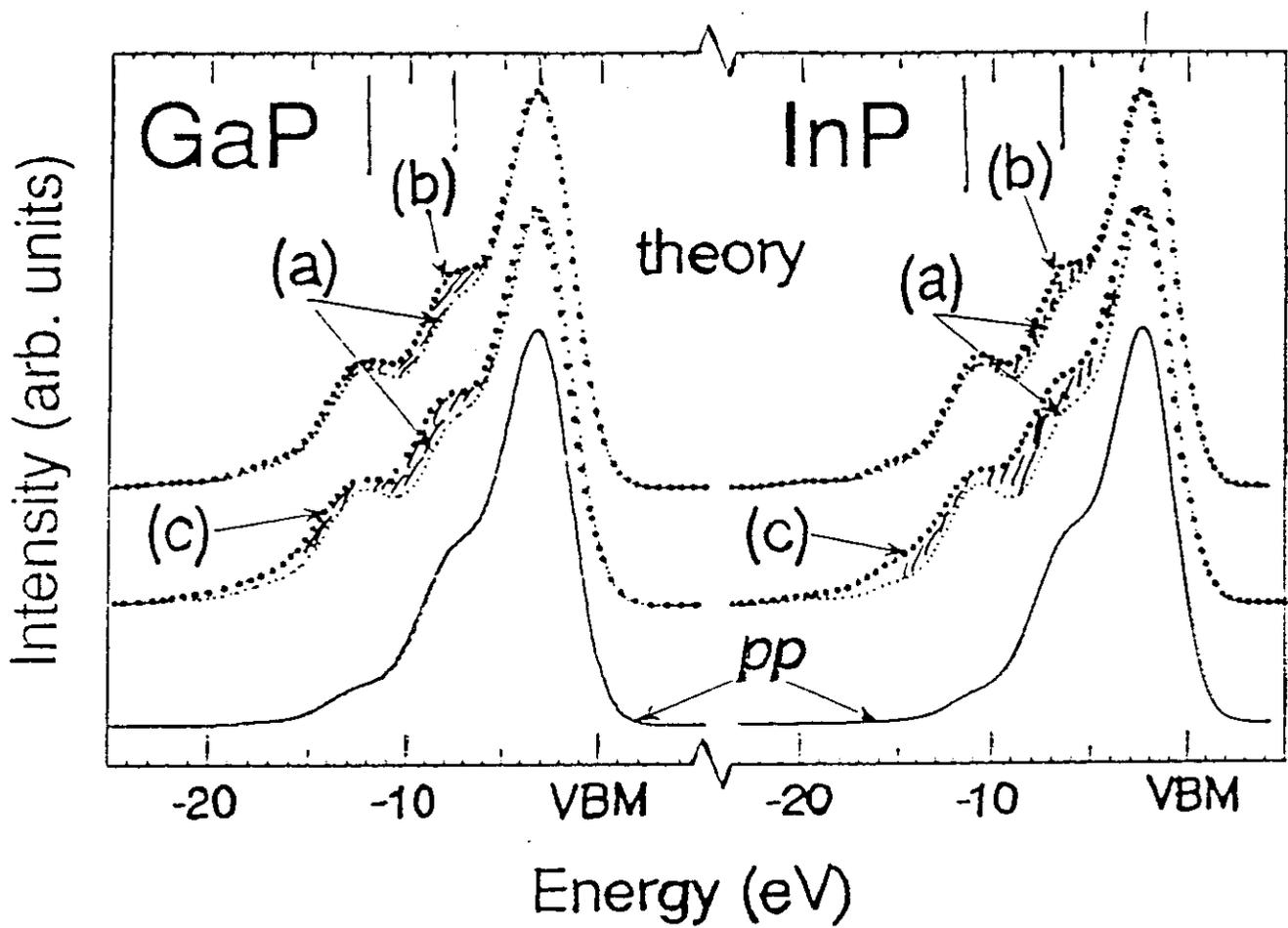
..... EXPERIMENTAL DIFFERENCE
CURVE   [CLEAVED] - [Sb]

o o o o o   1st LAYER   SELF-CONVOLUTED
TRANSITION   DOS

———   THEORETICAL DIFFERENCE
CURVE   [CLEAN] - [Sb]
- RESCALED

SURFACE VALENCE
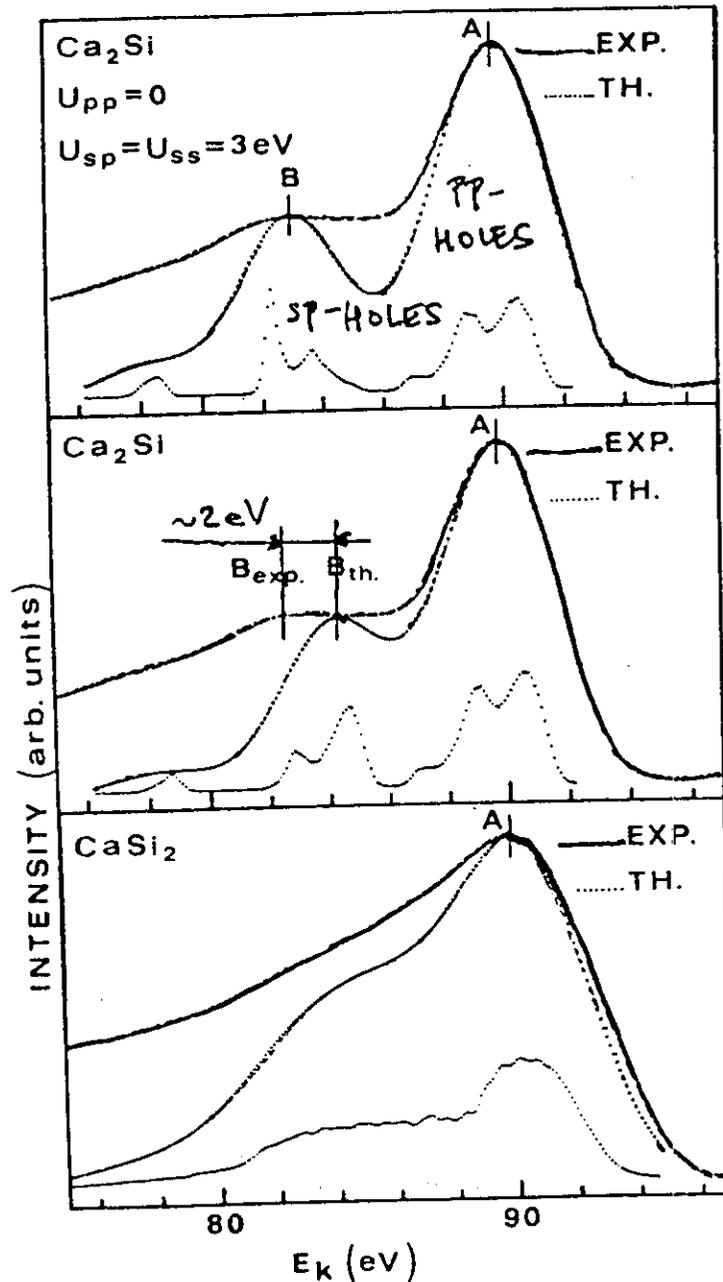BAND STATES

GaP   (b) (a)   theory   InP (b) (a)

(c)   (c)

pp

Intensity (arb. units)

-20   -10   VBM   -20   -10   VBM

Energy (eV)

(a) [TOTAL SELF-FOLDED TDOS] ......

(b) [TOTAL] - [1st SLAB]

(c) [TOTAL] ......

THEORY
P L$_{2,3}$VV

OCCUPIED STATES PROJECTED ONTO Si SITES

Si-$L_{2,3}$ VV AUGER LINESHAPE
SPECTROSCOPY

EXPERIMENT vs THEORY

M. SANCROTTI & al   PHYS REV   B37(1988)4805
                                                RAPID COMMUN

$U_{\ell\ell'}$ ON-SITE TWO-HOLE CORRELATION
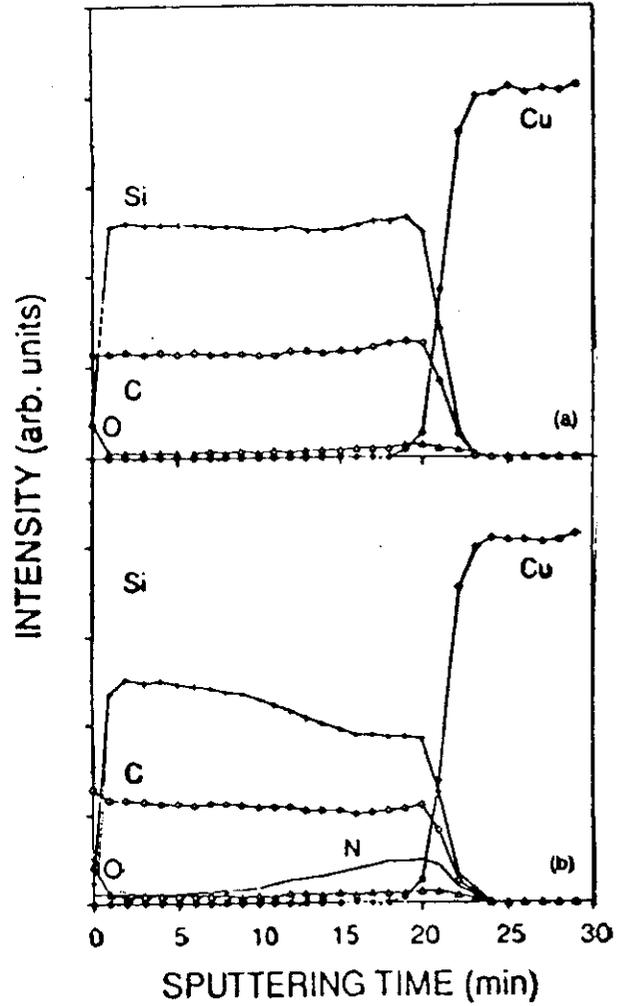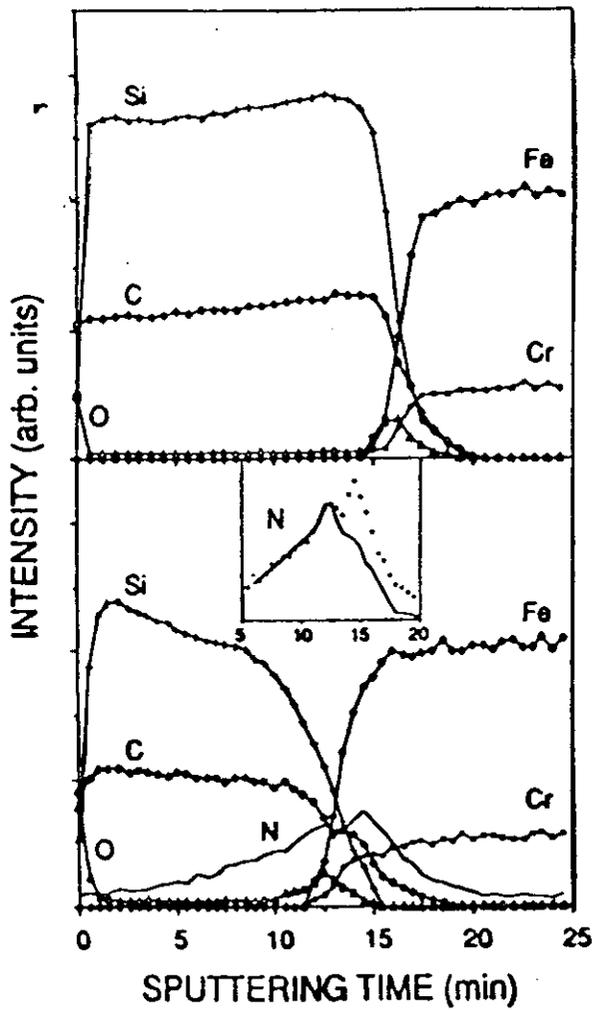   ENERGY

FIG. 10. Auger peak-to-peak heights, in derivative spectra, plotted as a function of sputtering time: (a) upper panel: as-deposited a-SiC film on steel substrate; (b) lower panel: N-implanted (1×10^{17} ions/cm²) SiC/steel sample. The inset shows the N depth distribution, across the interface, plotted in two different ways; dotted curve: N peak-to-peak height in the derivative Auger spectrum; continuous line: N peak height in the Auger integral spectrum.

FIG. 11. Auger peak-to-peak heights, in derivative Auger spectra, plotted as a function of sputtering time: (a) upper panel: as-deposited a-SiC film on Cu substrate; (b) lower panel: N-implanted (1×10^{17} ions/cm²) a-SiC/Cu bilayer.

SiC FILMS ON

STAINLESS STEEL & Cu

NITROGEN IMPLANTATION EFFECTS

N. LAIDANI, A. MIOTELLO, L. GUZMAN,
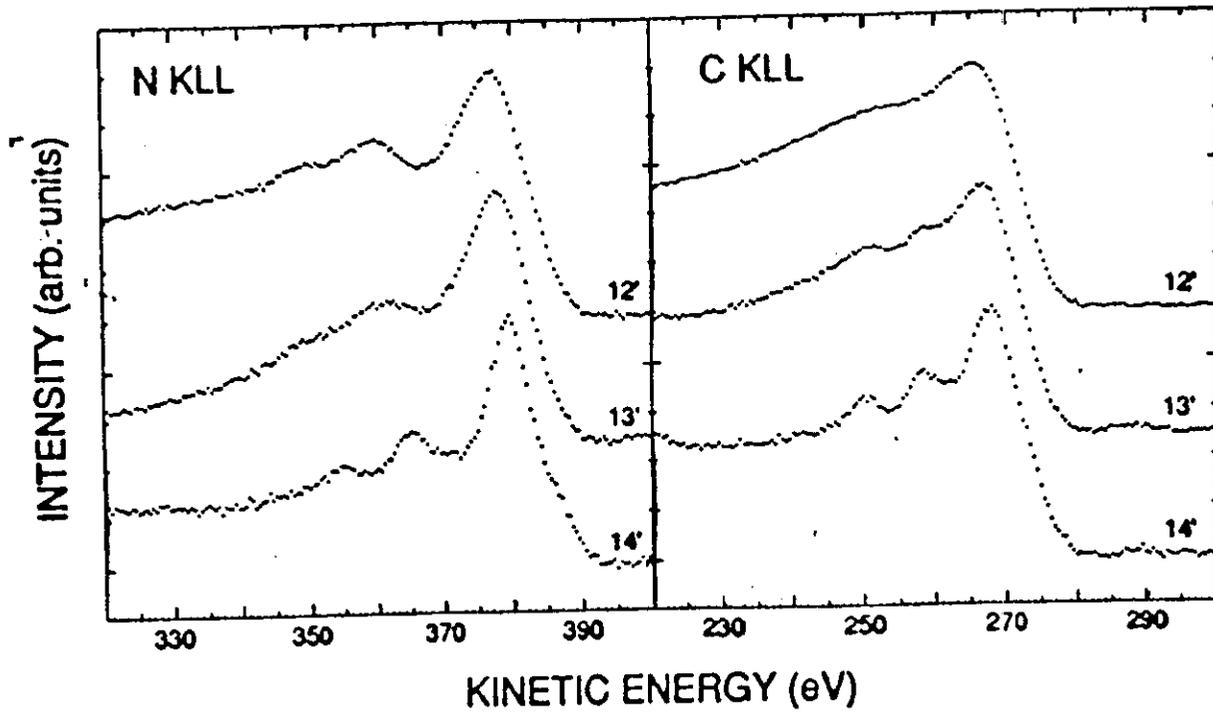S. TOCCIO, & L. CALLIARI
J. APPL. PHYS. 76 (1994) 285

FIG. 12. N KLL and C KLL Auger integral spectra at three selected points across the a-SiC/steel interfaces after 1×10^{17} N$^+$/cm^2 implantation.

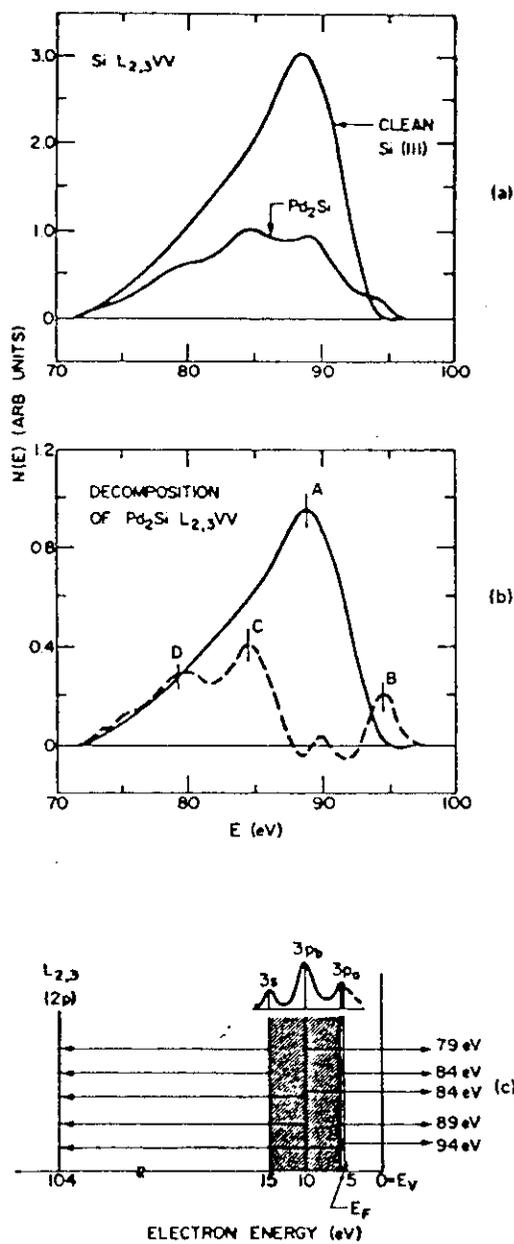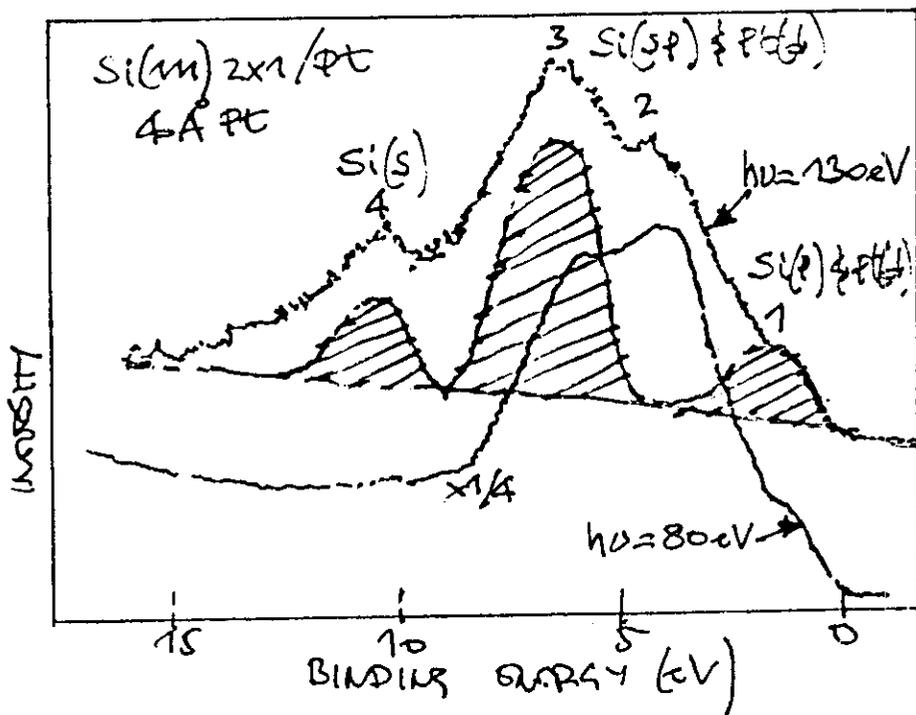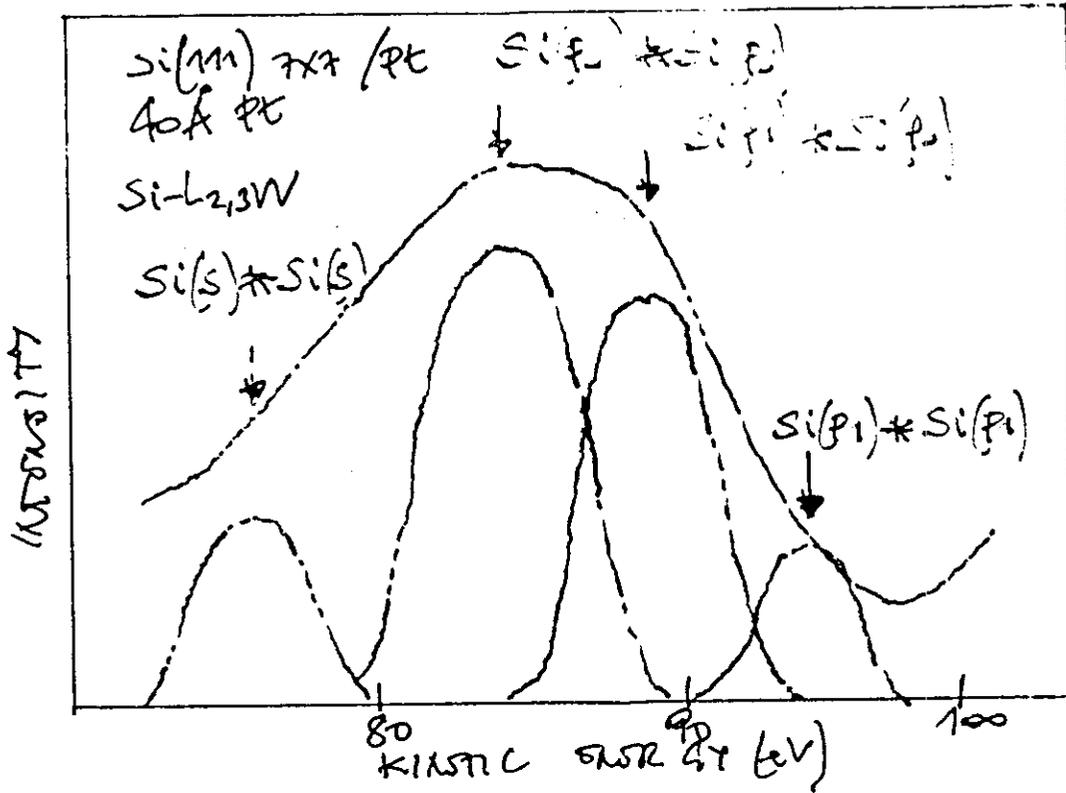FIG. 2. (a) Comparison of the $L_{2,3}VV$ Auger spectra observed on Pd_2Si and Si (111) surfaces. (b) Decomposition of the Auger spectra into two portions with the solid-line portion proportional to the elemental peak and the dashed-line portion showing the change as a result of silicide formation. (c) Schematics of the Auger transitions for Si $L_{2,3}VV$ in Pd_2Si according to calculated state densities.

Si(111) 7x7 /Pt   Si(s) *Si(s)
4Å Pt   Si(p₁) *Si(p₁)

Si-L₂,₃VV

Si(s) * Si(s)

Si(p₁) * Si(p₁)

INTENSITY

80   90   100
KINETIC ENERGY (eV)

Si(111) 2x1 /Pt   3 Si(sp) & Pt(d)
4Å Pt   2

Si(s)   hυ=130eV
4
                               Si(p) & Pt(d)
                                       1

INTENSITY

x1/4

hυ=80eV

15   10   5   0
BINDING ENERGY (eV)

FROM   P. MORGAN et al
       SURFACE SCIENCE (1987)

$$Si \quad L_{2,3} VV$$

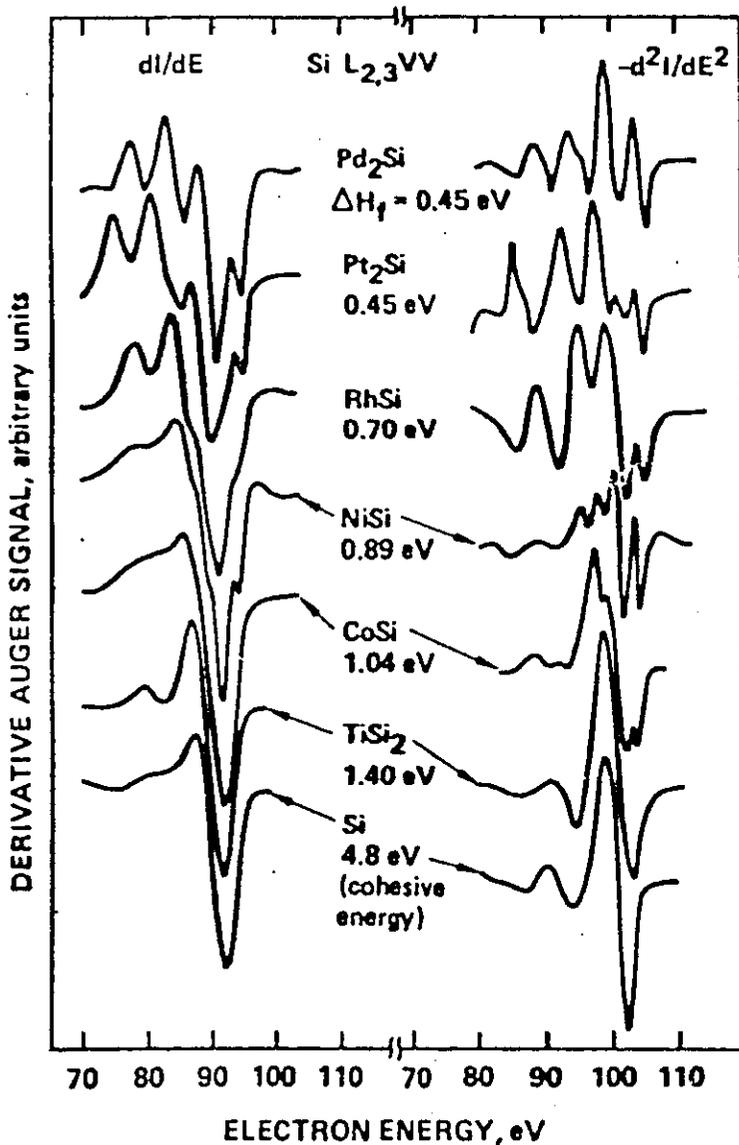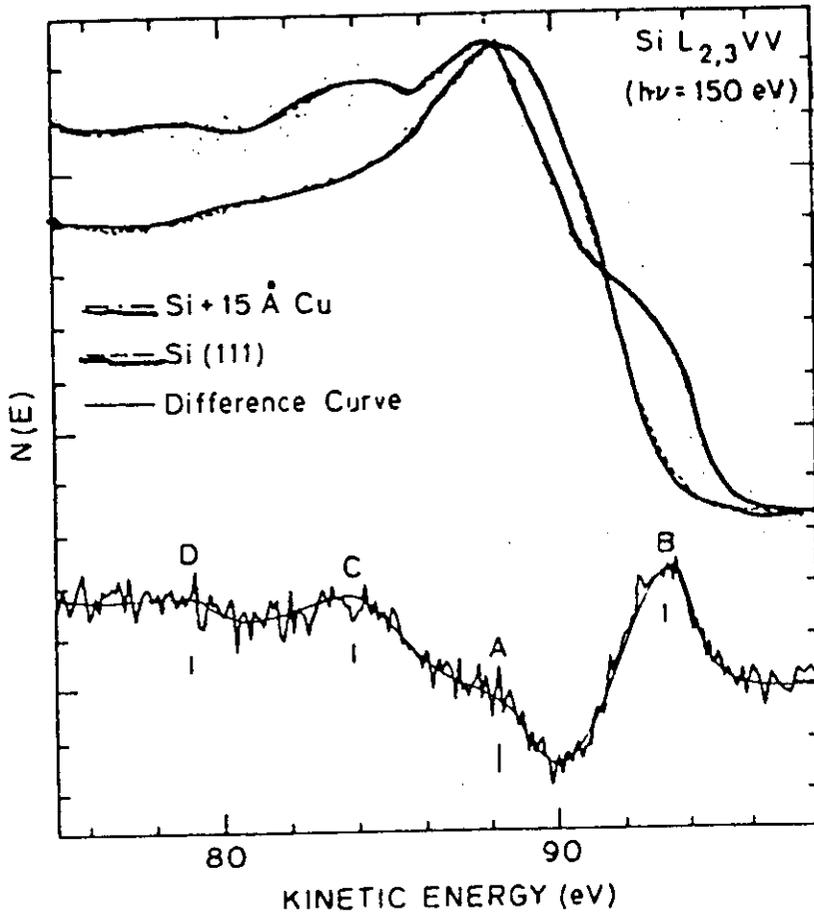$$IN \quad METAL \quad SILICIDES$$

$$dI/dE \qquad\qquad -d^2I/dE^2$$

FIG. 3. First- and second-derivative Si *LVV* Auger spectra of several silicides. Scale factors of the individual curves were adjusted to produce similar overall peak amplitudes in the plotted spectra. The silicide enthalpies of formation ΔH_f expressed per metal atom per formula unit are also indicated.

IG. 2. Si $L_{2,3} VV$ Auger lineshape for Si + 15 Å Cu (dots) and Si(111)
ashed line) obtained with $h\nu = 150$ eV. The bottom curve (solid) is the
fference curve and shows the position of the new peaks (see the text).
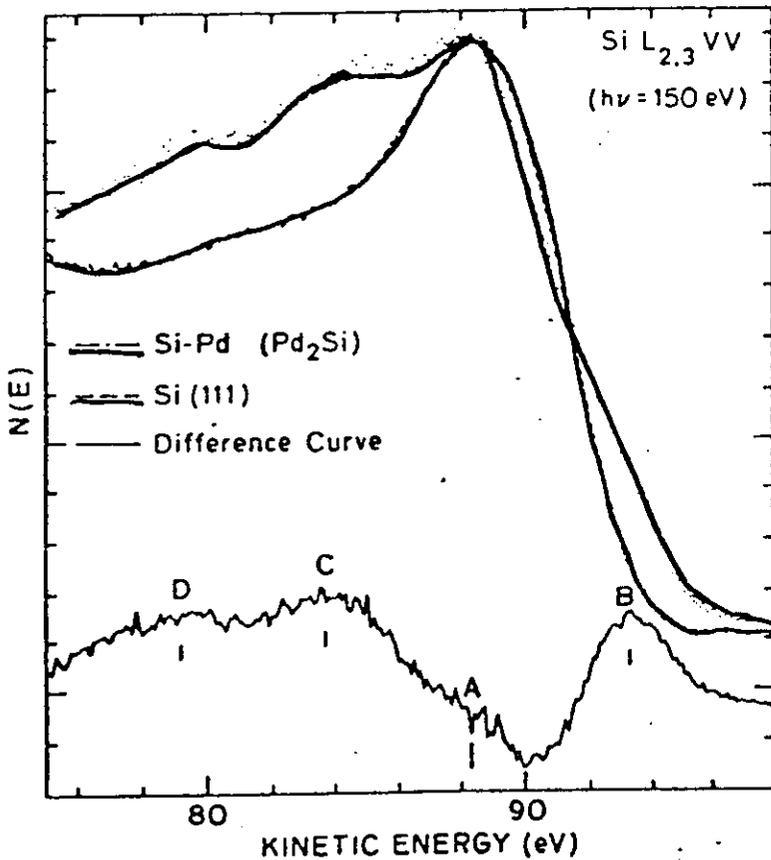
FIG. 2. Si $L_{2,3} VV$ line shapes $[N(E)]$ for Si-Pd (Pd$_2$Si) (dots),

OCCUPIED STATES
PROBED LOCAL TO
THE Si SITES VIA
Si $L_{2,3} VV$ AUGER
LINE-SHAPE
SPECTROSCOPY
SHOW A DISTRIBUTION
TYPICAL OF
(LATED) NEAR.-NOBLE
METAL SILICIDES
AT THE Cu/Si (111)
INTERFACE

G. ROSSI & I. LINDA
PR R 28 (1a0) 35a

VALENCE BAND   ; Si 2p
PHOTOEMISSION   SPECTROSCOPY

MOSTLY
Cu 3d STATES
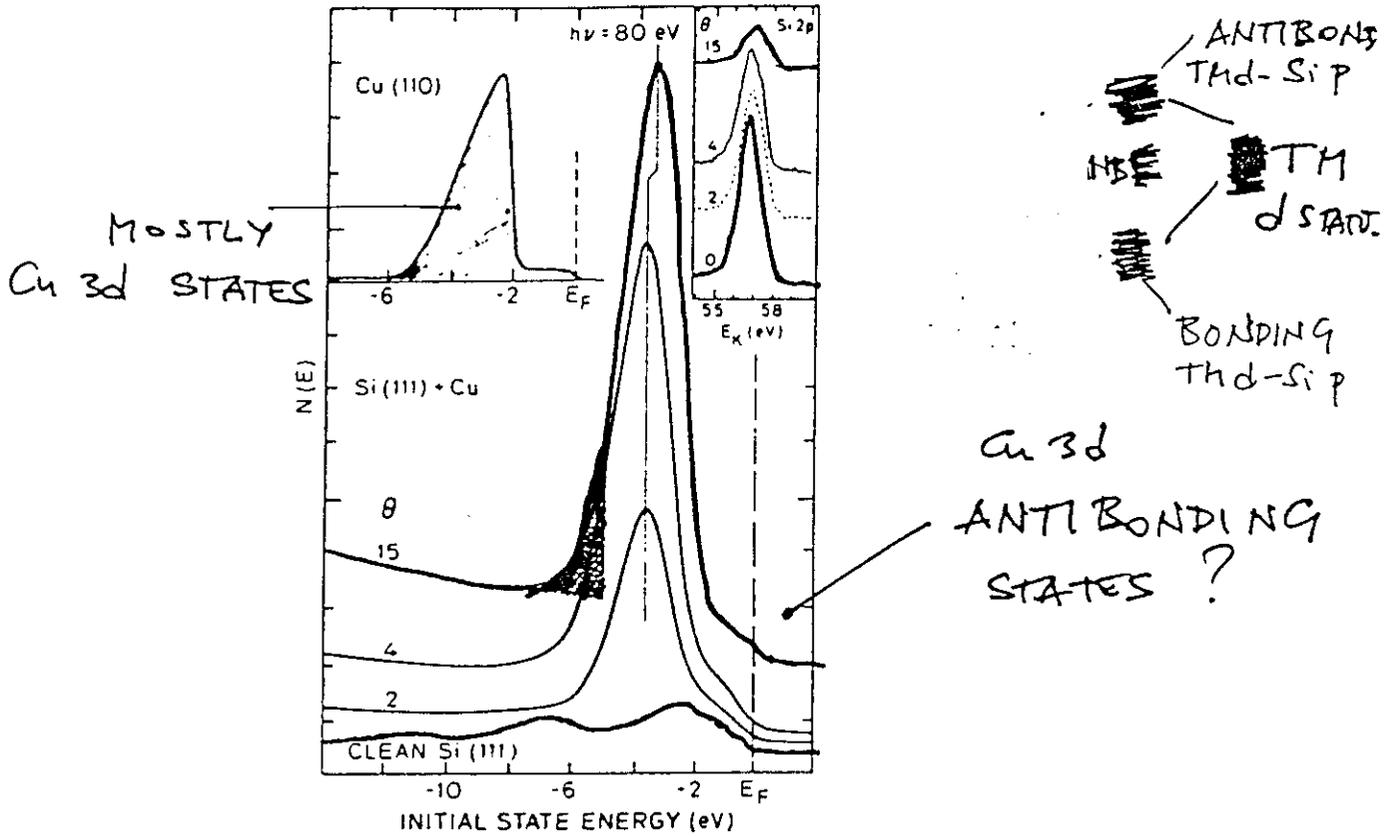
FIG. 1. Angle-integrated photoelectron energy distribution curves for
Cu(110), Si(111), and Si(111) + Cu as obtained with $h\nu$ = 80 eV, and for Si
2p core lines obtained with $h\nu$ = 160 eV. The shaded areas correspond to
the BE signal between − 5 and − 6 eV below E_F. Coverages θ are given in
Å.

ANTIBOND
Thd - Si p

H BE   TM
d STAT.

BONDING
Thd - Si p

Cu 3d
ANTIBONDING
STATES ?

MOSTLY Cu 3d - DERIVED   STATES

IN BONDING   CONFIGURATION

WITH   Si 3(sp) STATES

G. ROSSI & I. LINDAU   PR B 28 (1983) 3597

- 161 -

1 μm

FLAT REGION   SPATIALLY   RESOLVED (∼ 200 nm)
pseudo-5×5 Si $L_{2,3}$VV   AUGER   LINE-SHAPE

ISLAND

p-5×5
Si

N(E) E (arb. units)

dCN(E) EJ /dE (arb. units)

a

b

c

a'

b'

c'

ISLAND

FLAT REGION

FLAT REGION AFTER SOFT SPUTTERING

80   90   100   80   90   100
Kinetic Energy (eV)

CALLIARI,
MARCHETTI &
SANCROTTI
PHYS REV B 34
(1986) 521

Si (111) 2×1 +
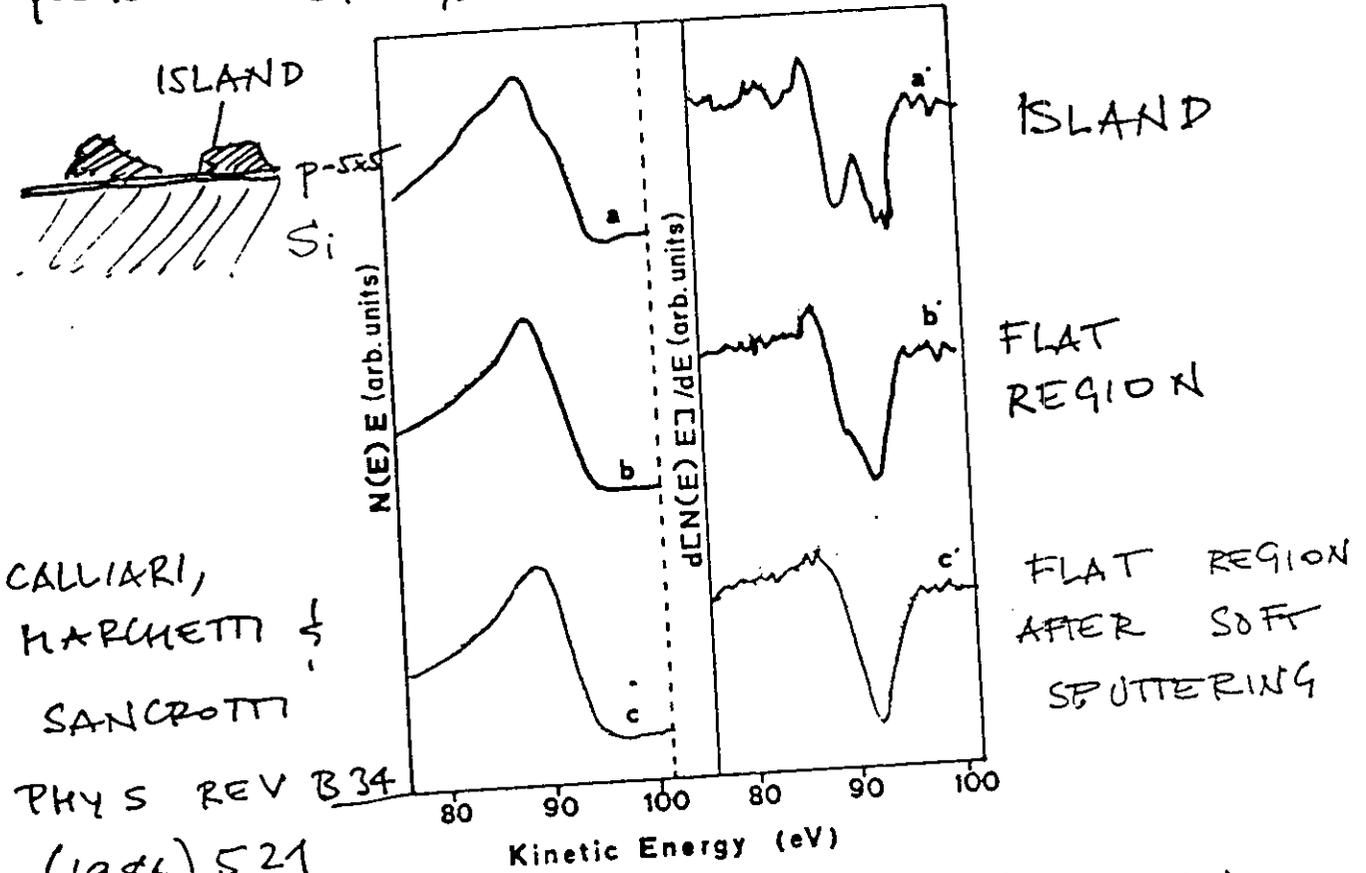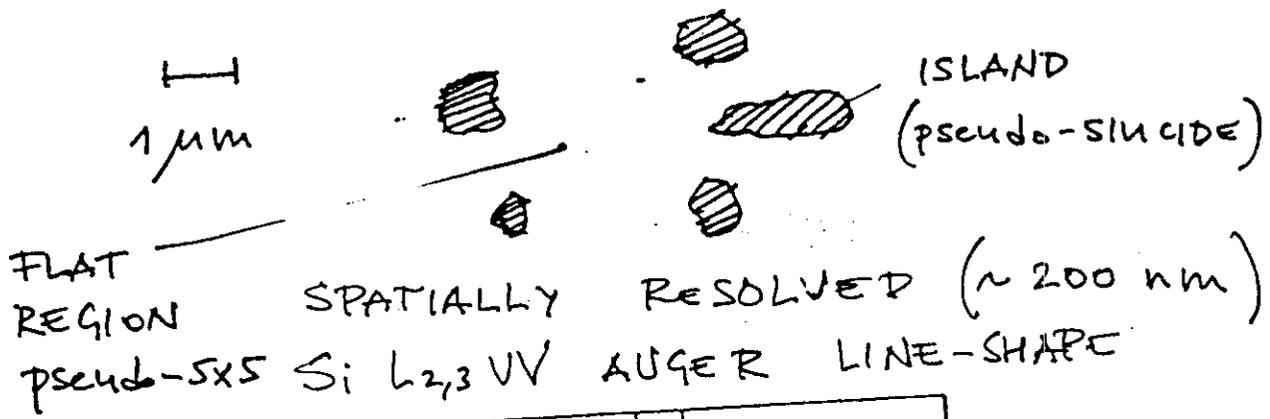+40 ML Cu +
ANNEALING @ 450°

FIG. 4. Spatially resolved Si $L_{2,3}$VV line shape in the integral form from different sites of a thermally agglomerated Si + 40 ML Cu sample: island, a; flat region, b; and flat region after a mild sputtering step, c. In the right column, the corresponding differentiated curves a', b', and c' are shown.

X-Ray Intensity (arb. units)

(a) island   (b) flat region

Si (Kα)   Si (Kα)

Cu (Kα)   Cu (Kα)
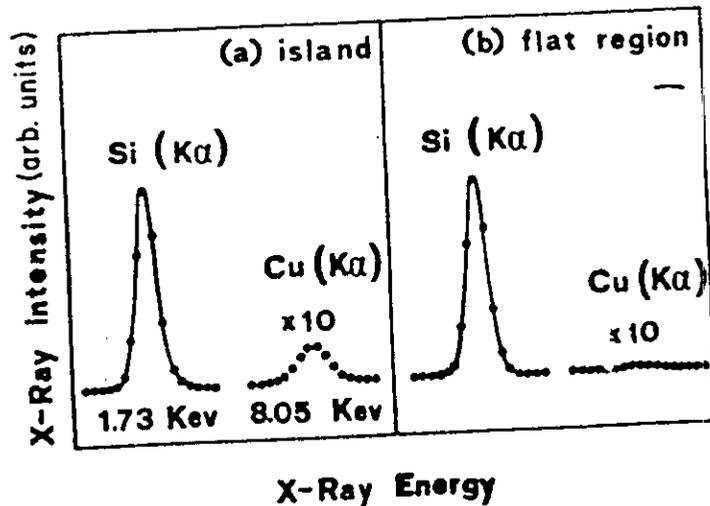x 10   x 10

1.73 Kev   8.05 Kev

X-Ray Energy

FIG. 6. Characteristic x-ray emission spectra (acquired with an energy-dispersive spectrometer) from an island and a flat re-
____ Si + 40 ML Cu sample.

Wire S2 (NiZn/ZnCo) after vulcanization
and humidity/temperature ageing

Legend: ·····■····· S → ·O Ni
        ····●···· C —◆— Fe —■· · Zn

Rubber compound WITH Co promoter

GOOD adhesion

concentration (at.%)

C

Fe

Zn

Ni

S

O

Sputtering time (min)

Rubber compound WITHOUT Co promoter

POOR adhesion

concentration (at.%)

Fe

Zn

Ni

O

C

S

Sputtering time (min)

J. Kovač, private communi.